BYTEBOOKS BUILD YOUR OWN Z80 COMPUTER

Design Guidelines and **Application Notes**

by Steve Ciarcia

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Please enjoy "Build Your Own Z80 Computer" as a great blast from the past. Its style is the foundation on which Circuit Cellar magazine was built and continues to grow. I look forward to seeing you become a part of the ongoing Circuit Cellar success story.

Sincerely,

Sean Donnelly, Publisher – Circuit Cellar <u>circuitcellar@circuitcellar.com</u>



Build Your Own Z80 Computer

Design Guidelines and Application Notes

Steve Ciarcia



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Build Your Own Z80 Computer

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Build Your Own Z80 Computer

To my wife Joyce, Steve Sunderland, and Judy and Lloyd Kishinsky

Introduction

A few years ago, when microprocessors were first introduced, computer enthusiasts and electrical engineers were one and the same. Those of us who lived only to solder kluge after kluge basked in our glory. Now, however, the prices of completely assembled and packaged systems have plummeted. Today anyone with an interest, almost regardless of technical capabilities, can own and operate a computer. Buying a computer is now similar to purchasing a television set and the ranks of computer enthusiasts have swelled accordingly.

With any popular movement, the available literature reflects the concerns of a majority of the followers. And, consistent with the popularization of computer science, the technical emphasis on computer bookshelves has shifted away from hardware design. Other than introductory texts called, say, *How Logic Gates Work*, most computer books either treat microcomputer hardware simplistically or attempt to be "catch-all" cookbooks, sometimes omitting tasty ingredients. Often, the only alternatives are engineering texts and trade journals, tedious reading at best.

For a number of years, I have been writing a column for *BYTE* magazine, and reader response has shown that there still exists a great deal of interest in hardware design and do-it-yourself projects. At the same time, I've been painfully aware of the lack of materials for such people. Most queries come from technical or high school students who have read all the descriptions and studied the block diagrams, but who crave practical answers and system examples. Unfortunately, there are very few books I can suggest.

Build Your Own Z80 Computer is a book written for technically minded individuals who are interested in knowing what is inside a microcomputer. It is for persons who, already possessing a basic understanding of electronics, want to build rather than purchase a computer. It is not an introductory electronics handbook that starts by describing logic gates nor on the other hand is it a text written only for engineering students. While serving to educate the curious, the objective of this book is to present a practical, step-by-step analysis of digital computer architecture, and the construction details of a complete and functional microcomputer.

The computer to be constructed is called a Z80 Applications Processor—ZAP computer for short. It is based on the industry standard Zilog Z80 microprocessor chip. This chip was chosen on the basis of its availability and low cost, as were the other components for ZAP. To further help the homebrew enthusiast, and for those experimenters who prefer to start a book at the back, I have listed in Appendix A a company that supplies parts and programmed EPROMs (erasable-programmable read-only memory).

I have structured the book as a logical sequence of construction milestones interspersed by practical discussions on the theory of operation. My purpose is twofold: to help a potential builder gain confidence, and to make the material more palatable through concrete examples.

Though this is basically a construction manual, considerable effort is given to the "why's" and "how's" of computer design. The reader is exposed to various subjects, including: the internal architectures of selected microprocessors, memory mapping, input/output interfacing, power supplies, peripheral communication, and programming. All discussions try to make the reader aware of each individual component's effect on the total system. Even though I have documented the specific details of the ZAP computer, it is my intention (and the premise of the book) that the reader will be able to configure a custom computer. ZAP is an experimental tool that can be expanded to meet a variety of applications. ZAP is constructed as a series of subsystems that can be checked and exercised independently. The first item to be built is the power supply. This is a good way to test ability and provide immediate positive reinforcement from successful construction. The three-voltage supply is both overvoltage and overtemperature protected and has adequate current for an expanded ZAP system.

Next, the reader learns why the Z80 was chosen for ZAP and the architectural considerations that affect component selection on the other subsystems. A full chapter is devoted to the Z80 chip. Each control signal is explained in detail and each instruction is carefully documented.

The hardware construction proceeds in stages with intermediate testing in order to ensure success. The basic elements of the computer are assembled first and then checked out. The reader selects which peripherals are to be added. The book contains sections on the construction of a hexadecimal display, keyboard, EPROM programmer, RS-232C serial interface, cassette mass storage system, and fully functional CRT terminal. In addition, a chapter addresses interfacing the ZAP to analog signals. I provide specific circuits that can convert ZAP into a digital speech synthesizer or a data acquisition system and data logger.

A special 1 K (1024 bytes) software monitor coordinates the activities of the basic computer system and the peripherals. Software is explained through flow diagrams and annotated listings. With this monitor as an integral component, ZAP can function as a computer terminal, a dedicated controller, or a software development system.

Build Your Own Z80 Computer is a book for hardware people. It cuts through the theoretical presentations on microcomputers and presents a real "How-to" analysis suitable for the reader with some electronics experience or for the novice who can call someone for supervision. From the power supply to the central processor, this book is written for people who want to understand what they build.

Steve Ciarcia May 1981

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CHAPTER 1 POWER SUPPLY

It's not enough to build a central processor card with a little input/output (I/O) and memory, and call it a computer. From the time you walk over to the computer and flip the switch, the system is completely dependent upon the proper operation of its power supply. A book concerned with building a computer system from scratch would be completely inadequate without a description of how to construct an appropriate power supply.

Much has been written on the subject of direct current (DC) power supplies. There are DC to DC and AC (alternating current) to DC converters, switching and shunt regulators, constant voltage transformers, and so on. It's not my intention to make a power supply expert out of everyone. Instead, I will outline the design of the specific DC power supply which we will use to power the Z80 Applications Processor (ZAP).

In large computers, the DC supplies convert enormous amounts of power to run thousands of logic chips; by necessity, manufacturers choose the most efficient methods of power conversion. These state of the art methods would be expensive and difficult for the hobbyist to build in prototype form. Fortunately, the power demands for ZAP are much less than those of the large computers; we can take advantage of established design methods while incorporating the latest advances in regulator technology. Figure 1.1 is a block diagram of the power supply for ZAP.

Each of the three DC supplies necessary to power ZAP consists of three basic modules: a transformer section to reduce the 120 VAC line voltage to the lower voltage used by the computer; an input rectifier/filter to convert AC to low ripple DC; and a regulator which stabilizes the output at a fixed voltage level. Overvoltage protection circuitry will be discussed separately.

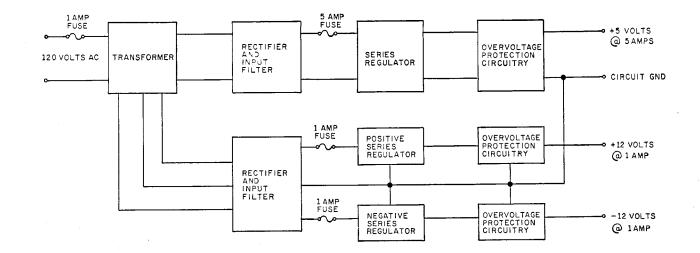


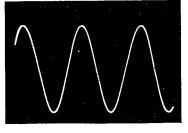
Figure 1.1 A block diagram of the basic power supply for the Z80 Applications Processor (ZAP).

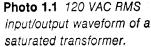
The proper specification of the transformer and input filter is often neglected by hobbyists who overlook the consequences of a poorly designed filter. This is caused, in part, by the abundant technical information circulated by semiconductor manufacturers extolling the virtues of their regulator circuits. One can easily conclude from this "publicity gap" that the regulation section of the power supply is the only component worthy of consideration; and in fact, advances in regulator design and the advent of high-power, three-terminal regulators have reduced the need for the analog designer in the application. In the past, 25-odd components and considerable calculations were necessary to produce an adequate voltage regulator. Now, however, the majority of applications can be accommodated with a single, compact device. Even so, an input filter section should not be taken lightly and still requires thorough consideration and a modest amount of computation for each application.

There are three supply voltages necessary to operate ZAP. Each supply incorporates an input filter section. Because the +5 V supply is the most important, it receives the most attention. For the purposes of this discussion, we will divide the supply into two sections: transformer/input filter, and output regulator.

A standard input filter block diagram is shown in figure 1.2. In its simplest form, it consists of three components that function as follows:

- A transformer that isolates the supply from the power line and reduces the 120 VAC input to usable, low-voltage AC.
- A bridge rectifier that converts AC to full-wave DC and satisfies the charging current demands of the filter capacitor.
- A filter capacitor that maintains a sufficient level between charging cycles to satisfy the regulator input voltage limitations.





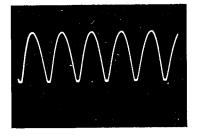


Photo 1.2 Rectifier waveform.

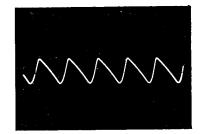


Photo 1.3 *Ripple waveform at various loads.*

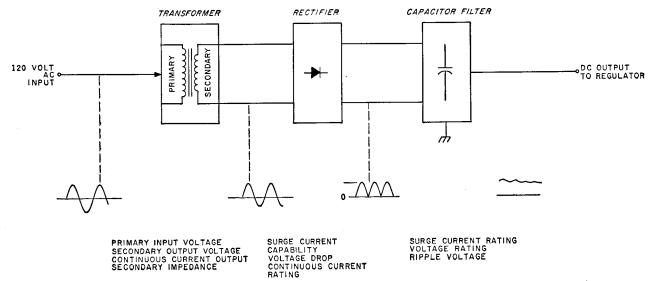


Figure 1.2 A block diagram of a standard input filter.

1

DESIGNING AN INPUT FILTER

You would think that specifying the transformer would be the first consideration when designing a power supply. Yes and no. The approximate output voltage can be determined by rule of thumb, but the exact requirements are deduced only by a thorough analysis that proceeds from the desired output voltage back. In practice, the difference between a reasonable guess and a laborious analysis will be important only to a person capable of manufacturing his own transformer. In most instances, the hobbyist will have to rely upon readily acquired transformers with standard output voltages. For this reason, my approach is predicated on the practical aspects of power supply design rather than on the minute engineering details that have no real bearing on the outcome.

A 120 VAC RMS (root mean square) sine wave is applied to the primary of the transformer. Figure 1.2 illustrates the waveforms anticipated at selected points through the filter section. Photo 1.1 shows that 120 VAC is actually 340 V peak to peak; care should be used in the insulation and mounting of components.

The secondary output of the transformer will be a similar sine wave, reduced in voltage. It is then applied to a full-wave bridge and the waveform will appear as in photo 1.2. You'll notice a slight flat spot between "humps." As a result of dealing with actual electronic components rather than mathematical models, we should be aware of certain peculiarities. Silicon diodes exhibit threshold characteristics and, in fact, have a voltage drop of approximately 1 V across each diode. This voltage drop becomes significant in full-wave bridge designs and, as figures 1.3a, 1.3b, and photo 1.2 illustrate, can accumulate as diodes are added in series. The 2 V loss in the bridge is an important consideration and should be reflected in the calculations.

The voltage regulator requires a certain minimum DC level to maintain a constant output voltage. Should the applied voltage dip below this point, output stability is

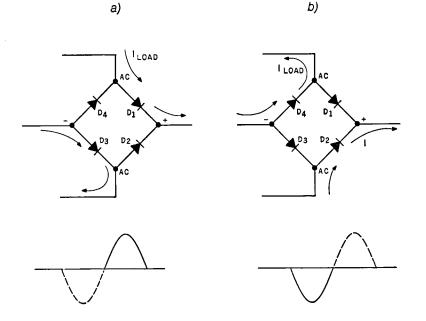


Figure 1.3 The direction of the current flow through the full-wave bridge.

- a) During the positive half of the AC cycle, current flow is through D_1 and D_3 ; D_2 and D_4 are not conducting. $V_{D1} + V_{D3} \approx 2$ volts.
- b) During the negative half of the AC cycle, current flow is through D_2 and D_4 ; D_1 and D_3 are not conducting. $V_{D2} + V_{D4} \approx 2$ volts.

severely degraded. Thus, a filter capacitor is used to smooth out the "humps" in the rectified sine wave. When the diodes are conducting, the capacitor stores enough charge to maintain the minimum voltage required until the next charge cycle. (In practice, we wouldn't want to cut it that close.) The input to the transformer is 60 Hz, but because of the characteristics of full-wave rectification, the charging cycles occur at 120 Hz. The capacitor charges up during one 8.3 ms cycle, and, as the regulator draws power from it to satisfy the load demands, it must continue to provide at least the highest minimum input voltage required by the regulator until the next charge cycle, 8.3 ms later. This periodic charge/discharge phenomenon is shown in photo 1.3. The magnitude of the voltage fluctuation between the two peaks of the cycle is referred to as ripple. The highest magnitude of the waveform including the ripple is designated as peak voltage. Both are important to remember and are shown in figure 1.4.

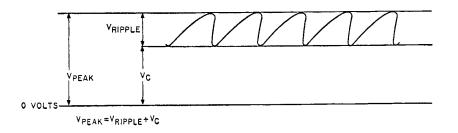


Figure 1.4 Output voltage as a combination of a certain steady-state voltage (V_c) plus a ripple voltage (V_{RIPPLE}).

Given a basic understanding of the individual components at this stage, we can proceed to the case at hand: a 5 V, 5 A power supply. For reasons we'll discuss later, the 5 V regulator section of this supply will require an absolute minimum of 8.5 V for proper operation. This means that whatever the magnitude of V_{PEAK} and V_{RIPPLE} , the final V_c level must not go below 8.5 V, or the regulator will not work. By giving ourselves some leeway, say $V_c = 10$ V, we can take a little more poetic license with the calculations and still produce a good design. Going much above 10 V, while still satisfying the input criteria, would increase power dissipation and possibly destroy the regulator. There is an answer to this vicious circle and that's to be conservative. Experience shows that adding a little insurance is worthwhile.

Now that 10 V is the goal, we can appropriately select the other filter components to meet it. Figure 1.5 is the filter circuit of our 5 V supply. R_s is the resistance of the secondary winding of the transformer. For a 5 to 8 A transformer, it will average about 0.1 ohms. The first values to recognize follow:

$$V_{C} = V_{REGULATOR MINIMUM INPUT VOLTAGE} = 10 V$$

$$I_{OUT} = I_{REGULATOR LOAD} = 5 A$$

$$R_{S} = R_{TRANSFORMER SECONDARY RESISTANCE} = 0.1 \text{ ohms}$$

 V_{PEAK} can be any voltage up to the maximum input for which the regulator is rated. However, this will increase the circuit power dissipation. The rule of thumb I use when designing supplies of this type is that V_{PEAK} should be approximately 25% higher than V_c . In this way, the capacitor value will be kept within reasonable limits. The ratio of V_c to $(V_{PEAK} - V_c)$ is referred to as the ripple factor of the filter capacitor.

$$Y_F = \frac{V_{PEAK} - V_C}{V_C} = \frac{12.5 - 10}{10} = 25\%$$

A ripple factor of 25% at 5 A will fall well within the acceptable capacitor ripple current ratings and eliminate the need for the hobbyist to dig into manufacturers' specifications of capacitors. This ripple factor is arbitrary, but it is best to keep it as low as possible.

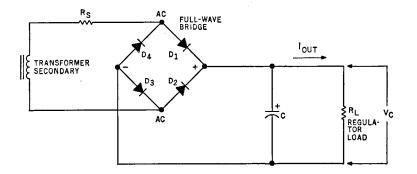


Figure 1.5 The input filter circuit of the 5 V power supply.

SIZING THE CAPACITOR

We now know that the capacitor must sustain 10 V from a peak input of 12.5 V.

$$V_{PEAK} = 12.5 V$$

$$V_{c} = 10 V$$

$$V_{RIPPLE} = 2.5 V$$

$$V_{c} = V_{PEAK} - V_{RIPPLE}$$

The next consideration is to choose a capacitor that will accomplish this goal. Another rule of thumb calculation that saves considerable labor is

$$C = \frac{\mathrm{dt}}{\mathrm{dv}} \mathrm{I}$$

where

C = capacitor value in farads = ?
I = maximum regulator current = 5 A
dt = charging time of capacitor = 8.3 ms (120 Hz)
dv = allowable ripple voltage =
$$2.5 \text{ V}$$

Plugging in the values of our circuit,

$$C = \frac{(5)(8.3 \times 10^{-3})}{(2.5)} = 16.6 \times 10^{-3}$$
 farads

or,

 $C = 16,600 \text{ microfarads } (\mu F)$

Generally available commercial electrolytic capacitors have a tolerance of +50 and -20%. To be on the safe side and to make it easier to find a standard stock component, a value of 20,000 μ F is better. The added 3,400 μ F reduces the ripple by another 0.4 V and gives us a little "insurance." The only other item to consider with the capacitor is operating voltage. Because the design dictates that V_{PEAK} is 12.5 V, this should be a satisfactory rating. However, experience shows that transformers end up running at higher output voltages than labeled and that 12.5 V at 115 VAC hits 13.6 V when the line voltage goes up to 125 VAC. A capacitor voltage of 15 VDC would appear to satisfy the requirement, but I recommend using the next increased standard value of 20 VDC.

The capacitor is therefore 20,000 μ F at 20 VDC. The rectifier can be a monolithic full-wave bridge, or it can be four discrete diodes. Note that because a bridge is usually encapsulated, the four terminals are labeled instead of showing the polarity markings of the individual diodes. The designations for the four terminals are two AC input terminals, and a + and - output terminal.

THE RECTIFIER

There are three considerations when choosing a rectifier: surge current rating, continuous current, and PIV (peak inverse voltage) rating. These choices are not inconsequential and must be considered carefully.

When a power supply is first turned on, the capacitor is totally discharged. In fact, it will instantaneously appear to be a 0 ohm impedance to the voltage source. The only aspect of the circuit that limits the initial current flow is the resistance of the secondary transformer windings and the connecting wiring; designers often add a series resistance to limit surge current.

The surge current in this circuit is

$$I_{SURGE} = \frac{V_{PEAK}}{R_s} = \frac{12.5}{0.1} = 125 \text{ A}$$

and the time constant of the capacitor is

$$\tau \cong \mathbf{R}_s \times \mathbf{C} \cong (0.1)(20 \times 10^{-3}) = 2 \text{ ms}$$

As a rule of thumb, the surge current will cause no damage to the diode if I_{SURGE} is less than the surge current rating of the diode and if

τ < 8.3 ms (which it is)

We can't check surge rating until after we choose a diode bridge, but the other two parameters can be defined.

The bridge can be either of the following:

Motorola MDA 980-2: $I_{CONT} = 12 \text{ A}$, $I_{SURGE} = 300 \text{ A}$, PIV = 100 V Motorola MDA 990-2: $I_{CONT} = 27 \text{ A}$, $I_{SURGE} = 300 \text{ A}$, PIV = 100 V

Both of the above bridges have a surge current rating of 300 A, so our surge requirement is also satisfied.

PIV

PIV (peak inverse voltage) is the maximum voltage that may appear across the diode before it self-destructs. Diodes, unlike capacitors, are unforgiving; transients will wipe them out. It is not unusual to have 400 V transients on the 115 VAC input line. This causes our 12.5 V to shoot up momentarily to 43 V! The bridge rectifier should therefore have a minimum PIV rating of 50 V. For a few pennies more, you can get a bridge rated for 100 PIV. Remember, insurance costs less than computers.

CONTINUOUS CURRENT

The last consideration is continuous current rating. Whereas the regulator may be designed for a 5 A output, the particular regulator I have chosen will draw 7 A if shorted. This is not standard operating procedure, but it can happen. The suggested standard component would be a 12 A, 50 PIV bridge. A preferred component would be one rated for 12 A at 100 PIV or, for an additional 15% cost premium, a 27 A at 100 PIV. This last design choice is strictly brute force, but it saves the diode bridge should the capacitor ever short-out accidentally. A 6 A transformer might put out more than 12 A in a short-circuit mode, but it's unlikely that it would be capable of 27 A. Either choice will satisfy the design, but only one saves the design from the builder.

THE TRANSFORMER

Now let's consider the transformer. We have determined the voltage drops across the various components. The values are used to calculate the required RMS (root mean

square) secondary voltage in the following way:

$$V_{SEC(RMS)} = \frac{V_c + V_{RIPPLE} + V_{RECT}}{\sqrt{2}}$$

$$V_{RECT} = Voltage drop across each diode-(approximately 1 V per diode)$$

$$= \frac{10 + 2.5 + 2.0}{1.414}$$

$$= 10.25 V$$

In practice, a 10 V, 6 A standard value transformer will be close enough.

The components of the + and -12 V supplies are chosen in a similar manner, with the exception that required current is only 1 A, and a 200 PIV bridge is recommended because of the particular rectifier configuration. The finished schematic of the transformer and filter section of our computer is illustrated in figure 1.6.

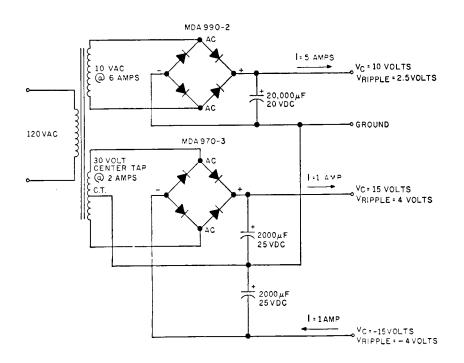


Figure 1.6 A schematic diagram of a transformer and input filter section.

VOLTAGE REGULATORS

The voltage regulator section of our power supply is the next consideration. All voltage regulators perform the same task: they convert a given DC input voltage into a specific, stable DC output voltage and maintain this setpoint over wide variations of input voltage and output load. The typical voltage regulator, as shown in figure 1.7, consists of the following:

- a reference element that provides a known stable reference voltage
- a voltage translation element that samples the output voltage level
- a comparator element that compares the reference and output level to produce an error signal
- a control element that can utilize this error signal to provide translation of the input voltage to produce the desired output

The control element depends on the design of the regulator and varies widely. The control determines the classification of the voltage regulator: series, shunt, or switch-

ing. For the series regulator, the control element regulates the output voltage by modulating the series element, usually a transistor, and causes it to act as a variable resistor (figure 1.8). As the input voltage increases, the series resistance R_s also increases, causing a larger voltage drop across it. In this way, the output voltage (V_{out}) is maintained at a constant level.

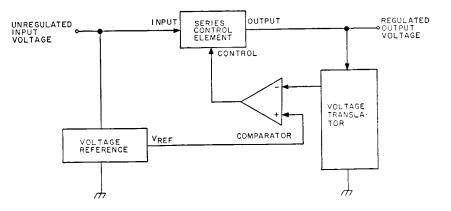
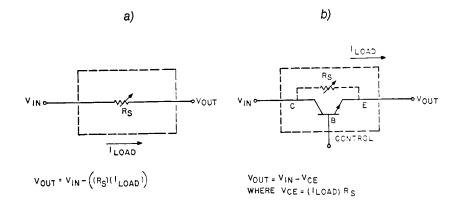
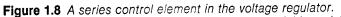


Figure 1.7 A block diagram of a typical voltage regulator.





a) The series control element acts as a variable resistance, R_s .

b) The series element is most often a transistor.

To accomplish this closed-loop control, a reference comparison and feedback system is incorporated into the hardware. A fixed and stabilized reference voltage is easily produced by a zener diode. The current produced is low, however; the device could not serve as a power regulator by itself.

The voltage translator connected to the output of the series control element produces a feedback signal that is proportional to the output voltage. In its simplest form, the voltage translator is a resistor-divider network. The two signals, reference and feedback, provide the necessary information to the voltage comparator for closed loop feedback to occur (figure 1.9). The output of the comparator effectively drives the base of the series pass transistor so that the voltage drop across the transistor will be maintained at a stabilized preset value when subtracted from the input voltage.

Modern power supply designers can still use individual components to construct the modular elements of a series voltage regulator, but most reserve this laborious endeavor for specialized applications. The ZAP computer system outlined here requires +5 V, +12 V, and -12 V. The combined temperature, stability, and drift

tolerances cannot exceed $\pm 5\%$ on any of the three set points. The easiest way to minimize risk is to reduce the number of circuit components to the bare minimum. Other designers had the same idea and thus the three-terminal regulator was invented. Figure 1.10 is the block diagram of such a device.

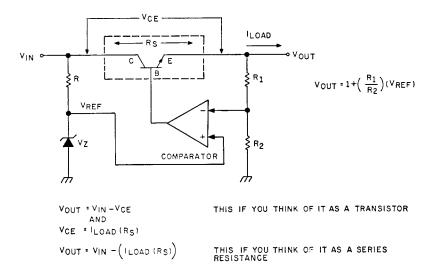


Figure 1.9 A schematic diagram of a series voltage regulator.

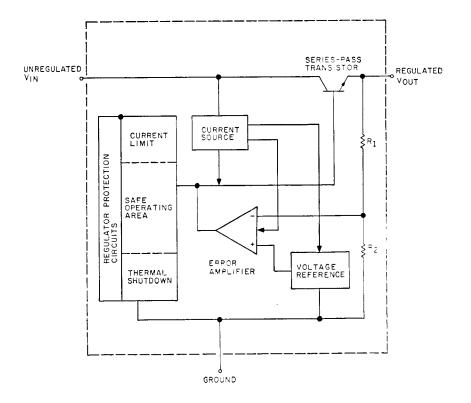


Figure 1.10 A block diagram of a three-terminal voltage regulator.

Basically, a three-terminal regulator incorporates all the individual transistors, resistors, and diodes into a single integrated circuit. While simple to use, these devices have a far more complicated internal structure than the series regulator of figure 1.9. Only three terminals are necessary in applications where the fixed output is a standard value such as: $\pm 5 \text{ V}$, $\pm 6 \text{ V}$, $\pm 8 \text{ V}$, $\pm 12 \text{ V}$, $\pm 15 \text{ V}$ or $\pm 24 \text{ V}$. The three connections are unregulated DC from our input filter, a ground reference, and finally, regulated DC output.

In a three-terminal regulator, the voltage reference is the most important part because any abnormality or perturbation will be reflected in the output. Therefore, the reference must be stable and free from noise or drift. More advanced designs use bandgap reference circuits rather than zener diodes. Because of its complexity, such an approach is practical only in the integrated circuit (IC) environment. Essentially, a bandgap reference voltage is derived from the predictable temperature, current, and voltage relationships of a transistor base-emitter junction.

Another advantage of the three-terminal regulator is that in monolithic circuits, stable current sources can easily be realized by taking advantage of the good matching and tracking capability of monolithic components. Also, as in the previous case, the designer can add as many active devices as necessary without significantly increasing the IC circuit area. Operation of the reference circuit at a constant current level reduces fluctuations due to line-voltage variation. Thus, the output has increased stability. The error amplifier is also operated at a constant current to reduce line-voltage influence.

The most important consideration for the hobbyist is that these chips incorporate protective circuitry, guarding the regulator from certain types of overloads. They protect the regulator against short-circuit conditions (current limit); excessive input/output differential condition (safe operating area); and excessive junction temperatures (thermal limit). Of course, all this circuitry is designed to protect the regulator, not the computer.

CHOOSING A REGULATOR

The 5 A μ A78H05 hybrid voltage regulator has all the inherent characteristics of the monolithic three-terminal regulator (ie: full protective circuitry). Each hermetically-sealed TO-3 package contains a μ A78M05 monolithic regulator chip driving a discrete series-pass transistor Q1 and two short-circuit-detection transistors Q2 and Q3 (see figure 1.11). The pass transistor is mounted on the same beryllium oxide substrate as the regulator chip, thus insuring nearly ideal thermal transfer between Q1 and the temperature-sensing circuit of the 78M05.

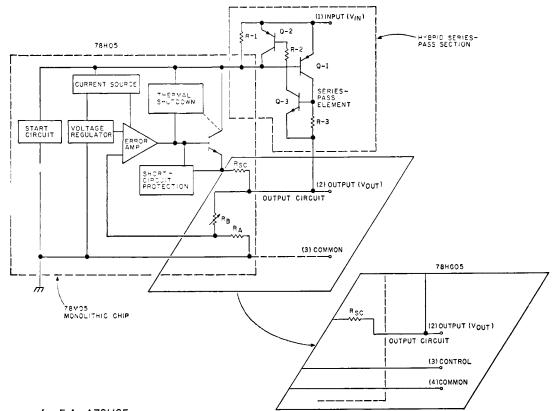


Figure 1.11 A block diagram of a 5 A µA78H05 and µA78HG05 hybrid voltage regulator.

ELECTRICAL CHARACTERISTICS: TJ = 25°C, IOUT = 2.0 A unless otherwise specified

			A78H0		
CHARACTERISTICS	CONDITIONS	MIN TYP MAX		UNITS	
Output Voltage	I _{OUT} = 2.0 A, V _{IN} = 10 V	4.8	5.0	5.2	v
Line Regulation	V _{IN} = 8.5 to 25 V		10	50	m٧
Load Regulation	10 mA ≤ I _{OUT} ≤ 5.0 A. V _{IN} = 10 V		10	50	mV
Quiescent Current	IOUT = 0, VIN = VOUT + 5.0 V			10	mΑ
Ripple Rejection	IOUT = 1.0 A, f = 210 Hz, 5.0 V P-P	60			dB
Output Noise	10 Hz < f < 100 kHz, VIN = VOUT + 50 V		40		µVRMS
	I _O = 50 A		3.0		v
Dropout Voltage	i ₀ = 3.0 A		26		V
Short Circuit Current Limit	VIN = 10 V		70		Apk

Figure 1.12 Electrical characteristics of the µA78H05 voltage regulator.

The output circuit is designed so that the worst-case current requirement of the Q1 base, added to the current through R2, always remains below the current-limit threshold of the 78M05. Resistor R1, in conjunction with Q2 and Q3, makes up a current serse and limit circuit to protect the series-pass device from excessive current drain.

Safe area protection is achieved by brute force and is designed with the hobbyist in mind. The series-pass transistor is capable of handling the short-circuit current at the maximum input voltage rating of the 78H05. (See figure 1.12 for the electrical characteristics of the 78H05.)

The output of the device is nominally 5.0 V but can vary between 4.8 and 5.2 V. Even though this falls within the 5.0 V \pm 15% tolerance necessary to run the computer, there might be a problem with the voltage drop in the cabling between the power supply and the computer. Up to 0.5 V could be lost in the wiring and connectors. Remember that at 5 A, a resistance of only 0.1 ohms can cause a 0.5 V drop. Unfortunately, the 78H05 is a fixed-output device when referenced to ground. If 4.8 V happens to come out, "that's all you gets" (sic). But, in a classic case of engineering razzle-dazzle, we can fool the regulator by making the ground reference adjustable. Figure 1.13 shows the circuit that makes this possible. A potentiometer sourced from the -12 V supply creates a relative-ground reference for the 78H05. If the particular device in question had an output of 4.95 V, and we adjusted R1 for a potential of 0.20 V on the common regulator pin, the output referenced to ground would change to 4.95 + 0.20, or 5.15 V. For the fanatics in the crowd, this particular circuit also allows a high-output device to be reduced to 5.00 V by selecting an appropriate negative voltage ground reference pin.

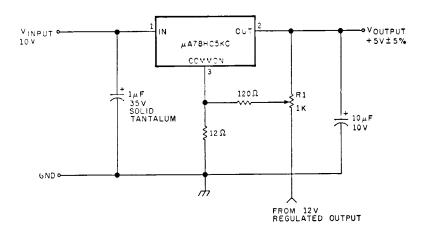


Figure 1.13 Adding 'trim adjust' to the µA78H05 three-terminal voltage regulator.

With the 5 V supply complete, our next concern is the ± 12 V and ± 12 V supplies. Other devices within the 7800 family of regulators will satisfy the requirements. The 7812 and a 7912 are 1 A positive and negative regulators respectively; they exhibit the same protection characteristics as the 78H05. Figures 1.14 and 1.15 outline the exact specifications. Because we are dealing with much lower currents than the ± 5 V supply, there is considerably less concern over voltage losses through connecting cables, and it is unnecessary to add trim adjustment circuitry. Figure 1.16 is the finished schematic of the ZAP power supply. Additional regulator circuit diagrams (figures 1.17a, b, c and d) are included to demonstrate how the 7800 series of regulators can be used in our application. Are we finished yet? Of course not. Close examination of figure 1.16 shows two items not discussed previously: heat sinks and overvoltage protection. These two subjects and a short discussion of the importance of correct layout complete the chapter.

CHARACTERISTICS		CONDITIONS		MIN	TYP	MAX	UNITS
Output Voltage		Ťj = 25°C		11.5	12.0	12.5	V
			14.5 V < VIN < 30 V		10	120	mV
Line Regulation	1	Ťj=25°C	16 V < VIN < 22 V		3.0	60	mV
			5 mA < 10UT < 1.5 A		12	120	mV
Load Regulation		Tj = 25°C -	250 mA < 10UT < 750 mA		4.0	60	mV
		15.5 V < VIN	v < 27 ∨		1		
Output Voltage		5 mA < 10UT < 1.0 A		11.4		12.6	V
*		P < 15 W					
Quiescent Current		Tj = 25°C			4.3	6.0	mA
	with line	15 V < VIN	< 30 ∨			0.8	mA
Quiescent Current Change	with load	5 mA < 100T < 1.0 A				0.5	mA
Output Noise Voltage		TA = 25°C, 10 Hz < f < 100 kHz			8	40	µV/Vou
Ripple Rejection		t = 120 Hz, 15 V < VIN < 25 V		61	71	I	dB
Dropout Voltage		30UT = 1.0 A, TJ = 25°C			2.0	2.5	V
Output Resistance		f=1 kHz			18		mΩ
Short Circuit Current		TJ = 25°C, VIN = 35 V			0.75	1.2	A
Peak Output Current		тј = 25°С		1.3	2.2	3.3	A
			-55°C < Tj < +25°C			0.4	mV/°C/
Average Temperature Coefficient of Output Voltage		100T - 5 MA	+25° C < T < +150° C			0.3	Vout

 μ A7812 ELECTRICAL CHARACTERISTICS: V_{IN} = 19 V, 1_{OUT} = 500 mA, -55°C < T_J < 150°C, C_{IN} = 0.33 μ F, C_{OUT} = 0.1 μ F, unless otherwise specified.

Figure 1.14 Electrical characteristics of the µA7812 voltage regulator.

ELECTRICAL CHARACTER			f = 500 mA, CIN = 240, COOT = 140	,			
	spec	T.eo.		-	-		
CHARACTERISTICS		CONDITIONS		MIN	TYP	MAX	UNITS
Output Voltage		Tj = 25°C		-11.5	-12.0	-12.5	<u>v</u>
		т _ј = 25°С	-14.5 V < VIN < -30 V		10	120	mV_
Line Regulation		13-23 0	-16 V < VIN < -22 V		3.0	60	m۷
		т ј = 25°С	5 mA < IOUT < 1.5 A		12	120	m۷
Load Regulation			250 mA < 10UT < 750 mA		4.0	60	mV
		-15.5 V < VIN < -27 V			-12.6	v	
Output Voltage		5 mA < IOUT < 1.0 A		-11.4			
		p < 15 W					
Quiescent Current		Tj = 25°C			1.5	3.0	mA
	with line	-15 V < V _{IN} < -30 V				1.0	mA
Quiescent Current Change	with load	5 mA < 10UT < 1.0 A				0.5	mA
Output Noise Voitage		TA = 25°C, 10 Hz < f < 100 kHz			25	80	μν/νου
Ripple Rejection		f = 120 Hz, -15 V < VIN < -25 V		54	60		dB_
Dropout Voltage		IOUT = 1.0 A, TJ = 25°C			1.1	2.3	
Peak Output Current		T. = 25°C		1.3	2.1	3.3	A
Average Temperature Coefficient of Output Voltage		IOUT = 5 mA, −55°C < Tj < 150°C				0.3	mV/°C Vout
Short Circuit Current		$V_{IN} = -35 V, T_{J} = 25^{\circ} C$			·	1.2	A

 μ A7912 ELECTRICAL CHARACTERISTICS: V_{IN} = -19 V, 1_{OUT} = 500 mA, C_{IN} = 2 μ F, C_{OUT} = 1 μ F, -55° C < T_J < 150°C, unless otherwise

Figure 1.15 Electrical characteristics of the µA7912 voltage regulator.

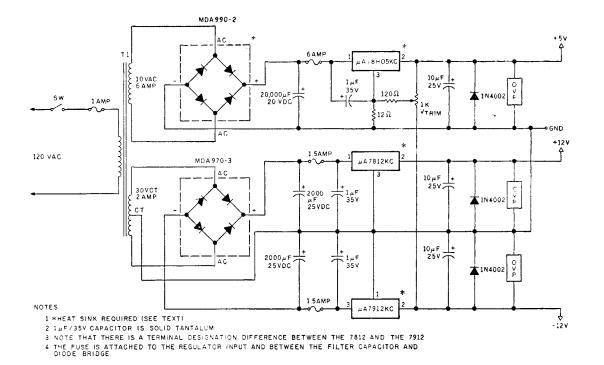


Figure 1.16 A schematic diagram of the finished power supply for the ZAP computer.

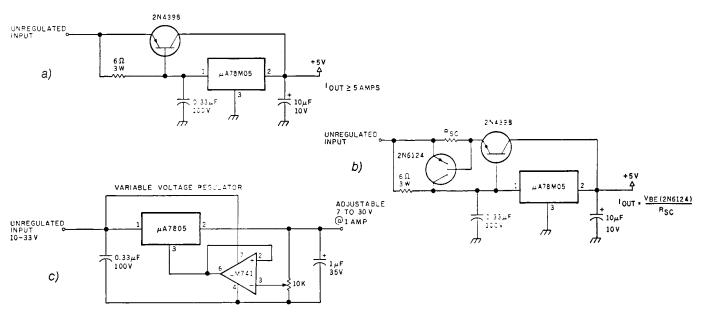
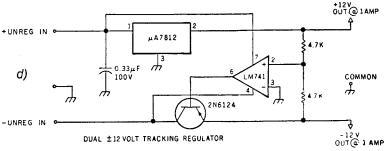


Figure 1.17 Additional voltage regulator circuit diagrams to demonstrate how the 7800 series of regulators can be used.

- a) A high-current voltage regulator using a 500 mA 78M05 three-terminal regulator.
- b) A high-current short-circuit protected voltage regulator, an enhanced version of figure 1.17a.
- c) Using a 7805 + 5 V voltage regulator to produce a higher output voltage.
- d) A dual ± 12 V tracking voltage regulator.

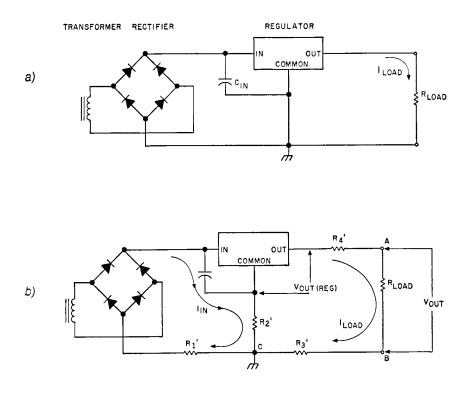


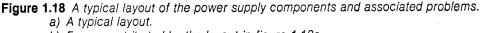
LAYOUT IS IMPORTANT

Integrated circuit regulators employ wide-band transistors in their construction to optimize response. As a result, they must be properly compensated to ensure stable closed-loop operation. Their compensation can be upset by stray capacitance and line inductance of an improper layout. Circuit lead lengths should be held to a minimum, and external bypass capacitors in particular should be located as close as possible to the regulator control circuit.

Figure 1.18a illustrates a typical layout of the components of our supply, and figure 1.18b details the areas that can cause problems. Improper placement of the input capacitor can induce unwanted ripple on the output voltage. This occurs when the current flowing in the input circuit influences the common ground line of the regulator. The voltage drop produced across R2' will cause the output of the regulator to fluctuate in the same manner as the voltage trim circuit we discussed previously. The peak currents in the input circuit (which consists of the rectifier and filter capacitor) can be tens of amperes during charge cycles. These high-current spikes can cause substantial voltage drops on long-lead lengths or thin-wire connections. They can also degrade performance to the point that proper input voltage to the regulator cannot be maintained except during low-current operation.

The output current loop is also susceptible to circuit layout. In a three-terminal regulator, the fixed-output voltage $V_{OUT(REG)}$ is referenced between "out" and "common" of the chip. Because the load current flows through R2', R3', and R4', as well as the load itself, these combined voltage losses may reduce V_{OUT} to an intolerable level. Notice that the ground for this circuit is at point C while the present R load is between points A and B. If another load, more memory for example, is connected to this supply between points A and C, it would have a different V_{OUT} . Adjusting the trim setting of such a seesaw supply can be dangerous; it's possible to have one load completely within tolerance and another over or under voltage. One last point to consider is that R4' serves to negate the purpose of the regulator because it continually reduces V_{OUT} as the load current increases.





b) Errors contributed by the layout in figure 1.18a.

Figure 1.19 is the block diagram of a proper layout. All high-current paths should use heavy wire to minimize resistance and resultant voltage drops. You'll notice now that the input and output circuit current paths are separated effectively. Note that the wires from the rectifier go directly to the capacitor and that two wires from the capacitor send power to the rest of the circuit. If you follow this convention and use two separate pairs of leads, you can eliminate input-circuit induced errors.

Finally, we need to discuss the concept of the single-point ground. One point in the power supply must be designated as ground; the grounds of all other supplies and loads are connected to it. In practical terms, the best way to implement this ground connection is to use a metal strip or several lengths of heavy wire soldered together. The strip is a ground bus with such a low resistance that a voltage measured between point A and any place along the bus will be virtually undetectable. Another +5 V bus should be connected to the output of the supply so that voltage distribution throughout the circuit is consistent. Use thick wire in power supplies. Even if zero-resistance wire isn't easily obtainable, always remember—there is no such thing as wire that is too thick!

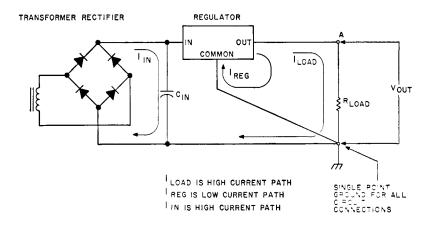


Figure 1.19 A block diagram of a proper layout for the power supply components.

THERMAL CONSIDERATIONS

1

You've just built the power supply I've outlined, flipped on the power, and everything works. After a few minutes, something happens and the computer suddenly stops running. Naturally, you start looking around and touching things. Eventually, your fingers will end up on the regulator chip. Immediately you scream, jump back, and in the process knock over the computer and your celebration martini. If you are lucky, your fingers will be the only thing burned!

When not properly cooled, the regulators will protect themselves from destruction by reducing their output or completely shutting off. In this case, the system could cease to function. A more catastrophic problem arises from ICs that use all three voltages for normal operation. Loss of one or more of these voltages could permanently damage the device. This will never happen if power dissipation is limited and the proper cooling methods are employed.

The first step is to check the power dissipation of our design with the ratings of the particular devices. In practical terms, power, expressed in watts, is volts times amperes:

$$P_D = E \times I$$

In our 5 V regulator we have $V_c = 10$ V and $V_{PEAK} = 12.5$ V at 5 A.

$$P_{D(NOM)} = (V_{c} - V_{OUT}) \times 5 \text{ A}$$

= (10 - 5) × 5
= 25 W
$$P_{D(PEAK)} = (V_{PEAK} - V_{OUT}) \times 5 \text{ A}$$

= (12.5-5) × 5
= 37.5 W
$$P_{D(AVERAGE)} = \frac{37.5 + 25}{2} = 31.25 \text{ W}$$

This means that under full load conditions, about 30 W of heat will be produced by the 78H05. The device is fortunately rated for 50 W at 25 $^{\circ}$ C and is still capable of handling 30 W up to 75 $^{\circ}$ C.

Although the internal power dissipation is limited, the junction temperature must be kept below the maximum specified temperature ($125^{\circ}C$) in order for the device to function at all. To calculate the heat sink required, there are specific equations to solve.

The required thermal data and calculations follow:

$$Typical \theta_{JC} = 2.0 \qquad Maximum \theta_{JC} = 2.5$$
$$Typical \theta_{JA} = 32 \qquad Maximum \theta_{JA} = 38$$
$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_{A}}{\theta_{JC} + \theta_{CA}} \qquad \text{for } \theta_{CA} = \theta_{CS} + \theta_{SA}$$

Solving for T_J,

$$T_J = T_A + P_D(\theta_{JC} + \theta_{CA})$$

or without a heat sink,

$$P_{D(MAX)} = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$
$$T_J = T_A + P_D \theta_{JA}$$

where $T_r = junction$ temperature

- T_A = ambient temperature
- $P_D = power dissipation$
- θ_{JC} = junction to case thermal resistance
- θ_{JA} = junction to ambient thermal resistance
- θ_{CA} = case to ambient thermal resistance
- θ_{cs} = case to heat sink thermal resistance
- θ_{sA} = heat sink to ambient thermal resistance

$$\theta_{JA} = \frac{T_J - T_A}{P_D} = \frac{125^{\circ}C - 25^{\circ}C}{31.25 W} = 3.2^{\circ}C/W$$

Because θ_{JA} as calculated is less than θ_{JA} from the specification sheet, a heat sink is definitely required, and a TO-3 type heat sink of $3.2^{\circ}C/W$ is the minimum desired.

Before you size a heat sink for the 78H05, realize that there are two more regulators and two bridge rectifiers that will need heat sinking. Each 12 V regulator will average about 5 W dissipation. The diode bridge associated with the +5 V supply (remember the 2 V drop) dissipates about 10 W while the other is good for 2 W. Therefore, any heat sinks in the power supply must handle more than 50 W.

WHAT IS THE PRACTICAL METHOD FOR CHOOSING HEAT SINKS?

Choosing a heat sink can be easy or hard depending upon your outlook on rule of

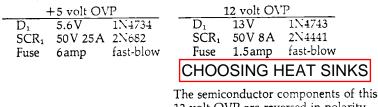
thumb measures. We already know that we need a 50 W heat sink. It's easy to assume that buying one "rated for 50 W" from a local electronics supply will solve the problem. What this rating usually means, however, is that if 50 W is applied through a transistor to this sink, and the ambient temperature is 25° C, the surface temperature of the sink will climb to 100° C. Fried eggs anyone?

We must not forget that manufacturers' specs always refer to limiting maximum junction temperature, not to keeping the case cool enough to touch. Personally, I hate red-hot power supplies. To get a heat sink that would take our 50 W and stay about 60-70°C would probably mean getting one rated for 200-300 W! Remember that heat sinks are expensive—and big.

The simplest solution is best. I prefer forced air cooling. Put the 50 W on an economical heat sink of, say, a 100 W rating and put your money into a good fan. You can still run through all the calculations and determine how many square inches you need, but the effect of blowing a little air over a heat sink multiplies its capabilities enormously.

OVERVOLTAGE PROTECTION

The final area to be addressed in the power supply is overvoltage protection. As designed by manufacturers, regulators protect themselves by reducing output voltage or complete shutoff. The chances of computer component damage from low voltage is miniscule by comparison to overvoltage. It is unlikely to happen, but if the 78H05 were to accidentally short out, as much as 12.5 V would be applied to the +5 V bus. You could then kiss the computer good-bye!



12 volt OVP are reversed in polarity for the -12 volt OVP.

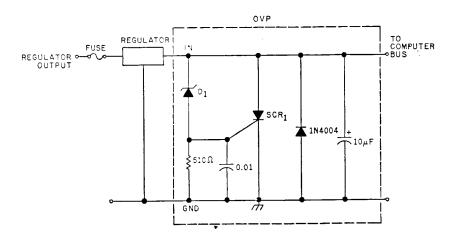


Figure 1.20 A simple overvoltage protection circuit.

The circuit of figure 1.20 is a simple OVP (over-voltage protector). It can be used as shown on the 5 V and 12 V supplies. The appropriate components are listed in the tables of figure 1.20. You'll notice that the fuses are rated higher than the output we've previously discussed. The fuse is for the OVP and not to protect the regulators. Unfortunately, the nature of fast-blow fuses is not to pass 5 A, if it is a 5 A fuse, but to open at 5 A. The fuse must have a higher rating in order to allow circuit operation at 5 A.

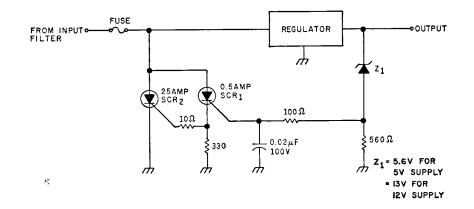


Figure 1.21 A schematic diagram of a more complex overvoltage protection circuit. The crowbar section of the OVP can be located next to the fuse while the OVP sensor Z₁ is located at the regulator output. This is a preferred placement of the parts if the sensor and clamp can be adequately separated. Low-current sensor Z₁ fires SCR₁ in an overvoltage condition. SCR₁ in turn fires high-current SCR₂. The combination of SCRs allows considerable leeway in the choice of SCR₂ since the question of gate current becomes less relevant.

Because the short-circuit current of the 78H05 is 7 A, the 25 A silicon-controlled rectifier (SCR) will certainly make short work of the fuse if it triggers. Figures 1.21 and 1.22 are slightly more complex OVP circuits and can also be used.

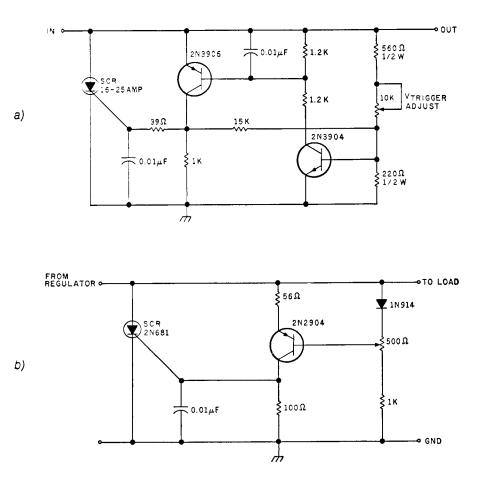


Figure 1.22 Schematic diagrams of adjustable-voltage overvoltage protection circuits.
a) An adjustable-voltage OVP circuit with an internal current amplifier to drive the SCR gate.
b) An alternate circuit for a simple adjustable-voltage OVP circuit.

18 POWER SUPPLY

What does an OVP (often called an "overvoltage crowbar") do? It monitors a particular bus voltage and shuts it down if it goes above a predetermined level. OVP circuits can be designed to trigger 1 mV above our 5% tolerance band. Such circuits are not only complicated, but they may also create additional problems through accidental triggerings. The failure modes that are most likely to occur concern a regulator short or accidentally tying two buses together, for example the +5 V and +12 V. In either case, the result is a rapid voltage rise on the output lines. As voltage rises above the zener value, current flows into the SCR gate. At a certain point, usually below where any components would have been damaged, the SCR fires and shorts the output line to ground. The excessive current blows the fuse, eliminating the problem regulator or regulators (both fuses would blow if the +5 V and +12 V were connected). All this occurs very fast. The test circuit of figure 1.23 demonstrates what happens when the +5 V OVP suddenly has +12 V applied. Test circuits are the only way you ever want to see the action of an OVP. If your power supply functions properly, it should never trigger. The SCR never allows the line to go to 12 V before clamping it to ground. Replacing the fuse with a 220 ohm resistor allows multiple applications of the push button without replacing fuses.

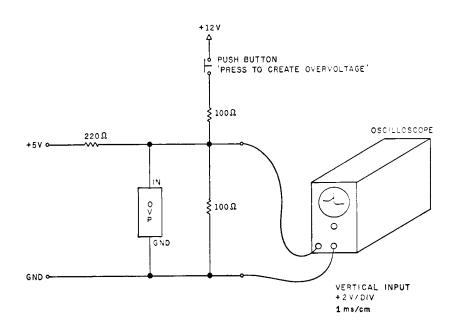


Figure 1.23 A test circuit to demonstrate the action of the overvoltage protector.

CHAPTER 2 CENTRAL PROCESSOR BASICS

There are many different microprocessors on the market and while instruction nomenclature is somewhat different for each one, the basic logical computing processes are similar in all devices. The rule to remember the next time a discussion turns to the capabilities of two computers is that "a computer is a computer." I don't wish to imply that they are all the same, but similarities abound and I would not like to spend a lifetime analyzing instruction sets and interfacing details before choosing one.

I once had lunch with the designer of one of the largest selling personal computer systems on the market. Thousands of computers had been sold, generating immense profits for the manufacturer. Our conversation eventually centered on the cost-effectiveness of his design. I had fanciful thoughts of a design team spending months reducing component count and analyzing instruction sets to determine minimum memory requirements. In actuality, my designer friend was given two months to come up with a manufacturable design. The investors' only question was the price and availability of the particular components he had chosen. Being an avid personal computer enthusiast, he simply built a computer around the microprocessor he already owned. The eventual advertising for his system touted the advanced architecture embodied in the central processor, but no machine-language programming facility was available to the user. It had only a high-level language BASIC interpreter and was, from an engineering point of view, simply a black-box computer. He could have used any microprocessor. So much for textbook engineering design.

Unfortunately, the hobbyist who is building a microcomputer from scratch, and who won't be making a black box, has to try to pick a device that is somewhere in the middle of the performance and capability spectrum. The general rule that all computers perform similar functions is true, but a printed-circuit board is a luxury. The hobbyist who has to do all the wiring by hand will surely be interested in efficient design. It's a fact that some of the more esoteric microprocessors require very expensive peripheral circuitry. Even devices that seem quite straightforward, with limited instruction sets, can require 50 or more ICs as interface elements. The ultimate configuration should be a trade-off between circuit complexity, ease of testing, and component price.

MICROPROCESSOR ARCHITECTURE

The internal architecture of the microprocessor determines the support devices required to make a microcomputer system. Perhaps the best place to start is to briefly discuss the major architectural differences.

Definition: A microcomputer is a logical machine that manipulates binary numbers (data) and processes this information by following an organized sequence of program steps referred to as instructions.

All microcomputers, like all computers, have the following features:

- 1. Input Facilities must exist to allow the entrance of data or instructions.
- 2. Memory The program sequence must be stored before and after execution, and resources must be available to store the result of any computations.
- 3. Arithmetic logic unit Performs arithmetic operations on input or stored data.

- 4. Control section Makes decisions regarding program flow and process control based on internal states of the results of arithmetic computations.
- 5. Output The results are delivered to the user or stored in an appropriate medium.

The microprocessor is the single integrated circuit around which a microcomputer is constructed. *The microprocessor is a device; the microcomputer is a system*. In their least complex form, microprocessors include only the functions of items three and four and must rely on external devices attached to buses to perform the other tasks. Figure 2.1 is the basic block diagram of an 8-bit microcomputer and shows the interconnection of these buses and support elements. The computer in figure 2.1 uses six separate buses: memory address, memory data in and out, I/O address, and data input and output. The microprocessor contains a central processor that consists of the circuitry required to access the appropriate memory and I/O locations and interpret the resulting instructions that are also executed in this unit. The central processor also contains the ALU (Arithmetic and Logic Unit), which is a combination network that performs arithmetic and logical operations on the data. Additionally, the central processor includes a control section that governs the operations of the computer, and the various data registers used for manipulation and storage of data and instructions.

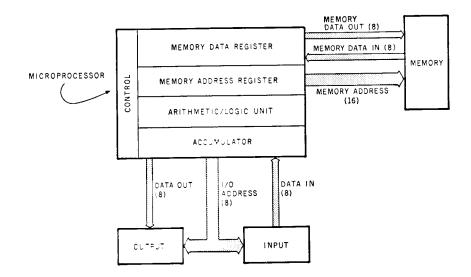


Figure 2.1 A basic block diagram of a microcomputer illustrating the data busing concept. Numbers in parentneses are the usual required quantity of physical wires to perform bus functions for an 8-bit microprocessor.

Actually few microprocessors support six separate buses. The number of pins that would be required on the IC is out of the question. Instead, to reduce pinouts, component manufacturers often combine the data input and output buses and make them "bidirectional." During an output instruction, data flows from the microprocessor to the output device and vice versa during an input instruction. To further cut the number of pins required on the central processor, the memory address bus can also serve as the address bus for input and output devices. During input/output instructions, the address present on the address lines references a particular input/output device(s). The resulting reduced configuration is shown in figure 2.2.

The concept of two buses is easy to understand and, from a hardware point of view, easy to utilize. The buses are time and function multiplexed. That is, during memory operations, the bits on the address bus refer to a memory location, and data on the data bus represent the content of memory. The direction of the data flow (to or from the central processor) is controlled within the microprocessor. Activities with input/output devices are performed in a similar fashion. During those instructions, input or output data and device addresses occupy the buses.

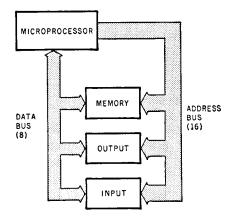


Figure 2.2 A block diagram of a microcomputer utilizing multiplexed bi-directional busing techniques to reduce pinout.

The number of bus wires can be further reduced by combining both data and address on the same lines and time multiplexing the data transfer along them. Figure 2.3 illustrates this final configuration. This method requires additional circuit elements to demultiplex and store pertinent data. The additional external components necessary to use this architectural feature defeat its purpose and make its use inadvisable for the hobbyist. There are other microprocessors that are simpler to use.

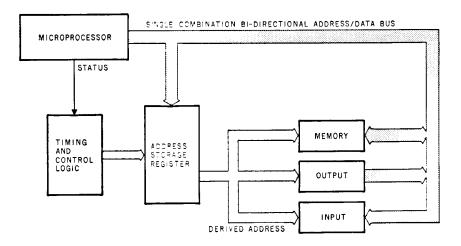


Figure 2.3 A block diagram of a microcomputer utilizing a single multiplexed bi-directional bus for both memory and input/output functions.

When building rather than buying a personal computer, the following criteria must be carefully considered:

- 1. Circuit complexity Keep components to a reasonable minimum. The more components in a design, the more likelihood of wiring errors and faulty devices.
- 2. Cost While cost is important, it should not be the primary consideration. Any microprocessor function could be simulated by using small scale integrated logic; however, indirect costs resulting from using 200 chips to replace 3 or 4 LSI (large scale integration) devices would negate the value of using cheaper parts initially. On the other hand, in the semiconductor industry, density means dollars. The more functions a device can provide, and the fewer components necessary to ac-

complish these tasks, the higher the price. The level of integration incorporated in a homebrew computer should fit somewhere in the middle. The ZAP computer outlined in this book is a prime example of this philosophy. It uses a combination of cost-effective LSI (large scale integration) and inexpensive SSI (small scale integration) to produce a computer that the hobbyist can truly build, test, and use.

3. Software compatibility and availability — Building the hardware of a microcomputer is only half the job. It must be programmed to perform useful work. Initially, the builder will by necessity hand code and assemble his own programs. Eventually, however, the need may arise for the computer to do a task requiring a very large program which cannot be easily hand assembled. The user must rely upon an assembler program in a larger machine. The assembler program would, of course, have to be compatible with the instruction set of the microcomputer.

A further consideration is that personal computer enthusiasts are forever exchanging software. It is possible to convert programs to run on any central processor, but the effort would be the same as writing the entire program from scratch. This defeats the purpose of exchanging software. The personal computer owner should choose a microprocessor that is somewhat compatible with the computers already on the market. My statement that all computers are alike is theoretically true, but a book on how to build an esoteric one-of-a-kind computer is of little practical value.

Each criterion could be analyzed and answered individually, but we must give some credit to the manufacturers of personal computers for doing some of the thinking for us already. The fact that so many personal computers are in use has established *de facto* standardization of central processor choice. To be compatible with existing software and to have sufficient documentation available, the builder should consider choosing among those central processors in commercial use. The four most used microprocessors are

- 1. Intel 8080A
- 2. Motorola 6800
- 3. MOS Technology 6502
- 4. Zilog Z80

As a result of each device's wide following, documentation and software are readily available. The availability of 8080A compatible software is highest; cost is low, but its circuit complexity is also the greatest of the above. The 8080A, while described as a "single-chip computer," relies on various external drivers and support devices. Its minimum functional configuration consists of three chips as shown in figure 2.4. Its central processor bus structure is similar to figure 2.3, but when combined with the 8224 and 8228 support chips, it emulates the more desirable bus architecture outlined in figure 2.2.

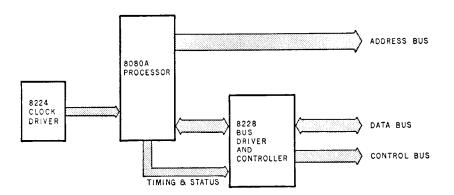


Figure 2.4 A minimum three-chip 8080A configuration illustrating the necessary support devices. The control bus contains the timing functions necessary to decode the contents of the data and address buses.

The best of both worlds is incorporated within the Z80. Not only does it execute the complete instruction set of the 8080A, but it also has additional instructions that serve to make it a very powerful processor. The Z80 bus structure is illustrated in figure 2.5. The Z80 is slightly more expensive than the other processors listed. However, its reduced external circuitry results in an effective cost comparison. Further, the ease of interfacing the Z80 makes it the natural choice when building a microcomputer from scratch.

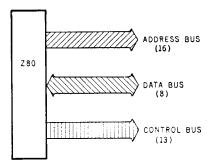


Figure 2.5 A block diagram of the Zilog Z80 bus structure.

CHAPTER 3 THE Z80 MICROPROCESSOR

Many books have been written on the software and hardware attributes of the Z80. Although I am not attempting to duplicate the efforts of other authors, any book dedicated to the construction of a microcomputer would be incomplete without a section describing the processor in some detail. By completely understanding the internal logic and external control functions of the central processor, you will be able to understand better the way I've designed the rest of the system hardware. You have many options when constructing a computer from scratch. The deeper your degree of understanding, the greater your confidence in the outcome, and it is more likely that you will add enhancements to your own design.

The ZAP computer allows considerable latitude in the selection of peripheral interfacing. The choice depends primarily upon the design philosophy of the system, which starts with the central processor.

CENTRAL PROCESSOR ARCHITECTURE

The Z80 is a register-oriented microprocessor. Eighteen 8-bit and four 16-bit registers within the central processor are accessible to the programmer and function as static programmable memory. These registers are divided into two sets, main and alternate, each of which contains six general purpose 8-bit registers that may be used either individually, or as three pairs of 16-bit registers. Also included are two sets of accumulators and flag registers. Figure 3.1 illustrates the internal architecture of the Z80 central processor. Figure 3.2 shows that within the Z80 there are accumulators and flag registers, along with general and special purpose registers.

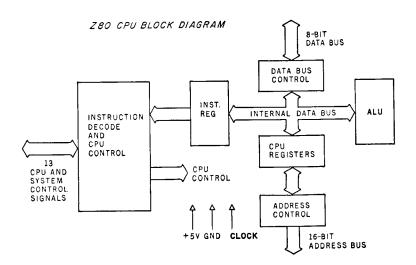
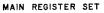


Figure 3.1 A block diagram of the internal architecture of the Z80 central processor.



ALTERNATE REGISTER SET

		$\overline{}$	
ACCUMULATOR	FLAGS F		
В	С	GENERAL	ſ[
D	E	> PURPOSE (ΥĽ
н	L	REGISTERS	۱ſ

	ACCUMULATOR A'	FLAGS F'
ſ	B	C'
$\langle $	D'	ε'
	н'	Ľ'

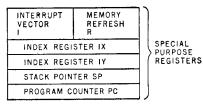


Figure 3.2 Z80 central processor register configuration.

The following is a description of the function and structure of the major components of the central processor.

- I. Registers
 - A. Accumulators and Flag Registers

The central processor contains two independent accumulator and flagregister pairs, one in the main register set and the other in the alternate register set. The accumulator receives the results of all 8-bit arithmetic and logical operations, whereas the flag register indicates the occurrence of specific logical or arithmetic conditions in the processor such as parity, zero, sign, carry, and overflow. A single exchange instruction allows the programmer to select either accumulator or flag-register pair.

B. General Purpose Registers

There are two similar sets of general purpose registers. The main register set contains six 8-bit registers called B, C, D, E, H, and L; the alternate register set also contains six 8-bit registers referred to as B', C', D', E', H', and L'. For 16-bit operations, these registers can be grouped in 16-bit pairs (BC, DE, HL or BC', DE', HL'). A single exchange instruction allows the programmer to alternately choose between the register-pair sets.

- C. Special Purpose Registers
 - 1. PC (program counter)

The program counter contains a 16-bit address in memory from which the current instruction will be fetched. Following execution of the instruction, the PC counter is either incremented, if the program is to proceed to the next byte in memory, or the present PC contents are replaced with a new value, if a jump or call instruction is to be executed.

2. SP (stack pointer)

The Z80 allows several levels of subroutine nesting through use of a "stack" and a "stack pointer": when certain instructions are executed, or when calls to subroutines are made, the PC counter and other pertinent data can be temporarily stored on a stack. A stack is a reserved area of several memory locations, the top of which is indicated by the contents of the stack pointer. That is to say, the stack pointer shows the address of the most recently made entry, because the memory locations are organized as a last-in, first-out file. By looking at particular entries in the stack,

the central processor returns to a main program regardless of the depth of nested subroutines. Theoretically, the stack could be 64 K bytes long; however, program space must not be overwritten by an expanding stack.

D. IX and IY Index Registers

Ì.

These registers facilitate table data manipulation. They are two independent 16-bit registers that hold the base addresses used in indexed addressing modes, and point to locations in memory where pertinent data is to be stored or retrieved. Incorporated within the indexed instructions is a two's complement signed integer that specifies displacement from this base address.

- E. Interrupt Page Address Register (I) This is an 8-bit register that can be loaded with a page address of an interrupt service routine. During a mode 2 interrupt program, control will vector to this page address.
- F. Memory Refresh Register (R) To enable dynamic memories for the Z80, a 7-bit memory refresh register is automatically incremented after each instruction fetch.
- II. Arithmetic and Logic Unit

Arithmetic manipulations and logical operations are handled eight bits at a time in the Z80 ALU (arithmetic and logic unit). The ALU communicates internally to the central processor registers and is not directly accessible by the programmer. The ALU performs the following operations:

> LEFT OF RIGHT SHIFT INCREMENT DECREMENT ADD SUBTRACT AND OR EXCLUSIVE OR COMPARE SET BIT RESET BIT TEST BIT

III. Instruction Register and Central Processor Control

The instruction register holds the contents of the memory location addressed by the PC (program counter) and is loaded during the fetch cycle of each instruction. The central processor control unit executes the functions defined by the instruction in the instruction register and generates all control signals necessary to transmit the results to the proper registers.

IV. Central Processor Hardware

A. Figure 3.3 details the pinout of the Z80. It comes in an industry standard 40 pin dual in-line package. The following is a listing and explanation of the pin functions:

- $D_0 D_7$ Three-state input/output, active high. $D_0 D_7$ consti-(Data Bus) tute an 8-bit bi-directional data bus which is used for data exchanges with memory and I/O devices.

M1 Output, active low. M1 indicates that the current ma-(Machine chine cycle is the operation-code fetch cycle of an inCycle One) struction execution. Note that during execution of 2-byte opcodes, M1 is generated as each opcode byte is fetched. These 2-byte opcodes always begin with CBH, DDH, EDH, or FDH. M1 also occurs with IORQ to indicate an interrupt acknowledge cycle.

MREQThree-state output, active low. The memory request(Memorysignal indicates that the address bus holds a valid address for a memory-read or memory-write operation.

IORQThree-state output, active low. The IORQ signal indi-
(Input/
OutputThree-state output, active low. The IORQ signal indi-
cates that the lower half of the address bus holds a valid
I/O address for an I/O read or write operation. An
Request)IORQ signal is also generated with an M1 signal when
an interrupt is being acknowledged to indicate that an
interrupt response vector can be placed on the data bus.
Interrupt acknowledge operations may occur during
M1 time while I/O operations are prohibited.

RDThree-state output, active low. RD indicates that the
(Memory
Read)Read)central processor wants to read from memory or an I/O
device. The addressed I/O device or memory should use
this signal to gate data onto the central processor data
bus.

RFSHOutput, active low.RFSH indicates that the lower(Refresh)seven bits of the address bus contain a refresh address
for dynamic memories and the current MREQ signal
should be used to do a refresh read to all dynamic
memories.

- HALTOutput, active low.HALT indicates that the central(Haltprocessor has executed a HALT instruction and isState)awaiting either a nonmaskable or a maskable interrupt(with the mask enabled) before operation can resume.While halted, the central processor executes NOPs (nooperation) to maintain memory refresh activity.
- WAITInput, active low. WAIT indicates to the Z80 central(Wait)processor that the addressed memory or I/O devices are
not ready for a data transfer. The central processor con-
tinues to enter wait states as long as WAIT is active;
this signal allows memory of I/O devices to be syn-
chronized to the central processor.
- INTInput, active low. The Interrupt request signal is gener-
(Interrupt) ated by I/O devices. A request will be honored at the
end of the current instruction if the internal software
controlled interrupt enable flip-flop is enabled and if the
BUSRQ signal is not active. When the central pro-
cessor accepts the interrupt, an acknowledge signal
(IORQ during M1 time) is sent out at the beginning of
the next instruction cycle. The central processor can re-
spond to an interrupt in the three different modes.

NMIInput, negative edge triggered. The nonmaskable inter-
rupt request line has a higher priority than INT and is
always recognized at the end of the current instruction,

Interrupt) regardless of the status of the interrupt-enable flip-flop. NMI forces the Z80 central processor to restart to location 0066₁₆. The program counter is automatically saved in the external stack so that the user can return to the program that was interrupted. Note that continuous WAIT cycles can prevent the current instruction from ending, and that a BUSRQ will override an NMI.

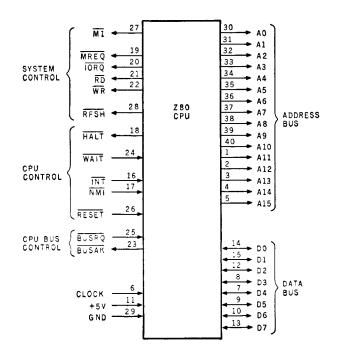


Figure 3.3 Pin configuration for the Z80 microprocessor.

The actual timing of these signals will be discussed in the hardware sections.

V. Z80 Instruction Types

The Z80 can execute 158 separate instructions including all 78 of the 8080A. They can be grouped as follows:

A. LOAD AND EXCHANGE

Load instructions move data between registers or between registers and memory. The source and destination of this data is specified within the instruction. Exchange instructions swap the contents of two registers.

B. ARITHMETIC AND LOGICAL

These instructions operate on data in the accumulator, a register, or a designated memory location. Results are placed in the accumulator and flags are set accordingly. Arithmetic operations include 16-bit addition and subtraction between register pairs.

- C. BLOCK TRANSFER AND SEARCH The Z80 uses a single instruction to transfer any size block of memory to any other group of contiguous memory locations. The block search uses a single command to examine a block of memory for a particular 8-bit character.
- D. ROTATE AND SHIFT

Data can be rotated and shifted in the accumulator, a central processor register, or memory. These instructions also have binary-coded decimal (BCD) handling facilities.

E. BIT MANIPULATION

Bit manipulation includes set, reset, and test functions. Individual bits may be modified or tested in the accumulator, a central processor, or memory. The results of the test operations are indicated in the flag register.

F. JUMP, CALL AND RETURN

A jump is a branch to a program location specified by the contents of the program counter. The program counter contents can come from three addressing modes: immediate, extended, or register indirect. A call is a special form of jump where the address following the call instruction is pushed onto the stack before the jump is made. A return is the reverse of the call. This category includes special restart instructions.

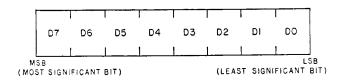
G. INPUT AND OUTPUT

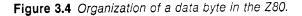
These instructions transfer data between register and memory to external I/O devices. There are 256 input and 256 output ports available. Special instructions provide for moving blocks of 256 bytes to or from I/O ports and memory.

- H. CPU CONTROL These instructions include halting the CPU or causing a NOP (no operation) to be executed. The ability to enable or disable interrupt inputs is a further control capability.
- VI. Instruction and Data Formats

Memory for the Z80 is organized into 8-bit quantities called bytes (see figure 3.4). Each program byte is stored in a unique memory position and is referenced by a 16-bit binary address.

Total direct addressing capability is 65,536 bytes (64 K) of memory, which may be any combination of ROM (read-only memory), EPROM (erasable-programmable read-only memory), or programmable memory. Data is stored in the formats of figure 3.5.





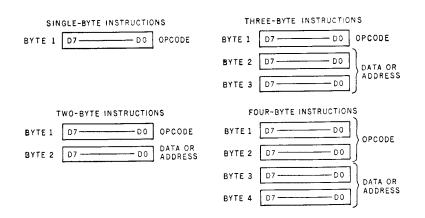


Figure 3.5 Machine-language instruction formats for the Z80.

VII. Z80 Status Flags

The flag register (F and F') supplies information to the user regarding the status of the central processor at any given time. There are four testable and two nontestable flag bits in each register. Figure 3.6 shows the position and identity of these flag bits.

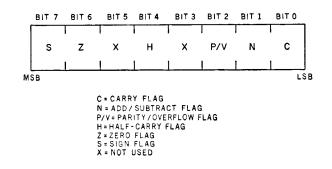


Figure 3.6 Position and identity of status flag bits in the flag register.

Instructions set (flag bit = 1) or reset (flag bit = 0) flags in a manner relevant to the particular operation being executed.

VIII. The Z80 Instruction Set

100000

1.87

The following symbols and abbreviations are used in the subsequent description of the Z80 instructions:

Symbol Meaning

accumulator address high-order address low-order address data high-order data low-order data port r, r' n nn d b e	Register A A 16-bit address quantity The most significant 8 bits of the 16-bit address The least significant 8 bits of the 16-bit address An 8- or 16-bit quantity The most significant 8 bits of the 16-bit data The least significant 8 bits of the 16-bit data An 8-bit address of an I/O device One of the registers A, B, C, D, E, H, or L A 1-byte expression in the range of 0 thru 255 A 2-byte expression in the range of 0 thru 65,535 A 1-byte expression in the range of -128 to 127 An expression in the range of 0 thru 7 A 1-byte expression in a range of -126 to 129
e	A 1-byte expression in a range of -126 to 129
сс	The state of the flags for conditional JR and JP instructions:

	<u>cc</u>	Condition	Relevant Flag
Ŗ,	000	NZ non zero	Z
C	001	Z zero	Z
0	010	NC non carry	С
E.	011	C carry	С
14	100	PO parity odd	P/V
1	101	PE parity even	P/V
	110	P sign positive	S
P	111	M sign negative	S

XXH	Denotes hexadecimal address	s value
qq	Any one of the register pairs	s BC, DE, HL, or AF
SS	Any one of the register pairs	s BC, DE, HL, or SP

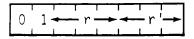
pp rr s dd m (HL) (nn) PC SP	 Any one of the register pairs BC, DE, IX, or SP Any one of the register pairs BC, DE, IY, or SP Any of r, n, (HL), (IX+d), or (IY+d) Any one of the register pairs BC, DE, HL, or SP Any of r, (HL), (IX+d), or (IY+d) Specifies the contents of memory at the location addressed by the contents of the register pair HL Specifies the contents of memory at the location addressed by the 2-byte expression in nn Program counter Stack pointer
t	An expression in the range of 0 thru 7.
C, N, P/V, H, Z, S	Condition flags:
	C Carry N Add/Subtract P/V Parity/Overflow H Half-Carry Z Zero S Sign
←	"is transferred to"
^	Logical AND
Ð	Exclusive OR
v	Inclusive OR Addition
+	Subtraction
 ↔	"is exchanged with"

EIGHT-BIT LOAD GROUP

LD r, r'

 $\mathbf{r} \leftarrow \mathbf{r}'$

The contents of any register r' are loaded into any other register r.

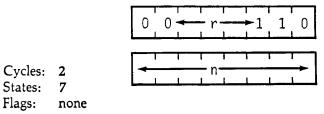


Cycles: 1 States: 4 Flags: none

LD r, n

r ← n

The 8-bit integer n is loaded into any register r.



LD r, (HL)

6.

r - (HL)

The 8-bit contents of memory location (HL) are loaded into register r. A ME.

$$0 \quad 1 \xrightarrow{\qquad r \rightarrow 1} 1 \quad 0$$

Cycles: 2 States: 7 Flags: none

LD r, (IX+d)

 $r \leftarrow (IX+d)$

The operand (IX+d) (the contents of the Index Register IX summed with a displacement integer d) is loaded into register r.

		1 1 0 1 1 1 0 1
Cvcles:	5	$0 1 \longleftarrow r \longrightarrow 1 1 0$
Cycles: States: Flags:	19 none	

LD r, (IY+d)

 $r \leftarrow (IY+d)$

Cycles: 5 States:

19

none

The operand (IY + d) (the contents of the Index Register IY summed with a displacement integer d) is loaded into register r.

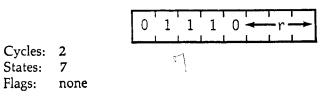
1	1		1	1	0	1
0	<u>1</u>			-1	1	0
		— d-				

LD (HL), r

(HL) - r

Flags:

The contents of register r are loaded into the memory location specified by the contents of the HL register pair.



LD (IX+d), r

 $(IX+d) \leftarrow r$

The contents of register r are loaded into the memory address specified by the contents of Index Register IX summed with d, which is a two's complement displacement integer.

		1	1	0	1	1	1	0	1	
Cycles: States:	5	0	1	1	1	0	↓	-r-		
States: Flags:	19 none			J	- d -	, ,		L	· ·	

LD (IY+d), r

 $(IY+d) \leftarrow r$

The contents of register r are loaded into the memory address specified by the sum of the contents of the Index Register IY and d, a two's complement displacement integer.

Cycles: 5 States: 19 Flags: none	$0 1 1 1 0 \leftarrow r \leftarrow$

Г

LD (HL), n

(HL) - n

Integer n is loaded into the memory address specified by the contents of the HL register pair.

Cycles:	3
States:	10
Flags:	none

0 0		0		1 0	
	n		<u>L</u>		

LD(IX+d), n

 $(IX+d) \leftarrow n$

The n operand is loaded into the memory address specified by the sum of the contents of the Index Register IX and the two's complement displacement operand d.

-		1	1	0	1	1	1	0	1
		0	0	1	1	0	1	1	
		-	1	1	- d -	[]	r	1	
Cycles: States: Flags:	5 19 none	-	1	r	- n -	I 1	I	1 1	

LD(IY+d), n

 $(IY+d) \leftarrow n$

Integer n is loaded into the memory location specified by the contents of the Index Register IY summed with a displacement integer d.

		1	1	1	1	1	1	0	
		0	0	1	1	0	1	1	0
				r	r - d -	I		L	
Cycles: States: Flags:	5 19 none				- n -		r		

LD A, (BC)

A - (BC)

The contents of the memory location specified by the contents of the BC register pair are loaded into the Accumulator.

0	0	0	0	1	0	1	0
				L]			

Cycles: 2 States: 7

Flags: none

LD A, (DE)

ł

1

A - (DE)

The contents of the memory location specified by the register pair DE are loaded into the Accumulator.

0	0	0	1	1	0	1	0
				L			

Cycles: 2 States: 7 Flags: none

LD A, (nn)

 $A \leftarrow (nn)$

The contents of the memory location specified by the operands nn are loaded into the Accumulator. The first n operand is the low-order byte of a 2-byte memory address. 2 Λ

memory	auuress.						H		
		0	0	1	1	1	0	1	0
				r—			1	1 	
		-	l		- n -	·	1		
Cycles: States:	4	_							
States:	13		1	1	1 - n -	1	1	1	
Flags:	none		1	1	1	ı	1	t	

LD (BC), A

(BC) - A

The contents of the Accumulator are loaded into the memory location specified by the contents of the register pair BC.

	0	0	0	0	0	0	1	0
Į				ļ	L			L

Cycles: 2 States: 7 Flags: none

LD (DE), A

(DE) - A

The contents of the Accumulator are loaded into the memory location specified by the DE register pair.

	0	0	0	1	0	0	1	0
ļ	1				L	Lj		L

Cycles: 2 States: 7 Flags: none

.

LD (nn), A

~

(nn) - A

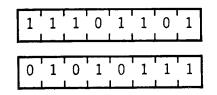
The contents of the Accumulator are loaded into the memory address specified by the operands nn. The first n operand is the low-order byte of operand nn.

		0	0		1	0	0	1	0
					- n -	[]			>
Cycles: States: Flags:	4 13 none			l	- n -	 			

LD A, I

 $A \leftarrow I$ The contents of the Interrupt Vector Register I are loaded into the

Accumulator.



- Cycles: 2
- States:
- Flags: S, Z, H, N, P/V

9

- S: set if I < 0; reset otherwise
- Z: set if I=0; reset otherwise
- H, N: reset
- P/V: contains contents of IFF2

LD A, R

A – R

The contents of Memory Refresh Register R are loaded into the Accumulator.

		1	1	1	0	1	1	0	1
Cycles:	2	0	1	0	1	1	1	1 1	1
States: Flags:	9 S,Z,H,N,P/	v							
	S: set if $R < Z$: set if $R = 0$								

- H, N: reset P/V: contains contents of IFF2
- 17 V. contains contents o
- ld I, A
 - I A

The contents of the Accumulator are loaded into the Interrupt Control Vector Register I.

		1	1	1	0	1	1	0	1
Cycles: States:	2	0	1	0	0	0	1	1	1
States: Flags:	9 none								

LD R, A

 $R \leftarrow A$

The contents of the Accumulator are loaded into the Memory Refresh Register R.

		1	1	1	0	1	1	0	1
Cycles: States: Flags:	2 9 none	0	1	0	0	1	1	1	1

SIXTEEN-BIT LOAD INSTRUCTIONS

LD dd, nn

dd 🗕 nn

The 2-byte integer nn is loaded into the dd register pair, where dd defines the BC, DE, HL, or SP register pairs, assembled as follows in the object code:

	Pair	<u>dd</u>	1
	BC DE	00 01	0 0 d d 0 0 0 1
	HL SP	10 11	
			←───── n ────► ►
Cycles: States:	3 10		n
Flags:	none		┗┯┉┸┯┈┟╌┄┟╶┈╽╴╹╷╶┟╶┯┛

LD IX, nn

IX – nn

Integer nn is loaded into the Index Register IX.

	0 0 1 0 0 0 0 1
4	
14 none	✓ 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1

LD IY, nn

IY – nn

Flags:

Cycles: 4 States:

Cycles: 4 States:

Flags:

14

none

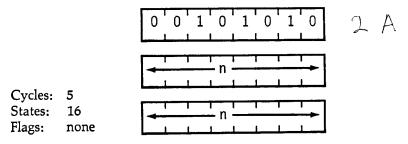
Integer nn is loaded into the Index Register IY.

1	1	1	1	1	1	0	1
0	0	1	0	0	0	0	1
			- n -				+
	1		- n -	1	1	1	+

LD HL, (nn)

 $H \leftarrow (nn+1), L \leftarrow (nn)$

The contents of memory address nn are loaded into register L, and the contents of the next highest memory location (nn+1) are loaded into register H.



LD dd, (nn)

 $dd_H \leftarrow (nn+1), dd_L \leftarrow (nn)$

The contents of address nn are loaded into the low-order portion of register pair dd, and the contents of the next highest memory address (nn+1) are loaded into the high portion of dd.

		•••		E	- - -			\mathcal{O}		
				1	1	0	1	1	0	1
								<u> </u>		
			0	1	d	d	1	0	1	1
	-,									
					1	- n				
Cycles:	6		<u></u>					<u> </u>		
Cycles: States:	20				1	– n -				-
Flags:	none				l	<u> </u>	L1	L		

LD IX, (nn)

 $IX_{H} \leftarrow (nn+1), IX_{L} \leftarrow (nn)$

The contents of the address nn are loaded into the low-order portion of Index Register IX, and the contents of the next highest memory address (nn+1) are loaded into the high-order portion of IX.

		1	1	0	1	1	1	0	1
•			0	1	0	1	0	1	0
Curler	,			T	- n	1	1	1 	I
Cycles: States: Flags:	6 20 none	_		t I	- n -	I 	I I I	1	

LD IY, (nn)

 $IY_H \leftarrow (nn+1), IY_L \leftarrow (nn)$

The contents of address nn are loaded into the low-order portion of Index Register IY, and the contents of the next highest memory address (nn+1) are loaded into the high-order portion of IY.

1	1	1	1	1	1	0	1
0		1				1	0
			·	 		r	-
		1	- n	I	1	1	

LD (nn), HL

 $(nn+1) \leftarrow H, (nn) \leftarrow L$

none

20

Cycles: 6 States:

Cycles: 5 States:

Cycles: 6 States:

Flags:

Flags:

16

none

Flags:

The contents of register L are loaded into memory address nn, and the contents of register H are loaded into the next highest address location nn+1.

) ()	1,0) (ן כ	1 0
		r			
-1		r			

LD (nn), dd

 $(nn+1) \leftarrow dd_H, (nn) \leftarrow dd_L$

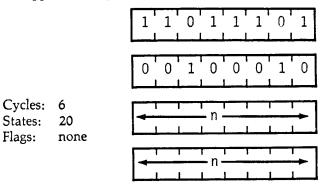
The low-order byte of register pair dd is loaded into memory address nn; the upper byte is loaded into memory address nn+1.

	1	1 1		1	1	0	1
	0	1 d	d	0	0	1	1
6 20			– n		[[]	-
none				l	۲ ۱	()	

LD (nn), IX

 $(nn+1) \leftarrow IX_{H}, (nn) \leftarrow IX_{L}$

The low-order byte in Index Register IX is loaded into memory address nn; the upper-order byte is loaded into the next highest address nn+1.



LD (nn), IY

 $(nn+1) \leftarrow IY_{H}, (nn) \leftarrow IY_{L}$

The low-order byte in Index Register IY is loaded into memory address nn; the upper-order byte is loaded into memory location nn+1.

	1	1	1	1	1	0	1
	0	1	0	0	0	1	0
			- n -				+
6 20 none			- n ·				+

LD SP, HL

SP 🗕 HL

Cycles: States: Flags:

The contents of the register pair HL are loaded into the SP (stack pointer).

1

Cycles: 1 States: 6 Flags: none

LD SP, IX SP – IX

The 2-byte contents of Index Register IX are loaded into the SP (stack pointer).

		1	1	0	1	1	1	0	1	
Cycles: States: Flags:	2 10 none	1	1	1	1	1	0	0	1	

LD SP, IY

 $SP \leftarrow IY$ The 2-byte contents of Index Register IY are loaded into the SP (stack pointer).

		1	1	1	1	1	1	0	1
Cycles: States: Flags:	2 10 none	1	1	1	1	1	0	0	1

PUSH qq

 $(SP-2) \leftarrow qq_{L'} (SP-1) \leftarrow qq_{H}$

The contents of the register pair qq are pushed into the external memory LIFO (last-in, first-out) Stack. The Stack Pointer (SP) register pair holds the 16-bit address of the current "top" of the Stack. This instruction first decrements the SP and loads the high order byte of register pair qq into the memory address now specified by the SP; then decrements the SP again and loads the low order byte of qq into the memory location corresponding to this new address in the SP.

Cycles:	3	1	1	q	q	0	1	0	1
States:	11			<u> </u>	<u> </u>	L	L	ا	
Flags:	none								

 $(SP-2) \leftarrow IX_L$, $(SP-1) \leftarrow IX_H$

The contents of the Index Register IX are pushed into the Stack. This instruction first decrements the SP and loads the high-order byte of IX into the memory address now specified by the SP; it then decrements the SP again and loads the low-order byte into the memory location corresponding to this new address in the SP.

		1	1	0	1	1	1	0	1
Cycles: States:	3	1	1	1	0	0	1	0	1
States: Flags:	15 none			L	L.,	<u>L</u>	<u></u>		

PUSH IY

Flags:

Cycles: 4 States:

Cycles: 3 States:

Flags:

10

none

Flags:

 $(SP-2) \leftarrow IY_L, (SP-1) \leftarrow IY_H$

The contents of the Index Register IY are pushed into the Stack. This instruction first decrements the SP and loads the high-order byte of IY into the memory address now specified by the SP; it then decrements the SP again and loads the low-order byte into the memory location corresponding to this new address in the SP.

	1	1	'1 	1	1	1	0	1
4	1	1	1	0	0	1	0	1
15				L	<u></u>	.	4	<u> </u>
none								

POP qq

 $qq_{H} \leftarrow (SP+1), qq_{L} \leftarrow (SP)$

The top 2 bytes of the Stack are popped into register pair qq. This instruction first loads into the low-order portion of qq the byte at the memory location corresponding to the contents of SP; then SP is incremented and the contents of the corresponding adjacent memory location are loaded into the highorder portion of qq, and the SP is now incremented again.

POP IX

 $IX_{H} \leftarrow (SP+1), IX_{L} \leftarrow (SP)$

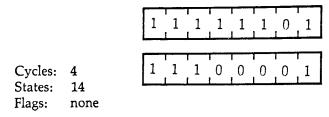
The top 2 bytes of the Stack are popped into Index Register IX. This instruction first loads into the low-order portion of IX the byte at the memory location corresponding to the contents of SP; the SP is incremented and the contents of the corresponding adjacent memory location are loaded into the high-order portion of IX. The SP is now incremented again.

1	1	0 1	'1	1	'1 —	0	′1 ⊥
1	1	1	0	0	0	0	1

Cycles: 4 States: 14 Flags: none POP IY

 $IY_H \leftarrow (SP+1), IY_L \leftarrow (SP)$

The top 2 bytes of the Stack are popped into Index Register IY. This instruction first loads into the low-order portion of IY the byte at the memory location corresponding to the contents of SP; then the SP is incremented and the contents of the corresponding adjacent memory location are loaded into the high-order portion of IY. The SP is now incremented again.



EXCHANGE, BLOCK TRANSFER AND SEARCH GROUP

EX DE, HL

 $DE \leftrightarrow HL$

The 2-byte contents of register pairs DE and HL are exchanged.

1	1	1	0	1	0	1	1
		1					

Cycles:	1
States:	4
Flags:	none

EX AF, AF'

AF 🕂 AF'

The 2-byte contents of the register pairs AF and AF' are exchanged.

0	0	0	0	1	0	0	0
	L I	l				1	

Cycles:	1
States:	4
Flags:	none

EXX

 $(BC) \leftrightarrow (BC')$, $(DE) \leftrightarrow (DE')$, $(HL) \leftrightarrow (HL')$ Each 2-byte value in register pairs BC, DE, and HL is exchanged with the 2-byte value in BC', DE', and HL' respectively.

1	1	0	1	1	0	0	1
1							

Cycles: 1 States: 4 Flags: none

EX (SP), HL

 $H \leftrightarrow (SP+1), L \leftarrow (SP)$

The low-order byte contained in register pair HL is exchanged with the contents of the memory address specified by the contents of register pair SP, and the high-order byte of HL is exchanged with the next highest memory address (SP+1).

ſ	1	1	1		0		•	1
L		<u> </u>	1	<u> </u>		<u> </u>	L	1

Cycles: 5 States: 19 Flags: none

Cycles: 6 States:

Flags:

EX (SP), IX

 $IX_H \leftrightarrow (SP+1), IX_L \leftrightarrow (SP)$

The low-order byte in the Index Register IX is exchanged with the contents of the memory address specified by the contents of register pair SP, and the high-order byte of IX is exchanged with the next highest address (SP+1).

	1	1	0	1	1	1	0	1
6	1	1	1	0	0	0	1	1
23 none		<u> </u>						

EX (SP), IY

 $IY_H \leftrightarrow (SP+1), IY_L \leftrightarrow (SP)$

The low-order byte in Index Register IY is exchanged with the contents of the memory address specified by the contents of register pair SP, and the highorder byte of IY is exchanged with the next highest memory address.

1	1	1	1	1	1	0	1
1	1	1	0	0	0	1	1

Cycles: 6 States: 23 Flags: none

LDI

 $(DE) \leftarrow (HL), DE \leftarrow DE+1, HL \leftarrow HL+1, BC \leftarrow BC-1$

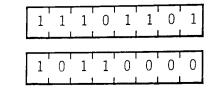
A byte of data is transferred from the memory location addressed by the contents of the HL register pair to the memory location addressed by the contents of the DE register pair. Then both register pairs are incremented and the BC (byte counter) register pair is decremented.

		1	1	1	0	1	1	0	1
Cycles: States:	4	1	0	1	0	0	0	0	0
	16 H, N, P/V								
	H,N: reset P/V: set if	BC-	- 1≠	0; r	eset	: oth	nerw	vise	

LDIR

$(DE) \leftarrow (HL), DE \leftarrow DE+1, HL \leftarrow HL+1, BC \leftarrow BC-1$

This 2-byte instruction transfers a byte of data from the memory location addressed by the contents of the HL register pair to the memory location addressed by the DE register pair. Then, both register pairs are incremented and the BC (byte counter) register pair is decremented. If decrementing causes the BC to go to 0, the instruction is terminated. If BC is not 0, the program counter is decremented by 2 and the instruction is repeated. Note: if BC is set to 0 prior to instruction execution, the instruction will loop through 64 K bytes. Also, interrupts will be recognized after each data transfer.



For BC≠0:

Cycles: 5 States: 21

For BC = 0:

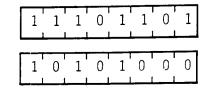
Cycles: 4

States: 16 Flags: H, N, P/V: reset

LDD

 $(DE) \leftarrow (HL), DE \leftarrow DE-1, HL \leftarrow HL-1, BC \leftarrow BC-1$

This 2-byte instruction transfers a byte of data from the memory location addressed by the contents of the HL register pair to the memory location addressed by the contents of the DE register pair. Then both register pairs including the BC (byte counter) register pair are decremented.



Cycles: 4 States: 16

Flags: H, N, P/V

ags: 11, 10, F/V

H, N: reset P/V: set if BC $-1 \neq 0$; reset otherwise

LDDR

 $(DE) \leftarrow (HL)$, $DE \leftarrow DE-1$, $HL \leftarrow HL-1$, $BC \leftarrow BC-1$

This 2-byte instruction transfers a byte of data from the memory location addressed by the contents of the HL register pair to the memory location addressed by the contents of the DE register pair. Then both registers, as well as the BC (byte counter), are decremented. If decrementing causes the BC to go to 0, the instruction is terminated. If BC is not 0, the program counter is decremented by 2 and the instruction is repeated. Note: if BC is set to 0 prior to instruction execution, the instruction will loop through 64 K bytes. Also, interrrupts will be recognized after each data transfer.

1	1	1	0	1	1	0	1
1	0		1			0	0

For BC \neq 0:

Cycles: 5 States: 21

For BC = 0:

Cycles: 4 States: 16

Flags: H, N, P/V: reset

CPI

A-(HL), $HL \leftarrow HL+1$, $BC \leftarrow BC-1$

The contents of the memory location addressed by the HL register pair are compared with the contents of the Accumulator. In case of a true compare, a condition bit is set. Then HL is incremented and the byte counter (register pair BC) is decremented.

1	1	1	0	1	1	0	1
1	0	1	0	0	0	0	1

Cycles: 4

States: 16

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if A = (HL); reset otherwise

H: set if no borrow from bit 4; reset otherwise

N: set

P/V: set if BC $-1 \neq 0$; reset otherwise

CPIR

A-(HL), HL - HL+1, BC - BC-1

The contents of the memory location addressed by the HL register are compared with the contents of the Accumulator. In case of a true compare, a condition bit is set. The HL is incremented and the BC is decremented. If decrementing causes the BC to go to 0 or if A = (HL), the instruction is terminated. If BC is not 0 and if $A \neq (HL)$, the program counter is decremented by two, and the instruction is repeated. Note: if BC is set to 0 before instruction execution, the instruction will loop through 64 K bytes, if no match is found. Also, interrupts will be recognized after each data comparison.

1 1	1	0	1	1	0	1
1 0	1	1	0	0	0	1

For BC \neq 0 and A \neq (HL): Cycles: 5 States: 21

For BC = 0 or A = (HL):

Cycles: 4

States: 16

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if A = (HL); reset otherwise

H: set if no borrow from bit 4; reset otherwise

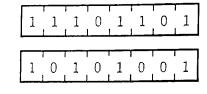
N: set

P/V: set if BC $-1 \neq 0$; reset otherwise

CPD

A-(HL), $HL \leftarrow HL-1$, $BC \leftarrow BC-1$

The contents of the memory location addressed by the HL register pair are compared with the contents of the Accumulator. In case of a true compare a condition bit is set. The HL and the BC are decremented.



States: 16

4

Cycles:

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if A = (HL); reset otherwise

H: set if no borrow from bit 4; reset otherwise

N: set

P/V: set if BC $-1 \neq 0$; reset otherwise

CPDR

A-(HL), $HL \leftarrow HL-1$, $BC \leftarrow BC-1$

The contents of the memory location addressed by the HL register pair are compared with the contents of the Accumulator. In case of a true compare a condition bit is set. The HL and BC register pairs are decremented. If decrementing causes the BC to go to 0 or if A = (HL), the instruction is terminated. If BC is not 0 and $A \neq (HL)$, the program counter is decremented by 2 and the instruction is repeated. Note: if BC is set to 0 prior to instruction execution, the instruction will loop through 64 K bytes if no match is found. Also, interrupts will be recognized after each data comparison.

1 1	0 1	1	0	1
1 0	1 1	0	0	1

For BC \neq 0 and A \neq (HL):

Cycles: States:	
For BC=	=0 or $A = (HL)$:
Cycles: States:	
Flags:	S, Z, H, N, P/V
	S: set if result is negative; reset otherwise Z: set if $A = (HL)$; reset otherwise H: set if no borrow from bit 4; reset otherwise N: set P/V: set if $BC-1 \neq 0$; reset otherwise

ADD A, r

 $A \leftarrow A + r$

The contents of register r are added to the contents of the Accumulator, and the result is stored in the Accumulator.

1 0 0 0 0 - r>	 _	1	T	- T	- T	-1	1
	1	0	0	0	0 🗲	-	r>

Cycles: 1

States: 4

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

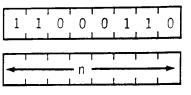
H: set if carry from bit 3; reset otherwise N: reset

C: set if carry from bit 7; reset otherwise P/V: set if overflow; reset otherwise

ADD A, n

A - A + n

The integer n is added to the contents of the Accumulator, and the results are stored in the Accumulator.



Cycles: 2

States: 7

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise

N: reset

C: set if carry from bit 7; reset otherwise

P/V: set if overflow; reset otherwise

ADD A, (HL)

A - A + (HL)

The byte at the memory address specified by the contents of the HL register pair is added to the contents of the Accumulator, and the result is stored in the Accumulator.

1	0	0	0	0	1	1	0
1		ł	1 1	1 1		l	1

Cycles: 2

States: 7

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

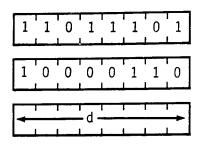
H: set if carry from bit 3; reset otherwise N: reset

C: set if carry from bit 7; reset otherwise P/V: set if overflow; reset otherwise

ADD A, (IX+d)

$$A \leftarrow A + (IX + d)$$

The contents of the Index Register IX are added to a displacement d to point to an address in memory. The contents of this address are then added to the contents of the Accumulator, and the result is stored in the Accumulator.





States:

S,Z,H,N,C,P/V Flags:

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise

N: reset

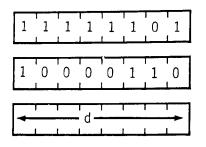
C: set if carry from bit 7; reset otherwise

P/V: set if overflow; reset otherwise

ADD A, (IY+d)

 $A \leftarrow A + (IY + d)$

The contents of the Index Register IY are added to a displacement d to point to an address in memory. The contents of this address are then added to the contents of the Accumulator, and the result is stored in the Accumulator.



Cycles: 5

States: 19

S, Z, H, N, C, P/V Flags:

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

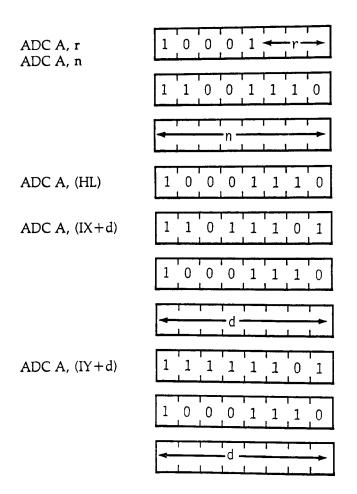
H: set if carry from bit 3; reset otherwise N: set

C: set if carry from bit 7; reset otherwise P/V: set if overflow; reset otherwise

ADC A, s

$A \leftarrow A + s + CY$

The s operand is any of r, n, (HL), (IX+d), or (IY+d) as defined for the analogous ADD instruction. These various possible opcode operand combinations are assembled in the object code as follows:



The s operand, along with the Carry Flag ("C" in the F register) is added to the contents of the Accumulator, and the result is stored in the Accumulator.

Instruction	Cycles	States
ADC A, r	1	4
ADC A, n	2	7
ADC A, (HL)	2	7
ADC A, $(IX+d)$	5	19
ADC A, $(IY+d)$	5	19

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise N: reset

C: set if carry from bit 7; reset otherwise P/V: set if overflow; reset otherwise

SUB s

 $A \leftarrow A-s$

The s operand is subtracted from the contents of the Accumulator, and the result is stored in the Accumulator.

SUB r	1	0	0	1	0	•	- r-	
SUB n	1	1	0	1	0	1	1	0
	-	1		- n -				-
SUB (HL)	1	0	0	1	0	1	1	0
SUB (IX+d)	1	1	0	1	1	1	0	1
	1	0	0	1	0	1	1	0
	-]]	l	- d -			1	
SUB (IY+d)	1	1	1	1	1	1	0	1
	1	0	0	1	0	1	1	0
	-	1 	1	-d -	1	I	1	

Instruction	Cycles	States
SUB r	1	4
SUB n	2	7
SUB (HL)	2	7
SUB $(IX + d)$	5	19
SUB (IY+d)	5	19

Flags: S, Z, H, N, C, P/V

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: set if no borrow from bit 4; reset otherwise
- N: set
- C: set if no borrow; reset otherwise
- P/V: set if overflow; reset otherwise

SBC A, s

A - A - s - CY

The s operand, along with the Carry Flag ("C" in the F register) is subtracted from the contents of the Accumulator, and the result is stored in the Accumulator.

SBC A, r	1	0	0	1	1.	ı ∢—	-r-	
SBC A, n	1	1	0	1	1	1	1	0
	-	r 1		-n -		l		+
SBC A, (HL)	1	0	0	1	1	1	1	0
SBC A, (IX+d)	1	1	0	1	1	1	0	1
	1	0	0	1	1	1	1	0
		l		d –				+
SBC A, $(IY+d)$	1	1	1	1	1	1	0	1
	1	0	0	1	1	1	' 1 1	0
	+	1 	l	— d ·	r	T 	T 	

Instruction	Cycles	States
SBC A, r	1	4
SBC A, n	2	7
SBC A, (HL)	2	7
SBC A, $(IX+d)$	5	19
SBC A, $(IY+d)$	5	19

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if no borrow from bit 4; reset otherwise

N: set

C: set if no borrow; reset otherwise

P/V: set if overflow; reset otherwise

AND s

$A \leftarrow A \land s$

A logical AND operation, bit by bit, is performed between the byte specified by the s operand and the byte contained in the Accumulator; the result is stored in the Accumulator.

AND r	1	0	1	0	0		- r -	
AND n	1	1	1	0	0	1	1	0
	-	I		- n -		[
AND (HL)	1	0	1	0	0	1	1	0
AND (IX+d)	1	1	0	1	1	1	0	1
	1	0	1	0	0	1	1	0
	-		[]	- d -		[
AND(IY+d)	1	1	1	1	1	1	0	1
	1	0	1	0	0	1	1	0
	-	r 	[1	- d -			1	-

<u>Instruction</u>	Cycles	States
AND r	1	4
AND n	2	7
AND (HL)	2	7
AND $(IX+d)$	5	19
AND (IX+d)	5	19

Flags: S, Z, H, N, C, P/V

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: set
- $N \colon \ reset$
- C: reset
- P/V: set if parity even; reset otherwise

$A \leftarrow A \lor s$

A logical OR operation, bit by bit, is performed between the byte specified by the s operand and the byte contained in the Accumulator; the result is stored in the Accumulator.

OR r	1	0	1	1	0-	1 	- r -	
OR n	1	1	1	1	0	1	1	0
	-	1	ř	- n -	t		[
OR (HL)	1	0	1	1	0	1	1	0
OR(IX+d)	1	1	0	1	1	1	0	1
	1	0	1	1	0	1	1	0
				- d -				-
OR(IY+d)	1	1	1	1	1	1	0	1
	1	0	1	1	0	1	1	0
	+	1	l	- d -	1	I	1	

Instruction	Cycles	States
OR r	1	4
OR n	2	7
OR (HL)	2	7
OR(IX+d)	5	19
OR (IY+d)	5	19

Flags: S, Z, H, N, C, P/V

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: set
- $N \colon reset$
- C: reset
- P/V: set if parity even; reset otherwise

OR s

XOR s

A ← A⊕s

A logical exclusive-OR operation, bit by bit, is performed between the byte specified by the s operand and the byte contained in the Accumulator; the result is stored in the Accumulator.

XOR r	1	0	1	0	1 -		- r -	-
XOR n	1	1	1	0	1	1	1	0
		 		- n -				
XOR (HL)	1	0	1	0	1	1	1	0
XOR (IX+d)	1	1	0	1	1	1	0	1
		0	1	0	1	1	1	0
				- d -	[I		+
XOR (IY+d)	1	1	1	1	1	1	0	1
		0	1	0	1	1	1	0
				- d	1 	r 1	г <u> </u>	

Instruction	Cycles	States
XOR r	1	4
XOR n	2	7
XOR (HL)	2	7
XOR (IX+d)	5	19
XOR $(IY+d)$	5	19

Flags: S, Z, H, N, C, P/V

- S: set if result is negative; reset otherwise
- Z: set if result if 0; reset otherwise
- H: set
- N: reset
- $C \colon reset$
- P/V: set if parity even; reset otherwise

A-s

CP s

h Í The contents of the s operand are compared with the contents of the Accumulator. If there is a true compare, a flag is set.

CP r	1	0	1	1	1	-	- r	-+
CP n	1	1	1	1	1	1	1	0
			I	- n -				
CP (HL)	1	0	1	1	1	1	1	0
CP(IX+d)	1	1	0	1	1	1	0	1
	1	0	1	1	1	1	1	0
			I	- d -				+
CP(IY+d)	1	1	1	1	1	1	0	1
	1	0	1	1	1	1	1	0
	-	1	1	- d -	· · · · ·	I	[-

Instruction	Cycles	States
CP r	1	4
CP n	2	7
CP (HL)	2	7
CP (IX+d)	5	19
CP(IY+d)	5	19

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if no borrow from bit 4; reset otherwise

N: set

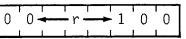
C: set if no borrow; reset otherwise

P/V: set if overflow; reset otherwise

INC r

 $r \leftarrow r+1$

Register r is incremented.



Cycles: 1

States: 4

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise

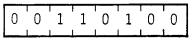
N: reset

P/V: set if r was 7FH before operation; reset otherwise

INC (HL)

 $(HL) \leftarrow (HL)+1$

The byte contained in the address specified by the contents of the HL register pair is incremented.



Cycles: 3

States: 11

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise

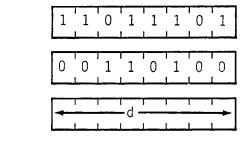
N: reset

P/V: set if (HL) was 7FH before operation; reset otherwise

INC (IX+d)

 $(IX+d) \leftarrow (IX+d)+1$

The contents of the Index Register IX are added to a two's complement displacement integer d to point to an address in memory. The contents of this address are then incremented.



Cycles: 6 States: 23

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise

N: reset

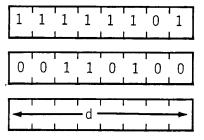
P/V: set if (IX+d) was 7FH before operation; reset otherwise

INC (IY+d)

 $(IY+d) \leftarrow (IY+d)+1$

The contents of the Index Register IY are added to a two's complement

displacement integer d to point to an address in memory. The contents of this address are then incremented.



Cycles: 6 States: 23

Flags: S, Z, H, N, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry from bit 3; reset otherwise

N: reset

P/V: set if (IY+d) was 7FH before operation; reset otherwise

DEC m

 $m \leftarrow m-1$

The byte specified by the m operand is decremented.

			1					
DEC r	0	0-	I ◀── L	- r -	 }	-1	0	1
DEC (HL)	0	0	1	1	0	1	0	1
DEC (IX+d)	1	1	0	1	1	1	0	1
	0	0	1	1	0	1	0	1
	-	F	 	d -		r	[
DEC (IY+d)	1	1	1	1	1	1	0	1
	0	0	1	1	0	1	0	1
				d –	· · · · · · · · · · · · · · · · · · ·	· · · · · · · · · · · · · · · · · · ·		-
Instruction DEC r DEC (HL)	<u>C</u>	ycle 1 3	<u>s</u>		<u>Sta</u> 4 11			

Cycles
1
3
6
6

S, Z, H, N, P/VFlags:

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if no borrow from bit 4; reset otherwise

N: set

P/V: set if m was 80H before operation; reset otherwise

23 23

CPL

 $A - \overline{A}$ Contents of the Accumulator are inverted (1's complement).

		0	0	1	0	1	1	1	1
Cycles: States: Flags:	1 4 H, N								
	H: set								

N: set

NEG

 $A \rightarrow 0 - A$

The contents of the Accumulator are negated (two's complement). This is the same as subtracting the contents of the Accumulator from 0.

1	1 1		0	1		0	1
0) 1	0	0	0	1		0

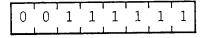
Cycles: 2 States: 8

S, Z, H, N, C, P/V Flags:

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: set if no borrow from bit 4; reset otherwise
- N: set
- C: set if Accumulator was not 00H before operation; reset otherwise
- P/V: set if Accumulator was 80H before operation; reset otherwise
- CCF

 $CY \leftarrow \overline{CY}$

The C flag in the F register is inverted.



Cycles: 1

States: 4

- H, N, C Flags:
 - H: previous carry will be copied

N: reset

C: set if CY was 0 before operation; reset otherwise

SCF

CY ← 1

The C flag in the F register is set.

Cycles: 1 States: 4 H,N,C Flags:

- H: reset N: reset
- C: set

NOP

The central processor performs no operation during this machine cycle.

0	0	0	0	0	' 0	0	0
	1	1	L	1	1	1	1

Cycles: 1 States: 4 Flags: none

DAA

This instruction conditionally adjusts the Accumulator for BCD addition and subtraction operations. For addition (ADD, ADC, INC) or subtraction (SUB, SBC, DEC, NEG), the following table indicates the operation performed:

OPERATION	C BEFORE DAA	HEX VALUE IN UPPER DIGIT (bit 7-4)	H BEFORE DAA	HEX VALUE IN LOWER DIGIT (bit 3-0)	NUMBER ADDED TO BYTE	C AFTER DAA
ADD ADC INC	0 0 0 0 0 0 1 1 1 1	0-9 0-8 0-9 A-F 9-F A-F 0-2 0-2 0-3	0 0 1 0 0 1 0 0 1	0-9 A-F 0-3 0-9 A-F 0-3 0-9 A-F 0-3	00 06 06 60 66 66 66 66	0 0 1 1 1 1 1 1 1
SUB SBC DEC NEG	0 0 1 1	0-9 0-8 7-F 6-F	0 1 0 1	0-9 6-F 0-9 6-F	00 FA A0 9A	0 0 1 1

M CYCLES: 1 T STATES: 4 4 MHZ E.T.: 1.00

Cycles: 1

States: 4

Flags: S, Z, H, C, P/V

- S: set if most significant bit of Accumulator is 1 after operation; reset otherwise
- Z: set if Accumulator is 0 after operation; reset otherwise

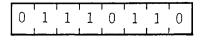
H: see instruction

C: see instruction

P/V: set if Accumulator is even parity after operation; reset otherwise HALT

÷

The HALT instruction suspends the central processor operation until a subsequent interrupt or reset is received. While in the halt state, the processor will execute NOPs to maintain memory refresh logic.



Cycles: 1 States: 4

Flags: none

DI

IFF ← 0

DI disables the maskable interrupt by resetting the interrupt enable flip-flops (IFF1 and IFF2). Note: this instruction disables the maskable interrupt during its execution.

		T	Ţ	1	1	[
1	1	1	1	Ω	0	1	1
-				. Č			

- Cycles: 1 States: 4
- Flags: none

EI

IFF ← 1

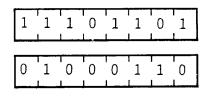
EI enables the maskable interrupt by setting the interrupt enable flip-flops (IFF1 and IFF2). Note: this instruction disables the maskable interrupt during its execution.

1	1	1	1	1	0	1	1
	L	<u> </u>	1	<u> </u>	1	L	1

Cycles: 1 States: 4 Flags: none

IM 0

The IM 0 instruction sets interrupt mode 0. In this mode the interrupting device can insert any instruction on the data bus and allow the central processor to execute it.



Cycles: 2 States: 8

Flags: none

IM 1

The IM 1 instruction sets interrupt mode 1. In this mode the processor will respond to an interrupt by executing a restart of location 0038H.

1 1	1 1 0	1 1	
1	1 0 1	0 1	10

Cycles: 2 States: 8 Flags: none

IM 2

The IM 2 instruction sets interrupt mode 2. This mode allows an indirect call to any location in memory. With this mode, the central processor forms a 16-bit memory address. The upper 8 bits are the contents of the Interrupt Vector Register I and the lower 8 bits are supplied by the interrupting device.

1 1	1	0	1	1	0	1
0 1	0	1	1	1	1	0

Cycles: 2 States: 8

Flags: none

SIXTEEN-BIT ARITHMETIC GROUP

ADD HL, ss

 $\text{HL} \leftarrow \text{HL} + \text{ss}$

The contents of register pair ss are added to the contents of register pair HL and the result is stored in HL.

				I	1		
0	0	S	S	1	0	0	1
				<u> </u>	ا ـــَــا		

Cycles: 3

States: 11

Flags: H, N, C

H: set if carry out of bit 11; reset otherwise

N: reset

C: set if carry from bit 15; reset otherwise

ADC HL, ss

 $HL \leftarrow HL + ss + CY$

The contents of register pair ss are added with the Carry Flag to the contents of the register pair HL, and the result is stored in HL.

1	1	1	0	1	1	0	1
0	1	S	S	1	0	1	0

Cycles: 4

States: 15 Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if carry out of bit 11; reset otherwise

N: reset

C: set if carry from bit 15; reset otherwise

P/V: set if overflow; reset otherwise

SBC HL, ss

HL - HL - ss - CY

The contents of the register pair ss and the Carry Flag are subtracted from the contents of register pair HL, and the result is stored in HL.

		1	1	1	0	1	1	0	1
Cycles: States:	4	0	1	s	s	0	0	1	0
States:	15								

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: set if no borrow from bit 12; reset otherwise

N: set

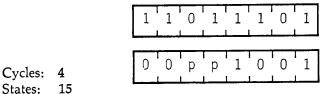
C: set if no borrow; reset otherwise

P/V: set if overflow; reset otherwise

ADD IX, pp

IX – IX+pp

The contents of register pair pp are added to the contents of the Index Register IX, and the results are stored in IX.



States: 15 Flags: H, N, C

H: set if carry out of bit 11; reset otherwise

N: reset

C: set if carry from bit 15; reset otherwise

ADD IY, rr

IY - IY + rr

The contents of register pair rr are added to the contents of Index Register IY, and the result is stored in IY.

1	1 1	1 1	1	0	1
0	0 r	r 1	0	0	1

Cycles: 4 States: 15

Flags: H, N, C

H: set if carry out of bit 11; reset otherwise

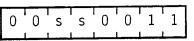
N: reset

C: set if carry from bit 15; reset otherwise

INC ss

ss ← ss+1

The contents of register pair ss are incremented.



Cycles: 1 States: 6 Flags: none

INC IX

 $IX \leftarrow IX+1$

The contents of the Index Register IX are incremented.

1 0	1		1
0		1	1

States:	10
Flags:	none

Cycles:

2

INC IY

 $IY \leftarrow IY+1$

The contents of the Index Register IY are incremented.

		1	1	1	1	1	1		1
Cycles: States:	2 10	0	0	1	0	0	0	1	1
Flags:	none								

DEC ss

 $ss \leftarrow ss - 1$

The contents of register pair ss are decremented.

0	0	S	S	1	0	1	1
	L						

Cycles: 1 States: 6 Flags: none

DEC IX

 $IX \leftarrow IX - 1$

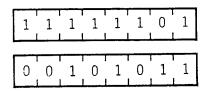
The contents of the Index Register IX are decremented.

1	1	0	1	1	1	י 0 1	1
0	0	1	0	1	0	1	1

Cycles: 2 States: 10 Flags: none

 $IY \leftarrow IY - 1$

The contents of the Index Register IY are decremented.

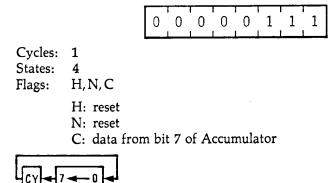


Cycles:	2
States:	10
Flags:	none

ROTATE AND SHIFT GROUP

RLCA CY 7 - 0 -

The contents of the Accumulator are rotated left. The content of bit 7 is copied into the Carry Flag, and also into bit 0.



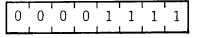
RLA

The contents of the Accumulator are rotated left. The content of bit 7 is copied into the Carry Flag, and the previous content of the Carry Flag is copied into bit 0.

-		
Cycles:	1	
States:	4	
	H,N,C	
	H: reset	
	N: reset	
	C: data from bit 7 of Accumulator.	
7->		

RRCA

The contents of the Accumulator are rotated right. The content of bit 0 is copied into bit 7 and also into the Carry Flag.



Cycles: 1 States: 4

A

- Flags: H, N, C
 - gs. 11,11, C

Α

- H: reset
- N: reset

C: data from bit 0 of Accumulator.

The contents of the Accumulator are rotated right. The content of bit 0 is copied into the Carry Flag, and the previous content of the Carry Flag is

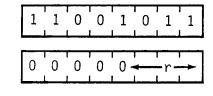
RRA

copied into bit 7.

Cycles: 1 States: 4 Flags: H, N, C H: reset N: reset C: data from bit 0 of Accumulator.

RLC r

The 8-bit contents of register r are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.



Cycles: 2

States: 8

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: reset

N: reset

C: data from bit 7 of source register

P/V: set if parity even; reset otherwise

RLC (HL)

The contents of the memory address specified by the contents of register pair HL are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.

1	1	0	0		0	1	1
0	0	0	0	0	1	1	0

Cycles: 4

States: 15 Flags: S,Z,H,N,C,P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

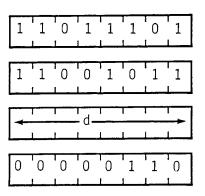
H: reset

N: reset

C: data from bit 7 of source register

P/V: set if parity even; reset otherwise

The contents of the memory address, specified by the sum of the contents of the Index Register IX and a two's complement displacement integer d, are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.



Cycles: 6

States: 23

Flags: S, Z, H, N, C, P/V

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

 $H: \ reset$

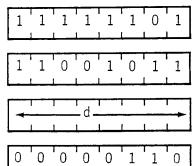
N: reset

C: data from bit 7 of source register

P/V: set if parity even; reset otherwise

RLC
$$(IY+d)$$
 $CY = 7 = 0$ $(IY+d)$

The contents of the memory address, specified by the sum of the contents of the Index Register IY and a two's complement displacement integer d, are rotated left. The content of bit 7 is copied into the Carry Flag and also into bit 0.



Cycles: 6

States:

Flags: S, Z, H, N, C, P/V

23

S: set if result is negative; reset otherwise

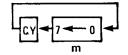
Z: set if result is 0; reset otherwise

H: reset

N: reset

C: data from bit 7 of source register

P/V: set if parity even; reset otherwise



The contents of the m operand are rotated left. The content of bit 7 is copied into the Carry Flag and the previous content of the Carry Flag is copied into bit 0.

RL m

RL r

RL (HL)

RL(IX+d)

1	1	0	0	1	0	1	1
С	0	0	1	0			
	1	0	0	1	0	1	1
0	0	0	1	0	1	1	0
1	1	0	1	1	1	0	1
1	1	0	0	1	0	1	1
		I1	- d -				+
0	0	0	1	0	1	1	0

RL (IY+d)

			1		
1	0	0	1	0	
		- d -			
0		1	0	1	 0

Instruction	Cycles	States
RL r	2	8
RL (HL)	4	15
RL(IX+d)	6	23
RL(IY+d)	6	23

Flags: S, Z, H, N, C, P/V

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: reset
- N: reset

CY

- C: data from bit 7 of source register
- P/V: set if parity even; reset otherwise

RRC m

The contents of the operand m are rotated right. The content of bit 0 is copied into the Carry Flag and also into bit 7.

RRC r	
	0 0 0 0 1 - r->
RRC (HL)	
RRC (IX+d)	

	1	1	0	0	1	0	1	1
	-	r 	[- d -		· · · · · · · · · · · · · · · · · · ·		
	0	0	0	0	1	1	1	0
RRC (IY+d)	1	1	1	1	1	1	0	1
	1	1	0	0	1	0	1	1
				- d -	r	r		
	0	0	0	0	1	1	1	0
	L				L		L	1

Instruction	Cycles	States
RRC r	2	8
RRC (HL)	4	15
RRC $(IX+d)$	6	23
RRC $(IY+d)$	6	23

Flags:
$$S, Z, H, N, C, P/V$$

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

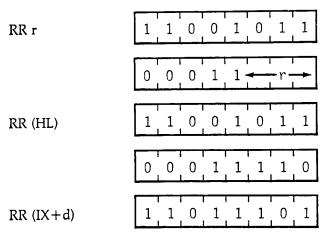
- H: reset
- $N \colon reset$

C: data from bit 0 of source register

P/V: set if parity even; reset otherwise

RR m

The contents of operand m are rotated right. The content of bit 0 is copied into the Carry Flag, and the previous content of the Carry Flag is copied into bit 7.



Instruction	Cycles	States
RR r	2	8
RR (HL)	4	15
RR(IX+d)	6	23
RR(IY+d)	6	23

Flags: S, Z, H, N, C, P/V

RR (IY+d)

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and the same second

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: reset
- N: reset
- C: data from bit 0 of source register P/V: set if parity even; reset otherwise

An arithmetic shift left is performed on the contents of operand m. Bit 0 is reset. The content of bit 7 is copied into the Carry Flag.

SLA r	1 1 0 0 1 0	
	0 0 1 0 0	-γ>
SLA (HL)	1 1 0 0 1 0	1 1
	0 0 1 0 0 1	1 0
SLA (IX+d)	1 1 0 1 1 1	0 1

1	1	0	0	1	0	1	1
+		1 	-d-	1	I	1 1	->
0	0	1	0	0	1	1	0
1	1	1	1	1	1	0	1
1	1	0	0	1	0	1	1
-			-d-	[
0	0	1	0	0	1	1	0

Instruction	Cycles	<u>States</u>
SLA r	2	8
SLA (HL)	4	15
SLA(IX+d)	6	23
SLA (IY+d)	6	23

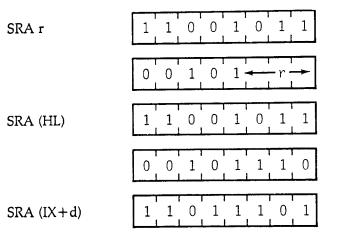
Flags: S, Z, H, N, C, P/V

SLA (IY+d)

S: set if result is negative; reset otherwise

- Z: set if result is 0; reset otherwise
- H: reset
- N: reset
- C: data from bit 7
- P/V: set if parity even; reset otherwise

An arithmetic shift right is performed on the contents of operand m. The content of bit 0 is copied into the Carry Flag, and the previous content of bit 7 is unchanged.



SRA (IY+d)

ł

r.

s

Flags: S, Z, H, N, C, P/V

- S: set if result is negative; reset otherwise
- Z: set if result is 0; reset otherwise
- H: reset
- $N \colon \ reset$
- C: data from bit 0 of source register
- P/V: set if parity even; reset otherwise

The contents of operand m are shifted right. The content of bit 0 is copied into the Carry Flag and bit 7 is reset.

SRL r	
	$0 0 1 1 1 - r \rightarrow$
SRL (HL)	
	0 0 1 1 1 1 1 0
SRL (IX+d)	

1	1	0	0	1	0	1	1
	 		- d-				->
0	0	1	1	1	1	1	0
							1
1	1	0	0	1	0	1	1
	· · · · · · · · · · · · · · · · · · ·	[-d-	 		1 	
0	0	1	1	1	1	1	0
0	0	1	1	1	1	1	

<u>Instruction</u>	Cycles	States
SRL r	2	8
SRL (HL)	4	15
SRL(IX+d)	6	23
SRL (IY+d)	6	23

Flags: S, Z, H, N, C, P/V

SRL (IY+d)

S: set if result is negative; reset otherwise

Z: set if result is 0; reset otherwise

H: reset

N: reset

C: data from bit 0 of source register

P/V: set if parity even; reset otherwise

RLD

A7 43 0 7 43 0(HL)

The contents of the low-order 4 bits of memory location (HL) are copied into the high-order 4 bits of that same memory location. The previous contents of those high-order 4 bits are copied into the low-order 4 bits of the Accumulator, and the previous contents of the low-order 4 bits of the Accumulator are copied into the low-order 4 bits of the memory location (HL). The contents of the high-order 4 bits of the Accumulator are unaffected.

1 1	1 0	1 1	1
0 1		1 1	1

Cycles: 5 States: 18

Flags: S, Z, H, N, P/V

S: set if Accumulator is negative after operation; reset otherwise

Z: set if Accumulator is 0 after operation; reset otherwise

H: reset

- $N \colon \ reset$
- P/V: set if parity of Accumulator is even after operation; reset otherwise

 $\langle \rangle$

RRD A74307430(HL)

The contents of the low-order 4 bits of memory location (HL) are copied into the low-order 4 bits of the Accumulator. The previous contents of the loworder 4 bits of the Accumulator are copied into the high-order 4 bits of location (HL), and the previous contents of the high-order 4 bits of (HL) are copied into the low-order 4 bits of (HL). The contents of the high-order 4 bits of the Accumulator are unaffected.

1	1	1	0	1	1	0	1
0	1	1	0		1	1	1

Cycles: 5 States: 18

Flags: S, Z, H, N, P/V

S: set if Accumulator is negative after operation; reset otherwise

Z: set if Accumulator is 0 after operation; reset otherwise

H: reset

N: reset

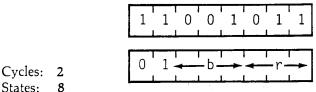
P/V: set if parity of Accumulator is even after operation; reset otherwise

BIT SET, RESET AND TEST GROUP

BIT b, r

 $Z \leftarrow \overline{r_b}$

After execution of this instruction, the Z flag in the F register will contain the complement of the indicated bit within the indicated register.



States: 8 Flags: S, Z, H, N, P/V

S: unknown

Z: set if specified bit is 0; reset otherwise

H: set

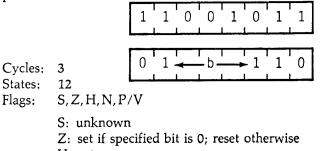
N: reset

P/V: unknown

BIT b, (HL)

 $Z \leftarrow \overline{(HL)}_{b}$

After the execution of this instruction, the Z flag in the F register will contain the complement of the indicated bit within the contents of the HL register pair.



H: set

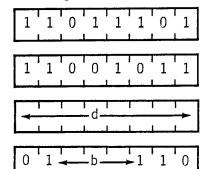
N: reset

P/V: unknown

BIT b, (IX+d)

 $Z \leftarrow (\overline{IX+d})_b$

After the execution of this instruction, the Z flag in the F register will contain the complement of the indicated bit within the contents of the memory location pointed to by the sum of the contents of register pair IX and the two's complement displacement integer d.



Cycles: 5 States: 20

Flags: S, Z, H, N, P/V

S: unknown

Z: set if specified bit is 0; reset otherwise

H: set

N: reset

P/V: unknown

BIT b, (IY+d)

 $Z \leftarrow \overline{(IY+d)}_b$

After the execution of this instruction, the Z flag in the F register will contain the complement of the indicated bit within the contents of the memory location pointed to by the sum of the contents of register pair IY and the two's complement displacement integer d.

		1	1	1	1	1	1	0	1
		1	1	0	0	1	0	1	1
					- d		1	1	· →
Cycles: States:	5 20	0	1.	 	-b-		- 1	1	0

States: 20 L Flags: S, Z, H, N, P/V

S: unknown

Z: set if specified bit is 0; reset otherwise

H: set

N: reset

P/V: unknown

SET b, r

$$r_b \leftarrow 1$$

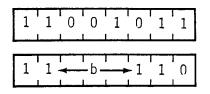
Bit b (any bit, 7 thru 0) in register r is set.

		[0	0	1	0	1	1
Cycles: States: Flags:	2 8 none	[:	1	-	-b-		- 	1 - r 1	

SET b, (HL)

 $(HL)_b \leftarrow 1$

Bit b in the memory location addressed by the contents of register pair HL is set.

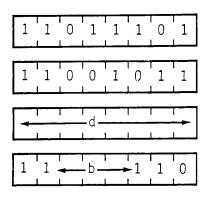


Cycles: 4 States: 15 Flags: none

SET b, (IX+d)

 $(IX+d)_b \leftarrow 1$

Bit b in the memory location addressed by the sum of the contents of the IX register pair and the two's complement displacement integer d is set.

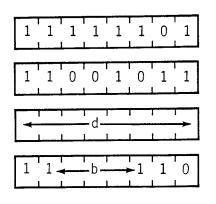


Cycles: 6 States: 23 Flags: none

SET b, (IY+d)

 $(IY+d)_b - 1$

Bit b in the memory location addressed by the sum of the contents of the IY register pair and the two's complement displacement integer d is set.



Cycles: 6 States: 23 Flags: none RES b, m

 $s_b \leftarrow 0$ Bit b in operand m is reset.

RES b, r			1
	1 0 <u>-</u> t		-
RES b, (HL)			1
) _ → 1 1	0
RES b, $(IX+d)$		1 1 0	1
	1 1 0 0		1
] 	
)> 1 _1	0
RES b, $(IY+d)$	1 1 1 1	1 1 0	1
	1 1 0 0) 1 0 1	1
		1 1 1 1 	
	1 0 -		0
Instruction	Cycles	States	

Instruction	Cycles	States
RES b, r	4	8
RES b, (HL)	4	15
RES b, $(IX+d)$	6	23
RES b, $(IY+d)$	6	23

Flags: none

JUMP GROUP

JP nn

PC ← nn

Operand nn is loaded into register pair PC (program counter) and points to the address of the next program instruction to be executed.

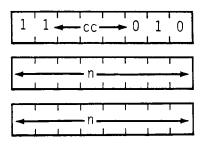
1	1	0	0	0	0	1	1
			.n_				→

Cycles: 3 States: 10 Flags: none

JP cc, nn

IF cc TRUE, PC - nn

If condition cc is true, the instruction loads operand nn into register pair PC, and the program continues with the instruction beginning at address nn. If condition cc is false, the program counter is incremented as usual, and the program continues with the next sequential instruction.



Cycles: 3 States: 10 Flags: none

JR e

$PC \leftarrow PC + e$

This instruction provides for unconditional branching to other segments of a program. The value of the displacement e is added to the PC and the next instruction is fetched from the location designated by the new contents of the PC. This jump is measured from the address of the instruction opcode and has a range of -126 to +129 bytes.

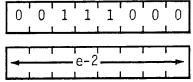
0	0	0	1	1	0	0	0
					r 	T	⊤ >

Cycles: 3 States: 12 Flags: none JR C, e

If C=0, continue

If C=1, $PC \leftarrow PC+e$

This instruction provides for conditional branching to other segments of a program depending on the results of a test on the Carry Flag. If the flag is set, the value of the displacement e is added to the PC, and the next instruction is fetched from the location designated by the new contents of the PC. If the flag is reset the next instruction is taken from the location following this instruction.



If the condition is met:

Cycles: 3 States: 12

If the condition is not met:

Cycles:	2
States:	7
1 -1	

Flags: none

JR NC, e

If C=1, continue

If C=0, $PC \leftarrow PC+e$

This instruction provides for conditional branching to other segments of a program depending on the results of a test on the Carry Flag. If the flag is reset, the value of the displacement e is added to the PC, and the next instruction is fetched from the location designed by the new contents of the PC. If the flag is set, the next instruction to be executed is taken from the location following this instruction.

0	0	1		0	0	0	0
			e-2				

If the condition is met:

Cycles: 3 States: 12

If the condition is not met:

Cycles: 2 States: 7 Flags: none

JR Z, e

If Z=0, continue

If Z=1, $PC \leftarrow PC+e$

If the Zero Flag is set, the value of the displacement e is added to the PC and the next instruction is fetched from the location designated by the new contents of the PC. If the Zero Flag is reset, the next instruction to be executed is taken from the location following this instruction.

0	0	1	0	1	0	0	0
-			·				-

If the condition is met:

Cycles: 3 States: 12

If the condition is not met:

Cycles: 2

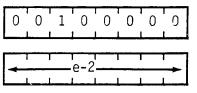
States: 7

Flags: none

JR NZ, e

If Z=1, continue If Z=0, PC \leftarrow PC+e If the Zero Flag is rese

If the Zero Flag is reset, the value of the displacement e is added to the PC, and the next instruction is fetched from the location designated by the new contents of the PC. If the Zero Flag is set, the next instruction to be executed is taken from the location following this instruction.



If the condition is met:

Cycles: 3 States: 12

If the condition is not met:

Cycles: 2 States: 7 Flags: none

JP (HL)

 $PC \leftarrow HL$

The PC is loaded with the contents of the HL register pair. The next instruction is fetched from the location designated by the new contents of the PC.

1	1	1	0	1	0	0	1
1					1 1	. 1	

Cycles: 1 States: 4 Flags: none

JP (IX)

 $PC \leftarrow IX$

The PC is loaded with the contents of the IX Register Pair. The next instruction is fetched from the location designated by the new contents of the PC.

1							1
1	1	1	0	1	0	0	1

Cycles: 2 States: 8

Flags: none

JP (IY)

PC – IY

Cycles:

States:

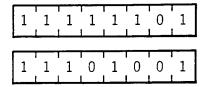
Flags:

2

8

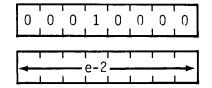
none

The PC is loaded with the contents of the IY Register Pair. The next instruction is fetched from the location designated by the new contents of the PC.



DJNZ, e

The B register is decremented, and if a non 0 value remains, the value of the displacement e is added to the PC. The next instruction is fetched from the location designated by the new contents of the PC. If the result of decrementing leaves B with a 0 value, the next instruction to be executed is taken from the location following this instruction.



If B≠0:

Cycles: 3 States: 13

If B = 0:

Cycles: 2 States: 8

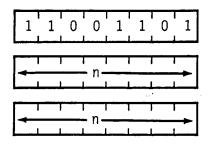
Flags: none

CALL AND RETURN GROUP

CALL nn

 $(SP-1) \leftarrow PC_H$, $(SP-2) \leftarrow PC_L$, $PC \leftarrow nn$

After pushing the current contents of the PC onto the top of the external memory stack, the operands nn are loaded into PC to point to the address in memory where the first opcode of a subroutine is to be fetched. Note: because this is a 3-byte instruction, the PC will have been incremented by three before the push is executed.



Cycles: 5 States: 17

Flags: none

CALL cc, nn

ړ

If cc TRUE: $(SP-1) \leftarrow PC_H$, $(SP-2) \leftarrow PC_L$, PC \leftarrow nn

If condition cc is true, this instruction pushes the current contents of the PC onto the top of the external memory stack, then loads the operands nn into PC to point to the address in memory where the first opcode of a subroutine is to be fetched.

1 1	↓ ↓	 1 	→1	0	0
-	- <u> </u>	 1	<u> </u>	Т <u>,</u>	
	- <u>i</u> 				
	1	 1	1	 	

If cc is true:

Cycles: 5 States: 17

If cc is false:

Cycles: 3 States: 10 Flags: none

Cycles:

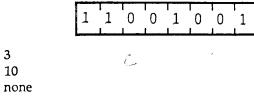
States:

Flags:

RET

 $PC_L \leftarrow (SP), PC_H \leftarrow (SP+1)$

Control is returned to the original program flow by popping the previous contents of the PC off the top of the external memory stack, where they were pushed by the CALL instruction. On the following machine cycle, the central processor will fetch the next program opcode from the location in memory now pointed to by the PC.



RET cc

If cc TRUE: $PC_L \leftarrow (SP)$, $PC_H \leftarrow (SP+1)$

If condition cc is true, control is returned to the original program flow by popping the previous contents of the PC off the top of the external memory stack where they were pushed by the CALL instruction. On the following machine cycle, the central processor will fetch the next program opcode from the location in memory now pointed to by the PC. If condition cc if false, the PC is simply incremented as usual, and the program continues with the next sequential instruction.

	T	—	1					
11	1	-	- C (<u> </u>	()	0	0
1		-				´ .	Č,	Ň

If cc is true: Cycles: 3 States: 11 If cc is false: Cycles: 1 States: 5

Flags: none

RETI

Return from interrupt

This instruction is used at the end of an interrupt service routine to

- 1. Restore the contents of the PC.
- 2. Signal an I/O device that the interrupt routine has been completed.

The RETI instruction facilitates the nesting of interrupts allowing higher priority devices to suspend service of lower priority service routines. This instruction also resets the IFF1 and IFF2 flip-flops.

1 1					1
0 1	0 0	1	1	0	1

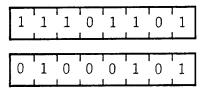
Cycles: 4 States: 14

Flags: none

RETN

Return from nonmaskable interrupt

Used at the end of a service routine for a nonmaskable interrupt, the instruction executes an unconditional return which functions identically to the RET instruction. Control is now returned to the original program flow; on the following machine cycle the central processor will fetch the next opcode from the location in memory now pointed to by the PC. Also, the state of IFF2 is copied back into IFF1 to the state it had prior to the acceptance of the NMI.



Cycles:	4
States:	14
Flags:	none

RST p

 $(SP-1) \leftarrow PC_H$, $(SP-2) \leftarrow PC_L$, $PC_H \leftarrow 0$, $PC_L \leftarrow p$ The current PC contents are pushed onto the external memory stack, and the page zero memory location given by operand p is loaded into the PC. Program execution then begins with the opcode in the address now pointed to by PC. The restart instruction allows for a jump to one of 8 addresses as shown in the table below. The operand p is assembled into the object code using the corresponding t state.

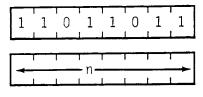
		1	1 -	_t_	 - 1	1	1
	<u>р</u> 00Н	<u>t</u> 000					
	08H 10H 18H	001 010 011					
	20H 28H 30H	100 101 110					
	30H 38H	110					
Cycles: States: Flags:	3 11 none						

INPUT AND OUTPUT GROUP

IN A, (n)

A - (n)

The operand n is placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. The contents of the Accumulator also appear on the top half of the address bus at this time. One byte from the selected port is then placed on the data bus and written into the Accumulator in the central processor.

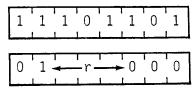


Cycles: 3 States: 11 Flags: none

IN r, (C)

r - (C)

The contents of register C are placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. The contents of register B are placed on the top half of the address bus at this time. One byte from the selected port is then placed on the data bus and written into register r in the central processor.



Cycles: 3 States: 12 Flags: S,Z,H,N,P/V

- S: set if input data is negative; reset otherwise
- Z: set if input data is 0; reset otherwise
- H: reset
- N: reset
- P/V: set if parity is even; reset otherwise

INI

 $(HL) \leftarrow (C), B \leftarrow B-1, HL \leftarrow HL+1$

The contents of register C are placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. Register B may be used as a byte counter, and its contents are placed on the top half of the address bus. One byte from the selected port is then placed on the data bus and written to the central processor. The contents of the HL register pair are then placed on the address bus, and the input byte is written into the corresponding location of memory. Finally, the byte counter is decremented, and register pair HL is decremented.

1	1	0	1	1	0	1
		0		0	1	

Cycles: 4 States: 10

- States: 16 Flags: S,2
 - S, Z, H, N, P/V
 - S: unknown Z: set if B-1=0; reset otherwise
 - H: unknown
 - N: set
 - P/V: unknown

INIR

 $(HL) \leftarrow (C), B \leftarrow B-1, HL \leftarrow HL+1$

The contents of register C are placed on the bottom half of the address bus to select the I/O device at one of 256 possible ports. Register B is used as a byte counter, and its contents are placed on the top half of the address bus. One byte is selected and is placed on the data bus and written into the central processor. The contents of the HL register pair are placed on the address, and the input byte is written into the corresponding memory location. The byte counter is then decremented and the HL register pair is incremented. If decrementing causes B to go to 0, the instruction is terminated. If B is not 0, the PC is decremented by two and the instruction repeated. Interrupts will be recognized after each data transfer.

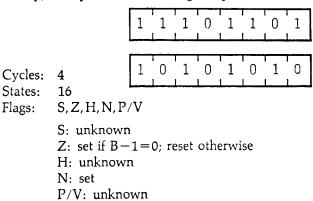
		1	1	1	0	1	1	1
		1	0	1	1	0	0	
If $B \neq 0$:		L						
Cycles: States:	5 21							
If $B = 0$:								
Cycles: States:	4 16							
Flags:	S, Z, H, N, P,	/V						

S: unknown Z: set H: unknown N: set P/V: unknown

IND

$(HL) \leftarrow (C), B \leftarrow B-1, HL \leftarrow HL-1$

The contents of register C are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its contents are placed on the top half of the address bus. One byte from the selected port is placed on the data bus and written to the central processor. The contents of the HL register pair are placed on the address bus, and the input byte is written into the corresponding memory location. Finally, the byte counter and register pair HL are decremented.



INDR

 $(HL) \leftarrow (C), B \leftarrow B-1, HL \leftarrow HL-1$

The contents of register C are placed on the bottom half of the address bus to select the I/O device. Register B is used as a byte counter, and its contents are placed on the top half of the address bus. One byte from the selected port is placed on the data bus and written to the central processor. The contents of the HL register pair are placed on the address bus and the input byte is written into the corresponding memory location. The HL register pair and the byte counter are then decremented. If decrementing causes B to go to 0, the instruction is repeated. Interrupts will be recognized after each data transfer.

1	1	1	0	1	1	0	1
1	0	1		1		1	0

If B≠0:

Cycles: 5 States: 21

If B = 0:

Cycles: 4 States: 16 Flags: S, Z, H, N, P/V S: unknown Z: set H: unknown N: set

P/V: unknown

OUT (n), A

(n) - A

The operand n is placed on the bottom half of the address bus to select the I/O device. The contents of the Accumulator appear on the top half of the address bus. Then the byte contained in the Accumulator is placed on the data bus and written into the selected peripheral device.

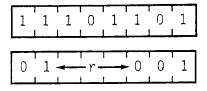
 1 0		Û Û	_	_
 	-n-	1		+

Cycles:	3
States:	11
Flags:	none

OUT (C), r

(C) – r

The contents of register C are placed on the bottom half of the address bus to select the I/O device. The contents of register B are placed on the top half of the address bus. The byte contained in register r is placed on the data bus and written into the selected peripheral device.

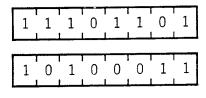


Cycles:	3
States:	12
Flags:	none

OUTI

(C) \leftarrow (HL), B \leftarrow B-1, HL \leftarrow HL+1

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in the central processor. After the byte counter (B) is decremented, the contents of register C are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus. The byte to be output is placed on the data bus and written into the selected peripheral device. Finally, the register pair HL is incremented.



Cycles: 4 States: 10

States: 16 Flags: S,Z,H

s: S, Z, H, N, P/V

- S: unknown
- Z: set if B-1=0; reset otherwise
- H: unknown
- N: set
- P/V: unknown

OTIR

$(C) \leftarrow (HL), B \leftarrow B-1, HL \leftarrow HL+1$

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in the central processor. After the byte counter (B) is decremented, the contents of register C are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus at this time. The byte to be output is placed on the data bus and written into the selected peripheral device. Then register pair HL is incremented. If the decremented B register is not 0, the PC is decremented by two and the instruction is repeated. If B is 0, the instruction is terminated. Interrupts will be recognized after each data transfer.

	1	1	1	0	1	1	0	1
	1	0	1	1	0	0	1	1
5 21								
4								
16								
S, Z, H, N, P	/V							
S: unknown Z: set H: unknow N: set								

OUTD

(C) \leftarrow (HL), B \leftarrow B-1, HL \leftarrow HL-1

P/V: unknown

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in the central processor. Then, after the byte counter (B) is decremented, the contents of register C are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus. The byte to be output is placed on the data bus written into the selected peripheral device. Finally, the register pair HL is decremented.

	,		0		1			
		1	1	0	1	1	0	1
	1	0	1	0	1	0	1	1
4 16	Anne and a							
S, Z, H, N, P	S, Z, H, N, P/V							
S: unknown Z_{i} act if $R_{i} = 1 - 0$, react otherwise								
Z: set if B-1=0; reset otherwise H: unknown								
N: set								
P/V: unkno	own							

Cycles: 4 States:

Flags:

If $B \neq 0$: Cycles: 5 States:

If B = 0: Cycles: 4 States:

Flags:

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OTDR

(C) \leftarrow (HL), B \leftarrow B-1, HL \leftarrow HL-1

The contents of the HL register pair are placed on the address bus to select a location in memory. The byte contained in this memory location is temporarily stored in central processors. Then, after the byte counter (B) is decremented, the contents of register C are placed on the bottom half of the address bus to select the I/O device. Register B may be used as a byte counter, and its decremented value is placed on the top half of the address bus. The byte to be output is then placed on the data bus and written into the selected peripheral device. Register pair HL is then decremented. If the decremented B register is not 0, the PC is decremented by 2, and the instruction is repeated. If register B is 0, then the instruction is terminated. Interrupts will be recognized after each data transfer.

1	1	1	0		1	0	1
1 (1	1	1	1	0	1	1

If B = 0:

If $B \neq 0$: Cycles: 5 States:

Cycles: 4 States: 16

S,Z,H,N,P/V Flags:

21

- S: unknown
 - Z: set
 - H: unknown
 - N: set
 - P/V: unknown

CHAPTER 4 BUILD YOUR OWN COMPUTER—Start With the Basics

The computer to be built from the design described in this book is called ZAP, for Z80 Applications Processor. Building a computer from scratch is both educational and utilitarian (and it saves money). I explain each section of the construction process in detail. Ideally, each step should be tested before proceeding on to the next stage. While this is not possible in all cases, there is a beneficial side effect in taking this route. Often good designs fail to work because the level of construction is beyond the ability of the builder.

I've made the assumption that most hobbyists do not possess sophisticated test equipment, such as oscilloscopes or logic analyzers, and as a result, I've kept testing procedures as simple as possible. By dividing ZAP into logical milestones for checkout and test (and using proven components), problems can be identified at earlier stages and rectified more easily.

The initial implementation of ZAP will constitute a minimum operable configuration. It is important that this works before you attempt to add any of the optional peripherals. Every effort will be made to familiarize the reader with the components of each section and the philosophy of design. While it is necessary to assemble all the components of this minimum configuration completely in order to check proper central processor operation, comprehensive subassembly pretesting should (I hope) correct any wiring errors.

The basic ZAP is divided into four major subassemblies: Z80 busing and control, memory and I/O chip select decoding, memory, and input/output registers. These major divisions are further divided at the component level. Schematics include a complete explanation of their logical function, and test procedures are outlined after each construction presentation.

The Processor

Figure 4.1 is a detailed block diagram of the basic ZAP computer.

I. Z80 Busing and Control Logic

A. Clock Generation

The ZAP computer runs on a 2.5 MHz TTL clock. Unlike the 8080A, the Z80 requires only a single-phase clock and can be driven from DC to 2.5 MHz (the Z80A runs to 4 MHz). Figure 4.2 illustrates the basic timing cycle of the computer.

Each basic operation (M_N) of the computer is completed in three or six clock periods. Figure 4.2 shows a typical instruction cycle which consists of three machine cycles: fetch, memory read, and memory write. After the op-code of the instruction is fetched during M1, the subsequent cycles move the data between memory and the central processor.

Figures 4.3a and 4.3b illustrate two possible clock designs for the Z80. Both clock circuits have a 330 ohm pull-up to +5 V. This will satisfy both the AC and DC clock signal requirements, but it is best to use a separate inverter gate

section to drive the pull-up whatever the oscillation technique.

The crystal controlled circuit of figure 4.3a is preferred if consistent execution time is to be maintained. Thus, the circuit of figure 4.3b, though otherwise acceptable, should be avoided if the computer is to be used as an event timer. It can serve a very useful purpose in the development stages, however, by allowing the user to slow the clock down (by increasing the values of R and C) to a rate where it is possible to directly monitor the central processor operation. Should it ever be necessary to single-step the clock, the circuit in figure 4.4 should be used. Given the multiple clock cycles necessary to execute a single instruction, it would take a lot of button pushes to follow a program through execution.

A much easier diagnostic method would be to use an instruction singlestepping circuit. The circuit, shown in figure 4.5, is not part of the finished schematic of ZAP because it is necessary only if the builder has a problem and needs to follow the execution of a program instruction by instruction. This single-stepping function is accomplished by using the control signals generated by the Z80 during program execution. The two particular signals of concern are M1 and WAIT. M1 is an output, and WAIT is an input. As shown in figure 4.6, M1 goes to a logic 0 level at the beginning of every instruction fetch cycle. M1 signifies that the computer has completed one instruction and is starting on the next. The objective is to stop the microprocessor before it executes this next instruction.

The $\overline{\text{WAIT}}$ input to the Z80 does just that. A logic 0 level applied to this input will suspend the program execution of the computer and indefinitely hold it in the $\overline{\text{M1}}$ cycle. During T_2 , the central processor samples the $\overline{\text{WAIT}}$ input line with the trailing edge of the clock. If, at this time, $\overline{\text{WAIT}}$ is at a logic 0 level, an additional wait state will be entered, and the line will be sampled again. The central processor will hang in this mode until $\overline{\text{WAIT}}$ is raised to a logic 1. It should be noted that this is not a computer halt command.

The real purpose behind these signals is to allow the relatively slow memory and peripherals to be used with a very fast central processor. Extra wait states should be inserted only when necessary for the central processor to access these devices. The effect is to synchronize the timing between the central processor and its I/O devices. The circuit of figure 4.5 allows us to control the WAIT state and to execute only one instruction with each press of the button. The output at IC 1, pin 8 (the \overline{WAIT} input) is normally low, causing an indefinite wait. When the button is pushed, a single debounced pulse clocks IC 2, which is a D-type flip-flop. The duration of this pulse (the time you hold the button down) is irrelevant, because the flip-flop is edge triggered and is only concerned with the leading edge. Pressing the button sets IC 2 and raises the WAIT line. No longer told to wait, the central processor executes the instruction at full clock speed. As it is about to start the next instruction fetch cycle, M1 goes low as before, and triggers the one-shot. When it fires, IC 3 resets IC 2 and returns the central processor to a wait condition until the next time the button is pushed.

The single-step feature isn't of much use in a computer unless there is some way to monitor the contents of all the registers and to determine what the computer is trying to do at any one time. To accomplish this, ZAP must be completely operational and be running a breakpoint-monitor program which allows the user to single-step with a software routine. We'll discuss such programs later.

This fact is of small consolation to a person with a partially debugged computer or hardware error that keeps side-tracking large programs. While it would be nice to see all the register contents, it is virtually impossible to do so without having a central processor that can run a dump and display routine. This cannot be done using the hardware stepping circuit of figure 4.5. It *is* possible, however, to look at the contents of the address and data buses while the central processor is stopped. This should give a good indication as to whether the computer is operating properly.

Many instruments can be used to read the TTL levels on the buses. A scope or high-impedance voltmeter can be used, but a visible display of the bus contents is a better idea. The circuits in figure 4.7 show simple methods to display the contents of the address and data buses. The circuits are included as aids and are not necessary for the operation of ZAP.

Basically, the circuit of figure 4.7a is a simple LED driver that is duplicated 16 times for the address bus and 8 times for the data bus. Because the Z80 should drive only one TTL load from each output pin (bus driver inputs are already attached), any display drivers of this type must be attached on the output side of the bus drivers. This circuit will serve as a rudimentary front panel for any builders who feel a computer isn't complete without flashing lights.

Sometimes the need arises to monitor a single point in a circuit and watch for level changes. While the LED driver of figure 4.7a would detect a slowly changing level, it would miss short pulses such as M1. To monitor the occurrence of such events, especially if no oscilloscope is available for testing purposes, it is advisable to build the circuit in figure 4.7b. This simple logic probe is adequate for most applications, but care must be taken in its use. It cannot detect an open circuit and the pulse detector only triggers on the negative edge of any transition. Should that present any problems, add the optional circuit using the 7486; that will allow it to detect either edge.

The logic probe or similar logic level detector (scope, DVM, VOM, etc.) is necessary to statically test the subassemblies.

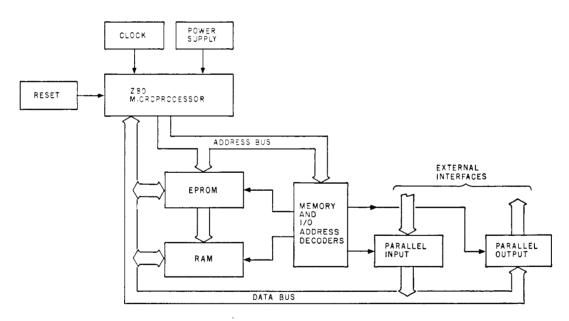


Figure 4.1 A block diagram of a minimum ZAP system.

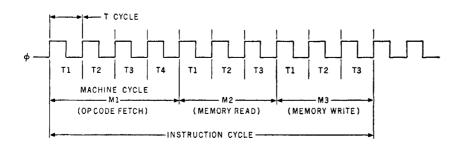


Figure 4.2 An example of timing during a typical instruction cycle.

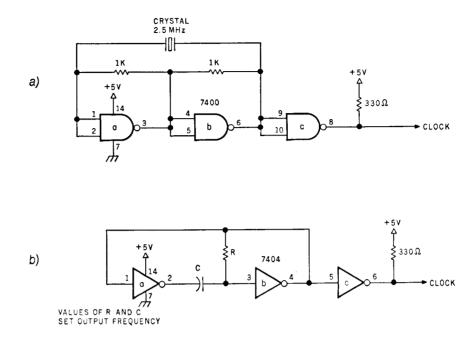


Figure 4.3 Typical 2.5 MHz clock circuits for the Z80.
a) With crystal control.
b) With a variable-frequency oscillator.

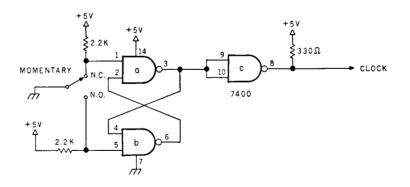


Figure 4.4 A single-cycle clock-generator circuit.

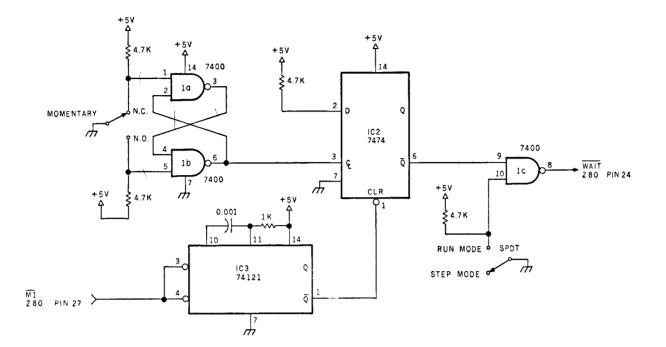


Figure 4.5 An instruction single-stepping circuit.

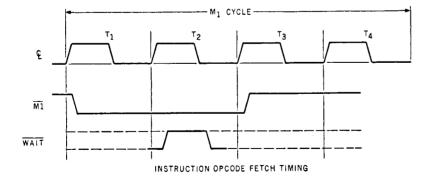
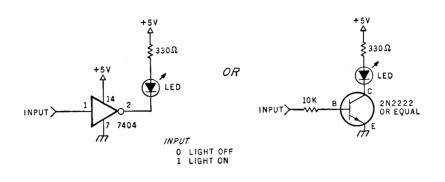


Figure 4.6 Instruction operation-code fetch ($\overline{M1}$) timing.



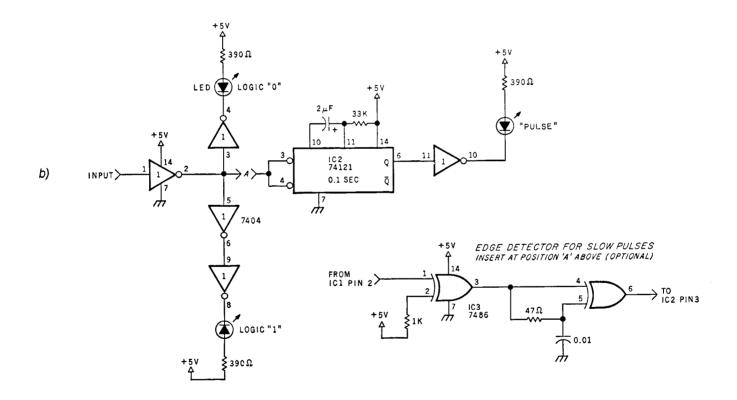


Figure 4.7 Typical LED drivers and a simple logic probe to monitor logic level changes. a) Visible logic level indicators that can be attached to the address and data buses to provide

- a display.
- b) A simple logic probe.

B. Reset Circuit

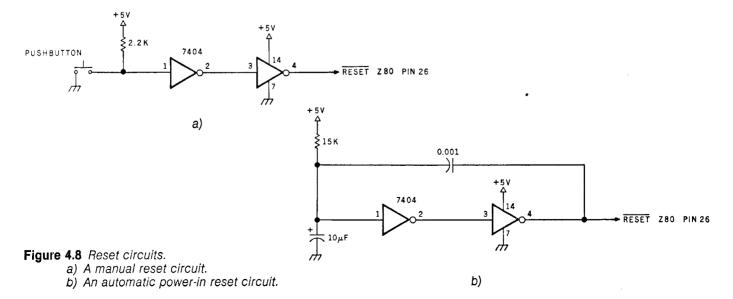
Often ignored, the reset function is one of the most necessary controls of a computer. Its importance is immediately recognized when running an incorrectly executing program. The reset command on the Z80 stops execution and loads the program counter with 00 hexadecimal (the lowest memory address). This allows the programmer to restart the program. When combined with the instruction single-stepping circuit previously outlined, programs may be started, stopped, and started again at any time.

A reset input can be manual, automatic, or a combination of both. Figure 4.8a is a standard push-to-reset circuit. Its output is normally high until the button is pushed, and then it goes low. The Z80 will remain reset for as long as the button is held and will only begin to execute again when released. Manual reset is a necessity for initial program checkout, and this circuit is employed in the basic ZAP.

When computers are used in applications where no human attendant is present, such as a traffic light controller, the manual reset cannot be used; an automatic reset must be employed instead. Figure 4.8b is the circuit of a totally automatic power-on reset. When power is first applied to the computer, the 10 mF capacitor will be completely discharged. The resultant logic 0 level on the input of the 7404 pin 1 will be maintained for approximately 50 ms, long after the +5 V supply has powered up the rest of the computer. The long charging rate of the capacitor will, in turn, generate a logic 0 (a reset condition) to the computer until the input level rises to approximately 2 V (a TTL logic 1). Once full power is applied, the time it takes the reset circuit to reach 2 V will constitute about a 35 ms power-on Reset pulse. Resetting the machine would require turning the power off.

Manual and automatic reset are combined in figure 4.9. This circuit allows the computer to start program execution immediately after power is turned on. The program can be stopped and restarted by pressing the reset button. Slightly different components and additional functions are included in this diagram. Schmitt-triggered inverters (7414s) increase the reliability of the design. When the power is turned off, the use of a diode to discharge the capacitor quickly assures that a pulse will be generated if power is suddenly reapplied. Because power line glitches are usually short in duration, the discharge rate of the capacitor has to be fast enough not to miss generating a reset pulse once power is restored.

While this reset circuit is not necessary for initial computer check-out, it should eventually be employed if ZAP is to be expanded to include any of the options outlined later. To synchronize the central processor and peripherals, they should be tied into the reset signal from this circuit.



BUILD YOUR OWN COMPUTER 97

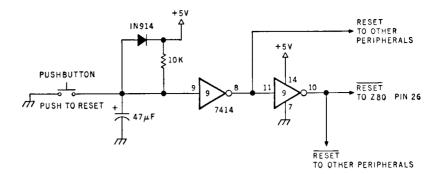


Figure 4.9 A circuit to combine manual and automatic reset functions.

C. Address Bus and Control Output Buffering

The Z80 has the ability to directly address 65,536 (often called 64 K) individual bytes of program memory and 256 individual input and output ports. Because the microprocessor is a binary device, it is only natural that this address be binary. There are 16 binary address lines labeled A0 thru A15. A0 is the LSB (least significant bit), and A15 is the MSB (most significant bit).

The logic levels on this bus are not arbitrary. The control section of the central processor sets the program counter to the next instruction to be executed, and on the fetch cycle, it places the program counter contents on the address bus. During I/O instructions, additional timing cycles place the I/O device address on the 8 least significant bits (A0 thru A7). Because this bus has to drive the inputs of many parallel devices, all of which draw some input power, the address bus must have an output current that will meet the load demand. The Z80 by itself can sink 1.8 mA maximum or one TTL load on each pin. This is no problem if the designer uses low power memories and peripheral interface chips. These are expensive devices, and their use would not necessarily serve to educate the builder in the same way as configurations of less complex circuits.

Using lower density ICs and TTL devices for decoding functions is less expensive but requires considerably more power from the bus. The following table lists the input loading of various devices:

<u>Device</u>	Worst case input current
Standard TTL (7404, 7442, etc)	1.6 mA
Low-power Schottky TTL (74LS04, etc)	0.18 mA
2708 (1K×8 EPROM)	10 µA
2114 (1K \times 4 programmable memory)	10 µA
2716 (2K×8 EPROM)	10 µA
2102 (1K×1 programmable memory)	10 µA
8212 (8-bit latch)	0.25 mA
8T97 (6-bit driver)	1.0 mA

It is easy to see that the real power eaters are TTL devices. Low-power Schottky TTL (LSTTL) devices can be substituted throughout the ZAP computer. They save power at slightly additional cost, but the circuit has sufficient power to support straight TTL. If LSTTL is substituted, it must be substituted throughout.

The loading caused by memory, especially with only 2 K bytes in the basic ZAP unit, is insignificant. With 1.8 mA drive current available from the Z80, we could use LSTTL for the I/O and memory address decoding but would have to limit the fanout (total input connections) on each address line to 9 LSTTL inputs. This is sufficient for the basic ZAP and would probably be an

acceptable procedure, but it is not recommended.

The first time a user attaches the logic probe (figure 4.7b) to an unbuffered address line, the computer may die. The load presented by the probe, as well as by the other circuitry, will exceed the drive capability of the bus. It's important that the monitoring devices not impede circuit operation.

Rather than try to optimize the design to a degree that forces the user to be aware of every μA (microampere) consumed by test probes and LED drivers, it's easier to add buffering that increases the bus output power to a point where loading is not an important factor. This is the philosophy behind ZAP busing, and as a side benefit, it will provide enough power to expand ZAP to 64 K should the user ever desire to do so. It also allows the user to add his own TTL circuitry without becoming overly concerned with bus loading.

To achieve high power output from the address bus, a buffering device (called a non-inverting bus driver) is used. The A0 thru A15 outputs of the Z80 make only one connection: to the drivers' input. All other devices that use the address are attached to the output of the drivers.

Figure 4.10 is the diagram and truth table of the 8T97 bus driver. (An equivalent bus driver is the 74367.) This three-state device is capable of sinking 48 mA and can accommodate any combination of TTL, LSTTL, and memory connections a user would want to make. The final address bus configuration is shown in figure 4.11.

The three-state function of the 8T97 is controlled by the BUSAK signal. This signal turns over control of the address bus to an external device during direct memory access operations. In a non-DMA situation, BUSAK is high and the 8T97 passes all outputs from the Z80. When a DMA request is acknowledged, BUSAK goes low, putting the 8T97 in a high impedance output mode. This facility allows memory to be written into or read by an external device and is usually reserved for high-speed operations that are faster than the central processor can achieve.

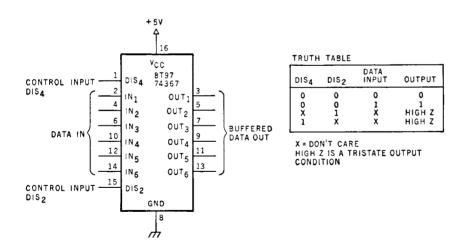


Figure 4.10 The pinout and truth table of an 8T97/74367 bus driver.

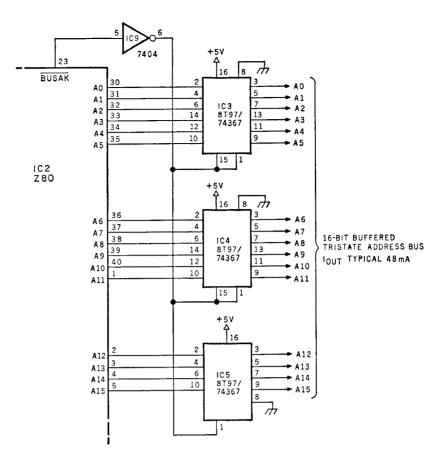


Figure 4.11 The final buffered address bus configuration.

D. Data and Control Bus

The fourth and last area of direct central processor connections is the data bus and the remaining lines of the control bus. The reason for buffering the data bus is similar to the argument for the address bus with one exception the data bus is bi-directional.

A bi-directional bus means, of course, that data flows in both directions. When the Z80 is writing a byte of data into a memory location, the data flows from the central processor to memory. When the central processor is reading a memory byte, data flows from memory to the central processor. The bi-directional nature of the data bus requires that the bus drivers be either bi-directional internally, or attached in such a way that the same function is performed.

One way of making this bi-directional driver is to use two 8212s. The 8212 (figure 4.12) was originally conceived and produced by Intel as an 8-bit latched input or output port. The 8212 can be latched continuously so that data flows through it, or it can be turned off to block the flow. It is well suited to this application because it has a three-state output.

Two 8212s (figure 4.13) are wired in opposite directions. IC 6 directs data from the central processor toward memory, while IC 7 channels data into the Z80. Control is exercised through a single line connected to the $\overline{\text{RD}}$ control signal of the central processor. $\overline{\text{RD}}$ is normally low except during write operations. This causes IC 6 to be off, in a three-state mode, and IC 7 on, which allows data from memory or I/O devices to reach the central processor. When $\overline{\text{RD}}$ goes high during a write operation, the process is reversed; IC 6 turns on and IC 7 turns off. It is only necessary to use the $\overline{\text{RD}}$ line to control data direction. We're assuming, of course, that when the central processor isn't writing data, it must be reading it. While not exactly true, the concept

works well enough in practice, and the two 8212s are connected schematically as in figure 4.14.

It is not absolutely necessary to use 8212s to perform this function. Either 8T97s or 74367s work equally well but take 4 IC packages. If you don't mind the extra wiring and have a source for 8T97s, they can be wired as illustrated in figure 4.15.

The final connections to the central processor to be discussed are the control bus signals, shown in figure 4.16. They coordinate peripherals and channel data and addresses into and out of the central processor at the proper times. Each was briefly explained on the Z80 pinout. Exact timing will be detailed when we discuss attachments of memory, I/O, and enhancements to ZAP. For the time being, unused control inputs are tied high (through resistors) to inhibit false triggering.

The output lines are buffered for the same reasons as was the address bus. Furthermore, because this is a development computer, with expansion in mind, both the inverted and noninverted control signals are brought out to the user.

The areas discussed thus far are combined into a single diagram (figure 4.17) called the Z80 bus and control diagram.

8212 LOGIC DIAGRAM

24 Vcc 23 INT DSI 2 МD 3 D11 001 5 D02 DI2 8212 7 D03 D13 10 9 DI4 D04 DATA 16 15 INPUT D05 DI5 18 17 D16 D06 19 20 D17 D07 22 21 D18 D08 14 11 ĒLR STB 13 DS2 GND 12 h MODE MD

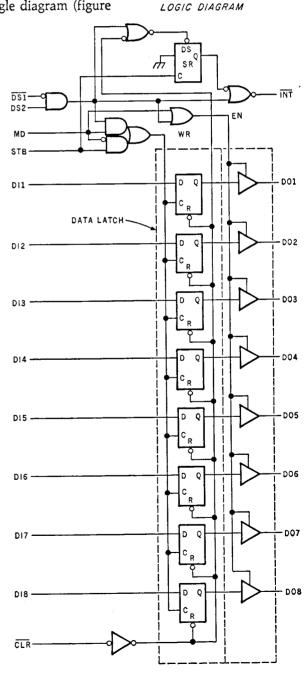
į i

+ 5 V

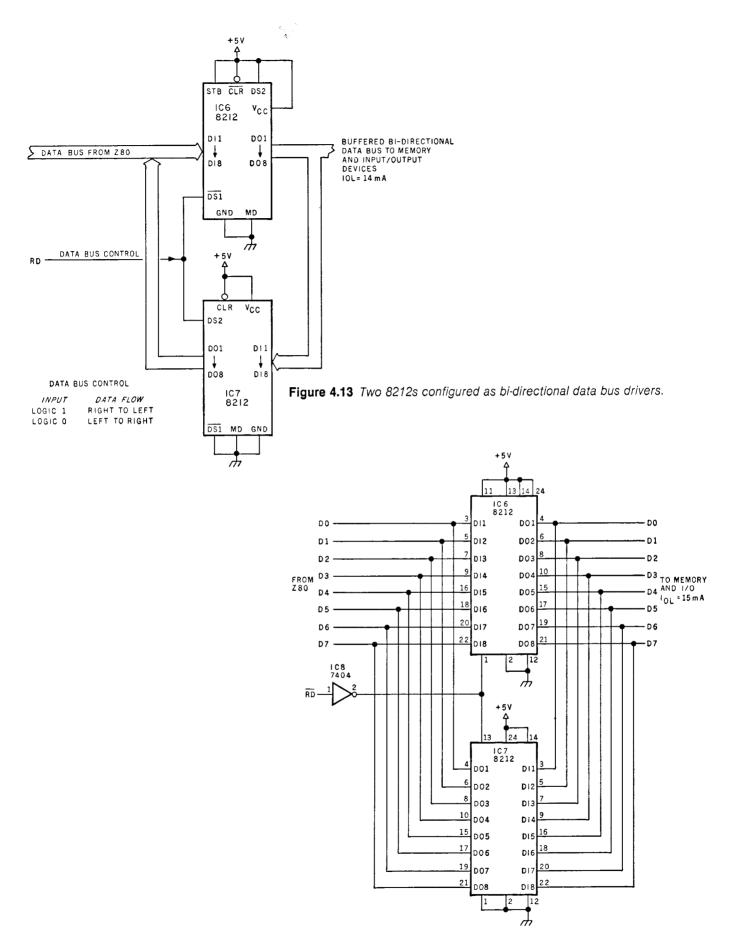
PINOUT

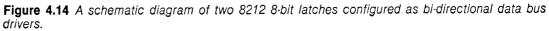
STB STROBE DEVICE SELECT 2 DS2 INT INTERRUPT CLR CLEAR

Figure 4.12 The pinout and logic diagram of the 8212 8-bit input/output port.



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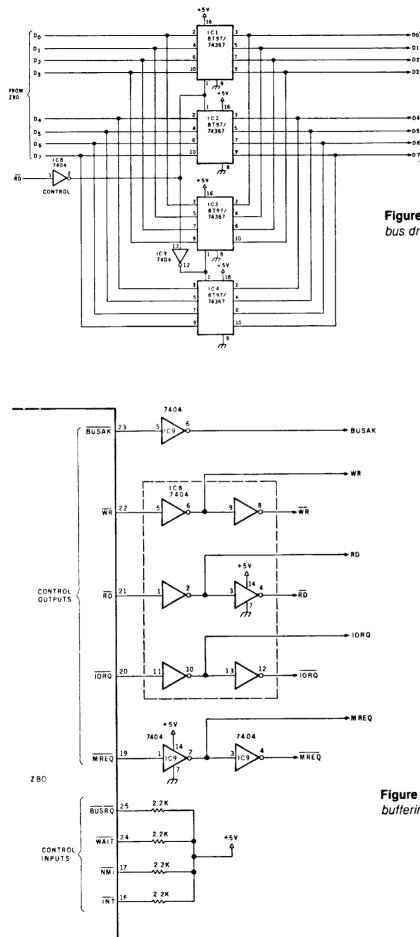
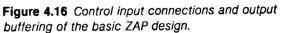
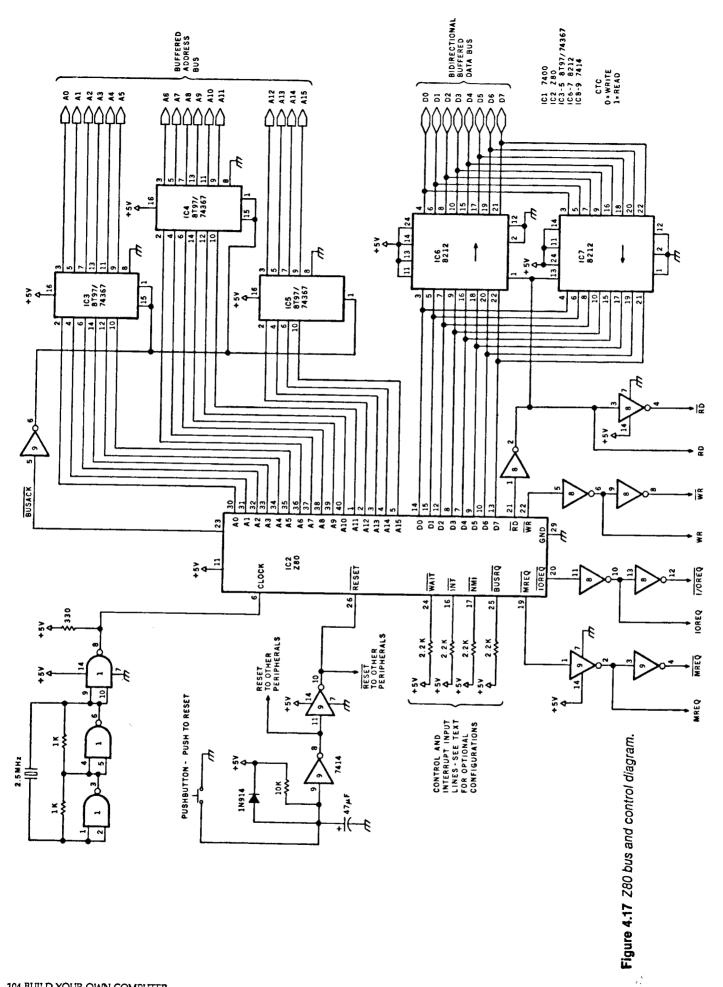


Figure 4.15 A schematic diagram of a data bus driver configured with 8T97s.

TO MEMORY





E. Testing

Insert all ICs except the Z80 and turn on the power. Each section is then individually tested as follows:

- <u>Clock</u> Testing the 2.5 MHz clock of figure 4.3a will require an oscilloscope or frequency counter to register the exact clock rate. Using the logic probe from figure 4.7b to monitor this clock rate would light all three LEDs. This indicates that the clock functions, but it will not indicate the rate. A similar test can be performed on figure 4.3b.
- <u>Single Cycle</u> The logic probe (without the addition of the 7486 edge detector) is perfect for checking the single-cycle circuit of figure 4.4. With the probe on section C pin 8, the indication should be low. Pressing and holding the button down should change the indication to a high level and cause the "pulse" LED to flash once. Releasing the button should not flash the pulse indicator as it returns to its initial logic condition.
- Single Step With the switch in the single-step mode position (figure 4.5), take a clip lead and *momentarily* ground IC 3, pin 3. The output at IC 1, pin 8 should be low. Pressing the single-step button will cause this output to go high. It will stay high until IC 3, pin 3 is momentarily grounded again. Check out the pushbutton debouncing circuit (which consists of IC 1 sections a and b) in the same manner as you did the single-cycle test. Finally, with the switch on the run mode, IC 1, pin 8 should always be high.
- <u>Power-on Reset</u> The circuits of figures 4.8a and 4.8b should have a normally high output. When power is first applied to figure 4.8b, or the button pressed in figure 4.8a, the output should go low. Either situation will cause a logic low level to occur from the circuit of figure 4.9.
- Address Bus Drivers The Z80 should not be inserted! With IC 9, pin 5 grounded, all outputs of ICs 3, 4, and 5 on schematic figure 4.11 should appear high. In actuality, this will be the three-state output mode and the proper test equipment will register them as open circuits. Tying IC 9, pin 5 to +5 V through a 2.2 K resistor will turn on all the bus drivers. Their outputs will all be logic high levels. Successively grounding the A0 thru A15 lines at the Z80 connector should result in a lowlevel indication on the respective buffered output line. When all 16 lines can do this successfully, the address bus checks out.
- <u>Bi-directional Data Bus</u> The data bus is tested in a similar manner except that the procedure is done twice—for data flow in either direction. Grounding \mathbf{K} 8, pin 1 (figure 4.14) simulates a read condition. Data should flow from right to left. Applying ground and +5 V (through a 2.2 K resistor) alternately to the data input pins of IC 6 should produce similar levels on DO1 thru DO8 of IC 6. Raising IC 8, pin 1 to +5 V allows similar data transfer, but only from left to right this time.
- <u>Control Bus</u> Referring to the schematic of figure 4.16, testing is simply a case of applying a known logic level to the input side of the series inverters and noting the output levels one gate at a time. For example, if Z80 pin 19 was a logic low, IC 9, pin 2 would be a logic high and conversely, IC 9, pin 4 would be low. Each inverter section which the signal passes through inverts the signal.

II. Memory and I/O Decoding

Before we can utilize the memory or I/O devices we must learn how the Z80 addressing works. Remember, the address FF hexadecimal could refer to memory, or an input or an output port. The computer must have the ability to differentiate among the three



possible meanings.

The control outputs of the Z80 contain the necessary routing information, and by properly gating them together, the correct signals are obtained. For basic I/O and memory operations, the four signals of particular interest are $\overline{\text{MREQ}}$, $\overline{\text{IORQ}}$, $\overline{\text{RD}}$, and $\overline{\text{WR}}$. Their definitions are as follows:

A. MREQ

Memory Request. Whenever a transaction occurs between the central processor and memory, the $\overline{\text{MREQ}}$ line goes to a logic 0.

B. \overline{IORQ}

Input/Output Request. Whenever a transaction occurs between the central processor and either an input port or an output port, the IORQ line goes to a logic 0.

Read Request. Whenever the central processor reads input data from either memory or an input port, the \overline{RD} line goes to a logic 0.

D. \overline{WR}

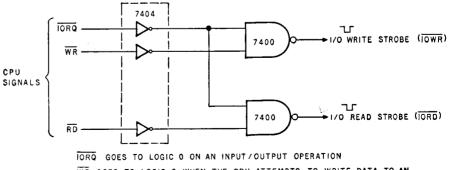
Write Request. Whenever the central processor is writing data to either memory or to an output port, the \overline{WR} line goes to a logic 0.

To differentiate between input and output ports during I/O instructions, $\overline{\text{IORQ}}$, $\overline{\text{RD}}$, and $\overline{\text{WR}}$ are gated together as shown in figure 4.18. In a similar manner, $\overline{\text{MREQ}}$, $\overline{\text{RD}}$ and $\overline{\text{WR}}$ are gated during memory transfers as shown in figure 4.19. Unlike the I/O decoding, but similar to the address bus driver discussed earlier, a memory-read condition does not have to be decoded. It is assumed that when the memory is not in a write mode, it is in the read state.

The resulting three decoded strobes define the operations of Input Port Read (\overline{IORD}), Output Port Write (\overline{IOWR}), and Memory Write (\overline{MEMWR}). If only three functions were required in your particular computer configuration, then no other decoding would be necessary. Such a computer would have one input port, one output port, and one bank of memory. To alleviate this problem, additional decoding of I/O and memory is necessary so that these control strobes can serve more than a single device. With the extra circuitry, the Z80 can independently address 256 input and output ports and 64 K bytes of memory.

During an I/O request (either input or output), the 8-bit binary address of the particular I/O port appears on lines A0 thru A7 of the address bus. An explanation of address coding is shown in figure 4.20. Additional examples are illustrated in figure 4.21.

Using this information, if an instruction were to designate output port 7 as its destination, then the circuitry of figure 4.22 could be used. When a code of 007 octal (07 hexadecimal or 00000111 binary) appears on the address lines with an \overline{IOWR} strobe, the signals present on the data bus would be stored in an 8-bit register as output data.



WR GOES TO LOGIC O WHEN THE CPU ATTEMPTS TO WRITE DATA TO AN OUTPUT OR MEMORY

 $\overrightarrow{\textbf{RD}}$ goes to logic 0 when the CPU attempts to read data from memory or an input device.

Figure 4.18 Input/output read and write decoding.

C. RD

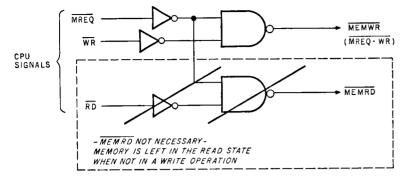
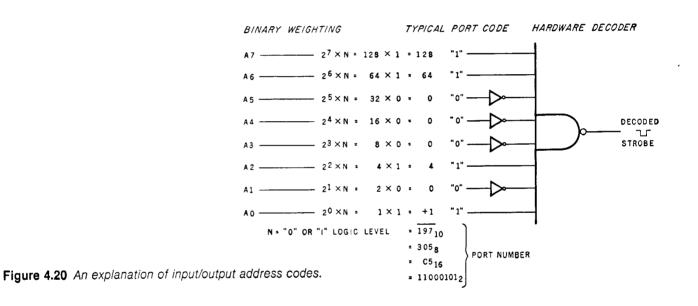
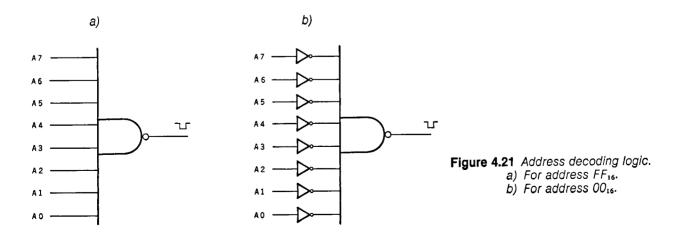
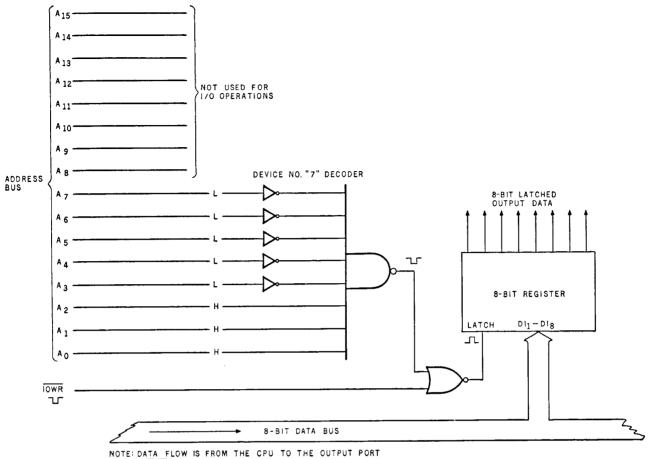


Figure 4.19 Memory read and write decoding.

MREQ GOES TO A LOGIC O DURING MEMORY OPERATIONS







DURING IOWR OPERATIONS.

Figure 4.22 A possible method for decoding a single 8-bit output port address. The circuit is for a 007₈ device code.

I/O Decoding

Of course, ZAP needs more than 1 port, even as a basic system. In fact, if it is expanded to include some of the optional peripherals, it will require 6 or 8 ports. Decoding these additional ports need not require 8 separate circuits like figures 4.20 or 4.21. By incorporating a 4 to 10 line demultiplexer into the design, 8 port strobes can be derived. The circuit of figure 4.23 can be used for either input or output port decoding (by selecting RD or WR) and is addressed for 000 octal to 007 octal. It works by selecting either of the two unconnected outputs (IC 3, pin 9 or 10) when an undecodable address is presented on the address bus. A3 thru A7 still must be treated in the same manner as that presented in figure 4.20, but A0 thru A2 serve as the 7442 address inputs. These 3 bits will designate 1 of 8 possible lines when IC 1's output goes low.

Duplicating this circuit to provide 8 separate input and output stobes (addressed 000 thru 007) would require a total of 7 chips. The number of chips can be reduced to 3 if we take a little poetic license with the design. So far, we have decoded all 8 bits of the I/O portion of the address bus, making our decoder select 1 of 256 or, as in the previous circuit, 8 of 256. In either case, only the designated addresses are of any importance; all others are meaningless. For all practical purposes we could decode lines A0 thru A2 and ignore the rest. A circuit that does just that is shown in figure 4.24.

The difference between this circuit and those previously described, besides having fewer chips, is that this one requires an intelligent user to recognize the advantages and disadvantages of taking such liberties. As in figure 4.23, this circuit decodes ports 000 octal thru 007 octal. What the user should realize, however, is that it also decodes 010 thru 017 and 020 thru 027, etc. The 3 LSB (least significant bits) repeat every 8 ad-

dresses. This is not a problem as long as the user is aware of repetitive addressing and watches his programming. Should more than 8 stobes be required, the 7442 can be replaced with a 74154 (4 to 16 decoders). This will give 16 I/O port strobes that repeat every 16 addresses.

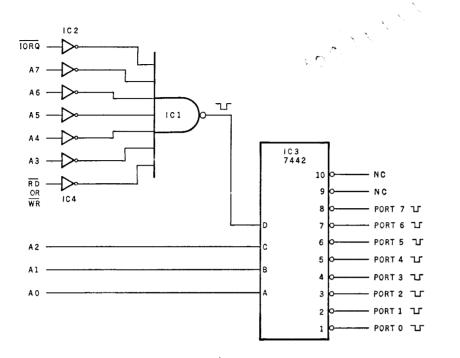


Figure 4.23 A formal input/output port address decoding method that decodes all 8 address lines.

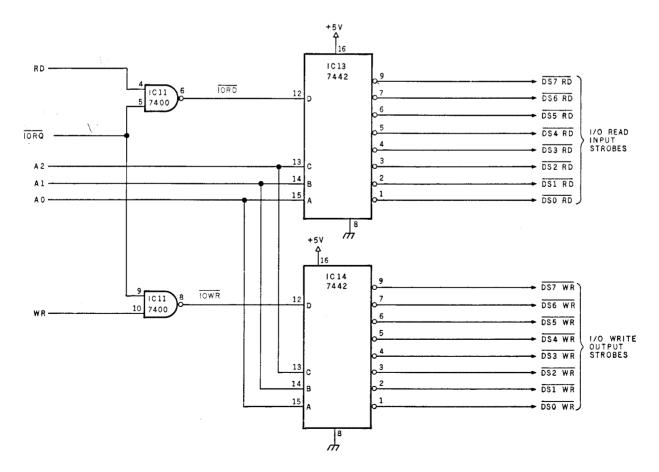


Figure 4.24 A method for decoding input/output strobes with a reduced amount of circuitry.

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Memory Decoding

Decoding the memory address bus is accomplished in a similar manner. It is inadvisable to take the same tack and allow repetitive memory addressing because there is more likelihood of error. Even though 16 lines are involved, in actual application, memory decoding turns out to be less complicated. ZAP uses 1 K \times 8-bit banks of programmable memory and 1 K-byte erasable read-only memory. Both of these devices require 10 address lines to define the 1 of 1024 locations in each bank. This leaves only 6 lines that have to be individually decoded to define any 1 K block of memory. Figure 4.25 illustrates how this can be accomplished. A 7442 (4- to 10-line decoder) is used to generate 8 separate chip-select lines. Because the address lines of the 7442 are tied to A10 thru A12, each strobe pulse will have a boundary of 1 K. It is not by chance that 1 K \times 8 was chosen as the memory capacity of each bank.

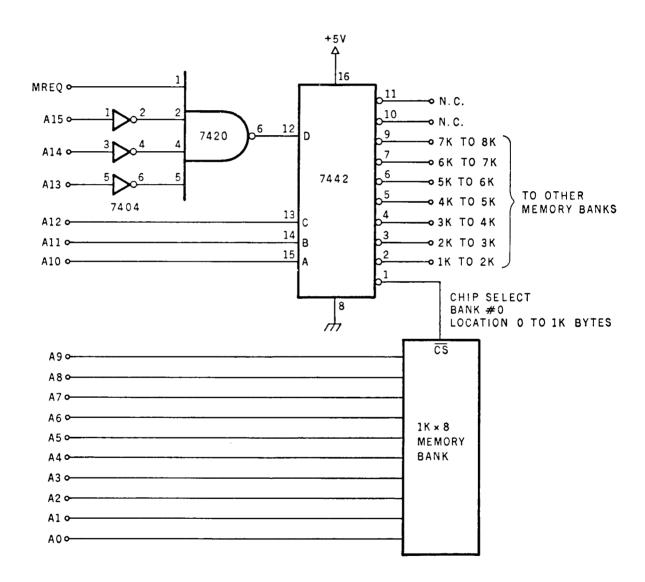


Figure 4.25 Memory bank decoding for 8 K of memory.

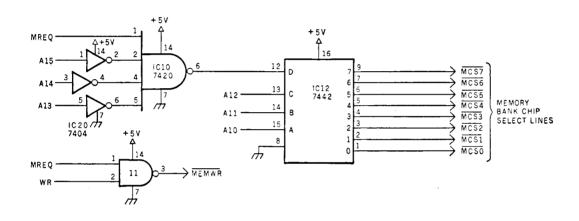
While the basic configuration of ZAP provides decoding for 8 K of memory and 8 input and output ports, not all of these chip selects and port strobes are used. The extra lines are left for expansion. Figure 4.26 is a completed schematic of the I/O and memory decoder for the builder to add to the circuit in figure 4.17.

Testing

After you have added the components of figure 4.26 to figure 4.17, you are ready to test the memory and I/O decoding. Insert ICs 10, 11, 12, 13, and 14, but don't insert IC 20 yet. ICs 1, 3, and 9 should remain inserted from the previous test. The Z80 should still be left out. The logic level at the D address input of each of the 7442s (ICs 12, 13, and 14) should be high. Pulling out ICs 8 and 9 (with power *off*) will cause this input to immediately change to a logic low level.

Next, ground pins 30, 31, and 32 and tie 23 high on the Z80 socket. With the address bus buffers enabled, and a 000 address jumpered on A0 thru A2, a chip-select low should appear on the lowest strobe address. In this case, pin 1 of ICs 13 and 14 should be low and the other strobe lines high. Changing the 3 jumpers on A0 thru A2 will enable other device chip-select strobes. The memory bank decoder works the same way except that the jumpering should be applied to address lines A10 thru A12.

After testing, insert all chips except the Z80.



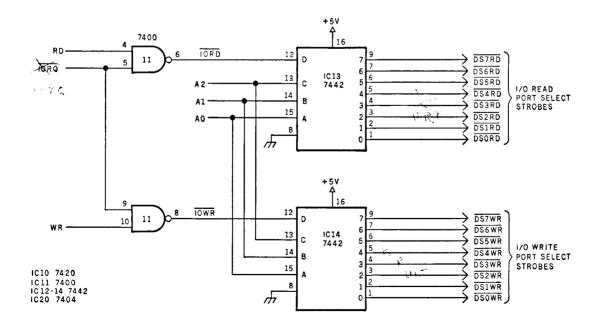


Figure 4.26 The memory and input/output decoding section of ZAP.

- a) Memory bank chip-select strobes.
- b) Input/output device chip-select strobes.

III. Memory

Of course, a major consideration for any computer system is memory. Both program instructions and data must be stored and recalled at the appropriate time so the computer can perform its function. Even though the Z80 central processor has a quantity of 8-bit storage registers, these can be only used for temporary manipulation of data and cannot store program instructions. Program instructions must be stored in external memory elements.

The external memory may be divided into two broad classes: ROM (read-only memory) and RWM (read/write memory). ROM is used to store specific, unchanging program steps or data. The contents of these memory locations are considered permanent and cannot be easily changed. Read/write memory, on the other hand, is used to store data that changes while the computer is operating. Examples would be the results of calculations or programs that change frequently. For either type of memory, the ultimate function is still the same: to provide, on demand, either an instruction for execution or a location where data may be stored.

Read-Only Memory

ROM (read-only memory) is an important part of the computer system. ROM functions as a memory array whose contents, once set by special programming techniques, cannot be altered by the central processor. There are few exceptions to this rule.

By its nature, ROM is non-volatile. When power is turned off, the program contents are not lost. Reapplication of power allows immediate program execution.

Within this basic category of ROMs there are three subcategories — ROM, PROM, and EPROM — which are defined more by usage and application than their names might imply.

ROM — Read-Only Memory

This is storage which can be written into only once. The information is fixed and cannot be changed. A ROM is usually mask programmed by the manufacturer and is bought with a preset bit pattern. These types of ROMs are considered to be custom programmed.

PROM — (User) Programmable Read-Only Memory

This storage can also be written into only once and the information is fixed. These devices are typically bipolar fusable link PROMs, which are programmed by the user rather than the manufacturer. ROMs and PROMs do not generally use the same semiconductor construction technology. Storage is much denser on a ROM than on a PROM, and cost-per-bit is generally lower on a ROM.

EPROM — Erasable-Programmable Read-Only Memory

This device combines the best parts of a ROM and a PROM. When received from a manufacturer, all storage locations are unprogrammed. Using a special interface, the EPROM can be programmed by the user as a PROM would be, with the result utilized as a ROM. If the EPROM content must be changed, it can be erased and reprogrammed. Depending upon the particular device, an EPROM can be either electronically alterable (often differentiated by the separate abbreviation EAROM) or ultraviolet erasable. The latter is sometimes called a UVEPROM, but is more often just called an EPROM. They are easily recognizable because they have a quartz window over the integrated circuit. This window is transparent to ultraviolet light and facilitates erasure.

While there can be considerable discussion as to the merits of each option, all ROMs perform the same ultimate function. For each independently addressable location, there is specific stored-bit pattern. Only the processor can determine whether this is data or an instruction. The method of storage is the same in either case. Figure 4.27 details the block diagram of a ROM.

A ROM is simply a logical block which, under program control, provides a preset

pattern. Figure 4.28 is a 3-bit read-only memory. When switch SW1 is closed (the position it would take when the central processor wanted the stored information), the 3-bit code of "101" would appear at the outputs. The diode grounds the input signals to the 7404 inverters when SW1 is closed. Expanding to more than 3 bits is simply a matter of adding more diodes, resistors and buffer stages. Such a circuit is referred to as a diodematrix ROM and in this case would be a 1-line by n-bit ROM.

A 3-bit memory is not much use. This concept can easily be expanded to 16 bytes by adding an address decoder as diagrammed in figure 4.29. A completed schematic with the diodes specifically arranged to perform a simple 9-byte program is illustrated in figure 4.30. This short test program will be used later during the checkout phase.

The diode-matrix ROM is presented for its educational value only. This is not a method that should be employed in the ZAP computer. Realizing that there are integrated circuits that would successfully fulfill the requirements in each of three categories, we must analyze our needs a little more closely.

The pertinent questions are: memory size, and the cost and ease of programming. The size of a ROM is determined by the user. When power is first applied, how much effort does the user want to expend to make the computer execute a specific program? ZAP has no front panel and no banks of address and data switches to toggle in instructions. This being the case, ZAP must have a program that executes immediately (when power is applied or the reset button is pushed), and that allows the central processor to communicate with its peripherals and set itself in a mode that is directly programmable through these devices. Once power is applied, a simple 50- to 100-byte program can be written, which facilitates keyboard to memory loading. But perhaps we need to enter a large program in memory? Are we to enter it all through the keyboard?

High-speed data entry can be accommodated through a serial interface. This can be added at the expense of another 100 or 200 bytes. Another consideration is the necessity for some operator address and data display to ease program development.

In conclusion, to incorporate all the functions necessary for a single-board development system, the ROM can easily require 500 to 1,000 bytes of storage. Many computer systems use a 64- to 256-byte ROM to store a bootstrap program. A bootstrap is a program that coordinates the minimum amount of necessary peripherals to load a larger program into the computer. In most personal computer systems, this bootstrap controls a cassette interface, and the program that is subsequently loaded is called a monitor.

A monitor (explained in Chapter 6) is a very important piece of software that requires about 1 K of program storage. Our decision is whether to make the monitor totally resident in ROM (ready for immediate execution), or to reduce ROM to the barest minimum and load the monitor from either a keyboard or a cassette storage system.

This is an important consideration for someone building a computer from scratch. When given a choice, I feel, you should almost always opt for the solution that calls for the fewest components and you should include the ROM monitor in the hardware. It's like putting the cart before the horse to require that a cassette interface be used to load all the diagnostic software. It's quite possible that the monitor program, resident in a 1 K ROM, would be required to troubleshoot and align the serial interface and cassette modem sections. A further consideration is that the ZAP computer can be brought on line sooner. With a ROM monitor, useful programs can be entered via the keyboard without having to build a serial interface.

I suggest that the preferred ROM memory size for ZAP be 1 K. As previously mentioned, ROM is mask-programmed by the manufacturer. However, let's not forget that for a home-built computer, you are the manufacturer. Fusable link PROMs are an expensive proposition when configured in a 1 K block. As a 64-byte bootstrap loader they are ideal.

The suggested alternative for the ZAP read-only memory is to use an EPROM that is programmed by the user. A 1 K EPROM such as the 2708 (or the 2 K 2716) is cost-effective for the home-built computer. The Intel 2708 ultraviolet erasable read-only memory is recommended for this application. (The 2716 is a 2 K EPROM with a single +5 V power supply.)

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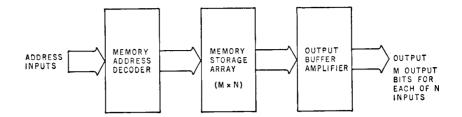


Figure 4.27 A block diagram of a read-only memory.

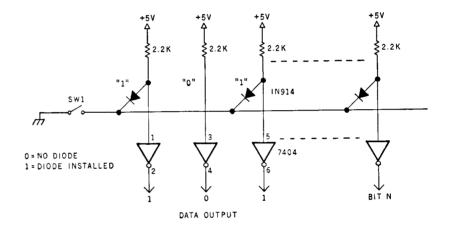


Figure 4.28 A simple 3-bit read-only memory (1×3 bits).

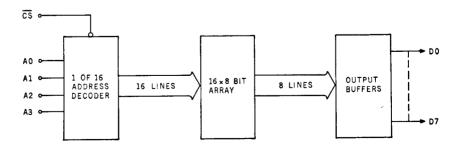
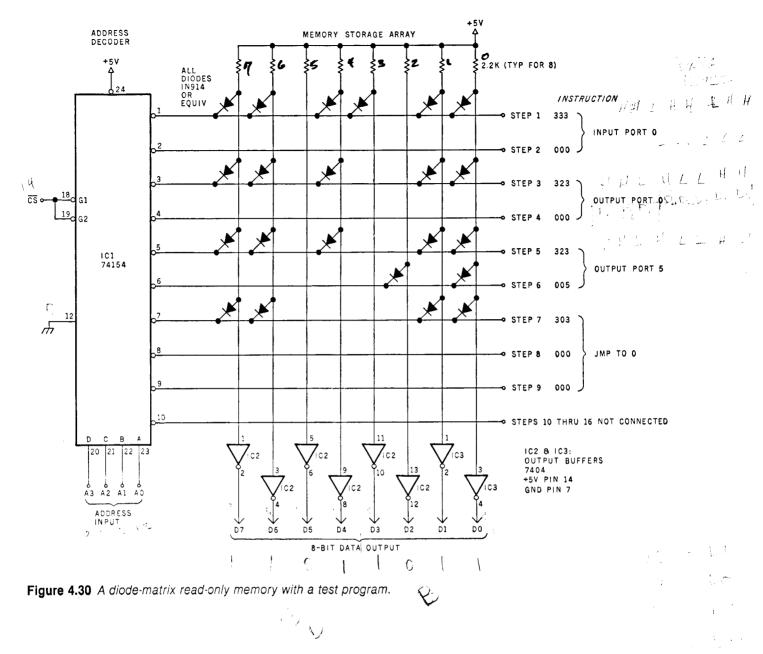


Figure 4.29 A block diagram of a 16-byte read-only memory.



EPROMs

The EPROM is a read-mostly memory. It is used as a ROM for extended periods of time, erased occasionally and reprogrammed as necessary. Erasure is accomplished by exposing the chip substrate, covered by a transparent quartz window, to ultraviolet light. The EPROM memory element used by Intel in the 2708 is a stored-charge type called a FAMOS transistor (Floating-gate Avalanche injection Metal Oxide Semicon-ductor storage device). It is similar to a p-channel silicon gate field-effect transistor with the lower or "floating" gate totally surrounded by an insulator of silicon dioxide. The 1 or 0 storage value of the FAMOS cell is a function of the charge on the floating gate. A charged cell will have the opposite storage output of an uncharged cell. By applying a 25 V charging voltage to selectively addressed cells, particular bit patterns that constitute the program can be written into the EPROM. Surrounded by insulating material, the charge can last for years. When this silicon dioxide insulator is exposed to intense ultraviolet light it becomes somewhat conductive and bleeds off the charge on the floating gate. The result is erasure of all programmed information.

Appendices C1 and C2 detail the pin layout and electrical specifications of the 2708 and the 2716 respectively. Chapter 7 explores various methods to program and test the chip.

1

Read/Write Memory

Read/write memory is just what its name implies. Such memory allows data to be written into it as well as be read from it. Read/write memory for microcomputers is generally configured from semiconductor programmable memory devices that retain data only while the power is on.

ROMs are technically random access devices; however, read/write memory, which is composed of semi-conductor devices and is primarily intended for use in microcomputers, has come to be called RAM (random access memory). From this point on, we shall refer to RAM as programmable memory.

There are two classes of programmable memories: static and dynamic. Static programmable memory stores each bit of information in a bi-stable storage cell such as a flip-flop. This information is retained as long as the power is supplied to the circuit. Dynamic programmable memories have a simpler internal structure, smaller size, dissipate less power, and are inherently faster. They store information as an electric charge on the gate to substrate of a MOS transistor. This charge lasts only a few milliseconds and must be refreshed. This necessity to refresh the stored information is one of the major distinctions between static and dynamic programmable memories.

Refreshing dynamic memories can be bothersome, however. The process requires that all storage cells be addressed at least once every few (usually 2) milliseconds. A counter circuit is usually incorporated to exercise the memory address lines when the computer is not accessing memory. In most systems, memory refresh requires additional external circuitry. The Z80 contains this circuitry within the central processor chip and greatly facilitates the use of dynamic memory. However, this facility is lost when the Z80 is reset. Therefore, extra refresh circuitry is necessary.

The choice between dynamic and static programmable memory technology is predicated on cost and convenience. Even with the expense of external refresh circuitry, dynamic memory is less costly. In a prototype system such as ZAP, however, dynamic memory is more trouble than it is worth. Once built and operational, dynamic memory might well be the best answer to memory expansion. But at this point in the building process, the inclusion of dynamic memory would over-complicate the design. This book, which emphasizes getting a beginner on-line, deals exclusively with semiconductor static programmable memory applications.

Static Programmable Memory

Figure 4.31 is a block diagram of a static programmable memory element typical of the type used in the ZAP computer. There are five basic components of a programmable memory: 1) address input lines, 2) data input, 3) data output, 4) chip select, and 5) a read/write- or write-enable strobe line. The address input lines are connected to the address bus of the computer. In the case of a N by M bit programmable memory, where N is the number of words and M is the length of each word, there must be enough address lines to address all N bytes. For example, in a 1 K programmable memory it would take 10 bits to address all 1024 bytes within this memory (eg: 2^{10} =1024). Static programmable memory, would obviously require fewer address lines. For a 64-byte memory, only 6 bits of address are necessary.

Because the function of a static programmable memory device is to allow storage and retrieval of data, provisions must be made for data input and data output from the device. The data input and data output lines (shown in figure 4.31) are designated as separate functions.

During the read function, the stored data within the addressed memory cell is available on the data output lines. During the write function, data that is placed upon the data input lines would be stored at the address designated by the code on the address input lines. It is not necessary that static programmable memory devices have independent data input and data output lines.

In most cases, these devices are configured with three-state outputs. Data input and data output can be attached together to a bi-directional data bus, or they can be the

same lines and time multiplexed. Figure 4.31 illustrates a three-state method of data busing. During a read function, the data input lines are disabled internally within the memory device. The contents of the memory cell addressed by the address input lines are available on data out and are fed directly to the bi-directional data bus. During a write function, the opposite is true. The data output lines are set in the three-state mode (which you may recall is effectively an open circuit), and draw no current from the bi-directional data bus. The contents of the bi-directional data bus are stored at the designated memory cell.

All of these multiplexing functions are dependent upon the read/write and chipselect lines. No operation can occur without the memory device being selected through the chip-select line. To select a particular bank, as outlined earlier, it is necessary to have decoding logic that enables these banks through the chip-select lines. Once a chip or bank of chips has been selected, the computer determines whether data should be read from or written into these memory locations. Under normal operation all static programmable memory is left in the read state, and only enabled during a write command by setting a level 0 on the write enable. This is called a write-enable strobe.

Figure 4.32 is a detailed timing diagram of the memory read and write cycles. The write/enable is a combination of memory request and write. A read/enable is a combination of memory request and read. Proper decoding of these signals and the chip select were discussed previously. In its basic form, ZAP has 8 chip-select lines, each addressing a 1 K bank of memory.

Figure 4.33 illustrates the memory map of the basic ZAP computer. As initially configured, ZAP contains 3 K bytes of memory. Location 0 thru 3FF is a 1 K EPROM. Locations 400 thru BFF are static programmable memory locations. The 1 K EPROM is configured to reside in locations 0 thru 3FF so that ZAP can be easily started with a power-on reset. Programmable memory located at locations 400 and above is considered to be user programmable memory. At least 2 K is recommended for satisfactory operation. ZAP will work with 1 K, but 2 K is recommended for basic peripheral expansion.

Figure 4.33 also shows how memory is attached to the computer. All three banks of memory are attached in parallel between the address and data buses. Each bank has a separate decoded chip-select. When the EPROM is enabled and $\overline{\text{MCS0}}$ is at a logic level 0, EPROM data is impressed upon the data bus lines. The other two banks of memory are in the three-state mode and have no effect on the bus. When the computer accesses programmable memory, the chip for that particular bank of memory is set to a logic 0, and only that bank of memory has access to the data bus.

While all banks of memory would have the same address applied to them, only the selected bank would be in the active mode. The logic flow is similar for the computer to write into a bank of memory. You will notice that there are write-enable lines leading to each of the 1 K static programmable memory banks, but not to the 1 K EPROM. A 1 K EPROM can only be written into with a special interface. Therefore, the write-enable strobe is only attached to the programmable memories.

If, for example, the computer were to write into location 400, the chip-select for bank 1 and the write enable for bank 1 would both have to be at a logic 0 to allow data on the data bus to be stored into location 400. This type of programmable memory configuration is both multiplexed and three-state. In the read mode, data flows from the programmable memory chip; in the write mode it flows into it, and when not selected it's three-state.

Up to this point, we have discussed block diagrams of static programmable memory. To produce an operational computer, it's necessary to configure this memory with actual parts. Unfortunately, single chip l K by 8-bit programmable memories were extremely expensive when ZAP was designed. Therefore, these 1 K blocks are designed from multiple components. Two relatively inexpensive and popular static programmable memory chips are the Intel 2102A (Appendix C3) and the Intel 2114 programmable memory (Appendix C4).

The 2102A is a 1 K \times 1 static programmable memory. Configuring a 1 K \times 8 block of memory requires eight 2102s attached in parallel. By comparison, configuring a 1 K \times 8 block with 2114s would require only two chips. This is because the 2114 has a higher internal density than the 2102. Because the objective of any hand-wired comput-

er project is to get the device on line easily, 2114s are the recommended programmable memory devices for ZAP. While 2102s will work, the added wiring necessary to use these devices far outweighs the additional cost of the 2114s.

Figure 4.34 illustrates how two 2114s are attached together to produce a $1 \text{ K} \times 8$ programmable memory bank. They share a common chip-select line. The data input lines are divided so that 4 bits of data are stored on each chip. Because each has a 1024-byte address capability, the 10-bit address lines are commonly shared. To build the basic ZAP, two circuits of the type illustrated in figure 4.34 should be constructed. The total memory for the basic computer is 3 K. It can be expanded to 8 K without additional address decoding. It is not absolutely necessary to have 2 K of programmable memory if the user wishes only to check the operation of the system. At a minimum, the EPROM must be wired as 1 bank of memory.

The 1 K EPROM contains the monitor which allows ZAP to function. This monitor contains many smaller programs that are called subroutines. When the main program calls a subroutine, it places the return address on a software stack located in programmable memory. At the conclusion of the subroutine, the central processor pulls this address from the stack and returns to the main program. Usually the stack requires no more than 64 bytes. However, it is no less trouble to wire two 2114s for a full $1 \text{ K} \times 8$ bank of memory than to try to wire a 64-byte memory.

An additional bank of 1 K, designated as bank 2, could be added at the user's discretion. This bank is necessary if you plan to write programs that will occupy more than 1 K of memory including the stack. As the computer is presently configured, 1 K may appear adequate; however, for the additional programs outlined in this book, 2 K is recommended. This is especially true when a buffer area is required to communicate with external peripherals. The schematic for the final memory configuration is shown in figure 4.35. It should be added to the circuitry of figures 4.17 and 4.26.

Unlike the other sections of the computer, the memory cannot be checked except under program control. Theoretically, the address lines can be preset and data read or stored, but it's not worth the effort. Memory checks will occur after the input/output section is wired. Basically, it will be checked first with EPROM alone, then with the addition of the programmable memory. I mentioned previously that EPROM and programmable memory are related yet operate independently. While a program is often stored in PROM, it usually requires programmable memory for proper execution.

In a short program that loads the accumulator, writes to an output port, and jumps back to itself again, with no subroutine calls, programmable memory is not necessary. It can be completely located on EPROM. The exact procedure for this test will be outlined at the end of the I/O section.

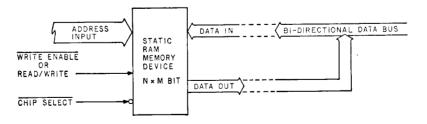


Figure 4.31 A block diagram of a static programmable memory element of $N \times M$ bits.

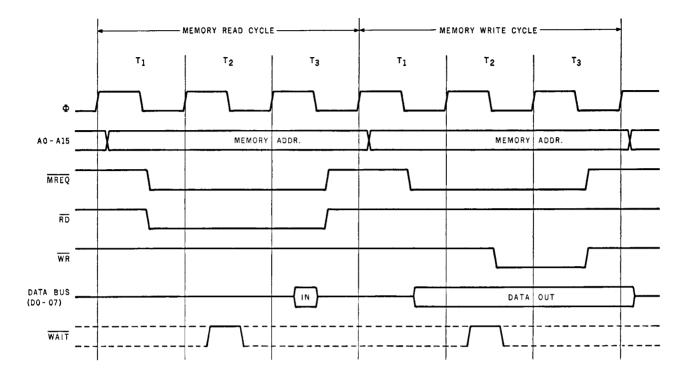


Figure 4.32 A timing diagram of the memory read or write cycles for the Z80. This diagram does not include WAIT states.

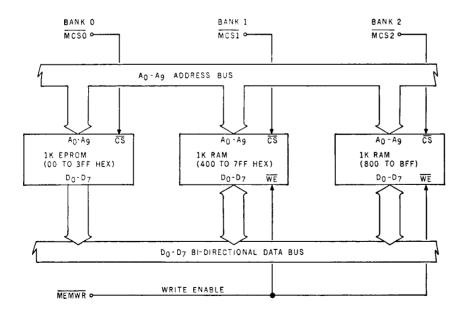


Figure 4.33 A block diagram of the memory map for the ZAP computer.

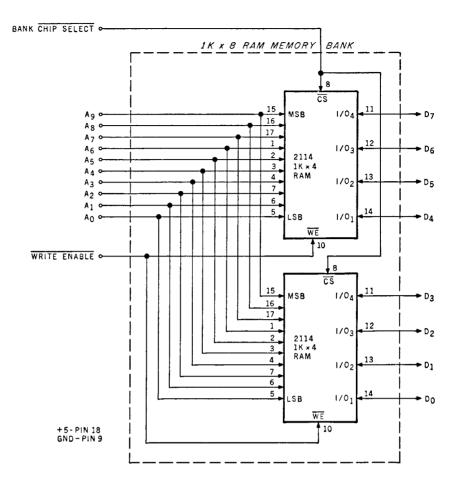


Figure 4.34 A 1 K \times 8 programmable memory bank constructed by using two 2114 1 K \times 4-bit programmable memory chips.

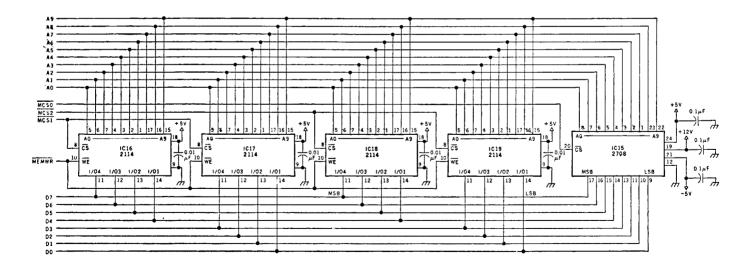


Figure 4.35 A schematic diagram of the final memory configuration for the basic ZAP computer.

IV. Input/Output

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Thus far we have discussed the central processor control and memory decoding. The input and output functions are equally important. For the computer to display useful information, it must be "interfaced" to peripherals. "Interface" is an overworked term that refers to a capability of communicating with external devices such as keyboards, video or LED displays, and memory storage systems. Communication can be either data input or output.

Input data can come from keyboards, audio cassette mass storage, or special data acquisition interfaces. Similarly, output data flows from the computer to peripherals (eg: video displays, numeric readouts, printers, and external control interfaces). The function and format of the data communication between the central processor and the peripherals might vary considerably, but the internal routing of the data is fundamentally the same.

The Z80 microprocessor provides both an input and output instruction. An output from the processor is logically the same as writing to memory, and receiving an input from an external device is similar to a memory-read command. They are differentiated from memory operations by gating the read and write status lines with the I/O request control line. Logical concurrence of an I/O request and a read or write status output designates the direction of the communication with the peripheral device. Simultaneously with the control signals, the address code (1 of 256) of the subject device is placed on the address bus. A timing diagram of these signals is shown in figure 4.36. The decoding logic was detailed in section II of this chapter.

Wiring the I/O ports for ZAP is a two-stage process. When hand wiring a computer, the most important consideration is to see that the input/output function works by the least complicated method. A successful test of the ZAP I/O section also indirectly tests memory. This is so because input and output instructions cannot be exercised except by a program stored in memory.

Z80 input and output is handled 8 bits at a time. It does not matter whether the external interface configuration is serial or parallel. Data transfer between the central processor and I/O is 8 bits parallel and basically occurs as follows.

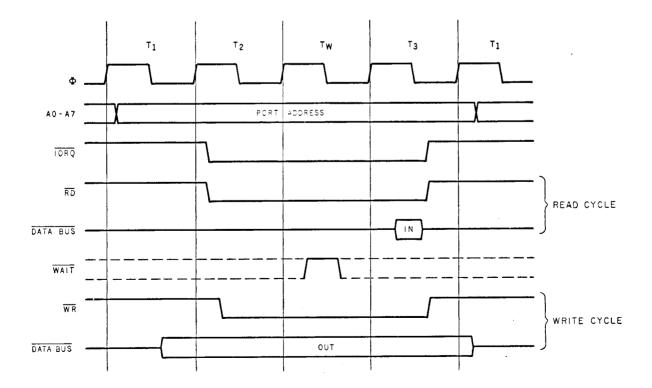


Figure 4.36 A timing diagram of input or output cycles for the Z80.

Output Instruction

OUT(n), A

When this instruction is executed, the contents of the accumulator A are placed on the data bus and written into device n. The address of device n is located on address lines A0 thru A7.

If the accumulator contains 40 hexadecimal when the instruction OUT 23, A is executed, 40 hexadecimal will be written into the peripheral device (also called "port number") decoded as 23 hexadecimal.

While there are other more complicated output instructions available in the Z80 instruction set, they all pass data through the data bus to the external device. Because the data bus is used for transfer of information between the central processor and memory as well as I/O, the computer must be allowed to continue executing its program. Data cannot remain on the data bus waiting for the peripheral (the central processor can be made to do this but such abstract configurations would be confusing at this time). The data is valid for only a few clock cycles and must be stored if needed for a longer period.

Figure 4.37 diagrams a typical 8-bit storage register. It consists of 8 individual storage elements with a common "store enable" input. In its simplest form, the single storage cells can be D-type flip-flops such as shown in figure 4.38. Input data (ie: the data bus) is attached to the D input lines and is only clocked onto the output lines (Q and \overline{Q}) during an I/O write strobe. Using 7474s would require 4 chips for an 8-bit word. A better method is to use the improved circuits of figure 4.39.

Input Instruction

IN A, (n)

When this instruction is executed, the data from the selected port (n) is placed on the data bus and loaded into the accumulator.

If the subject external device reads 10 hexadecimal when the instruction IN A, 20 is executed, the value 10 hexadecimal read from device number 20 hexadecimal would be loaded into the accumulator.

There are other more complicated input instructions but as was the case with output instructions, the route for all data is still the data bus. To keep the data bus from being dominated by a single device attached to it, all input devices (ie: the output from them) must be three-state. This can be accomplished either by using interface logic such as UARTs and peripheral interface adapters that are designed to be three-state, or by add-ing three-state input buffers such as illustrated in figure 4.40 (the block diagram of the typical 8-bit, parallel-input port).

Whatever is on input lines B_0 thru B_7 during an I/O read instruction will be directed to the central processor. Using these direct read instructions there is no interaction between the central processor and the external hardware attached to the input port. Additional logic is required to coordinate the exact timing between the computer and an external peripheral. The solution is called "handshaking." Such a capability requires either more sophisticated input port hardware, connection to the central processor, interrupt logic, or additional I/O ports to coordinate the timing.

Checking out the basic ZAP hardware is best accomplished by using the least complicated hardware. A simple input port is illustrated in figure 4.41 and consists of 2 quad three-state buffers. Should there be any brave experimenters who wish to have full handshaking on I/O ports or need more than the 8 mA output drive capabilities of a LSTTL device, input and output ports can easily be configured using Intel 8212s. The specifications described in Appendix C5 demonstrate its versatility.

Input/Output Checkout

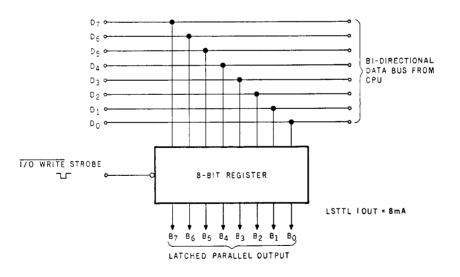
Ultimately, ZAP could have a keyboard, RS232 serial CRT terminal, audio cassette interface, and analog, as well as digital I/O capabilities. Trying to attach all these pe-

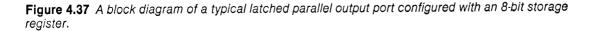
ripherals together and checking everything simultaneously is a monumental undertaking. A more methodical approach is to construct the minimum hardware and software that proves operational and then build upon it. That is the route taken thus far.

With the exception of memory, we have attempted to eliminate any potential problems by static testing where possible. The simple I/O devices of figures 4.39 and 4.41 lend themselves easily to this situation. To test I/O fully requires one input port and one output port. It should be wired as shown in figure 4.42. Only port 0 need be connected at this time. The additional circuitry included in this diagram can be ignored. Only ICs 21 thru 23 are of concern presently. The other devices are enhancements to the basic ZAP and will be discussed later.

Static Test

With power off, remove all ICs previously installed. Insert ICs 20, 21, 22, and 23. Turn on power. Temporarily ground $\overline{\text{DS0WR}}$ and $\overline{\text{DS0RD}}$. This maneuver, impossible under direct computer control, allows data bus access to both input port 0 and output port 0 at the same time. With the two ports connected in this manner applied input data should be available immediately at the output port. With the input lines of ICs 21 and 22 open and power applied, the outputs of IC 23 should be at a high level. Sequential grounding of input lines B₀ thru B₇ should be reflected on lines B₀ thru B₇ of IC 23. A final test is to disconnect the temporary ground on $\overline{\text{DS0WR}}$ while one of the input lines of IC 21 and 22 is grounded. The logic 0 output of IC 23 should remain low even when the input line is no longer grounded. The result is that the data is "latched." It will remain until updated by another write strobe.





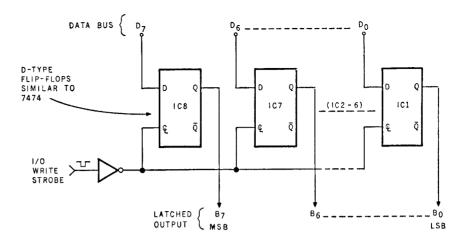


Figure 4.38 A block diagram of a latched parallel output port using D-type flip-flops as a storage register.

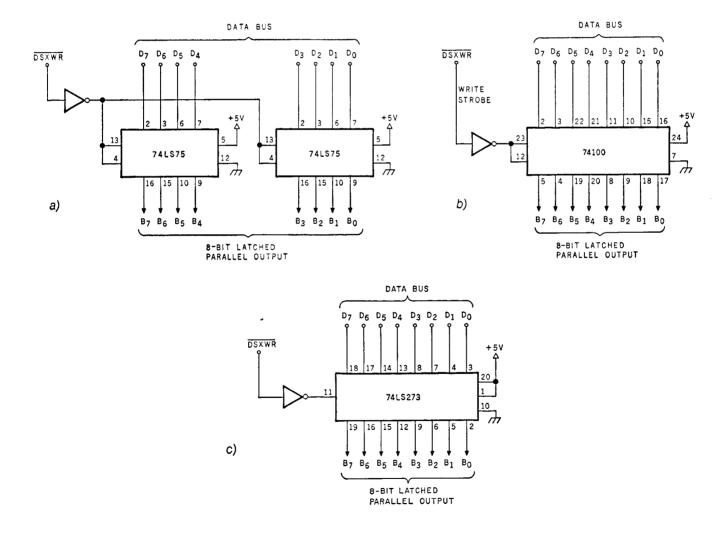


Figure 4.39 Schematic diagrams of 8-bit latched parallel output ports.

- a) Using two 4-bit LSTTL latches.
- b) Using a traditional 8-bit TTL latch. Note that non-LSTTL devices can be substituted but care should be taken to observe the total bus loading.
- c). Using a newer 8-bit LSTTL latch.

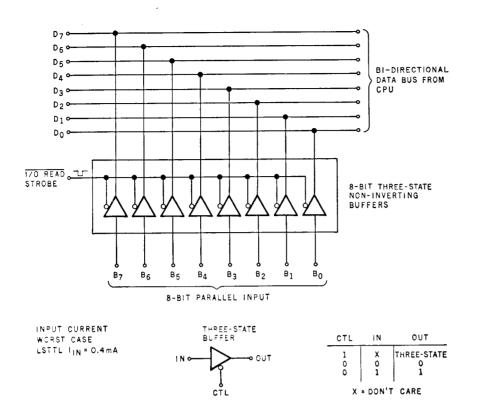


Figure 4.40 A block diagram of a typical 8-bit parallel input port.

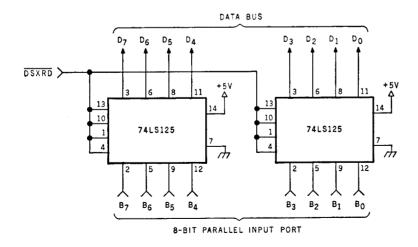


Figure 4.41 A schematic diagram of an 8-bit parallel input port for the ZAP computer.

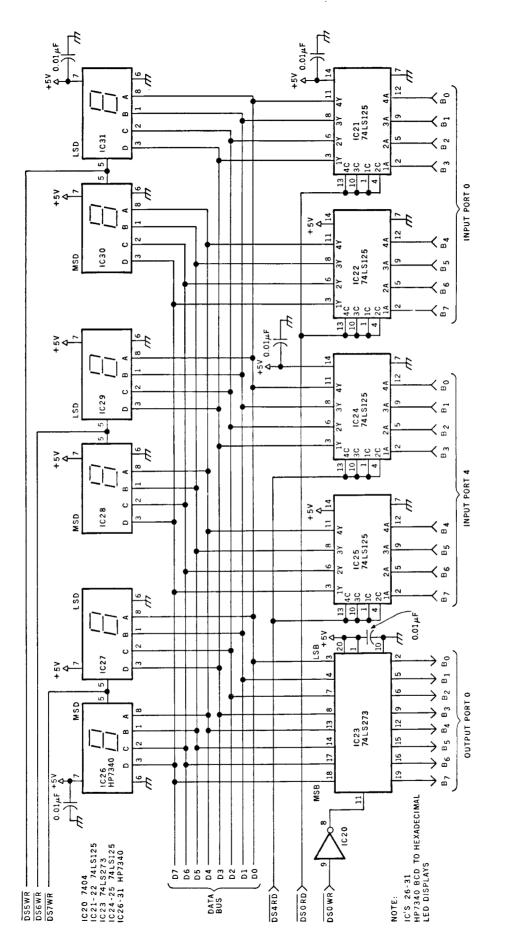


Figure 4.42 A schematic diagram of a parallel input/output ports of the basic ZAP computer with addi-tional enhancements required for use with the ZAP monitor software.

V. Dynamic Checkout of the Basic Computer

All systems, with the exception of memory, should have successfully passed the static checkout procedures. The memory wiring should be checked for continuity. Because ZAP has no front panel or indicator (unless you wish to add one), the full system can only be tested by executing a program that dynamically exercises all the system hardware. This is easier than it sounds. For the computer to output a number to a specific port address, the central processor must be operational and have reset properly to execute the instruction. The memory read must work or the central processor wouldn't know what to do. The memory and I/O decoding must work for the data stored in memory to arrive at the right output port. And finally, for the data to be read at the port, the output port must function as well. In short, if you can execute a program, the computer works.

We can make the process simpler by using the fewest program steps possible and by initially eliminating the necessity for programmable memory. Remember, ZAP has both EPROM and programmable memory. With no monitor or front panel, programmable memory cannot be loaded directly to run a test program. The test program must be already loaded in ROM (in our case EPROM). By carefully selecting the instructions used in the test program, programmable memory can be left out entirely when we run the first test. Why complicate matters by having more hardware than is necessary?

Few instructions are required to test the operation of the processor, reset, memory and I/O. Usually the central processor either works or it doesn't. Central processor failure is rarely a case of one of the instructions executing improperly. If ZAP can read in data at port 0 and output the same value to output port 0, we can assume it all works. For the data to reach output port 0, it must travel through the central processor (assuming you have removed the temporary grounds on the I/O strobe lines) under program control. ()e[×], 55

Such a test program is:

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	OCTAL	HEXADECIMAL	
IN A, 0	333 000	DB 00	read port 0 in
OUT 0, A	323 000	D3 00	write to port 0 out
JP NN	303 000 000	C3 00 00	jump to beginning

This 7-byte program will read input port 0 data into the accumulator and then write this same data to output port 0. The jump instruction will cause the program to repeat this action continuously. The program requires no programmable memory to store either intermediate data or the stack pointer. Because only the accumulator is affected, the 7-byte program can be completely contained in ROM. In this case, ROM can be either a 2708 EPROM programmed manually as described in Chapter 7 or a simulated ROM as shown in figure 4.30. If you use a simulated ROM, it may be necessary to reduce the 2.5 MHz clock rate to compensate for the capacitance of the external circuitry. Figure 4.30 also includes an output to port 5 that tests a data display to be added later. Rather than rewrite the EPROM or rewire the pseudo-ROM, you may wish to add this instruction now.

The final test of the basic ZAP is to exercise a program that uses both programmable memory and EPROM. Again, the philosophy is that if it can store and retrieve 1 byte from programmable memory, then all 1 K of that bank should work. A slightly longer program is used this time. The following program is stored in EPROM and the programmable memory is used by the central processor to store the stack:

		OCTAL	HEXADECIMAL	
	LD SP, nn	061 000 006	31 00 06	set stack pointer to
				middle of bank 1
				programmable memory
	IN A, 0	333 000	DB CO	read port 0 input
	CALL TEST	315 014 000	CD 0D 00	call program test
	OUT 0, A	323 000	D3 00	write data to port 0 out
	JP nn	303 000 000	C3 00 00	jump to beginning
EST	RET	311	C9	return to main program
				1. 27 Ret

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When assembled, the 14-byte program would be loaded as follows (in hexadecimal):

Location	Program
00/00	31 00 06
03	DB 00
05	CD 0D 00
08	D3 🛤 🔿 🖉
0A	C3 00 00
0D	C9

The operation of this program is similar to the previous example. A byte is read from input port 0 and then read back out to output port 0. In between these operations there is a call to a subroutine that is just a return instruction. When the call is executed, the location where the program is to resume operation after the call is put on the stack in programmable memory. At the conclusion of the call (the return instruction), the address is popped off the stack and placed in the program counter so that the program can resume where it left off. The only way for the input data from input port 0 to get to output port 0 is for this call to be executed properly. Of course, this requires that programmable memory work properly.

Many other programs that would further enhance the diagnostic checkout procedures can be written. In my experience, however, if it executes these two programs, you can count on everything running.

Once these milestones are reached, the experimenter has a truly operational computer. The next step is to expand this basic unit and make ZAP somewhat more versatile by adding address and data displays, a hexadecimal keyboard, a serial interface, along with an operating system that coordinates the activities of these peripherals. While the present system is a computer, these additions are necessary to move beyond an experimenter's breadboard project.

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CHAPTER 5 THE BASIC PERIPHERALS

Once the basic ZAP computer has been constructed and tested, we are ready to add a few necessary peripherals that will greatly increase the system's utility. External peripherals facilitate the input and output capabilities of the computer. They include such items as printers, cathode-ray tubes (CRTs), tape drives, and disks. Peripherals of this magnitude, however, are usually used on larger systems. For our Z80-based ZAP, useful peripherals include a keyboard to ease data and program entry; a visual display to allow the computer to indicate a logical conclusion in readable form; a serial communications interface, which allows ZAP to "talk" to another computer; and an interface to an audio cassette mass storage device. These four ingredients are the difference between an experimental breadboard and a useful personal computer.

The keyboard can be either a small keypad for limited data entry or an alpha-numeric "typewriter"-style ASCII (American Standard Code for Information Interchange) keyboard for text editing and high-level language programming. The visual display could range from a hexadecimal LED readout to a full 24-line by 80-character CRT terminal. The serial port, in conjunction with the audio cassette interface, could be used to cold start the computer and load application programs.

As with the previous circuits in this book, I've tried to provide various alternative designs so that you, the builder, may construct a truly personal system. Each of the four peripheral devices will be explained in detail and numerous design examples will be provided; both limited function hexadecimal input and full ASCII keyboards will be addressed. In the case of the visual display, we will discuss a rudimentary LED octal and a hexadecimal readout for ZAP. For more sophisticated visual interaction, a CRT terminal is required. Because this unit is much more complicated than a keyboard or an LED display, an entire chapter has been dedicated to it. My basic premise is to start with the essentials, provide a thorough understanding of their applications, then move to more complex, more useful add-ons.

The expansion of the basic ZAP into an interactive microcomputer system requires the addition of a software program to synchronize and exercise the new peripherals. This software is called a monitor and is discussed in a later chapter. Peripherals merely provide the means for added data entry and display capability.

I. KEYBOARDS

The only way the Z80 can communicate to an external device is through the input/ output bus structure previously described. (While more esoteric methods such as direct memory access exist, they will be ignored for the present.) When the processor wishes to signal the user that an event has occurred, it can do so by changing the output level on one bit of a parallel-output port. For example, the end of program execution can be designated by bit 7 on port 0 going from a logic 0 to a logic 1. Using this concept, **8** separate elements could be individually designated and controlled from the 8 bits of output provided on the single "basic ZAP" port.

Information input is just as simple. The numbers 0 thru 7 could correspond to 8 switches on the 8 input bits of port 0. This is shown graphically in figure 5.1. When

bit-7 switch is pressed, grounding the input, the logic level transition can signify a numeric entry of 7 to the computer; many microprocessor applications require only these few bits of I/O. A traffic light controller, for example, with a single red, yellow, and green light would need only three bits of output.

The program to control the lights would have been written, assembled, and programmed into some type of non-volatile storage. However, ZAP must interact with a human operator in such a way that programs can be developed and tested. The major difference between the traffic light controller and ZAP would be the peripherals and not the microprocessor's capabilities.

In our example, we could put 8 switches on an input port. To enter information, we have only to write a short program that reads the data on port 0 into the accumulator and then stores or acts upon it. The chapter on monitor software will address these manipulations, but one problem must be solved first: synchronizing peripherals to the computer.

How does the computer know when the data on the switches is or is not valid? And, could we make a timer in software or hardware that reads the port every second, on the second? Can you, for example, see yourself trying to flip all the switches in time or to make the computer wait?

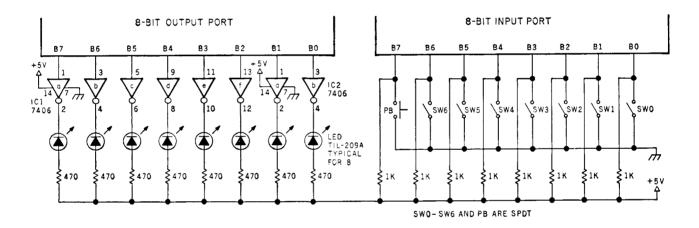


Figure 5.1 A parallel input/output interface with LED readout and switch input.

The most popular method of synchronizing a peripheral that has slow data input to a computer with fast program execution is to use "data ready" strobe pulses. (Interrupts may also be used but they involve complicated programming and will not be considered here.) The program is written to read and check the logic level of one bit only. By substituting a push button for one of the eight switches, say bit 7, we can simulate the strobe. To accomplish this, first set data on the other seven switches; then, with the program sitting in a loop checking bit 7, press the push button to generate a logic transition. The program, sensing that a "data ready" strobe is present, reads in the entire port and uses the other 7 bits of data.

Frequently, it is not practical to limit ourselves to just 7 symbolic interpretations when using 7 bits of input. A more logical approach is to code the input and let the 7 bits represent up to 128 individual symbols. The choice between a coded versus a straight parallel input is governed by the application. If the computer is part of a burglar alarm, with each input bit representing a door or window switch, then it is important to know individual and simultaneous bit transitions. In this application, it is necessary to have parallel signal input. On the other hand, alpha-numeric entry from a typewriter keyboard is by nature serial, one letter at a time. Therefore, nothing is gained by using 128 parallel input bits for a 128-key keyboard. A 7-bit code is more cost-effective.

The most widely used keyboard code is ASCII (American Standard Code for Information Interchange). Appendix B lists the code and the characters it represents. Any homebrew keyboard should reflect this coding to be compatible with commercially available software such as BASIC.

There are a number of methods that can be used to generate suitable key codes. Figures 5.2 and 5.3 reflect hardware and software approaches, respectively. The block diagram outlined in figure 5.2 is a hardware scanning system suitable for a 64-key keyboard. A 6-bit counter progressively enables each column while scanning all rows in each step. Should any key be pressed, a logic 0 will be routed through the 8-input multiplexer to the scan control logic. This signal is used to generate a key-pressed strobe (also called data-ready strobe) to the computer. The row and column address lines from the counter are read and indicate the binary matrix address of the pressed key. Compatibility with the ASCII code is simply a matter of placing the proper key at the correct address within the matrix.

Another suitable encoding method is outlined in figure 5.3. This technique, which uses software logic to scan the matrix, should be used only when computer program execution speed is not critical. While reducing the circuitry to one chip, the trade-off in this approach requires both an input and output port. It functions in the same way as figure 5.2. The computer sets a 4-bit column counter code on the decoder. Then it searches the parallel input port for the row with the logic level 0 signifying a pressed key. While this may seem to be an easy way to decode 128 keys, there are certain software considerations.

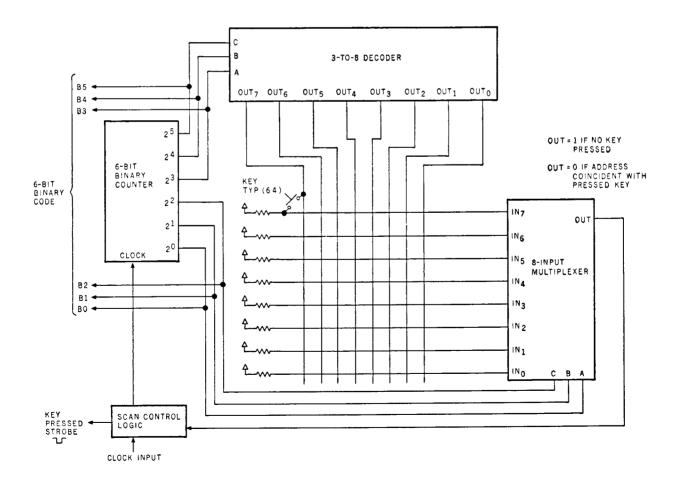


Figure 5.2 A matrix keyboard scanner for a 64-key keyboard.

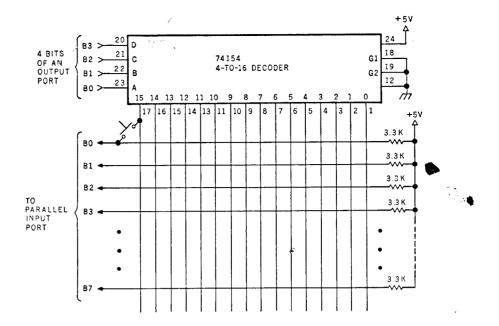


Figure 5.3 A software-driven 128-key encoder circuit.

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The key-pressed or data-ready strobe in any keyboard serves two purposes: it signifies that data is present and ready, and it is timed so the strobe is not generated until after a mechanical debounce time period has elapsed. The reason for the delay is obvious. Remember, these microprocessors can execute 200,000 instructions a second. A program written to look for a strobe and read the data would run a hundred times on a single keypress because of contact bounce. The mechanical making and breaking of the contact could appear like 100 data-ready strobes if we aren't careful. A true data-ready strobe is not generated until after a debounce time-out and then it should be fast-rise-time (< 200 ns) pulse with à rate exceeding the cycle time of the computer. The duration of the pulse should be *long* enough to allow the scanning program to catch it even if it is off doing some other task, and *short* enough so that the central processor doesn't see the same strobe twice.

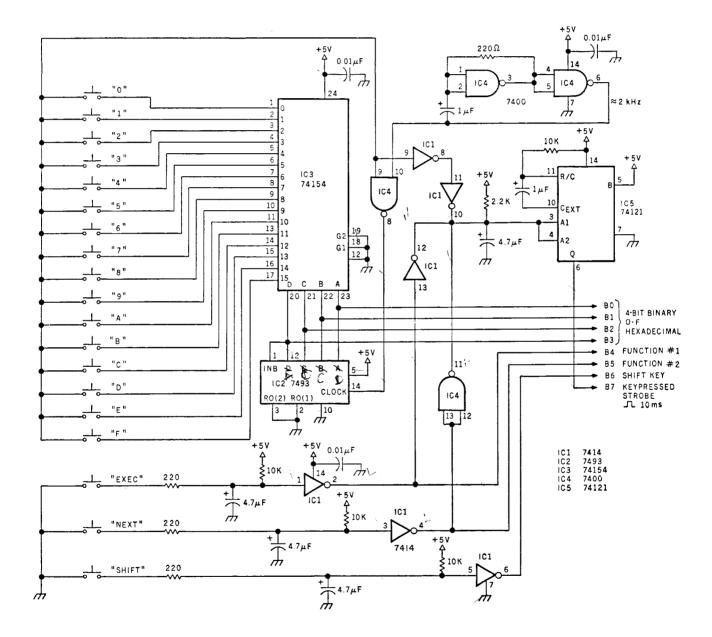
There are two techniques to combat the problem of strobe duration. One is to set a flip-flop with the rising edge of the strobe and tie the clear line of the flip-flop to an output bit. After reading in the data, the program can clear the "data-ready" condition by resetting the flip-flop. This is usually employed in cases where the response time to a keyboard or other device is variable. This method also guarantees that an event will be registered and not missed due to time delays. Of course, most keyboard encoders do not latch their output data. If a key is released, even if the strobe has been set in a flip-flop, no data will be present when the computer reads the keyboard. There are ways to get around this but they all involve additional hardware.

Usually the experimenter's problem is reading a strobe twice rather than not waiting long enough to acknowledge it. Instead of using a hardware flip-flop, most programmers employ a software flag, the second technique in dealing with strobe duration. When a key-pressed strobe is sensed, the program sets a flag in a memory location, reads the data, then checks the strobe again. If the strobe is high, the flag is checked and the data is not read. Only when the strobe returns to a logic zero is the flag reset, enabling data input the next time.

It's not easy to construct keyboard encoders for 64- or 128-key ASCII keyboards. It's simpler to use a commercially available, scanning, read-only memory encoder such as the one documented in Appendix C6.

As far as ZAP is concerned, it is important to learn to walk before we run. Most people would consider ZAP to be a learning tool that could be eventually expanded into a full-blown microcomputer system. A full 128-key ASCII keyboard could prove to be as expensive as the entire ZAP computer. To minimize expense and retain the experimental qualities of this endeavor, a limited keyboard, suitable for hexadecimal entry, is suggested as the first level of expansion. With a limited number of keys to encode, hardwired TTL circuitry offers a reasonable cost advantage over expensive encoder read-only memories.

Figure 5.4 is a hexadecimal keyboard interface designed specifically for the ZAP software monitor. A hexadecimal keyboard allows data and instruction entry as 2 digit hexadecimal numbers. In addition to the 16 numeric keys, there are 3 command keys designated "EXEC" (for execute), "NEXT," and "SHIFT." EXEC and NEXT will be explained in the monitor section. The SHIFT is similar to a regular keyboard and is used to double the number of key codes by allowing a SHIFT 1, SHIFT 2, etc. The particular significance of each code will be explained later.





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The keyboard required to support the ZAP software monitor has 19 keys. The encoder in figure 5.4 is a combination scanner and hard-wired parallel output. Encoding depends upon the particular key pressed. The hexadecimal keys 0 thru F are sensed through a multiplexed scanner, IC 2 and IC 3. As IC 2 counts, it sequentially places a logic 0 on each of the 16 output lines of IC 3. If any key is pressed, that low level is routed back to IC 4 and stops the clock. The counter is then locked on the address of the particular key being pressed. The same action that stops the clock also triggers a one-shot IC 5 which generates a key-pressed strobe. The output lines B0 thru B3 will contain the binary value of the pressed key while bit 7 is reserved for the strobe. The three function keys are directly tied to input bits 4, 5, and 6. Three sections of IC 1 serve to dampen contact bounce. The EXEC and NEXT are tied in so they will generate a key-pressed strobe when activated. Because the shift key is always used in conjuction with another key, it is not connected to the strobe circuit.

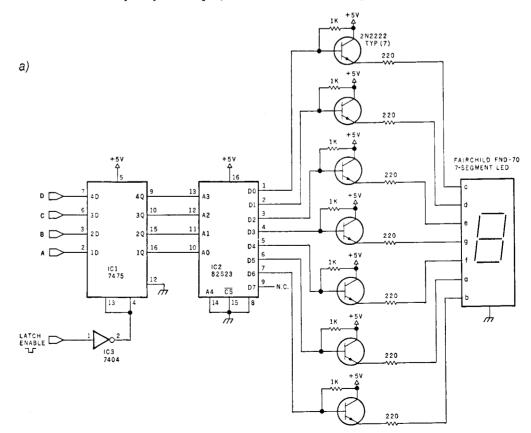
It is important to recognize that the coding of this 19-key circuit is not ASCII. An ASCII keyboard cannot be used directly with the software monitor outlined in this book, unless you use only those ASCII keys that correspond to the coding of figure 5.4, or rewrite the software monitor to accept ASCII rather than binary codes for each key.

II. ADDING A VISUAL DISPLAY

Once a keyboard has been added to ZAP, we are ready for program development. The other key ingredient is a visual display that allows the programmer to examine instruction statements and data. The least costly configuration is an LED display, preferably hexadecimal because the software monitor is written that way. For the octal diehards, I've also included an octal display.

Hexadecimal displays may seem a trivial addition to an expensive computer system, but it is sometimes these little helpful add-ons that make program debugging easier. I don't intend that it should replace a CRT, but it's a necessary tool when debugging a program and a necessity for using the ZAP monitor. It will never replace a stepper or a break-point-monitor program, but it's great to display keyboard or I/O data quickly with a single output instruction.

There are many ways to display hexadecimal on a 7-segment LED. Figure 5.5 is an



b)	INPUT CODE	82S23 PROGRAM	7-SEGMENT DISPLAY
~)	DCBA	D7D6D5D4D3D2D1D0	
	0 0 0 0	0 1 1 1 0 1 1 1	0
	0001	0100001	1
	0 0 1 0	0 1 1 0 1 1 1 0	2
	0011	01101011	3
	0100	0 1 0 1 1 0 0 1	4
	0101	0 0 1 1 1 0 1 1	5
	0 1 1 0	0 0 1 1 1 1 1 1	6
	0111	01100001	7
	1000	01111111	8
	1001	0 1 1 1 1 0 0 1	9
	1010	01111101	А
	1011	0 0 0 1 1 1 1 1	b
	1 1 0 0	0 0 1 1 0 1 1 0	С
	1 1 0 1	0 1 0 0 1 1 1 1	d
	1110	0 0 1 1 1 1 1 0	Е
	$1 \ 1 \ 1 \ 1$	0 0 1 1 1 1 0 0	F

Figure 5.5 A possible method for a hexadecimal latch/decoder/driver using a standard 7-segment LED.

- a) This entire circuit would be needed to replace one HP7340. CS on the 82S23 can perform the blanking function.
- b) The program for the 82S23 (IC 2).

example of the usual brute force method using a PROM as a hexadecimal decoder. (A method of programming the 82S23 was described in the article in the November 1975 issue of *BYTE* magazine entitled "A Versatile Read-Only Memory Programmer," if you choose to use this circuit.)

However, this approach uses an excessive number of components and most people would not want to program a PROM. One alternative is to allow the computer to perform the decoding and drive the 7-segment display through the transistors directly from a latched 8-bit output port. Another way puts additional logic around a standard 7-segment decoder driver for the extra requirements. The former case necessitates a computer program while the latter can involve as many components as figure 5.5.

Fortunately, there is a product on the market that can solve the problem. It is the HP7340 hexadecimal LED display (from Hewlett Packard; equivalent displays are available from other manufacturers). These hexadecimal digits depart from the standard 7-segment format by using dots instead of bars and being capable of displaying a capital "B" and "D" in hexadecimal. This is accomplished by controlling the corner dots, which gives the appearance of "rounding." This ability discriminates a "B" from an "8" or a "D" from a "0." There are 16 distinctly different characters.

An additional feature of the HP7340 is that each display circuit contains a 4-bit latch and decoder/driver. This allows the display to be attached directly to the data bus. The result is a single 8-pin hexadecimal display that successfully accomplishes the function of all the circuitry of figure 5.5. The specifications of the individual pins are given in figure 5.6.

5080-7340 PIN CONNECTIONS

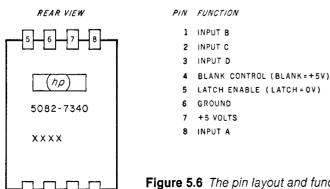


Figure 5.6 The pin layout and functions for the HP7340 BCD to hexadecimal display. Similar displays are produced by Dialite and Texas Instruments.

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Figures 5.7 and 5.8 demonstrate how the HP7340 can be configured to function as a 2-digit hexadecimal output port or a 3-digit octal port. An 8-bit latch is not required because it already contains one. The HP7340s can be attached to the data bus as simply as any other parallel output port and are strobed from the chip-select decoder outlined earlier in the section on I/O decoding.

To utilize the software monitor properly, 6 hexadecimal displays (separated into 3 single byte displays) are necessary. Three bytes are required to display a particular H and L address and the data contents of that location. The 6 hexadecimal displays should have the following decoded strobes:

Output Port #	Logic Line	Display Parameter	IC#
5	DS5WR	MSD address field	30, 31
6	DS6WR	LSD address field	28, 29
7	DS7WR	data field	26, 27

MSD – Most Significant Digit

LSD – Least Significant Digit

A more complete description of each display function is described within the monitor section, and a completed schematic showing how the 6 displays are attached to the data bus is illustrated in figure 5.9.

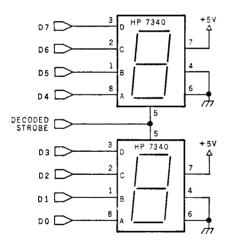


Figure 5.7 An HP7340 hexadecimal latch/decoder/driver display.

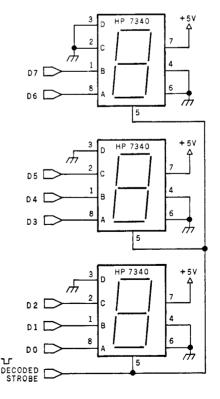
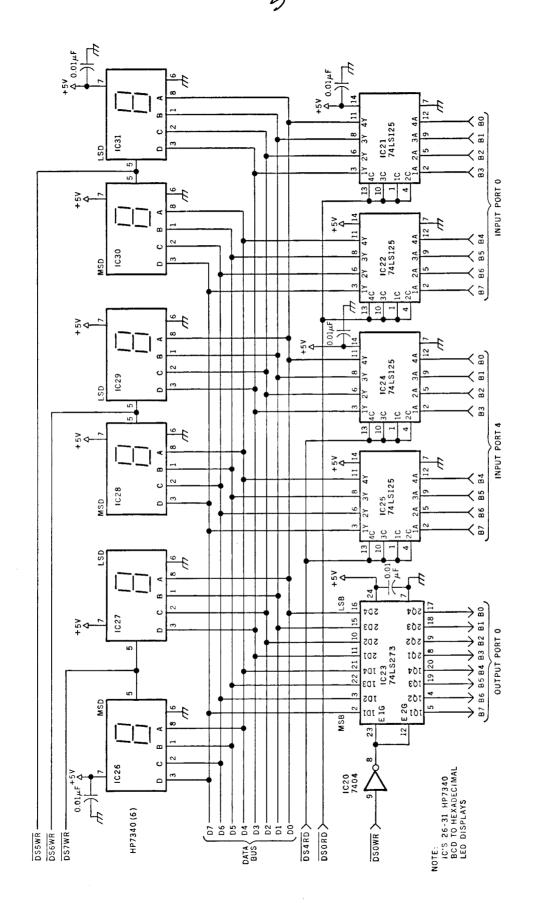


Figure 5.8 An HP7340 octal latch/decoder/driver display. The HP5082-7300 can be substituted for the HP5082-7340 in octal display applications. The HP7300 displays numerics only.





III. SERIAL INTERFACE

A serial communication capability is not absolutely necessary to make ZAP work, although the software monitor supplied in this book supports a serial interface.

First a word about concept before we pursue the design details. Why would ZAP need to communicate? When we discuss the serial cassette interface, you will understand that there are more advantages to it than appear presently. If future expansion is in mind or commercially made peripherals such as a CRT or printer are ever added, their interface will most likely be serial.

This last sentence is significant. Realize that I said nothing about communicating with another computer. While talking to another computer over telephone lines requires a serial link, in general, standard peripherals such as CRTs and printers also "talk" serially. Therefore, by designing a serial port to accommodate a printer, we also gain the ability to talk with another computer.

Communication is simply the transfer of information from one device to another. In the case of a CRT display unit, the computer sends character information for screen display while the keyboard relays the user's input to the computer. Each end of the fullduplex communication line must have a transmitter and a receiver. In both cases, the information being transferred is ASCII data probably consisting of a 7-bit code and, in some cases, an additional parity bit for error checking. This 7-bit data (ignoring the parity bit) will appear on the lines of a parallel port. These 7 lines plus a ground reference and a strobe (remember we have to tell the receiver when the data is valid) can be brought out to the CRT input. Keeping that as a dedicated line from the computer to the CRT, we now want a similar line between the keyboard output and an 8-bit parallel port on the computer. This requires an additional 9 lines. To further complicate matters, let's separate the terminal and the computer by 300 to 400 feet, as might happen in some commercial computer systems. The result is that 400 feet of 18 lead (17 if you combine ground references) cable will cost more than the terminal. Also realize that the TTL parallel output should not be used to drive lines longer than 20 feet without special buffers/drivers; otherwise data errors could occur.

The solution to this costly wiring problem is to use serial rather than parallel communication. The parallel data is converted to serial and sent one bit at a time down a single twisted pair wire. If buffers/drivers are needed for long distances, less are required with the serial approach. Specially encoded "start" and "stop" bits included in the serial transmission notify the receiver that valid data is being sent. For the above example, only two pairs of wire are needed to perform "full-duplex" interaction (see figure 5.10). In "half-duplex" mode this can be reduced to a single twisted pair, but synchronization of the shared communication line is more complicated. All serial transmission references I shall make will be limited to full-duplex operation.

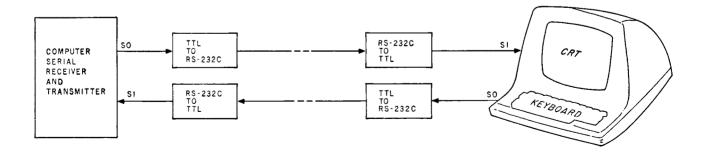


Figure 5.10 A block diagram of a full-duplex RS-232C communication link.

Now that we agree that the communication should be serial, how do we accomplish the parallel to serial conversion? The answer is a device called a UART (Universal Asynchronous Receiver/Transmitter). Appendix C7 gives the specification information for the SMC COM2017 UART which is equivalent in function to the AY-5-1013A (General Instruments). To minimize power supply requirements, a single +5 V AY-3-1015 or TR1602 (Western Digital) can be substituted as I have done. The only change from the specification sheet is that pin #2 is no longer tied to -12 V.

A UART's internal structure consists of a separate parallel-to-serial transmitter and serial-to-parallel receiver joined by common programming pins. This means that the two sections of the UART can be used independently, provided they adhere to the same bit format that is hard-wire or software selectable on the chip.

The transmission from the computer to the CRT is done asynchronously and in one direction only. The computer likewise receives data directly from the keyboard through a dedicated line. As far as the computer is concerned, after reconversion to parallel in the UART, this input device is communicating parallel data.

Actual data transmission follows the asynchronous serial format illustrated in figure 5.11. Using the keyboard as an example, when no data is being transmitted, the data line is sitting at a mark (or "1" level) waiting for a key-pressed strobe. A key-pressed strobe is a 1 to 5 ms positive pulse (it can be as short as 200 ns) indicating that a keyboard key has been pressed, and that an ASCII code of that key is available for transmission. This key-pressed strobe, which is attached to the data strobe of the UART, causes the ASCII data to be loaded into a parallel storage buffer and starts the UART transmission cycle. The serial output will then make a transition from a 1 to a 0. This mark-to-0 start bit is 1 clock period long and indicates the beginning of a serially transmitted word. Following the start bit, up to 8 bits of data follow, each data bit taking 1 clock period. At the conclusion of the data bits, parity and stop bits are output by the UART to signify the end of transmission. If another key is pressed, the process repeats itself.



Figure 5.11 A single data byte as it is transmitted in asynchronous serial format.

On the receiving end, the UART is continuously monitoring the serial input line for the start bit. Upon its occurrence, the 8 bits of data are slipped into a register and the parity checked. At the completion of the serial entry, an output signifying data available is set by the UART and can be used as an input strobe to the computer. The UART will not process additional serial inputs unless the data available flag is acknowledged, and the data available reset line is strobed. Actual transmission can include or exclude parity, have 1 or 2 stop-bits, and data can be in 5- to 8-bit words. These options are pin selectable.

The following is a pin function description for the AY-5-1013, COM2017, or AY-3-1015.

Pin #	NAME	SYMBOL	FUNCTION
1	V _{cc} Power Supply	V _{cc}	+5 V Supply
2	V _{cc} Power Supply	V _{GG}	-12 V Supply (not con- nected on AY-3-1015)
3	Ground	GND	Ground
4	Received Data Enable	RDE	A logic "0" on the receiver enable line places the re- ceived data onto the output

			lines.
5 thru 12	Received Data Bits	RD8 thru RD1	These are the eight data output lines. Received char- acters are right justified; the LSB always appears on RD1. These lines have three-state outputs.
13	Parity Error	PE	This line goes to a logic "1" if the received character parity does not agree with the selected parity. Three- state.
14	Framing Error	FE	This line goes to a logic "1" if the received character has no valid stop bit. Three- state.
15	Over-Run	OR	This line goes to a logic "1" if the previously received character is not read (DAV line not reset) before the present character is trans- ferred to the receiver hold- ing register. Three-state.
16	Status Word Enable	SWE	A logic "0" on this line places the status word bits (PE, FE, OR, DAV, TBMT) onto the output lines. Three- state.
17	Receiver Clock	RCP	This line should have as an input a clock whose frequency is 16 times $(16 \times)$ the desired receiver data rate.
18	Reset Data Available	RDAV	A logic "0" will reset the DAV line.
19	Data Available	DAV	This line goes to a logic "1" when an entire character has been received and trans- ferred to the receiver hold- ing register. Three-state.
20	Serial Input	SI	This line accepts the serial bit input stream. A marking (logic "1") to spacing (logic "0") transition is required for initiation of data recep- tion.
21	External Reset	XR	Resets shift registers. Sets SO, EOC, and TBMT to a logic "1." Resets DAV and error flags to "0." Clears in- put data buffer. Must be tied to logic "0" when not in use.
22	Transmitter Buffer Empty \mathcal{O}	TBMT	The transmitter buffer empty flag goes to logic "1"

mitter buffer empty flag goes to logic "1" when the data bits holding

					aracter. Three-
23	Data Strobe	DS	enter data l Initial initiate of DS	the da bits h data ed by . Data	n this line will ata bits into the olding register. transmission is the rising edge a must be stable e strobe.
24	End of Character	EOC	each ti transm this le	ime a nitted. vel ur nissior	es to a logic "1" full character is It remains at ntil the start of of the next
25	Serial Output	SO	bit, pro mitted main a	ovide chara at log	l serially, bit by the entire trans- acter. It will re- ic "1" when no g transmitted.
26 thru 33	Data Bit Inputs	BD1 thru BD8			p to eight data es available.
34	Control Strobe	CS	enter t NB1, I the co registe	he co: NB2, ontrol r. Th d or h	on this lead will ntrol bits (EPS, TSB, NP) into bits holding is line can be nard-wired to a rel.
35	No Parity	NP	elimina from receive indicat will irr last da	ate t the tr ed cha tion). media ata bi ad mu	on this lead will he parity bit cansmitted and aracter (no PE The stop bit(s) ately follow the t. If not used, ast be tied to a
36	Number of Stop Bits	TSB	numbe two, t mediat bit. A	r of st o be ely a logic ' ts. A l	will select the top bits, one or appended im- fter the parity "0" will insert 2 logic "1" inserts
37 38	Number of Bits/ Characters	NB2, NB1	ternally either S charact NB2 0	y dec 5, 6, 7 ter. NB1 0	5
			0 1	1 0	6 7
			-	-	_

•

register may be loaded with

> 8

1

1

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39	Odd/Even Parity Select	EPS	The logic level on this pin selects the type of parity that will be appended im- mediately after the data bits. It also determines the parity that will be checked by the receiver. A logic "0" will insert odd parity, and a logic "1" will insert even parity.
40	Transmitter Clock	ТСР	This line should have as an input a clock whose fre- quency is 16 times $(16 \times)$ the desired transmitter data rate.

The final serial interface configuration is shown in figure 5.12. Because a UART is a three-state device, it can be attached directly to the data bus. Data is written into or read from it 8 bits parallel as any other I/O port manipulation. To the computer, the UART appears as one output and two input registers: status, transmitted data, and received data. As with all data bus manipulations, data transfers are synchronized through decoded strobes. The ZAP software monitor uses three port addresses to coordinate the hardware and software. To be compatible, they should be wired as follows:

Port #	Logic Line	Signal
02 INPUT	DS2RD	READ DATA
03 INPUT	DS3RD	READ STATUS
02 OUTPUT	DS2WR	WRITE DATA

The primary focus of this chapter is the hardware section of the serial interface. When connected directly to the data bus in this manner, there is no way to operate the UART except under program control. Explanation of the protocol and the significance of each UART register can be found in the section on the ZAP monitor.

There are two remaining hardware considerations: data rate and transmission signal level. Data rate can be loosely termed as bits per second and refers to the transmission speed along the twisted pair. Keep in mind that at lower data rates, only 8 of 11 bits of each transmitted word are data; 1 start bit and 2 stop bits are used. While any transmission frequency can be set on a UART, by adjusting the clock rate there are eight frequently used standard asynchronous transmission rates:

110	bps
150	bps
300	bps
600	bps
1200	bps
2400	bps
4800	bps
9600	bps

Using a special data rate generator chip and switch selector network shown in figure 5.12, ZAP can accommodate any of these specific frequencies. In normal operation, most teletypes run at 110 bps, printers such as the DECwriter II at 300 bps, acoustic telephone modems at 300 bps, and video terminals from 1200 to 19,200 bps. As you can see, in theory, we can communicate with them.

Transmission rate is only part of inter-communication prerequisites. A computer could be all TTL level logic while a peripheral used 15 V CMOS. They would be completely incompatible. Therefore, it is necessary to have one additional standard that governs the signal level of the transmissions. The most widely accepted and generally

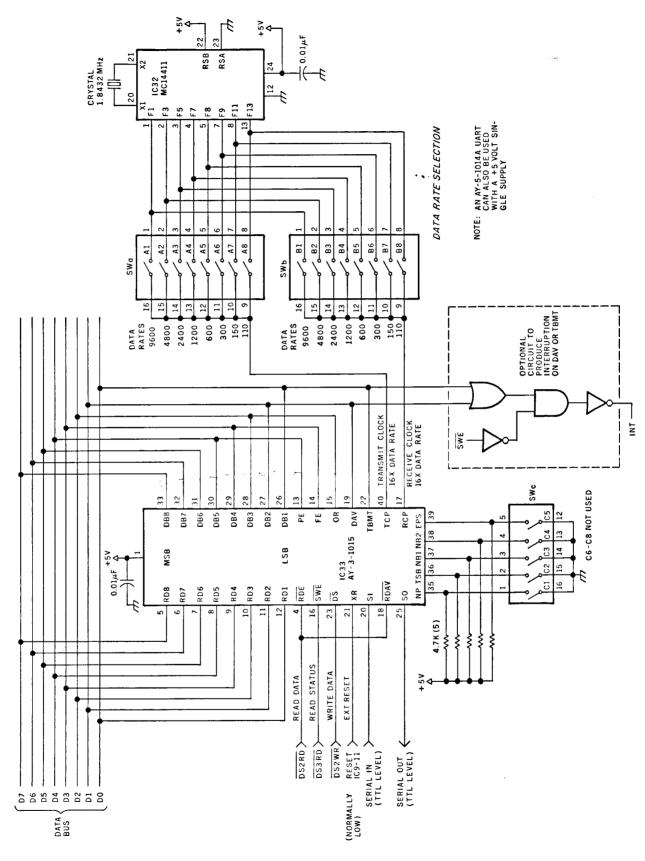


Figure 5.12 The final serial interface configuration.

used standard is EIA RS-232C.

Although TTL levels could be used for communication, they are not suitable for carrying signals more than 10 or 20 feet. The problem stems from the fact that only 2 V separates a logic 1 or 0 rather than speed or drive capabilities. With only 2 V immunity to noise, communication would be susceptible to interference from motors and switches.

An industrial committee agreed to a standard interface to solve this problem as well as to suggest standards for the industry. Modem equipment uses EIA RS-232C. This specification applies not only to the specific voltages assigned to logic 0 and 1, but also to the type of plug, pin assignments, source and load impedances, as well as to a variety of other related functions.

The signal levels of RS-232C are bipolar and use a negative voltage between -3 and -15 V to represent a logic 1 and a positive 3 to 15 V to represent a logic 0. The region between -3 V and +3 V helps our noise immunity and is a dead region. Even though + and -15 V would provide optimum transmission, +3 V and -7 V are also acceptable. However, try to maintain equal bipolar levels over long distances.

The basic ZAP computer requires +12, +5, and -12 V (-5 V is necessary for the EPROM memory and is derived from the -12 V supply) supplies for operation. We can use the positive and negative supplies to generate RS-232C voltage levels in a number of ways. Figure 5.13 illustrates some RS-232C drivers, and figure 5.14 shows a couple of receiver circuits. One from each selection would have to be attached to the serial I/O pins of the UART for it to have complete RS-232C compatibility.

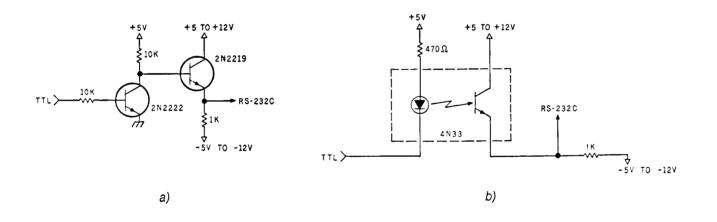
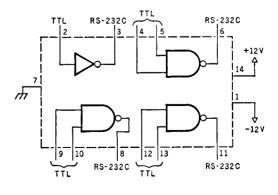
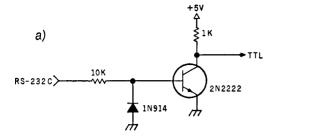


Figure 5.13 TTL to RS-232C drivers.

- a) Using two transistors as a level shifter.
- b) Using an opto-isolator as a level shifter.
- c) Using a standard RS-232C line driver.

PINOUT OF MC1488 TTL TO RS-232C DRIVER





PINOUT OF MCI489 RS-232C TO TTL RECEIVER

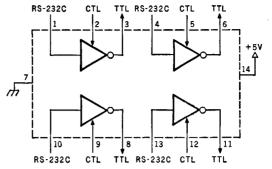


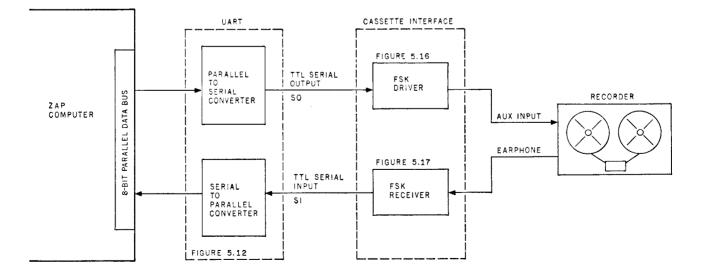
Figure 5.14 RS-232C to TTL receivers. a) Using a transistor. b) Using a standard RS-232C line receiver.

IV. CASSETTE STORAGE INTERFACE

The last but by no means least of the enhancements we should add to ZAP is a cassette interface. With the keyboard and display, an operator will be able to write some elaborate programs but, unless they are transferred into read-only memory storage, they will be lost when power is turned off. Of course, the computer's power can be left on constantly. But what if you want to develop a second program that must occupy the same memory address space? The preferable solution is to have some medium that temporarily stores large memory blocks.

In large computer systems, this capability is achieved through hard-disk and 9-track magnetic tape systems. These high-speed, high-volume media are beyond the personal computing budget, but their value in large systems is obvious. A low price, lower performance alternative is an audio cassette storage system.

In general, a cassette storage interface consists of three major subsystems: a serial transmitter/receiver; a hardware assembly that converts serial TTL data so it's audio cassette compatible, and an application program that keeps track of what's going out to tape and can load it back into the correct place. The basic configuration is illustrated in block diagram form in figure 5.15.



b)

Figure 5.15 A block diagram of an audio cassette storage system.

The serial transmitter/receiver section is nothing more than the UART serial interface which we have already added. With MC1488 and 89 converters on its serial lines, it communicates via a RS-232C. However, if you attach a cassette interface to these lines, it can double as a storage device. An additional benefit is that serial data generated by the UART will offer some compatibility between personal computing systems; standard data rates and standard serial communication protocol will promote this.

The output of the UART is TTL. Even with the RS-232C drivers, the logic output is still a DC level. Because audio recorders cannot record DC, the UART output must be converted in some way. The solution is FSK (frequency shift keying). The TTL output from the UART is converted into audio tones. One frequency represents a logic 0, and a second represents a logic 1.

Figure 5.16 shows a circuit that will produce frequency shift keyed tones. A 4800 Hz reference frequency is derived from the MC14411 data rate generator previously installed. IC 2A and 2B function as a programmable divider chain. With a TTL logic 1 on the input IC 2 divides the 4800 Hz by 2, giving a 2400 Hz output. When the input level is changed to logic 0, it divides by 4, producing a 1200 Hz output. The FSK frequencies are generated at a serial output rate of 300 bps and connected directly to the recorder through the microphone or auxiliary input. (These frequencies and data rate are often referred to as the Kansas City Standard.)

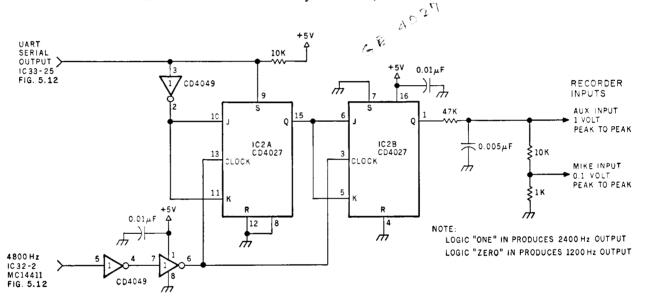


Figure 5.16 A 300 bps serial output driver to an audio recorder.

Getting the recorded tones off the audio tape requires the circuit shown in figure 5.17. In general, it consists of a pair of band-pass filters and a voltage comparator. The recorder is set to an output level of approximately 1 V peak to peak. This level is not critical because it is amplified and limited as it passes through IC 1. IC 2 and IC 3 are band-pass filters with center frequencies of 2400 Hz and 1200 Hz, respectively. The output of IC 1 is fed into both of them, but should be passed by only one. IC 4 compares the outputs of the two filters and generates a TTL logic 1 when a 2400 Hz tone is received and a logic 0 with a 1200 Hz tone. Tuning the interface will be explained later.

The choice of the FSK frequencies and data rate are not left to chance. They are a function of receiver response speed and recorder bandwidth. Most cassette recorders have a frequency response of around 8 kHz. Less expensive units can be as low as 5 or 6 kHz. It is unwise to try to record tones at this upper limit. The center of the frequency range offers more reliability, so the logic "1" FSK tone should be set less than 3 kHz (2400 Hz in our case). In addition, it takes time for the receiver to recognize a particular frequency. The circuit of figure 5.17 takes 2 or 3 cycles to respond. This means that at the low frequency of 1200 Hz, each logic 0 bit will need 3 cycles at 1200 Hz to be recognized.

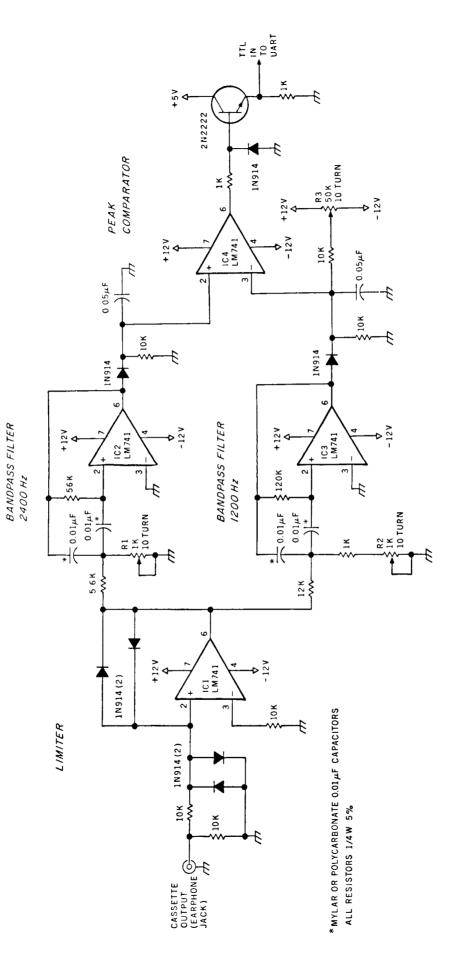


Figure 5.17 A 300 bps serial input receiver from an audio cassette.

If we consider a worst case condition of sending all zeros, the transmission rate would have to be slower than 400 bps to be accurately received. The closest standard data rate to this value is 300 bps. Raising the 1200 Hz tone to increase the transmission speed only complicates the filter design the closer it is to 2400 Hz. This interface has been tested at 600 bps but it requires precise alignment to achieve faster speeds. The low frequencies and moderate data rate are chosen specifically to increase the probability of successful construction rather than to compete with high speed data storage systems.

The final point to consider is the software that runs the hardware. The ZAP monitor, as it now stands, does not directly support a cassette interface even though it does handle all the serial housekeeping. Until you write the cassette driver into an EPROM, you will have to type in a short "bootstrap" program. To read the cassette, the logic of the program would follow the flow diagram in figure 5.18.

First, a pointer is set in the H and L registers to designate where the cassette data will be stored in programmable memory and an address where it will end. Next, taking advantage of the serial communication routine in the ZAP monitor, we simply call "SERIAL IN" which returns with a byte of data from the UART. This byte is stored in memory, and the HL register pair is decremented and compared to a predetermined stop address. If not equal, it repeats the process of getting another byte of data.

Storing memory is equally straightforward and is diagrammed in figure 5.19. Again, a pointer is set to the beginning and the memory area to be written to tape. Next, the "SERIAL OUT" routine is called from the ZAP monitor, which sends the byte of data to the cassette. Finally, the pointer is decremented and compared to the end address to see if more data is to be written.

These are relatively easy routines to write and short enough that they may be squeezed into the few empty bytes within the ZAP monitor EPROM. Whatever the case, you will soon realize the versatility and capability that such a simple interface adds to a computer system. The 2 K of programmable memory on the basic ZAP will become resident program space while the cassette will be a potential megabyte file storage system for it.

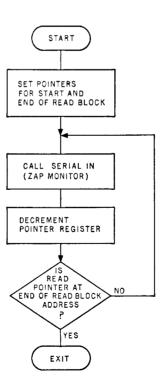


Figure 5.18 A flowchart of software to read a cassette.

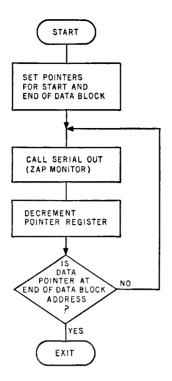


Figure 5.19 A flowchart of software to write a cassette.

TUNING THE CASSETTE INTERFACE

To test the cassette interface, it is necessary first to construct the circuit from figure 5.16. Use a frequency counter to determine that the input to IC 1, pin 5 is 4800 Hz. With no UART installed, the frequency at pin 1 of IC 2b should be 2400 Hz. Grounding IC 2b, pin 1 should change this output to 1200 Hz. In both cases, voltages of 1 and 0.1 V should be present on the cassette auxiliary and microphone inputs respectively.

The receiver uses the frequencies generated by the output section previously described to set the calibration. With the output section set to 2400 Hz, attach a jumper from the output interface to the input of the receiver circuit (figure 5.17). Using an oscilloscope, check that the waveform at IC 1, pin 6 is a square wave of 2400 Hz. Next, with the scope attached to IC 2, pin 6, adjust R1 until the voltage at that point is maximum. Moving the scope probe to IC 3, pin 6, and changing the input frequency to 1200 Hz, repeat the procedure by adjusting R2 until the voltage peaks.

R3 sets the point at which the comparator switches between logic levels when the input frequencies change. The proper way to set this is to use a function generator on the input and set R3 to switch at exactly 1800 Hz. The result should be clean logic level switching at IC 4, pin 6, as the frequency is cycled between 1200 Hz and 2400 Hz. Generally speaking, the comparator setting is not especially critical.

CHAPTER 6 THE ZAP MONITOR SOFTWARE

The function of an operating system is to provide the programmer with a set of tools to help him in developing, debugging and executing a program. In general, the operating system assists the programmer by managing the resources of the computer, and by eliminating his involvement with repetitive machine-code manipulations. Operating systems span a broad spectrum of complexity. Small systems, for example, provide only a rudimentary means for a programmer to enter and read 8-bit data from memory; large systems, on the other hand, can dynamically manage the allocation of all memory and peripherals.

Large systems allocate computer resources to more than one user in a multiprogramming, multitasking, or a time sharing environment. A system of this magnitude far exceeds the capabilities of the computer described in this book. This being the case, what would be a suitable operating system for the ZAP computer? As previously stated, the objective of an operating system is to manage the resources of the computer. The ZAP computer described in the previous chapters, and enhanced with the minimum peripherals, contains the following resources:

- Z80 microprocessor
- 1024 bytes of EPROM memory
- 1024 bytes of programmable memory (2048 optional)
- Nineteen-key keyboard
- Two-character data display
- Four-character address display
- UART for serial I/O

The operating system must provide access to these resources and give the user a way to manage them during execution of programs. The operating system designed for ZAP will include the following facilities and functions:

- 1. Cold start
- 2. Warm start
- 3. Memory display and replace
- 4. Register display and replace
- 5. Execute (begin program execution at a designated point)
- 6. Serial input and output

Each will be explained in detail concerning its functions and program implementation.

I. OPERATING SYSTEM FUNCTIONS

Cold Start Operation

The operating system must be available immediately after power is applied to

the computer. In the past, some systems provided this capability by storing, in read-only memory, a small "bootstrap" routine. This bootstrap routine was then used to load the operating system into memory from another device, such as a paper-tape reader or a cassette recorder. New technology eliminates this tedious step. The operating system for your computer resides permanently on the EPROM (erasable-programmable read-only memory) chip and is ready to be executed as soon as power is applied and the "RESET" button is pressed. The depression and release of the "RESET" button sets the Z80 PC (program counter) to zero.

With the next machine cycle, the processor begins execution of the instruction located at 00₁₆ (location 00 hexadecimal) in memory. The operating system of the Z80 microprocessor provides the instructions to begin execution. This particular series of program instructions constitutes a "cold start" procedure and establishes the required start up conditions for the operating system. The operating system then initializes the SP (stack pointer) to an area in programmable memory for maintaining the "push-down/pop-up" stack. This stack is required for execution of any of the "RESTART" and "CALL" instructions provided by the Z80 instruction set. If it were not initialized before the execution of a "CALL" or "RESTART" instruction, the effects of the instruction would be unpredictable. In this operating system, the stack pointer is set to programmable memory location 07C4₁₆.

Warm Start Operation

After initializing the SP address, the operating system enters a command recognition module. Before discussing this feature of the operating system, some of the other restart features should be explained. The Z80 gives the user eight address-vectored "RESTART" instructions (see Chapter 3 for a description of the instructions). For example, the execution of a RST 08₁₆ will store the current PC on the "STACK" and program execution will begin at location 08₁₆.

The following "RESTART" instructions are available within the operating system:

RST	1016
RST	1816
RST	2016
RST	2816
RST	3016
RST	3816

The execution of any of these instructions causes the operating system to jump to a location in programmable memory. At that location the user executes a jump instruction to vector the computer to a new location.

RST 00_{16} and RST 08_{16} have been reserved for use by the operating system for special functions and will not result in a jump to a location in programmable memory. These two RST instructions can be utilized in the debugging of programs. RST 00_{16} will perform the same function as pressing the "RESET" button; or it will reinitialize the stack pointer and enter the command recognition module through execution of the "cold start" routine.

The execution of a RST 08₁₆ by the Z80 will result in the "warm start" module being entered. This module saves the existing data in all the registers in the "register save area" located in programmable memory (see the listing of the ZAP operating system in Appendix D). The module will also extract from the stack the user's restart address and save this in the register save area. The operating system then enters the command recognition mode to wait for the next command. The use of this feature allows the programmer to save register, pointer, flag, and program counter data, prior to using any additional debugging features in the operating system. A detailed description of the "warm start" module is provided in section II.2 of this chapter.

Program Development and Debugging Services

The cold start and warm start procedures exit to the command input sequence. With these command procedures, the programmer is able to examine and replace data in memory or registers, and to begin execution at a user-specified location. Upon entry to the command input module, the operating system displays "FFFF" on the address section, and "FF" on the data section of the six character hexa-decimal LED display. The user then implements one of the three command functions by holding down the "SHIFT" key and pressing the "0," "1," or "2" keys. A "SHIFT 0" (the SHIFT key and 0 key are pressed simultaneously) tells the operating system to enter the memory display and replace function; "SHIFT 1" enters the register display and replace function, and a "SHIFT 2" enters the go execute module.

Memory Display and Replace

The memory display and replace function allows the user to examine the contents of both read-only memory and programmable memory. During operation the address and the contents of that location are shown on the respective displays.

The memory display and replace function is entered by executing a "SHIFT 0" when the system is in the command recognition mode (address display = FFFF and data display = FF). At this time, the operating system is waiting for the user to enter an address of one to four hexadecimal digits from the keyboard. As entered, these shift into the display area sequentially. If more than four digits are entered, only the last 4-digit value (shown in the address display) will be used as the address. Inputting of address data is terminated by pressing the "NEXT" key. This causes the contents of the indicated address to be displayed on the two digit hexadecimal data display. If the user wishes to display subsequent memory locations, he need only continue pressing the "NEXT" key. This will step the memory display program to the next higher memory location and display the new address and memory contents. If the user wishes to change the contents of a displayed memory location, he may enter new data by typing a two-digit value for that location before hitting the next key. This new value is loaded into the indicated address when the "NEXT" key is pressed. Pressing the "NEXT" key continues the sequential display of address and data.

Termination of this function is accomplished by pressing the "RESET" or "EXEC" buttons. Control is returned to the command recognition portion of the operating system.

Display Memory Example

Key	Address Display	Data Display
	FFFF	FF
"SHIFT O"	0000	FF
1	0001	FF
А	001A	FF
F	01AF	FF
"NEXT"	01AF	01
"NEXT"	01B0	1C
"RESET"	FFFF	FF

Memory Replace Example

Key	Address Display	Data Display
	FFFF	FF
"SHIFT O"	0000	FF
4	0004	FF
0	0040	FF
0	0400	FF

"NEXT"	0400	01
2	0400	02
1	0400	21
"NEXT"	0401	05
6	0401	06
A "EXEC"	0401	6A
The results will be:	Address	Data
	0400	21
	0401	6A

Register Display and Replace

The register display and replace function allows the user to examine and change the contents of the saved Z80 registers. This is accomplished by executing a RST 1 (warm start) during the execution of the program. During execution of this function, the contents of the registers are shown on the address display. Eight-bit registers will be displayed on the lower two digits of the address display. (The upper two digits will be zeros during the display of 8-bit registers.) A code that indicates which register is being displayed is shown on the data display. Table 6.1 describes the codes that have been assigned to the register display and replace function, as well as the key that initiates a particular register display sequence.

Code	Z80 Register	Initiating Key
(shown on data display)	(shown on address display)	
02	IX	2
03	IY	3
04	SP	4
05	PC	5
06	I	6
07	R	7
08	L	8
09	Н	9
0A	Α	А
OB	В	В
0C	C	С
0D	D	D
OE	E	E
OF	F	F
40	L'	"SHIFT O"
41	H'	"SHIFT 1"
42	A'	"SHIFT 2"
43	B'	"SHIFT 3"
44	C'	"SHIFT 4"
45	D'	"SHIFT 5"
46	E'	"SHIFT 6"
47	F'	"SHIFT 7"

 Table 6.1 Display code/Z80 register/Initiating key correspondence.

The register display and replace function is entered by pressing a "SHIFT 1" when the system is in the command recognition mode (address display = FFFF and data display = FF). At this time the operating system is waiting for the programmer to enter the one-digit register code (see table 6.1). If more than one digit is entered, only the last code indicated on the data display will be used as the reg-

ister identifier. When the central processor detects that the 'NEXT" key has been depressed, the contents of the indicated register are displayed on the address display.

If the user wishes to display subsequent registers he need only press the "NEXT" key. This causes the next register to come up with the register code and its contents. To change the contents of a displayed register the value is entered and loaded when the "NEXT" key is pressed. For 16-bit registers, the last four hexadecimal digits will be accepted if more than four characters have been entered. For 8-bit registers the last two hexadecimal digits will be accepted. When replacing register data, the "NEXT" key also causes the register code to be indexed to the next register (see table 6.1) and its contents to be displayed.

The user may terminate this function by pressing the "EXEC" key. Control is returned to the command recognition portion of the operating system.

Display Register Example

Key	Data Display (register code)	Address Display (register contents)
	FF	FFFF
"SHIFT 1"	00	FFFF
А	0A	FFFF
"NEXT"	ОA	005C
"NEXT"	OB	0063
"RESET"	FF	FFFF

Register Replace Example

Key	Data Display (register code)	Address Display (register contents)
	FF	FFFF
"SHIFT 1"	00	FFFF
5	05	FFFF
"NEXT"	05	043A
4	05	0004
2	05	0042
С	05	042C
"NEXT"	06	OOFF
"NEXT"	07	0003
"EXEC"		

Go Execute ("EXEC")

The "go execute" ("EXEC") function allows the user to change the contents of the PC (program counter) register in order to direct execution of instructions at the user-selected address.

The "go execute" function is entered by pressing a "SHIFT 2" when the system is in the command recognition mode. Now the user must enter an address of one to four hexadecimal digits. If more than four digits are entered, only the value shown in the address display is used as the address to begin program execution. Execution begins when the "NEXT" or "EXEC" keys are pressed. This causes the Z80 registers to be stored in the register save area (see the operating system listing in Appendix D) and execution begins at the user-specified address.

GO EXECUTE Example

Key	Address Display	Data Display
	FFFF	FF
"SHIFT 2"	0000	FF
1	0001	FF
Α	001A	FF
F	1ACF	FF
"NEXT"		
or		
"EXEC"		

Serial I/O Services

The ZAP computer includes a serial input/output capability that is implemented with a UART. This interface allows serial communication between the computer and peripheral devices such as a printer or a CRT. To aid the user in utilizing this capability, the operating system has a UART diagnostic module, a serial input module, and a serial output module. The input and output modules are set up as subroutines that can be called during program execution and that are not necessarily keyboard and display limited.

UART Diagnostic Module

The UART diagnostic module provides a means for checking the performance of the UART. To utilize this feature the user must first attach the serial output and input lines together so that data output from the UART may be read by the same device. The serial diagnostic subroutine is initiated by using the "go execute" function. Execution starts at $032D_{16}$.

Once started, the diagnostic module (UATST) begins by sending data to the UART and waiting for data to become available. The status of the UART is checked to verify that no fault conditions are present. In the event that a fault is detected, the status of the UART is displayed on the two low-order digits of the address display. (See table 6.2 for error codes.) If there are no errors, the data is read and displayed on the two-digit-data display. A comparison is made between the input and output data. If the 2 bytes are equal, the output character is incremented and another byte is sent to the UART to continue the sequence. This procedure continues until the "RESET" button is pressed, or until an error is detected. In the event that the input character does not equal the output character, a $0F_{16}$ is displayed in the two lower digits of the address display and the diagnostic is halted. Figure 6.1 details the logic flow of this software routine.

Displayed Code 12₁₆ or 13₁₆ 0A₁₆ or 0B₁₆ 06₁₆ or 07₁₆ 00 0F₁₆

Error

Parity Error Framing Error Overrun Error Transmitter Buffer Not Empty Input Character ≠ Output Character

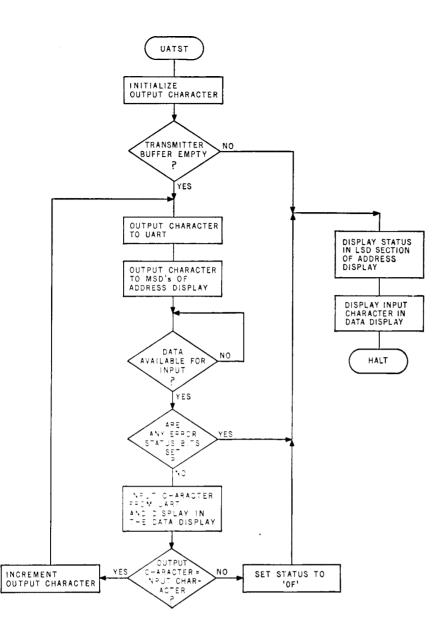


Figure 6.1 A flowchart of the UART diagnostic module (UATST).

Serial Input Module

The serial input module has been included so the user can read serial data from external devices. To utilize this capability, the user must set aside a programmable memory buffer where the input data is to be stored, and designate the number of input characters expected. The input buffer address is stored at address 07F9₁₆ in memory (see Appendix D), and the number of characters is stored at address 07FD₁₆. The communication reception begins when the TTYINP module is called.

Serial Input Initiation Example

TTYINP	EQU 035F16	Address of input module
BUFFER	EQU 07F916	Input buffer address
NCHAR	EQU 80	Number of characters to be received
TTYIBU	EQU 07F916	Operating system address constant
TTYIC	EQU 07FD16	Operating system address constant
	LD HL, BUFFER	Set buffer for operating system
	LD (TTYIBU), HL	

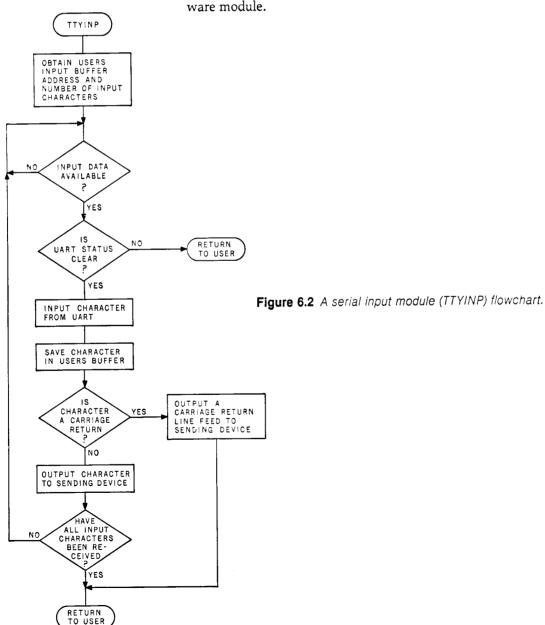
LD A, NCHAR	Set character count for operating system
LD (TTYIC), A	
CALL TTYINP	Call UART serial input routine

The data read by the serial input module will be stored in the user-specified buffer until the input sequence is terminated. When this occurs, control is returned to the user's program at the next instruction. Termination of the input process may be due to any of the following conditions:

• A status error is detected

- The number of characters read equals preset count •
- The receipt of a carriage return as an input character (ASCII 0D16)

In the event that a status error is detected, the A register will be equal to 8016 when control is returned to the user. If termination results from filling the character buffer correctly, the A register will be equal to 0016. However, if termination is the result of a carriage return, the A register will be equal to the number of characters remaining to be input. Figure 6.2 details the logic flow of the TTYINP software module.



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Serial Output Module

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The serial output module is provided to assist the user in communicating serial output data to external devices. To use this module, the operator designates an output data buffer address and the the number of characters (bytes) to be transmitted. The output buffer address must be stored at $07FB_{16}$ in memory (see Appendix D) and the number of characters to be sent is stored at address $07FE_{16}$. Data transmission starts when TTYOUT is called.

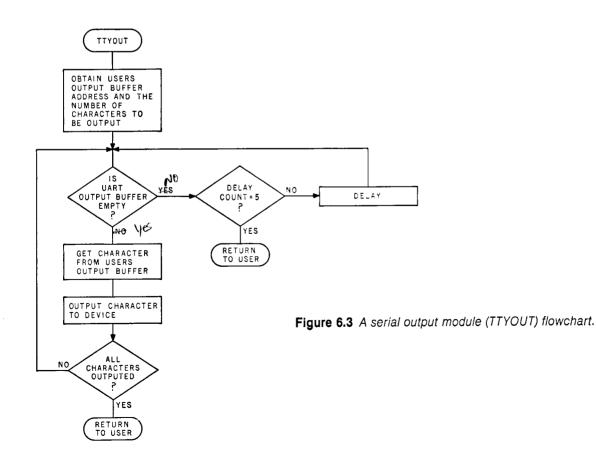
Serial Output Initiation Example

TTYOUT	EQU 039E16	Address of output module
BUFFER	EQU 07FB ₁₆	Output buffer address
NCHAR	EQU 35	Number of characters to be transmitted
TTYOBF	EQU 07FB ₁₆	Operating system address constant
TTYOC	EQU 07FE16	Operating system address constant
	LD HL, BUFFER	Set buffer address for operating system
	LD (TTYOBF), HL	
	LD A, NCHAR	Set character count for operating system
	CALL TTYOUT	Call UART serial output routine

Control will be returned to the user when

- The output buffer is empty
- The transmit buffer does not become available, indicating an error

In the event that a normal termination occurs, the A register will be equal to 00_{16} when control is returned to the user. However, if a premature termination and return are required, the A register will be equal to 01_{16} . Figure 6.3 details the logic flow of the serial output software module.



II. Operating System Module Description

II.1 Warm Start Module

The warm start module (WARM1) is responsible for saving all Z80 registers in the register save area allocated in the reserved portion of programmable memory (see Appendix D). Upon entry, the user's A, H, and L registers are saved to provide working registers for the remainder of the module operation. Next, the user's PC is removed from the stack and is saved in the memory locations reserved for it.

The AF register pair is pushed onto the stack and popped off into the HL register pair. This procedure enables the flag register to be saved in the register save area. The remainder of the user's working and alternate registers are examined and transferred to the register save area. Upon completion of this task, the module exits to the command recognition module. (See Appendix D for additional details.) Figure 6.4 details the logic flow of the warm start module.

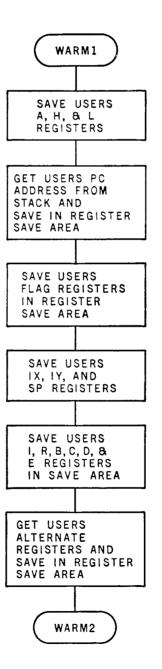


Figure 6.4 A flowchart of the warm start module (WARM1).

II.2 Command Recognition Module

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The command recognition module (WARM2) is entered after the completion of a cold or warm start sequence. When initiated, the module clears the keyboard input buffer and the keyboard flags. This removes ambiguity for future operations. The module will set the data display to FF and the address display to FFFF. When completed, the module enters the KEYIN subroutine to get an input character from the keyboard. Any input character is checked to see if it corresponds to one of the three allowable functions. If so, control is transferred to the proper function; otherwise, the input is ignored and the module waits for the next input from the keyboard. (See Appendix D for additional details.) Figure 6.5 illustrates the logic flow of the command recognition module.

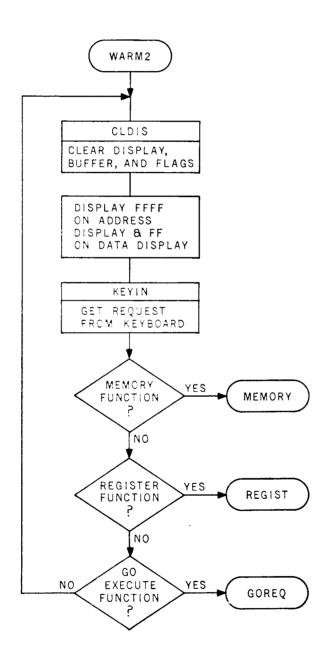


Figure 6.5 A flowchart of the command recognition module (WARM2).

II.3 Restart Module

The restart module (RESTRT) takes the values stored in the programmable memory register save area. It then restores the user's 8- and 16-bit registers before returning control to the location specified in the PC save area. This procedure restores the alternate registers, and then the working registers. In either instance, the flag registers are restored by pushing the data onto the stack and then popping if off to the F register. In order to exit to the user's restart address, the saved PC is pushed onto the stack and a "RET" (return instruction) is executed. (See Appendix D for additional details.) Figure 6.6 details the logic flow of the restart module.

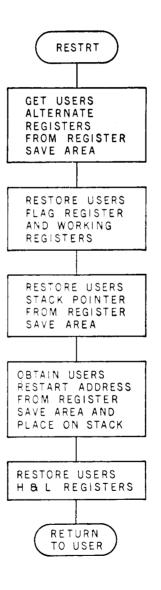


Figure 6.6 A flowchart of the restart module (RESTRT).

II.4 Keyboard Input Module

The keyboard input module (KEYIN) provides the primary interface between the computer and the user. Upon entry, it begins to read data from the keyboard input port. It stays in a loop, checking the MSB (most significant bit) of the data. The MSB is the key-pressed strobe. When it goes to a logic one level, the seven LSBs (least significant bits) of the keyboard input port are retained as the desired input character. The module then returns to the user's program with the keyboard character in the accumulator. (See Appendix D for additional details.) Figure 6.7 details the logic flow of the keyboard input module.

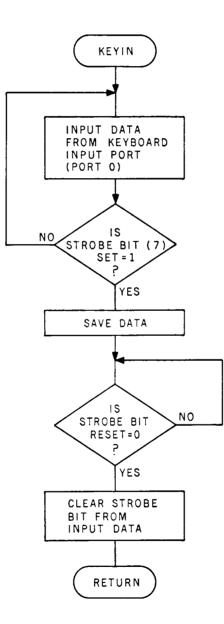


Figure 6.7 A flowchart of the keyboard input module (KEYIN).

II.5 One Character Input Module

The function of this module (ONECAR) is to input one or more characters from the keyboard. This module also indicates the last character and whether it was accompanied by a "NEXT" or "EXEC" key.

Upon entry, the input buffer and keyboard flags are cleared. (The data display may or may not be cleared depending on the requirements of the calling module.) The module waits for an input character to be passed to it. When it receives a character, it checks to see if it is a "NEXT", "EXEC", or valid data. In the event that the input is a "NEXT" or "EXEC", the appropriate keyboard flag is set along with the no data flag and control returned to the user (see figure 6.8).

If an invalid data character is received, the module is reinitiated. Upon receipt of valid data, the data is stored in a 1-byte input buffer, and the module waits for the next input character. This character is processed in a manner similar to the one just described with the following exception: in the event that the input character is a "NEXT" or "EXEC", only the appropriate flag is set before returning control to the user. (See Appendix D for additional details.) Figure 6.9 shows the logic flow of the one character input module.

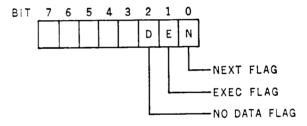
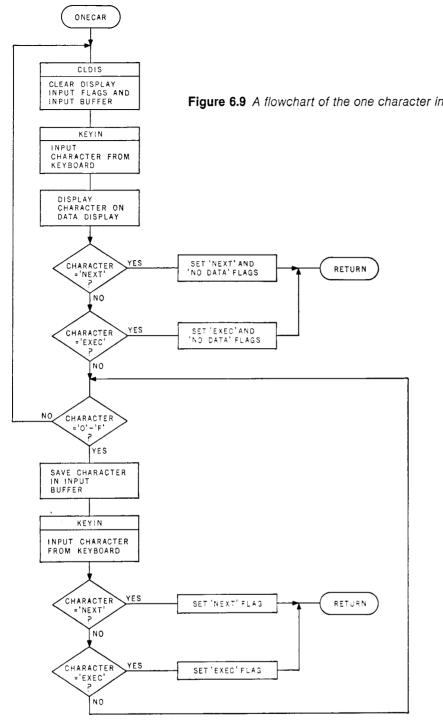


Figure 6.8 The configuration of the keyboard flags.



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Figure 6.9 A flowchart of the one character input module (ONECAR)

II.6 Two Character Input Module

The function of this module (TWOCAR) is to input one or more characters from the keyboard and transfer to the user the last two characters when a "NEXT" or "EXEC" key is pressed. The module also notifies the user of the type of termination that took place.

Upon entry, the input buffer and keyboard flags are cleared. (The data display may or may not be cleared depending on the requirements of the calling module.) This module calls the keyboard input module to obtain its input data. The first character is checked to determine if it is a "NEXT" or "EXEC"; the appropriate keyboard flag is set along with the no data flag, and control is returned to the user (see figure 6.8). If an invalid character is received, the module is reinitiated.

The receipt of valid data will cause the module to format the data as a two-digit value in the keyboard input buffer. It then returns to the user with the appropriate flags set. (See Appendix D for additional details.) Figure 6.10 details the logic flow of the two character input module.

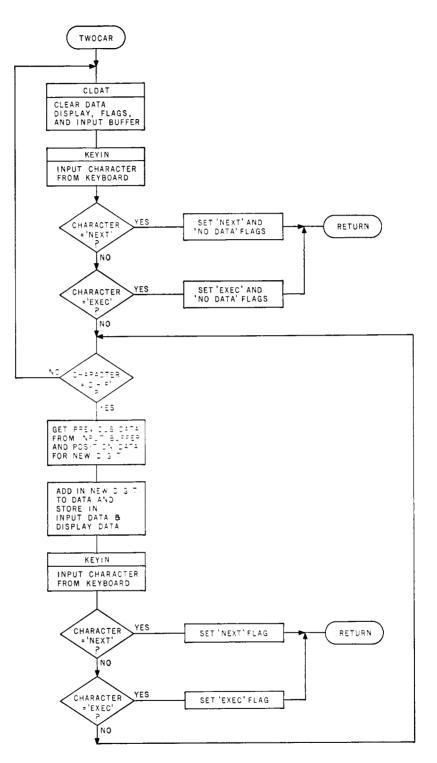


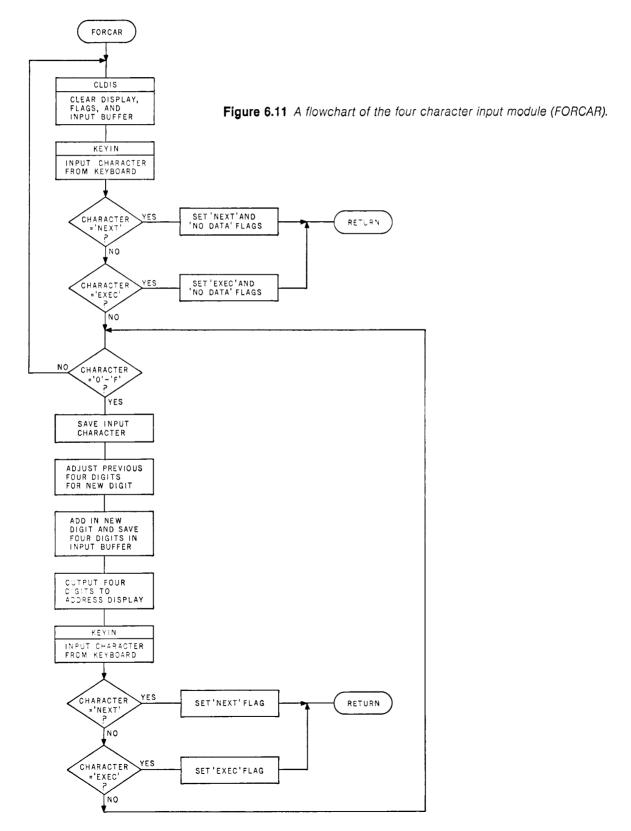
Figure 6.10 A flowchart of the two character input module (TWOCAR).

II.7 Four Character Input Module

The function of this module (FORCAR) is to input one or more characters from the keyboard and to transfer to the user the last four characters when a "NEXT"

or "EXEC" key is pressed. In the event that less than four characters are input, the higher order digits will be set to zero. The module also notifies the user via the keyboard flags (see figure 6.8).

The operation of this module is very similar to the two character input module. The main difference lies in the manner in which the new data (input from the keyboard) is merged into previous input data from the keyboard. (See Appendix D for additional details.) Figure 6.11 shows the logic flow of the four character input module.



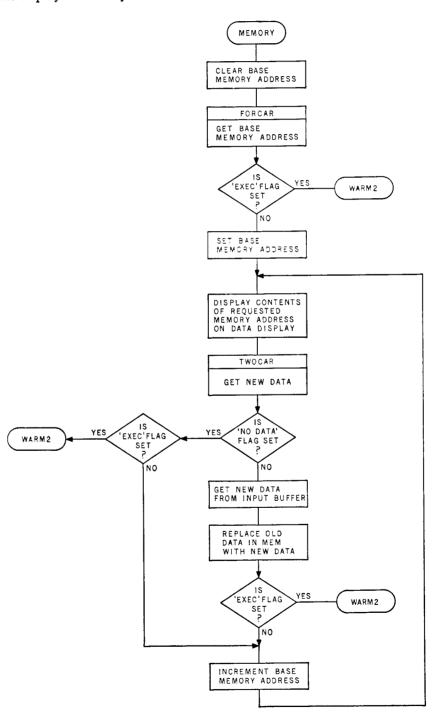
II.8 Memory Display and Replace Module

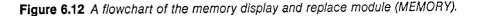
The memory display and replace function is one of the three major modules of the operating system. Upon entry (see command recognition module), this module (MEMORY) makes a call to FORCAR (four character input module) to get the base memory address at which to begin displaying the memory contents. When it returns from FORCAR, the keyboard flags are examined to determine if the "EXEC" flag is set (=1). In the event that the "EXEC" flag is set, control is transferred to the restart module (RESTRT). If the "EXEC" flag is not set (=0), the address location and memory contents are output to the appropriate displays. The TWOCAR (two character input module) is called to obtain new data from the displayed memory location.

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When control is returned from TWOCAR, the module checks the "no data" flag in the keyboard flag word. If this flag is set (=1), the "EXEC" flag is examined. If that is set, control is transferred to the command recognition module (WARM2). If, on the other hand, the "EXEC" flag is reset (=0), the user's memory address is incremented, displayed on the address display, and its contents are displayed on the data display.

If, on return from TWOCAR, the "no data" flag is reset (=0), the new data is extracted from the keyboard input buffer and stored in the displayed memory location. At this time, the module determines if TWOCAR was exited via an "EXEC" or "NEXT" directive. In the event that the "EXEC" flag is set (=1), control is transferred to the command recognition module (WARM2). If, however, the flag is reset (=0), the user's memory address is incremented, displayed on the address display, and its contents are displayed on the data display. Then the two character input module is called to get the next directive for the memory display and replace module. (See Appendix D for additional details.) Figure 6.12 shows the logic flow of the memory display and replace module.

II.9 Register Display and Replace Module

The register display and replace module (REGIST) is one of the three major modules of the operating system. This module calls the ONECAR (one character input module) to get the initial register display code from the user (see table 6.1). Upon return from ONECAR, the "EXEC" flag is checked. If this flag is set (=1), control is transferred to the command recognition module (WARM2). If the "EXEC" flag is reset (=0), the base register display index is calculated from the user's register display code.

At this time, the register index is checked to see if the register request is an 8- or 16-bit register. If the user requests a 16-bit register, the appropriate register code is displayed in the data display, and the requested register data is obtained from the register save area and displayed in the address display. The module then makes a call to the FORCAR (four character input module) to get new data for the register. Upon return, the "no data" flag is checked. If this flag is set and the "EXEC" flag is set, control is transferred to the RESTRT (restart module). If the "no data" and "NEXT" flags are set, the register data is obtained from the register and displayed in the data display. The new register data is obtained from the register save area and displayed on the address display.

If an 8-bit register has been requested, the register code (see table 6.1) is displayed in the data display, and the appropriate data is obtained from the register save area and displayed on the address display. At this time, the module calls TWOCAR to get new data from the displayed register. When the two character input module returns control, the module determines the mode of execution by examining the keyboard flags. If the "no data" and "EXEC" flags are set, control is transferred to the command recognition module (WARM2). If the "no data" and "NEXT" flags are set, the register index is incremented and the register contents channeled to the appropriate display.

If the "no data" flag is reset, the new register data is obtained from the keyboard input buffer and stored in the appropriate register save location. At this time the "EXEC" flag is checked and, if set, control is transferred to the command recognition module (WARM2). If the "EXEC" flag is reset, the register data is displayed and the user directive processed. (See Appendix D for additional details.) Figure 6.13 details the logic flow of the register display and replace module.

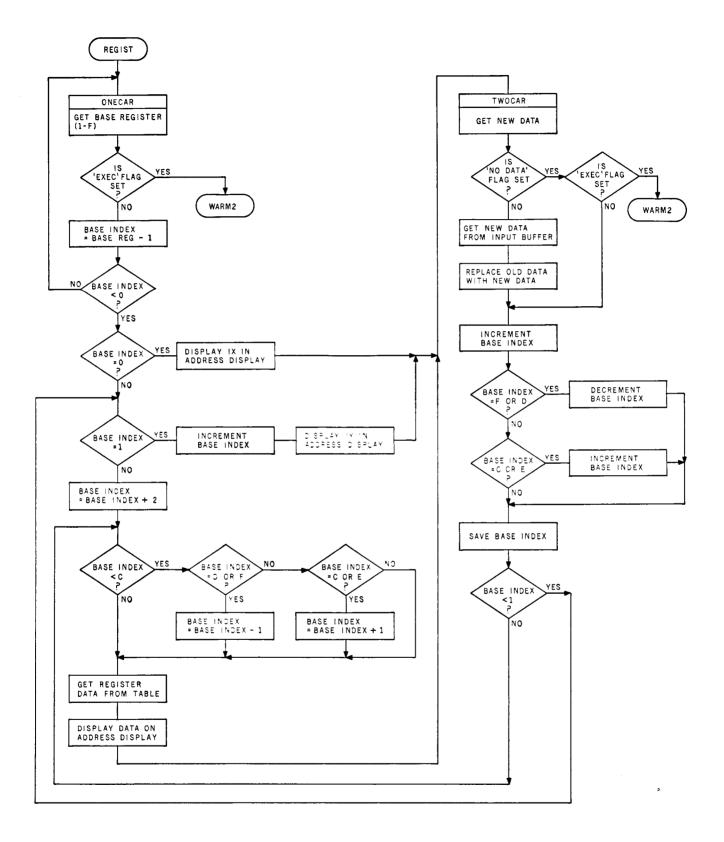


Figure 6.13 A flowchart of the register display and replace module (REGIST).

II.10 Go Execute Module

The go execute module (GOREQ) is the last of the three major functions of the operating system. Upon entry (see command recognition module), this module calls FORCAR to get the address where execution is to begin. Upon return from FORCAR, the "no data" flag is examined to determine the mode of execution. If this flag is set (=1), control is immediately transferred to RESTRT. This restores the Z80 registers and resumes execution at the PC address currently contained from the keyboard input buffer and stored in the PC save location in the register save area. Control is then transferred to the command recognition module (WARM2) which will restore the registers with the saved data, and begin execution of the user's program at the specified address. (See Appendix D for additional details.) Figure 6.14 details the logic flow of the go execute module.

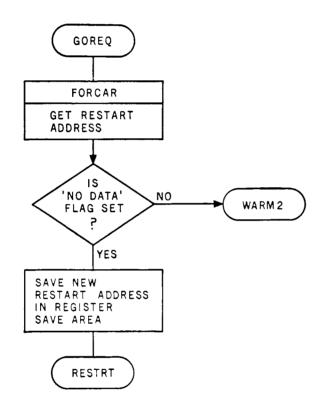


Figure 6.14 A flowchart of the go execute module (GOREQ).

CHAPTER 7 PROGRAMMING AN EPROM

The ZAP computer has been designed to be inexpensive, reliable, and easy to construct. To keep costs and complexity to a minimum, some computer features that could be helpful to a beginner have been eliminated. The most visible of the missing features are a front panel and display. While this in no way detracts from the operation of the computer, its inclusion would make initial checkout and program development easier.

To properly test ZAP, a program must be in memory. This program does not have to be very long—only a few instructions are necessary to determine whether the computer runs at all. The problem arises when the user wishes to run a program of 50 or 100 bytes in length. We end up with a "catch-22" situation. To effectively enter machine code into ZAP's programmable memory, a program that coordinates this activity must be running in EPROM. Such a program is called a monitor and is outlined in Chapter 6. The catch is that writing the monitor software into an EPROM automatically requires the monitor to be running the programmer. Fortunately, if one has an alternate way of writing the 1 K ZAP monitor into EPROM, this is no longer a problem.

Rather than leaving the experimenter to his own devices, this section includes information on programming EPROMs. To solve the startup situation, I've outlined a design for a couple of manual EPROM programmers. Loading programs on a manual programmer is tedious. They are primarily intended for much shorter routines such as checking basic system operations. However, one manual unit can be modified to load the full 1 K monitor software. When ZAP is fully operational, you can use it in conjunction with an automatic programmer. This will help in writing a number of EPROMs. In the event that you do not wish to write your own EPROM, consult Appendix A for the availability of preprogrammed EPROMs.

A Quick Review of EPROMs

It is often desirable to have the non-volatility of ROMs but the read/write capabilities of semiconductor programmable memories. An effective compromise is the EPROM. This is a read-mostly memory. It is used as a ROM for extended periods of time, occasionally erased and reprogrammed as necessary. Erasure is accomplished by exposing the chip substrate, covered by a transparent quartz window, to ultraviolet light. We'll cover erasure at the end of this chapter.

The EPROM memory element used by Intel and most other manufacturers is a stored charge type called a FAMOS transistor (Floating-gate Avalanche injection Metal Oxide Semiconductor) storage device. By selectively applying a 25 V charging voltage to addressed cells, particular bit patterns that constitute the program can be written into the EPROM. This charge, because it is surrounded by insulating material, can last for years. Exposure to intense ultraviolet light drains the charge and results in the erasure of all programmed information.

There are many EPROMs on the market—2708s, 2716s, and 2732s are the major ones. For the most part, computerists have moved away from the very difficult-toprogram 1702s and have opted for the more easily programmed 2708s and 2716s. An added benefit is their greater storage density. The newer EPROMs on the market are considerably more expensive than the 2708. All things considered, the 2708 is the best buy for the money. At slightly greater expense, you could use the 2758 for a single supply operation. For these reasons, the EPROM programmer outlined in this chapter is the 2708.

Figure 7.1 is the circuit for a manual 2708 programmer. IC 5 and two sections of IC 3 provide the +25 V program pulse to the EPROM. IC 5 is set for a duration of 1 ms and is triggered by a logic 0 to 1 transition at its input. The EPROM both sources and sinks current through programming pin 18. A combination of devices rather than a simple open-collector driver is necessary. In the write mode, when CS/WE pin 20 is at +12 V and between programming pulses, pin 18 has to be pulled down by an active device because it sources a small amount of current. The programming pulse itself is about 30 mA and cannot easily be accommodated without emitter-follower configured Q1. This pulse should be between 25 and 27 V at pin 18. Three 9 V batteries will suffice. (An alternative is to use a commercial encapsulated 24 V, 50 mA power supply. The encapsulated supply can be resistor trimmed to produce the desired 25 to 27 V.)

To write a byte into the EPROM, a 10-bit address designating which of the 1024 bytes will receive the data is preset on switches SW 1 thru SW 10. To start at location 0, all switches will be in the closed position. Next, the 8 bits that are to be stored are set on switches SW 12 thru SW 19. This data byte should be reflected on the output display LED 1 thru LED 8. Finally, to get the programmer in the write mode, switch SW 11 is set open. Actual insertion of the data occurs when the write pulse pushbutton PB 1 is pressed. This fires a 1 ms pulse of 25 V into the 2708 program pin. According to manufacturer's specifications, no single programming pulse should be longer than 1 ms. For maximum data retention, 100 of these programming pulses are recommended (totalling 100 ms per byte).

Unfortunately, 100 ms cannot be applied to a single address all at once. Manufacturers specify that it should be done sequentially and should consist of 100 1-ms applications. In short, it means that for a 25-byte program, each address should be written with one pulse and then the loop repeated up to 100 times. I have never tried to lengthen the pulse and program a 2708 faster than called for. Experience has shown, however, that some EPROMs are completely written with as few as 2 or 3 loops. Obviously, for full retention each address should be rewritten on an automatic programmer.

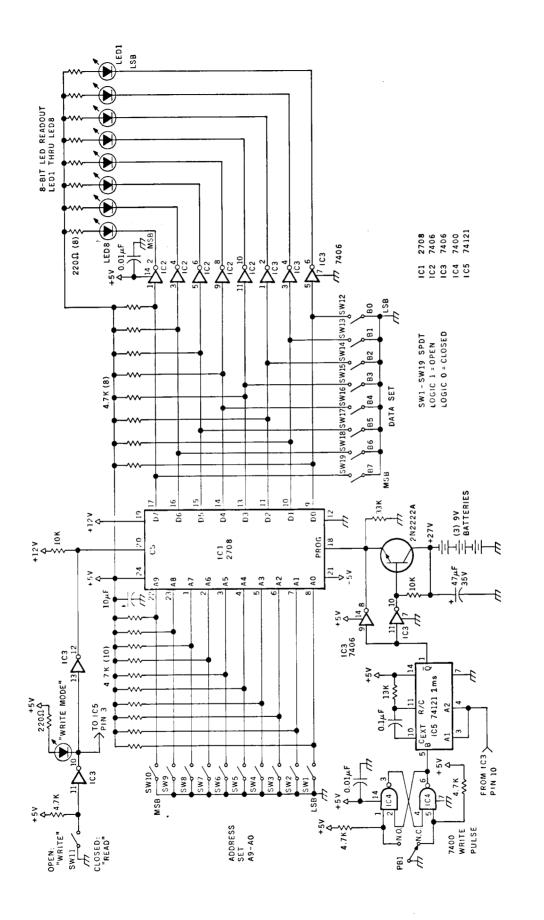
Reading back the stored contents of a 2708 is easy on the same manual programmer. First, all data input switches SW 12 thru SW 19 are opened to the "1" state and then "read/write" switch SW 11 is set in the closed or "read" mode. No other pulsing or clocking is necessary. The output display will show the contents of the byte pointed to by the address input switches SW 1 thru SW 10. It will remain constant until set to another address. Reading out the contents is simply a matter of incrementing this 10-bit address through the range of program addresses.

A slightly more complex manual programmer is demonstrated in figure 7.2. Three presettable counters are inserted between the address input switches and the EPROM. Instead of changing the switch positions for each address, they are now used only to preset the counters to some beginning address. If we want to program an EPROM starting at hexadecimal 3AA, the switches would be set to that address and the "address preset" switch pressed. The 10 LEDs, LED A0 thru LED A9, would read 3AA as the address. The data to be programmed is set on SW 12 thru SW 19. Pressing the "write data" push button PB1 (the renamed "address increment") stores the data from the switches. Successive memory locations are programmed by setting SW 12 thru SW 19 and pressing PB1. Resetting the address counter to zero is accomplished by pressing the clear button.

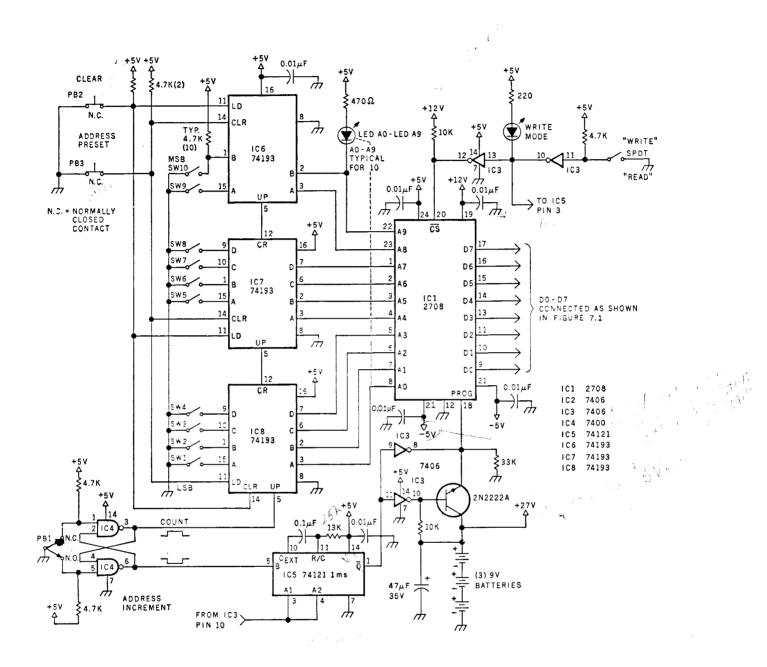
It is easy to see how this manual programmer, while not greatly improving programming time, facilitates reading memory. Put all the data input switches to the logic 1 level, set the interface to the read mode, and preset and load a start address. Readout is accomplished simply by repeated operation of the address increment button.

An Automatic Programmer

You will need an operational ZAP computer to build an automatic programmer. The







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Figure 7.2 A schematic diagram of a self-incrementing manual 2708 programmer. Light-emitting diodes (LEDs) are to be connected to all 10 address-input lines of the 2708. For clarity, only one LED (connected to address line A9) is shown in the diagram. The other LEDs are to be wired in the same way.

complexity of design can be reduced considerably by taking advantage of decoded, but to this point unused, I/O strobes provided in the basic ZAP. The circuit shown in figure 7.3 takes three less chips than the manual programmer in figure 7.2. Its operations, while similar in operation, are quite different in detail.

Four I/O strobes (input and output port 1, and input and output port 4) synchronize the hardware and software. Figure 7.4 shows the logic flow for writing an EPROM. With the EPROM connected directly to the data bus, only the strobes, rather than fulllatched registers, are necessary for this interface.

To write data, the sequence should be as follows: first, an OUT 04 pulses the address counter clear lines, setting them to 0. Next, the EPROM is set to the program mode, and the first byte is written into the EPROM with an OUT 01 instruction.

Figure 7.5 shows how the 2708 program mode is selected. The significance of this circuit is that its output is wired as a 2-bit digital-to-analog converter to control the chipselect line of the 2708.

When an OUT 04 is executed, the \overline{CS} pin will see 0 volts enabling the read mode. When an OUT 01 is executed, this voltage will be 12 V for program mode. When no strobe is present, \overline{CS} will be at +5 V and the 2708 will be three-state.

An OUT 01 fires the 25 V program pulse for 1 ms while the pertinent data is on the data bus. After that, an INP 01 is executed, which increments the address counter to the next address position. We are not actually doing any input function, but instead we are using the decoded strobe of the INP 01 instruction to mean "increment address register."

The hardware automatically keeps track of the address, but the software must implement its own counters to keep track of the 0 to 1023 positions as well as the number of times the complete 1024 bytes have been programmed. Remember, the manufacturer suggests 100 1-ms loops.

Reading the EPROM automatically is also very simple. A flow diagram of the logic is shown in figure 7.6. The address counter is cleared again by doing an OUT 04. Data is read by executing an INP 04. This data can be stored and analyzed. Finally, the address counter is incremented again with an INP 01, and the process is repeated to read the next byte.

While discussion has centered on the Intel 2708 EPROM as the most cost-effective choice, there are many other EPROMs on the market. Two devices of particular importance (should their price and availability improve by the time you read this) are the Intel 2758 and 2716. These are 1 K and 2 K single supply (+5 V) EPROMs, respectively. The significance for the experimenter is that these parts can be programmed with a single, 50 ms, 25 V program pulse to each address rather than successive 1-ms loops. The three programmer circuits presented are set up for 2708s but can be easily reconfigured for these other devices. Changing the one-shot timing pulse from 1 ms to 50 ms and rewiring a few pins will allow complete programming with just a single run through the addresses (they don't have to be successively programmed, either).

Erasing An EPROM

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EPROMs bought directly from a manufacturer come completely erased. If you plan on writing an EPROM program once, and you either don't want to modify it or you don't make mistakes, forget about erasing. The majority of computerists will want to reprogram EPROMs. It then becomes necessary to know how to erase them. We all know that EPROMs are ultraviolet erasable. However, duration, distance from the light source, and intensity determine the quality of the erasure.

People concerned about maintaining a manufacturer's specifications during the programming sequence should also be advised of the proper erasing methods. Unlike the test read-after-write-loop method for programming, EPROMs are usually removed from the circuit during erasing. Therefore, it is advisable to perform the procedure correctly, or it will have to be repeated.

The typical 2708 EPROM can be erased by exposure to high intensity shortwave ultraviolet light, with a wave length of 2537 Å. The recommended integrated dose (UV intensity \times exposure time) is 12.5 watt-seconds per square centimeter (Ws/cm²). The time required to produce this exposure is a function of the ultraviolet light intensity.

Cost and safety, equally emphasized, should be the guiding factors when selecting an ultraviolet eraser. A commercial unit not only specifies its intensity (that allows computation of exposure time), but also includes important interlocks. It is conceivable that some homebrew erasers might have improper shielding that could allow the ultraviolet light to escape or be accidentally turned on while being viewed. Such possibilities can lead to permanent eye damage.

One of the more cost-effective erasers on the market is the UVS-11E by Ultra-Violet Products, Inc, San Gabriel CA, 91776. This unit is made especially for the home computer market and includes some important safety features. The lamp will not operate unless properly seated, and if lifted from its holding tray, it will automatically shut off. At the standard exposure distance of 1 inch, the UVS-11E produces an intensity of 5,000 μ W per square centimeter (μ W/cm²). Exposure time for the 2708 is easily calculated.

Exposure time
$$(T_E)$$

 $T_E = J \div I$

Where

- J = required erasure density of device
- I = incident power density of eraser

For a 2708 which requires 12.5 Ws/cm²

$$I = 5000 \ \mu W/cm^2$$

 $J = 12.5 \ Ws/cm^2$

$$T_{E} = \frac{12.5}{5000 \times 10^{-6}} = 2500$$
 seconds

or $T_E = 41.6$ minutes for complete erasure

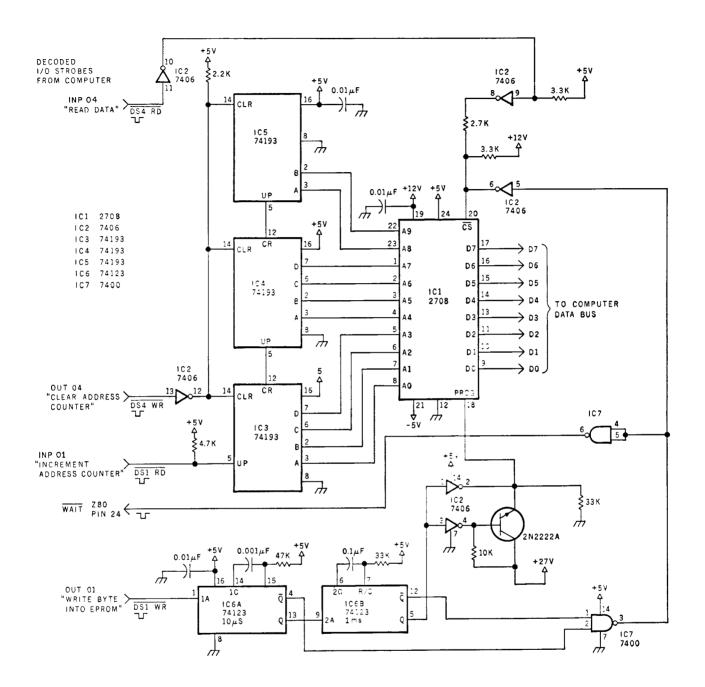


Figure 7.3 A schematic diagram of an automatic 2708 programmer.

 e^{-}

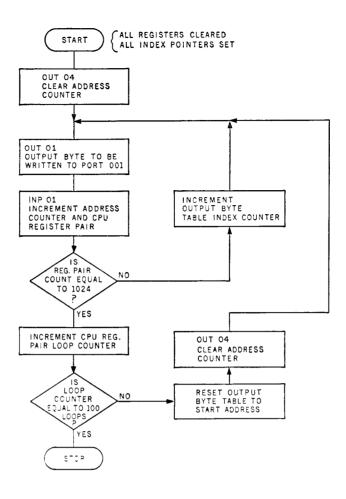


Figure 7.4 A flowchart of an automatic EPROM programmer write cycle.

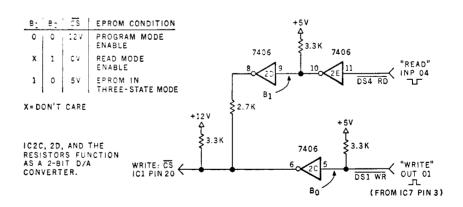


Figure 7.5 Programmable control of an EPROM \overline{CS} line in an automatic EPROM programmer.

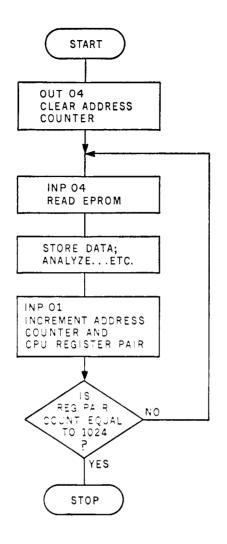


Figure 7.6 A flowchart of an automatic EPROM programmer read cycle.

CHAPTER 8 CONNECTING ZAP TO THE REAL WORLD

It's now obvious that the ZAP computer can be configured in a number of ways. Depending on your needs, you can go far beyond the basic system I have outlined. If you want a personal computer that is the equivalent of large commercial microcomputer systems, then you must add considerably more memory and peripherals. Accommodations must be made for a more powerful operating system and most probably a high-level language such as BASIC or Pascal. If you intend to use the ZAP computer as a word processing system, then a video display and printer will be required. This, in turn, necessitates adding more parallel and serial ports. Whatever the eventual configuration, the design considerations that went into constructing the ZAP computer do not change.

The ZAP computer is intended as a trainer. This book is structured in such a way that you should be able to lay out a system configuration and build it. I have not discussed what it takes to design a word processing system, or to add floppy disk storage, because it is beyond the scope of this introductory text. The support material necessary to adequately cover such an undertaking would be enough for another book. This does not mean, however, that everything is finished once the ZAP computer is constructed and you learn how to write and execute a short program. Quite the contrary; a more significant application of ZAP is to connect it to something considered part of the "real world" and have it perform some constructive task. ZAP's "power to weight" ratio makes it a natural for intelligent control applications. The real key to using ZAP effectively is learning how to connect it to the real world.

Within the framework of the direct examples I have outlined, the ZAP computer created from this book should be a single-board computer suitable for use in a variety of applications. Because it includes a serial port, two parallel ports, PROM monitor, and programmable memory, ZAP is in many respects equivalent to commercial digital controllers costing hundreds of dollars more.

Small single-board computers are most often used in data acquisition and intelligent control applications. Their function is usually to digest certain input parameters and compute a result. For example, in a 100 HP electric motor control, the inputs would be voltage, current and RPM, and the control output would be a load factor correction voltage.

In all probability, a few of these "intelligent controllers" were used by the press that printed this book. A likely place is the electronic control unit that monitors print density and automatically adjusts ink flow. The computer "reads" the print and decides whether to increase or decrease the ink flow to the paper. This decision must take into account various input parameters such as humidity, temperature, paper velocity, and specific gravity of the ink. The control algorithm written in machine code and stored in ROM shifts through all the input data and generates its conclusion in the form of a proportional output to an ink-flow valve.

In most cases, computerized functions do not stop with simple control. In any process where repeatability and quality control are important, significant process parameters are constantly monitored for deviation from preset limits and an alarm is set if the limits are exceeded. To aid in long-term analysis, the data acquisition function often includes recording raw-process data from the input sensors at specific intervals and generating a permanent log.

THE REAL WORLD

I don't want to confuse you by discussing too many commercial applications of single-board controllers. I doubt there are many web presses hidden in closets to which you want to add computer control. There are, however, many equally challenging and less esoteric applications for computer controls around the home. For example, a few that come to mind include energy management, security, and environmental monitoring. I refer to such systems as real world systems, as opposed to the TTL digital world of computers.

Because real world is anything outside of the computer, it is generally an analog environment. The metamorphosis of ZAP into an intelligent controller is dependent primarily upon effective analog interfacing. For this reason, the rest of this chapter is dedicated to the design and construction of an economical analog I/O interface.

But first let's review the basics of D/A (digital-to-analog) conversion and then discuss a method to use a D/A to perform A/D (analog-to-digital) conversion. In data acquisition systems, there is often a need to acquire high resolution multiple channels, and AC as well as DC inputs. This being the case, I will also discuss a circuit which, in effect, allows ZAP to function as an 8-channel digital voltmeter. Finally, because the temporal relationship of so many events is significant, ZAP will be configured with a real-time clock that defines the time at which control operations occur.

DIGITAL-TO-ANALOG CONVERTERS

The D/A (digital-to-analog) converter can be thought of as a digitally controlled programmable potentiometer that produces an analog output. This output value (V_{oUT}) is the product of a digital signal (D) and an analog reference (V_{REF}) and is expressed by the following equation:

$$V_{OUT} = D V_{REF}$$

To a large extent, no D A or A D converter is very useful without specifying the type of code used to represent digital magnitude. Converters work with either unipolar or bipolar digital codes. Unipolar includes straight binary and binary coded decimal (BCD). Offset binary, one's or two's complement and Gray code, is usually reserved for bipolar operation. However, we will limit our discussion to straight and offset binary.

It is important to remember that the binary quantity presented by the computer is a representation of a fractional value to be multiplied by a reference voltage. In binary fractions, the MSB (most significant bit) has a value of 1/2 or 2^{-1} , the next MSB is 1/4 or 2^{-2} , and LSB (least significant bit) is $1/2^{\pi}$ or $2^{-\pi}$ (where n is the number of binary places to the right of the binary point). Adding up all the bits produces a value that approaches 1. (The more bits, the closer that value is to 1.) The algebraic difference between the binary value that approaches 1, and 1, is the quantization error of the digital system (to be discussed later).

Offset binary is similar to straight binary except that the binary number 0 is set to represent the maximum *negative* analog quantity; the MSB is a 0 for negative analog values, and a 1 for *positive* analog values.

The conversion of digital values to proportional analog values is accomplished by either of two basic conversion techniques: the weighted-resistor D/A converter and the R-2R D/A converter. The weighted-resistor D/A converter is by far the simplest and most straightforward. This parallel decoder requires only one resistor per bit and works as follows: switches are driven directly from the signals that represent the digital number D; currents with magnitudes of 1/2, 1/4, 1/8, ... 1/(2ⁿ) are generated by resistors with magnitudes of R, 2R, 4R, ... 2ⁿR, that are connected by means of switches between a reference voltage, $-V_{REF}$, and the summing point of an operational amplifier. The various currents are summed and converted to a voltage by an operational amplifier (see figure 8.1).

While this may appear to be a simple answer to an otherwise complex problem, this method has some potentially hazardous ramifications. The accuracy of this converter

is a function of the combined accuracies of the resistors, switches (all switches have some resistance), and the output amplifier. In conversion systems of greater than 10-bits resolution, the magnitudes of the resistors become exceptionally large and the resultant current flow is reduced to such a low value as to be lost in circuit thermal noise.

A reasonable alternative to the weighted-resistor D/A converter is the R-2R converter. This is often referred to as a resistor-ladder D/A converter and is the most widely used type even though it uses more components. This circuit (see figure 8.2) also contains a reference voltage, a set of binary switches, and an output amplifier. The basis of this converter is a ladder network constructed with two resistor values, R and 2R.

One resistor (2R) is in series with the bit switch, while the other (R) is in the summing line, so that the combination forms a "pi" network. This suggests that the impedances of the three branches of any node are equal, and that a current I, flowing into a node through one branch flows out as I/2 through the other two branches. In other words, a current produced by closing a bit switch is cut by half as it passes through each node on the way to the end of the ladder. Simply stated, the position of a switch, with respect to the point where the current is measured, determines the binary significance of the particular switch closure.

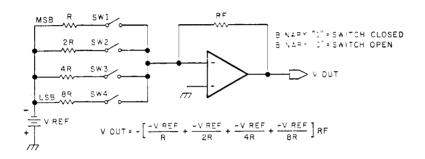


Figure 8.1 A 4-bit weighted-resistor digital-to-analog converter. A 4-bit word is used to control four single-pole single-throw switches. Each of these switches is in series with a resistor. The resistor values are related as powers of 2, as shown. The other sides of the switches are connected together at the summing point of an operational amplifier. Currents with magnitudes inversely proportional to the resistors are generated when the switches are closed. They are summed by the cp amp and converted to a corresponding voltage.

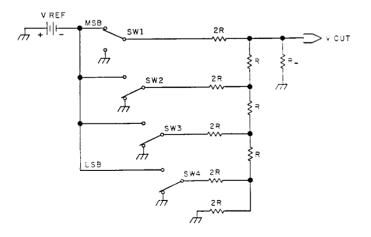


Figure 8.2 A 4-bit R-2R resistor-ladder digital-to-analog converter. This type of D/A converter makes use of a resistor-ladder network constructed with resistors of value R and 2R. The topology of this network is such that the current flowing into any branch of a 3-branch node will divide itself equally through the two remaining branches. Because of this, the current will divide itself in half as it passes through each node on its way to the end of the ladder. The four switches are again related as powers of 2. The position of each switch with respect to its distance from the end of the ladder determines its binary significance.

This type of converter is easy to manufacture because only two resistor values are needed; in fact, one value, R, will suffice if three components are used for each bit. Keeping matched resistor values with the same temperature coefficients contributes to a very stable design. Certain trade-offs are required between ladder resistance values and current flow to balance accuracy and noise.

One form of the R-2R ladder circuit is the multiplying D/A converter and is available with either a fixed or an externally variable reference. Multiplying D/A converters that utilize external variable analog references produces outputs that are directly proportional to the product of the digital input multiplied by this variable reference. These devices have either current or voltage output. The current output devices are much faster because they do not have output amplifiers that limit the bandwidth; therefore, they tend to cost less than voltage types.

An economical 8-bit multiplying D/A is the Motorola MC1408-8 (see figure 8.3). As previously mentioned, this monolithic converter contains an R-2R ladder network and current switching logic. Each binary bit controls a switch that regulates the current flowing through the ladder. If an 8-bit digital input of 11000000 (192 decimal) is applied to the control lines of the illustrated converter, the output current would be equal to (192/256)(2 mA) or 1.50 mA. Note that when binary 11111111 (255 decimal) is applied, there is always a remainder current that is equal to the LSB. This current is shunted to ground, and the maximum output current is 255/256 of the reference amplifier current, or 1.992 mA for a 2.0 mA reference current. The relative accuracy for the MC1408-8 version is $\pm 1/2$ the LSB, or 0.19% of full scale (see figure 8.4). This is more than adequate for most home computer analog control applications.

The final circuit (figure 8.5) is an 8-bit MC1408-8 multiplying D/A converter. As previously outlined, "multiplying" means that it uses an external variable reference voltage. In this case, a 6.8 V zener-diode regulated voltage is passed through a resistor that sets the current flowing into pin 14 to approximately 2 mA.

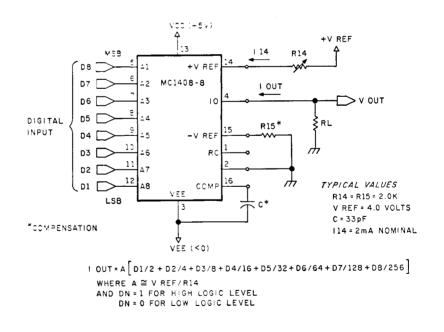


Figure 8.3 A typical 8-bit current-output monolithic multiplying D/A converter. This Motorola integrated circuit contains an R-2R network like the one in figure 8.2, plus additional current-switching logic.

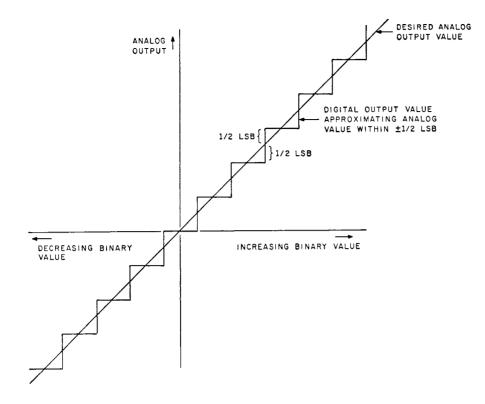


Figure 8.4 Output characteristics of a digital-to-analog converter showing least significant quantization.

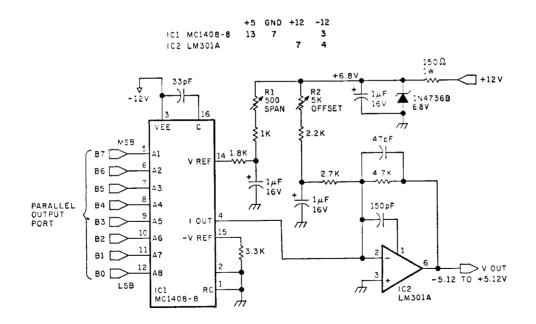


Figure 8.5 A final 8-bit MC1408-8 multiplying digital-to-analog converter with span and offset adjustments. An additional resistor, R1 (also in this current leg), allows the current to be varied by a small percentage and provides the ability to adjust the full-scale range of the D/A converter. The output is a current that is equivalent to the product of this reference current and the binary data on the control lines. The current is converted to a voltage through IC 9 and can be zero offset through the use of the offset adjustment pot, R2.

Using this circuit with the ZAP computer is simply a matter of connecting the input lines of IC 1 to a convenient parallel output port on ZAP. Any 8-bit value sent to that port will be converted to a voltage proportioned to that output.

The digital code presented to the D/A converter must be in offset binary. A binary value of 00 hexadecimal produces an output of -5 V while FF hexadecimal is equivalent to +5 V. In offset binary, if the MSB is a 0, the output is negative, and if the MSB is a 1, the output is positive. Because the converter has a range of 10 V, and is an 8-bit device, the resolution of the converter is 1/256 of 10 V, or approximately 40 mV. This means that the smallest output increments will be in 40 mV steps. To change this to finer increments requires a shorter range, such as +2.56 V to -2.56 V. By adjusting the span and zero pots, any reasonable range may be chosen, but the resolution will always be equal to the LSB or 1/256 of the range, and accuracy is estimated to be $\pm 1/2$ the LSB.

Calibration is fairly straightforward. Apply the power, and with a short program that outputs a value from the accumulator, send a binary 10000000 to the port address corresponding to the D/A interface board. Using a meter to monitor the output of the LM301A, adjust the zero pot R2 until the output is 0 V. With the same program, load in binary 1111111 to the port address and adjust the span pot R1 for a meter reading of +5.12 V. A binary setting of 00000000 should produce -5.12 V. If you are unsuccessful at this point, turn the power off and remove the MC1408-8 and the LM301A; then reapply power and verify that the binary output is correct on the parallel output port. Nine times out of ten, problems like this can be attributed to choosing an incorrect output code.

If the test is successful, you are now ready to generate analog outputs under program control. A simple test is to designate a section of memory and sequentially output the values to the D/A. If the table is 256 bytes long with the values ranging from 0 to FF hexadecimal in 01 increments, the result will be a sawtooth-waveform output. If the samples are sent to the output rapidly enough, and it is connected to a speaker, the waveform will be audible. The exact frequency will be a function of the update timing loop.

The following is a short program that exercises the D/A in such a manner:

START END OPORT SAMP	EQU EQU EQU EQU	0400 05 07 A0	Memory table start HL address Memory table end H address D/A output port number Sample rate time constant
AGAIN	LD LD OUT CALL INC LD CP JP HALT	A, (HL) OPORT, A DELY HL A, H END	Load table start address Table value to accumulator Output byte to D/A Sample time delay Test to see if at end of table If not, output the next sample
DELY DCR	LD DEC JP RET	B, SAMP B NZ, DCR	Sample rate timing loop

The table can be set to any length. Values in the table can be calculated to produce any shape waveform.

ANALOG-TO-DIGITAL CONVERTERS

It's always a good idea to discuss D/A converters first. They are rather straightforward and there are not an overwhelming number of conversion methods. By introducing them first, you will become aware of the process of binary conversion and appreciate the concepts of resolution and accuracy. Practically speaking, however, if you were going to set up the ZAP computer to serve in a data acquisition mode—say, reading and recording temperatures—you would need an A/D (analog-to-digital) converter before a D/A (digital-to-analog).

An A/D does what its name implies. It converts analog voltages into a digital representation compatible with the computer input. As in the case of an 8-bit D/A, an A/D is subject to the same conversion rules. If you are trying to read a 10 V signal with an 8-bit converter, the resolution will be 1/256 of 10 V (or 40 mV) and the accuracy will be $\pm 1/2$ the LSB.

For greater resolution more bits are necessary. The number of bits does not set the range of a converter; it only determines how finely the value is represented. An 8-bit converter (either A/D or D/A) can be set up just as easily to cover a range of 0 to 1 V or 0 to 1000 V. Often the same circuitry is used, but a final amplification stage or resistor-divider network is changed. Understand, of course, that with a range of 1000 V and an 8-bit converter, the resolution is 4 V. Such a unit would be useless on 0 to 10 V signals. The problem can be reconciled in a number of ways, but the easiest solution is to use a converter with more bits. A 16-bit converter that has 65,536 (2^{16}) steps instead of 256 (2^{8}) would cover the same 1000 V range in 15 mV increments.

For the ZAP computer, the question becomes more one of reasonable price performance than nth degree accuracy.

Analog-to-digital conversion is considerably more expensive than D/A—the price is directly related to resolution and accuracy. There are many ways that A/D conversion can be accomplished. The range varies from very slow, inexpensive techniques to ultrafast, expensive ones. An A D converter can cost as little as \$5 or as much as \$10,000. An A/D converter that scans thermistor probes and provides data to control the temperature in a large supermarket may cost \$4.75, but it cannot encode video information from an optical scanner.

The objective of this book, of course, is to help you to build your own computer; little is served by presenting designs that are beyond a reasonable budget and average construction abilities. For those reasons, I have sifted through a multitude of techniques to select four designs that can easily be built and attached through the ZAP computer's parallel interface. One of them should meet your basic data acquisition requirements.

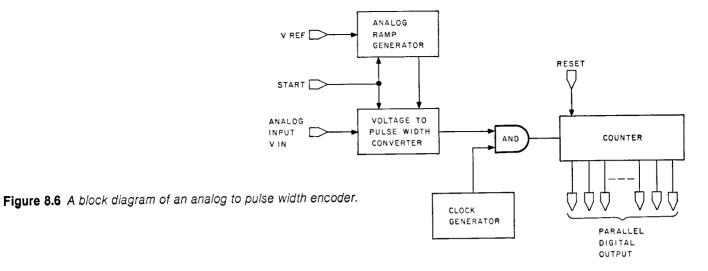
- 1. Basic analog to pulse width converter
- 2. Low cost and low speed 8-bit binary-ramp counter converter
- 3. High speed 8-bit successive approximation converter
- 4. Eight-channel 3¹/₂-digit 0-200 V AC/DC interface

PULSE WIDTH AND BINARY COUNTER CONVERTERS Analog to Pulse Width Converter

This converter is one of the most popular open-loop encoders because of its simplicity. A basic block diagram is shown in figure 8.6. This device uses a fixed oscillator in combination with a circuit that generates a pulse width that is a linear function of the analog input voltage.

To obtain this variable linear pulse width, designers frequently use a ramp generator and a Schmitt-trigger circuit. A gating pulse is started at the beginning of the ramp and a counting circuit starts incrementing at a fixed frequency. When the linear ramp reaches the same value as the input voltage, the counting is terminated. The value left in the register at that point is representative of the analog input.

Figure 8.7 is a schematic of a unipolar analog to pulse width converter that operates on this principle. IC 1 is configured as a gate controlled linear ramp generator and IC 2 is the input comparator. The process starts when the 7.5 KHz clock signal fires IC 3 (a 74121 one-shot), and starts its 35 ms period, which is the gate time. At the beginning of this gate period, a pulse that clears the two 7493s and the ramp generator is generated.



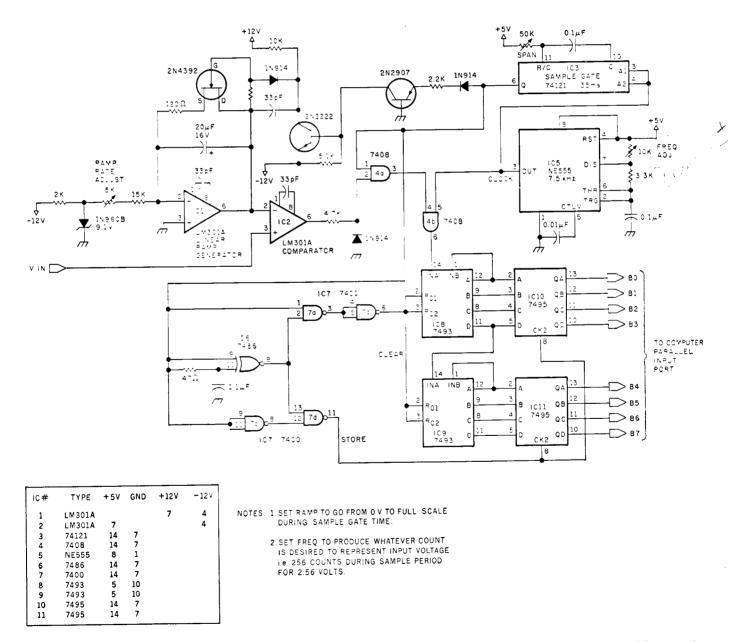


Figure 8.7 A schematic diagram of a unipolar analog to pulse width converter.

This, in turn, enables the clock signal to the counter. The slew rate of the ramp generator is set to be approximately 10 V per 35 ms. IC 2 continuously compares the input and ramp voltages. When they are equal, the clock signal to the counter is stopped and the ramp generator is reset. At the conclusion of the 35 ms gate time, whatever value is in the counter is transferred to an 8-bit storage register. The value stored in this register is an 8-bit number proportional to the input voltage. The entire process starts again on the next clock pulse.

By properly selecting the gate times and the clock rate, you can change the span and resolution of the circuit. With a gate time of 35 ms and a clock rate of approximately 7500 Hz, 256 clock pulses should be counted during the gate time. The ramp timing adjustment pot should be set so that the counter reaches maximum count when 2.56 V is applied to the input of IC 2. A 10:1 divider attached to this input will allow the same 8-bit count to represent 25.6 V.

This circuit is simple, but its accuracy depends on the stability of the individual sections of the circuit. To use it, connect the register output to a parallel input port. Simply read the port when you want the latest value. The circuit automatically updates 28 times a second, hence no reading is older than 35 ms.

Binary-Ramp Counter Converter

The above A/D technique is most often used in slow sampling rate, high-accuracy measurements. Achieving these results, however, hinges on the use of precision components and proper construction. The next most productive approach to consider is the binary-ramp counter method. In my opinion, this is the best type if you plan to construct an A/D for ZAP. It uses fewer components and, in practice, is much faster and easier to build than linear-ramp circuits.

Figure 8.8 illustrates the basic block diagram for the binary-ramp counter converter. The linear-ramp generator of the previous technique has been replaced by a D/A converter. In this case, the D/A is used to reconvert the digital output of the binary counter back to analog for comparison against the analog input. If they are equal, then whatever code is presently set on the D/A input is also our A/D output.

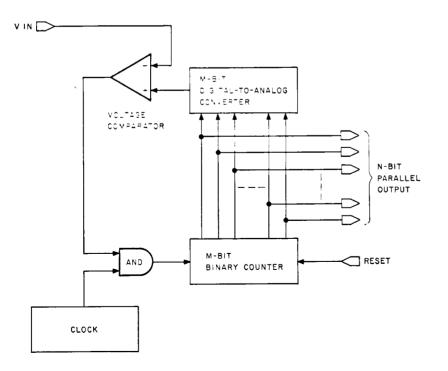
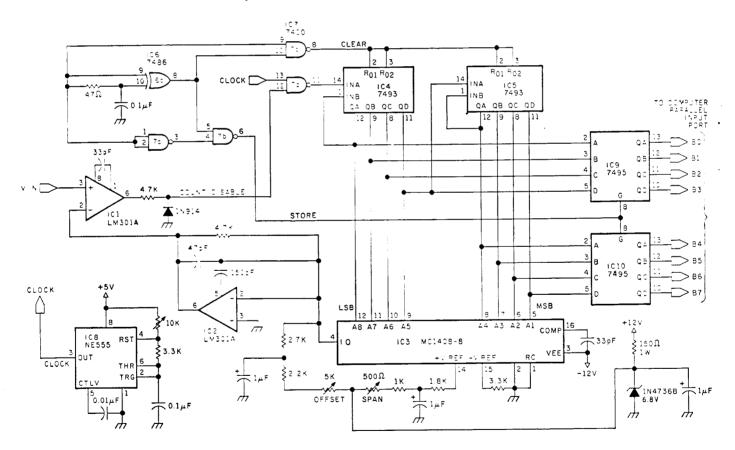


Figure 8.8 A block diagram of a basic binary-ramp counter A/D converter.

The simplest way to operate the system is to start the counter initially at 0 and to allow it to count until the D/A equals or exceeds the analog input. The only critical consideration in designing this circuit is that the clock rate cannot be faster than the response of the comparator and D/A. If it takes 100 μ s for these components to do their job, then the maximum clock rate should be 10 KHz. For an 8-bit converter (counting from 0 to 256 each sample period), the maximum sample rate is 10,000/256 or some 39 samples a second. In practice, however, 5 μ s is a more reasonable settling time, resulting in about 750 samples per second. For still higher speeds, we use a different kind of A/D (more on this later).

Figure 8.9 shows a schematic of a binary-ramp counter converter that uses a MC1408-8 multiplying D/A converter chip. The counter output is connected to the MC1408-8 to provide a direct analog feedback comparison of the value set on the counter. Initially, ICs 4 and 5 are cleared, and the D/A output should equal the minimum input voltage. For a 0 to 5.12 V converter, this would be 0 V. For a -2.56 to +2.56 V unit, it would be -2.56 V. If the output of IC 1 is less than V_{IN}, the clock pulses are allowed to reach the counter. As each pulse increments the counter, the output of the D/A keeps rising until eventually it equals or just exceeds V_{IN} on the comparator. When this happens, additional clock pulses are inhibited. At the end of the sample period, the count value of ICs 4 and 5 is stored in a separate register. For ZAP to read this data, it just requires connecting this register to an input port and reading it directly.



TYPE	+ 5V	GND	+12V	-12V
LM301A	7			4
LM301A			7	4
MC1408-8	13	7		3
7493	5	10		
7493	5	10		
7486	14	7		
7400	14	7		
NE555	8	1		
7495	14	7		
7495	14	7		
	LM301A LM301A MC1408-8 7493 7493 7493 7486 7400 NE555 7495	LM301A 7 LM301A MC1408-8 13 7493 5 7493 5 7493 5 7486 14 7400 14 NE555 8 7495 14	LM301A 7 LM301A MC1408-8 13 7 7493 5 10 7493 5 10 7486 14 7 7400 14 7 NE555 8 1 7495 14 7	LM301A 7 LM301A 7 MC1408-8 13 7 7493 5 10 7493 5 10 7486 14 7 7400 14 7 NE555 8 1 7495 14 7

Figure 8.9 A schematic diagram of an 8-bit binary-ramp counter A/D converter.

Using the Computer to Replace the Counter

Figure 8.9 is a stand-alone circuit. It does not require the computer for operation. The A/D updates itself at a preselected sample rate and loads this value into an 8-bit latch. As far as the computer is concerned, there is a steady state reading from the converter. Every function required to perform the A/D conversion is constructed from hardware components.

There are certain advantages to this approach. The A/D can be independently assembled and tested without a computer. For example, a voltage can be applied to the input and the 8-bit value can be displayed on 8 LEDs. The ability to test each subsystem independently is the way I've tried to present all the hardware in this book. If, on the other hand, you feel you've mastered the art of programming and would rather not build elaborate interfaces, much of the hardware of figure 8.9 can be replaced with software subroutines.

Consider for a moment the major elements of this design. This 8-bit A/D has four sections: D/A, analog comparator, 8-bit counter, and timing logic. The resistor ladder and analog comparator are necessary components, but the last two sections are prime candidates for synthesis through the computer. The combined function of these devices is to increment an 8-bit count and check the output of the comparator.

The ZAP computer has parallel input and output ports. By incrementing a central processor register and outputting the value after each increment, the 8 lines from the port will have all the appearances of a standard 8-bit counter made with 7493s and so on. By using one bit of an input port to read the status of the comparator, we can also replace the rest of the timing logic.

The resulting interface has fewer components and is shown in figure 8.10. The D/A remains essentially the same except that rather than being driven from two 4-bit counters, it is connected to an 8-bit parallel output port. The analog output of the D A will be whatever value is sent to the output port. Instead of hardwired logic to detect when the D/A and input voltage are equal, we attach the comparator output to bit 0 of an available input port.

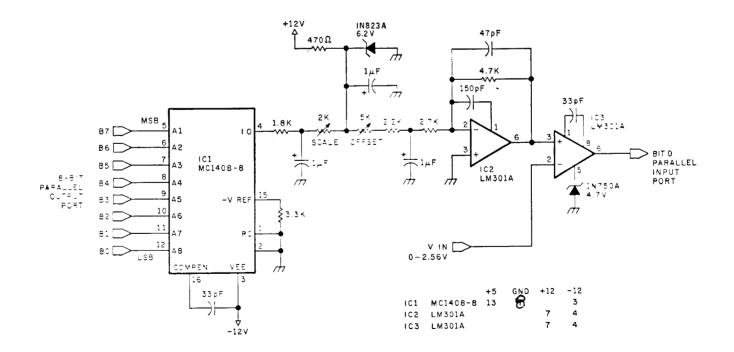


Figure 8.10 A software-driven 8-bit analog-to-digital converter.

The conversion process is not unlike the hardware version. First, we clear a register (B, for example) and then output the register value to the port attached to the D/A. This will set the D/A to its minimum output. Next, we read the input port that has the comparator attached to it and check bit 0 (a logic 1 indicates that the input and D/A voltages are equal). If the comparator is low (the voltages are not equal), the register is then incremented and the process is repeated. Eventually, the register will be incremented to the point where the D/A output and the unknown input voltage are equal. The comparator will then switch. At this point the program is halted and the value of the B register is the digital equivalent of the input voltage. The program to accomplish this follows:

	MVI	В	Clear B register
	OUT	0, B	Output B register
AGAIN	INC	В	Increment B register
	OUT	0, B	Output B register
	IN	04	Read comparator port
	ANA	01	Isolate bit 0
	JNZ HLT	AGAIN	Continue if voltages not equal A/D value is in B register

The above program should be repeated each time a new reading is needed and the sample rate can be adjusted within broad limits. Remember, however, that we still have to wait for the D/A circuitry to settle and it should not be incremented any faster than 5 μ s. Using the 2.5 MHz Z80 should not present a problem. Using a 4 MHz crystal the central processor might necessitate a few NOPs in the loop.

There are many variations on this circuit. As described, it takes up to 255 iterations of the program to find an answer. On a computer with a 2 μ s average instruction time, the program could take 3 μ s to finish, limiting us to about 300 samples a second. Add the other tasks that the computer must perform and you might be limited to 100 samples a second. Executing counting routines takes time; it will not, however, be a problem if you are merely monitoring a temperature probe that has a 30-second time constant.

If you should want to track and record fast changing signals, such as an acoustic waveform, then a much faster conversion algorithm is required. One method that speeds up the process is called successive approximation (more later).

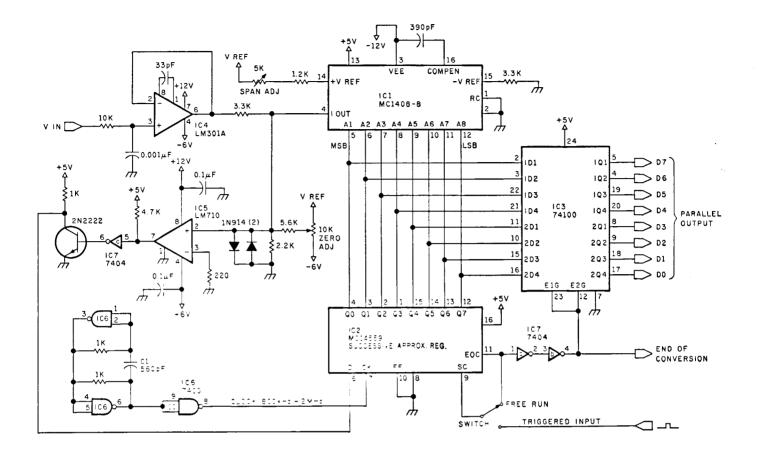
The capabilities of this circuit can be expanded in other ways. An additional CMOS multiplexor can be connected to 3 bits of another output port to turn this simple circuit into an 8-channel A/D. Also, because this circuit includes a D/A, its output is available as well.

Successive Approximation Converters

More than likely one of the three converters presented thus far will suffice for noncritical data acquisition. Slowly changing signals can be handled accurately and efficiently. However, there are occasions when the signal in question is not slow or it carries a particular transient that must be captured. For example, detecting a 100 μ s event requires a converter with a capability of 20,000 samples per second. In such cases we need a much faster conversion method.

Figure 8.11 is the schematic of a general purpose high-speed, 8-bit converter. It is capable of sample rates in excess of 200,000 samples per second. To attain these speeds, a technique called successive approximation is used. Like the binary-ramp counter converter, this A/D also incorporates a D/A in a feedback loop but replaces the counters with a special SAR (Successive Approximation Register). The circular logic of successive approximation is best explained in the block diagram of figure 8.12.

Initially the output of the SAR and mutually connected D/A are at a zero level. After a start conversion pulse, the SAR enables the bits of the D/A one at a time starting with the MSB. As each bit is enabled, the comparator gives an output signifying that the input signal is greater or less in amplitude than the output of the D/A. If the D/A output is greater than the input signal, a "0" is set on that particular bit. If it is less than the input signal, it will set that bit to "1". The register successively moves to the next least



;#	TYPE	+ 5∨	GND	+12V	-12V	-67
1	MC1408-8	13	1		з	
2	MC14559	16	8			
3	74100	24	7			
1	LM301A			7		4
5	LM710			8		4
5	7400	14	7			
,	7404	14	7			
	MC1408-8	13	1	_	3	
	LM301A			7	4	
.5	2. ALL CAP	ACITO	IDICATE	ED. E 100 V C	ERAMIC	S
ES	OTHERW 2. ALL CAP UNLESS 3. WITH CC CY IS 8	ACITO OTHE OMPON	IDICATE RS ARE RWISE ENTS S THIS	ED. E 100 V C INDICATI HOWN, C	ERAMIC ED. CLOCK FR DO CONVE	EQUEN
ES	OTHERW 2. ALL CAR UNLESS 3. WITH CC CY IS 8 PER SEC 4. THE FOL	VISE IN PACITO OTHE DMPON 00 kH2 COND	IDICATE RS ARE RWISE ENTS S 2. THIS IN FREE NG CIRC PIN OF	ED. E 100 V C INDICATI HOWN, C IS 100,000 E RUN MC CUIT CAN IC3 IF A + 5V ↑	ERAMIC ED. DLOCK FR DO CONVE DDE.	EQUEN RSIONS

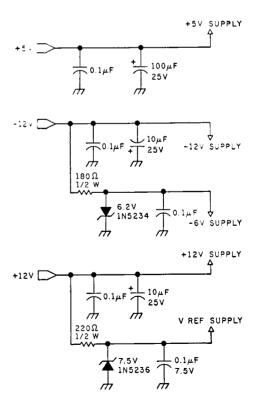


Figure 8.11 A schematic diagram of an 8-bit successive approximation A/D converter.

CONNECTING ZAP TO THE REAL WORLD 195

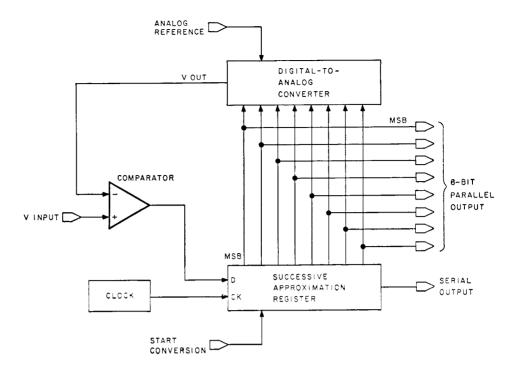


Figure 8.12 A block diagram of a typical 8-bit successive approximation A/D conversion system.

significant bit (retaining the setting on the previously tested bits) and performs the same test. After all the bits of the D/A have been tried, the conversion cycle is complete. As opposed to the 256 clock pulses of the binary counter method, the entire conversion period takes only 8 clock cycles. Another conversion would commence on the next clock cycle when it's in the free-run mode. To retain the 8-bit value between conversions, an 8-bit storage register IC 3 has been added. To use this A/D, simply connect the output of this latch to an 8-bit input port.

The components of the D A circuit are changed slightly from previous implementations to increase the speed, and a faster comparator is used. With a clock rate of 800.000 Hz, the circuit will do 100.000 conversions a second. Because they are automatically loaded into the 8-bit-holding register IC 3, the update is transparent to the computer and can be read at any speed. The sample rate is a function of the clock rate. If it is unnecessary to have such a high sample rate, it may be reduced by increasing the value of C1. High speed A/D converters are susceptible to layout and component selection. While 200,000 samples per second is attainable, 20,000 samples per second might be more practical.

A Unique Application for a Fast A/D

When we first considered adding an A/D to ZAP, our thoughts centered on monitoring some process or turning ZAP into an intelligent controller. In most cases, this requires one of the simpler A/D converters I've outlined. However, with the addition of a high speed A/D peripheral, a few more experiments come to mind.

Most often when we think of high speed analog, we want to capture video or other high bandwidth phenomena that have a voltage level within the range of the A/D. Of course, the audio frequencies, while much lower than video, may also require a high performance A/D for proper representation.

The bandwidth of the human voice is about 4000 Hz. These analog signals, when spoken into a microphone and fed to an A/D, can be digitized just like any other waveform. And, if our voice samples are taken quickly enough and stored, the accumulated data can be used to reconstruct the same voice. This reconstructed voice is called digitized speech.

In essence, digitized speech is simply the result of a standard data acquisition technique. When speaking into a microphone and amplifier, your voice results in a fluctuating waveform, whose frequency rate varies. If this signal is applied to the input of a high speed A/D, and the conversions stored in memory, the computer couldn't care whether the source was speech or a nuclear reaction. The analog fluctuations would be digitized at discrete sampling intervals and stored. If the stored samples are output to a D/A at the same rate they were taken, speech will be reproduced. The fidelity of this reconversion is a function of the sampling rate.

Most of the intelligence or information content of human speech occurs in the frequency region below 1500 Hz. Obviously, sampling this waveform at 25 samples per second would be useless. It must be sampled very rapidly to retain anything of significance.

There is a specific law known as the "Nyquist criterion" that is used to determine the optimal sampling rate. In theory, this law states that at the very minimum, the sample rate must be twice the frequency of the input waveform. Thus, if the human voice extends to 4 Hz, then the minimum rate should be 8000 samples per second. This also presumes an ideal filter on the output, the existence of which is about as ephemeral as perpetual motion. In actuality, the sampling rate should be 3 or 4 times the highest input frequency. To digitize voice accurately requires a sampling rate of 12 Hz to 16 Hz. If, on the other hand, we shoot for just the lower frequencies, we can get by with 3 Hz or 4 Hz.

The possibility of using this speech technique has to be considered in light of the availability of large amounts of memory. At a 4 Hz sample rate, one second of speech takes 4000 bytes of memory. If you have added more than the 2 K of memory in the original configuration of ZAP, then perhaps you'll want to experiment with digitized speech. Even with just 2 K you should hear something.

A fairly simple program is needed to coordinate the digitization process and store the data:

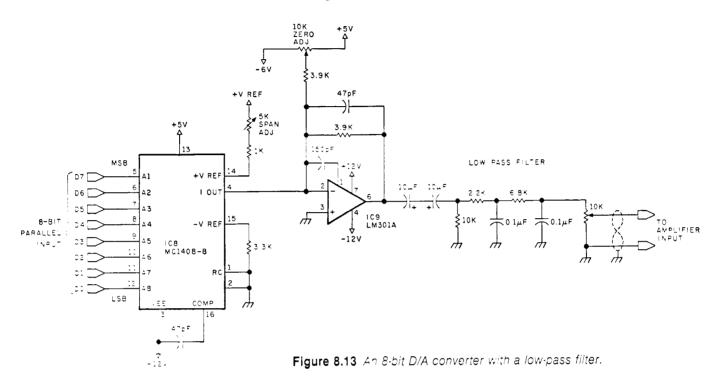
START END TRIG IPORT SAMP	EQU EQU EQU EQU EQU	400 C00 A8 04 38	Memory table start HL address Memory table end H address Input start conversion level A/D input port Sample-rate time constant
INP	IN CP JP LD	IPORT TRIG NZ, INP HL, START	Read A/D input value Compare input to trigger level Loop again if below trigger level Load table start address
AGAIN	IN LD CALL INC LD CP IP	IPORT (HL), A DELY HL A, H END NZ, AGAIN	Take a sample Store sample in memory Delay between samples Test to see if at end of table If not, take another sample
	HALT	,	
DELY DCR	LD DEC JP RET	B, SAMP B NZ, DCR	Start delay timer

When the program is executed, it will scan the A/D input port and compare the reading to A8 hexadecimal (about 65% of full scale). When speech is present, the audio level will presumably exceed this trigger level. When this happens, the program sets the address of the storage table and starts dumping data samples into it at a rate of about 4000 per second. The rate is determined by the value of "SAMP." The higher the number, the lower the sampling frequency. When the table is filled, the program stops and the memory will contain a digitized representation of whatever was spoken during the sample time. For 2 K of memory, only $\frac{1}{2}$ second of speech will be captured.

To hear this stored data, use the program outlined in the section on D/A converters.

Set the limits to be the area of the memory table, then choose a time constant that results in putting out the samples at the same rate that they were taken. (It is also possible to create a digital reverberation system using this hardware, but for decent fidelity 12- or 14-bit converters are required.)

Because digitized speech is a specialized application, the D/A circuit is modified slightly to include a low-pass filter. This will improve the sound quality. The modified circuit is shown in figure 8.13.



Using ZAP for High Resolution Data Acquisition

Up to this point our discussion has concerned experimenting with ZAP. Some aspects of these designs are useful in noneducational applications, but for the most part they are intended more as teaching aids than as replacements for expensive monitoring equipment. However, it is possible to add more specialized interfacing to ZAP which allows it to be used in such a manner.

The 8-bit A/D converters presented thus far have limited resolution and are singlechannel devices. They are adequate for measuring temperature in a solar heating system, but it is doubtful that they have the resolution to monitor the temperature gradient along a length of heating duct. The sensors used to measure such parameters would need to have a higher resolution than ambient air temperature sensors. For a range of -20 to 108° C, an 8-bit A/D could provide 0.5° resolution. In a solar heating application, considering the variations in air movement, cloud cover, and general weather patterns, this is as much resolution as you would need. Within the system, however, there are areas that will require closer measurement.

A solar system is a typical example. After installation the next step is usually to investigate how to increase its efficiency. Nine times out of ten this requires cutting heat losses in the pipes and ducts. One way to determine such loss is to place temperature sensors along the heat distribution path and look for cold spots. The measured differences between sensors may be very small, a few tenths of a degree or so, but the overall losses could be significant. Measuring temperatures to tenths or hundredths of a degree and maintaining the same dynamic range requires more than 8-bit resolution. Something between 10 and 12 bits is needed.

The situation is further complicated by the large number of points that may need monitoring within a system. It's rare to find only one temperature indicator in the system. At the very least there would be six: inside air, outside air, storage tank top, storage tank bottom, collector, and distribution air temperature. Very few commercial data acquisition systems use a single channel. Usually they come with either eight or 16 multiplexed channels. The input of one A/D converter is switched (usually on a demand basis) between the channels and the results are compiled and averaged by the computer. This information can be logged on recording tape, transmitted serially to another system, or used to run a real-time display. What one does with the data is a function of the application program.

There are various ways to configure ZAP for high-resolution data acquisition. One is to simply to replace the 8-bit A/D with a 12-bit binary converter. When the conversion is finished, 12 bits of parallel data are available. Depending upon the converter chosen, many outboard analog components might still be required, but the process is straightforward. Unfortunately, these converters are not what you would call inexpensive. Although they are becoming cheaper every day, at this writing they are still considerably more expensive than 8-bit converters of similar speed.

Most 12-bit binary converters are expensive because they are designed to give the appearance of parallel converters. Toggle the convert enable line and zip, there's 12 bits of answer. When the computer wants this data, it scans, manipulates, and stores it in a table for use by other programs. Making the hardware section of an A/D interface less expensive involves doing less in parallel. Taking the alternative serial approach generally requires more time and additional data manipulation. We can opt for the ^{*}Owest expense and let our computer do most of the work. We have already demonstrated how to eliminate counters and timing logic by doing these functions in software.

An 8-Channel 31/2-Digit AC/DC Interface for ZAP

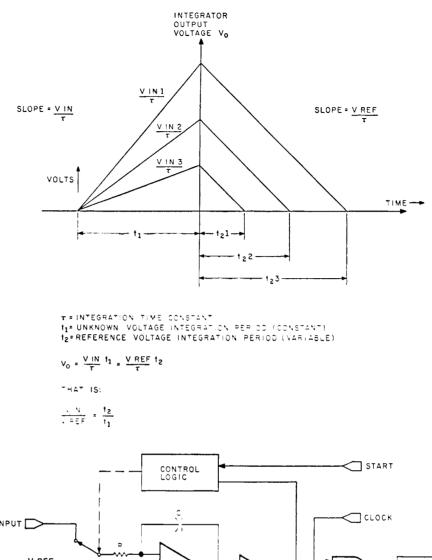
The solution to the high resolution versus expense question comes in the form of a $3\frac{1}{2}$ -digit multiplexed A/D converter chip. The MC14433 CMOS integrated circuit is intended primarily for use in digital voltmeters (DVMs) but enjoys a variety of other applications because of its versatility. It is a single-channel 11-bit converter, but it is called $3\frac{1}{2}$ digits. The output is BCD (binary-coded decimal) and it specifically covers a range of -1999 to +1999 counts. Basic chip specifications are as follows:

MC14433 3¹2-Digit A/D Converter

Accuracy: $\pm 0.05\%$ of reading ± 1 count Two voltage ranges: 1.999 V and 199.9 mV 25 conversions per second 1000 M Ω input impedance Auto zero Auto polarity Over, under, and auto ranging signals available

The MC14433 is a modified dual-ramp integrating A/D converter and is outlined in figure 8.14. The conversion sequence is divided into two integration periods: unknown and reference. During the V_{IN} (unknown input) integration sequence, the unknown voltage is applied to an integrator with a defined integration time constant for a predetermined time limit. The voltage output of the integrator then becomes a function of the unknown input input. The more positive the input, the higher the integrator output.

During the second cycle of the integration sequence, a reference signal of 2.000 V is connected to V_{IN} . This causes the integrator to move toward zero while the digital circuitry of the chip keeps track of the time it takes to reach zero. The time difference between the two integration sequences is then a function of their voltage difference. If 2.000 V were the applied V_{IN} then t_2 would equal t_1 . The unknown voltage is equivalent to the ratio of the periods times the voltage reference (V_{REF}). This is also known as a ratiometric converter. The full scale of the converter is determined by V_{REF} . Changing V_{REF} to 0.200 V will make the 1999 count output represent 199.9 mV instead of 1.999 V full scale.



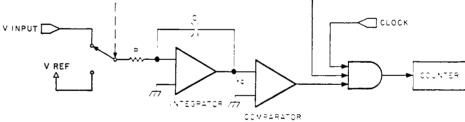


Figure 8.14 A simplified representation of a dual-ramp A/D converter.

The output of the DVM chip is a combination of serial and parallel data. There are 4 digit-select and 4 BCD data lines:

BCD Out	put Lines
Pin 23	Q3 (MSB)
Pin 22	Q2
Pin 21	Q1
Pin 20	Q0
<u>Digit-Sele</u>	ct Outputs
Pin 19	DS1 (MSD)
Pin 18	DS2

DS1

DS0

Pin 17

Pin 16

With respect to what the computer sees through 74LS04 output buffers, the digit select output is low when the respective digit is selected. The most significant digit ($\frac{1}{2}$ DS1) goes low immediately after an EOC (end-of-conversion) pulse and is followed by the remaining digits in a sequence from MSD to LSD. The multiplex clock rate is the system clock divided by 80; two clock periods are inserted between digit outputs.

During DS1, the polarity and certain status bits are available. The polarity is on Q2 and the $\frac{1}{2}$ digit value is at Q3. If Q2 is a "1", then the input voltage is negative, and if Q3 is a "0", then the $\frac{1}{2}$ digit is a 0.

Figure 8.15 details the schematic of the 8-channel interface board. As shown, it has the following capabilities:

ZAP 31/2-Digit DVM Interface

- 8 programmable-input channels
- AC or DC input capability
- Programmable gain of 1, 10, or 100
- Ranges of 0-200 mV, 0-2 V, 0-20 V, or 0-200 V
- Input overvoltage protection

IC 1 is the MC14433 DVM chip. It is set for approximately 25 conversions a second and all outputs are buffered. IC 2 is a precision voltage reference chip that supplies the V_{REF} signal. It is nominally 2.5 V and is trimmed to 2.000 V and 0.200 V with two potentiometers. While a zener diode might provide the same voltage, the temperature drift associated with such components makes them inadvisable in this application.

IC 5 is configured as a set reset flip-flop. When the conversion is finished, an EOC signal sets IC 5, indicating to the computer that data is available. When the computer finishes reading the data, it resets this flip-flop and awaits the next conversion.

ICs 1, 2, 3, and 4 constitute a single-channel $3\frac{3}{2}$ -digit converter. It has a range of either 0.200 V or 2.000 V determined by V_{REF} . To achieve multichannel operation and AC capability, it is necessary to place an input multiplexer and AC to DC converter in front of IC 1.

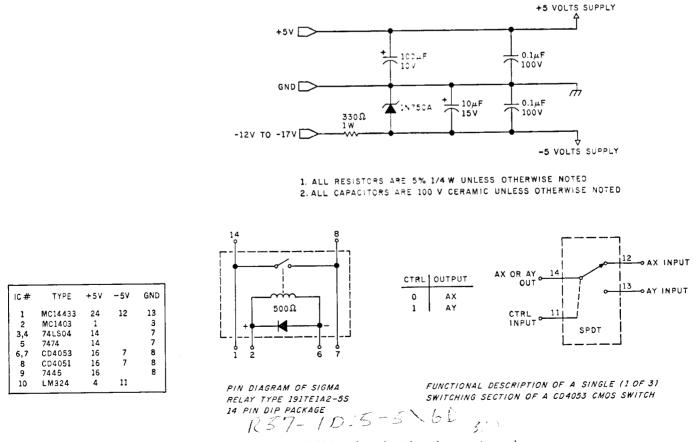


Figure 8.15 An 8-channel 31/2-digit 0-200 V AC/DC DVM interface (continued on next page).

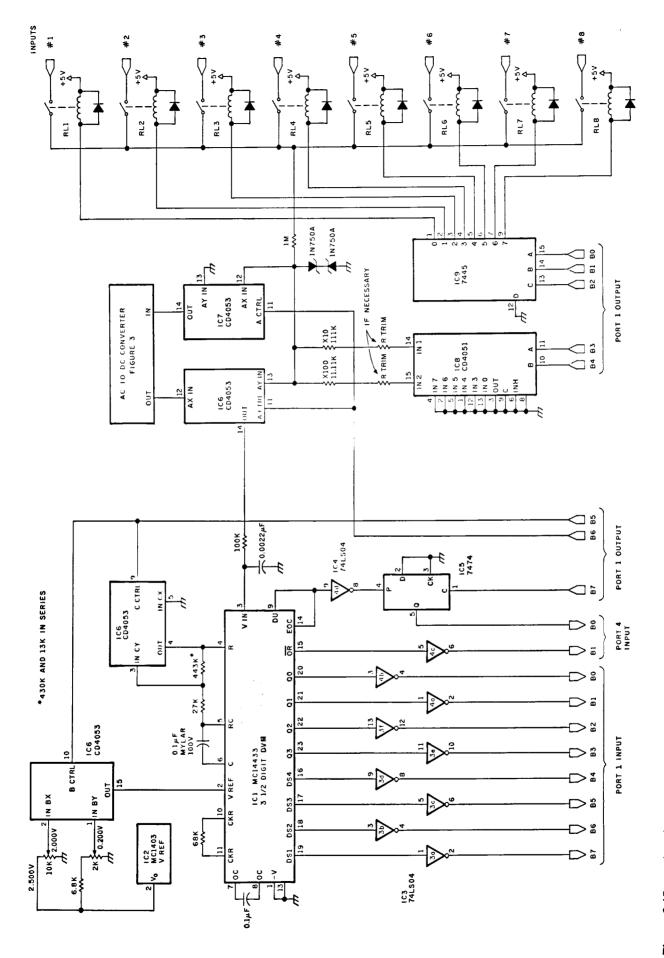


Figure 8.15 continued

Figure 8.16 shows the voltage reference and range selection setup of this interface. The MC14433 can cover either 0–199.9 mV or 0–1.999 V. The ranges depend upon the level of V_{REF} . When B5 of port 1 is low, switches 5 and 6 are in the positions shown. This would apply 2.000 V to V_{REF} input and set the integration time constant with an 82 k Ω resistor. With B5=0, V_{REF} is 0.200 V, and the integration resistor is 10 k Ω .

Figure 8.17 illustrates the input subsystem in simplified terms. SW1 and SW2 represent the gain selection section. As shown, the gain is 1 and no divider network is enabled. When an input relay is closed (controlled through IC 9), the input voltage of that channel is sent directly to the input of IC 1 through a 1 M Ω resistor. If the interface is set for DC and a gain of 1, a 1.400 V input signal at channel 3 would be read directly as 1.400 V by the DVM chip. If, however, 150 V were suddenly applied, it would be shunted through Z1 and Z2, which protect IC 1. The data read by the computer will indicate an out of range condition because the input would be shunted to 4 V.

Closing SW1 or SW2 forms a divider network that allows the computer to read these higher voltages. A 10:1 divider is formed by closing SW1. The result is a divider network consisting of the 1 M Ω resistor R1, and a 111 k Ω resistor R2 to ground. An 8 V input signal would be read as 0.800 V at the input of IC 1. The programmer should keep in mind that a divider was used on that channel and multiply the answer by 10 when recording it.

Closing SW 2 forms a 100:1 divider. The mathematics is the same except that the resistor (R3) is now 11.11 k Ω . An 8 V input would become 0.080 V and a 150 V input would become 1.500 V. Obviously, proper range selection is necessary to maximize resolution.

An additional feature of this interface is the ability to accommodate AC inputs. This is accomplished by simply converting the AC signal to DC after the divider section output. IC 6 and IC 7 function as single-pole, double-throw switches to gate the converter in or out of the signal path. The actual AC-to-DC converter is shown in figure 8.18.

This device is known as an average RMS (Root Mean Square) converter. If you apply a 1.0 V peak AC signal to it, it will output 0.707 VDC. This is the technique used in most digital multimeters. This is also the way we commonly express AC voltages. For example, household 115 VAC is 115 V average RMS. The peak is about 176 V. The converter passes both AC and DC because there is no blocking capacitor on the input. If it is inadvertently switched into a DC signal, it will multiply the reading by 1.414.

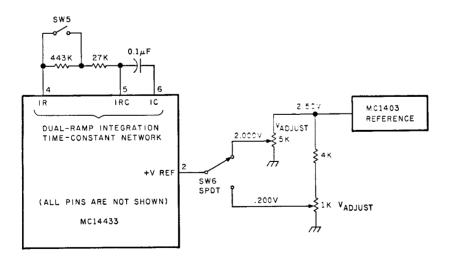


Figure 8.16 Voltage reference and integration time-constant modification circuitry for the digital voltmeter.

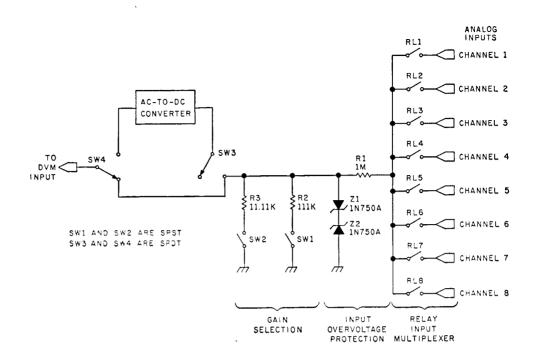


Figure 8.17 DVM input conditioning sections.

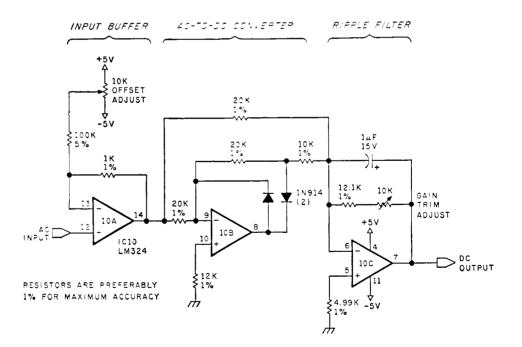
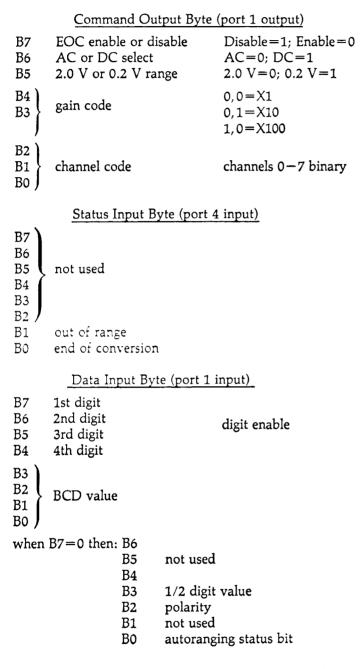


Figure 8.18 A schematic diagram of an AC-to-DC converter.

Exercising the Interface with a Software Driver

The interface is attached to ZAP through I/O ports. It takes 10 input bits and 8 output bits for full operation. They are arbitrarily chosen as ports 1 and 4 for this description. The actual choice will depend on what addresses you wire when you are configuring ZAP. These ports are not used for anything in the original description and will require the proper port hardware to be added. Summarizing the I/O requirements for the DVM (digital voltmeter) interface:



This interface uses a software driver to reduce hardware complexity. The program is not unlike a communications driver. To obtain data from the interface effectively, the computer must be synchronized with the DVM chip and must perform a specific sequence of operations to demultiplex the input data stream.

The actual program that interfaces to and stores the values from the DVM chip is written as a subroutine. All the information necessary for proper execution of the driver is provided in the DE register pair at the time of the call. Its contents will tell the interface which channel to set, whether it should be AC or DC, and which V_{REF} and gain to use. One channel is converted every time the driver routine is called.

The information set in the DE register pair at the time of the call is the command out-

put byte (port 1 output), and each bit has the designations previously listed. The only difference is that bit 7 (the enable/disable bit to the A/D converter) is sent as a logic 0 when doing a call. The driver will set it to an enable condition after it has pulled in the proper relay and allowed a 1.3 ms bounce delay.

Demultiplexing the output of the DVM chip is fairly straightforward. Following the call, the outputs to the interface close the proper switches, and the central processor hangs in a loop waiting for an end-of-conversion signal. When this happens, the program knows that the next 4 digits of data are what it wants. The DVM chip sets each of the digit select lines successively, and the program records the values of the 4 BCD data lines each time. It strips the status and polarity bits from the MSD $\frac{1}{2}$ -digit byte and reformats and stores the voltage input value in 4 bytes of memory. The 3 whole digits are stored in BCD notation and occupy 3 of the bytes. The $\frac{1}{2}$ digit, polarity, and out of range indication are located in the fourth byte. Polarity is indicated by setting the MSB. A positive reading is a logic 1 and a negative input is a logic 0. The $\frac{1}{2}$ -digit value can only be a 0 or 1 and occupies the LSB of the quantity. Out of range is handled with a little program manipulation. If the driver detects that the incoming reading is not within range, it sets the equivalent of +2 in the $\frac{1}{2}$ -digit byte. Obviously, this is an illegal condition for a DVM only capable of counting to 1999. The programmer using this stored data should check the limits of the data before acting upon it.

When the driver completes its operation, it has acquired a 3¹₂-digit reading and stored it as 4 bytes in a special table in memory. The 8 channels of data constitute a 32-byte table. The location of a particular channel's data is found by a simple expression:

The 4-byte data starts at memory location L+4(N-1)

where L = starting address of memory table N = channel number (1 to 8)

Figure 8.19 is the assembly listing of the program that exercises this DVM interface. When assembled, it occupies less than a page of memory.

Note: One caution should be kept in mind when measuring AC signals with this interface. The ground on the DVM interface is the same as the computer's and a potential short circuit exists unless either the computer power supply or the measured voltage is isolated.

```
0100 *
0110 *** MC14433 3 1/2 DIGIT A/D CONVERTER DRIVER
0120 *
0125 * REV. 1.9
0130 *
                           DATA INPUT PORT NUMBER
0140 DIP
             EQU
                  1
                           STATUS INPUT PORT NUMBER
0150 SIF
             EQU
                  4
                           COMMAND OUTPUT PORT NUMBER
0160 COP
             EQU
                  1
0170 EE0C
             EQU
                  200
                           ENABLE EOC INPUT
0180 DECC
             EQU 000
                          DISABLE EOC INFUT
0190 *
0200 *
0210 * CONVERTED CHANNEL DATA BUFFERS
0220 *
             ΠW
                   000000
0230 CHANO
0240
             Tilu
                   000000
0250 CHAN1
             ΠW
                   000000
0260
             τiω
                   000000
0270 CHAN2
             ΣIW
                   000000
             ΣiW
                   000000
0280
0290 CHAN3
             TIW
                   000000
0300
             ΠW
                   000000
                                Figure 8.19 A listing of the assembly-language
             TIW
                   000000
0310 CHAN4
                               program that exercises the digital voltmeter.
                   000000
             IW
0320
                   000000
0330 CHAN5
             IW
0340
             ĽιW
                   000000
```

ΠW 000000 0350 CHAN6 DΨ 000000 0360 TIW 000000 0370 CHAN7 000000 ΠW 0380 0390 * 0400 * INTERMEDIATE DATA BUFFERS 0410 * ΠB 000 CURRENT CHANNEL NUMBER 0430 CHAN ΠW 000000 COMMAND CHANNEL PARAMETER 0440 CCP 0460 * 0470 * 0480 *** START A/D CONVERTER 0490 * 0550 * 0560 START LD A,E 0570 L D (CCP),A 0580 AND 007 0590 LD (CHAN) #A 0600 LD IX, CHANO 0910 LD It+O 0920 LU E,A E CALCULATE BUFFER OFFSET SLA 0930 E. 0940 SLA ADD IX,DE 0950 0960 * 0970 * SELECT CHANNEL AND START CONVERSION 0980 * LI B,3 SET CYCLE COUNT 0985 0990 SCSC LI A,(CCP) OUT COP SELECT CHANNEL 1000 CALL DELAY 1005 ENABLE EOC OUTFUT 0R EEOC 1010 OUT COP COMMAND A/D CONVERTER 1020 1030 * 1040 * WAIT FOR EOC 1050 * READ CONVERTER STATUS SIF 1060 WEOC IN TEST FOR EOC 1070 BIT 0,A Z,WEOC JUMP IF NOT READY 1080 JR-DUNZ SCSC 1085 TEST FOR OVERANGE 1090 BIT 1,A NZ, OVER JUMP IF TRUE JR 1100 1110 * 1120 * CONVERSION DONE; PROCESS FIRST (MSD) DIGIT 1130 * B,200 SELECT DIGIT 1 1140 MSD0 LD 1150CALL RDIG WAIT AND READ DIGIT 1 CPL 1160 JUSTIFY DIGIT VALUE RRCA RIGHT 1170 1180RRCA RRCA 1190 AND 1 ISOLATE 1200 INITIALIZE STATUS BYTE E,0 1210 LD 2,0 TEST POLARITY 1220 BIT JR NZ, MSD3 JUMP IF POSITIVE 1230 E,200 LOAD POLARITY SIGN LD 1240 1440 * 1450 * SAVE MSD AND CURRENT POLARITY 1460 * ADD FOLARITY SIGN TO MSD 1470 MSD3 **O**R E (IX+O), A SAVE IN DATA BUFFER 1480 LD 1500 * 1510 * PROCESS 2ND DIGIT 1520 * SELECT DIGIT 2 1530 RRC B

Figure 8.19 continued

1540 CALL RDIG WAIT AND READ DIGIT 1550 AND 017 ISOLATE 1560 LI (IX+1), A STORE SECOND DIGIT 1570 * 1580 * PROCESS 3RD DIGIT 1590 * SELECT 3RD DIGIT RRC В 1600 CALL RDIG WAIT AND READ DIGIT 1610 1620 AND 017 ISULATE 1630 L D (IX+2),A STORE 1640 * 1650 * PROCESS 4TH DIGIT 1660 * 1670 RRC В SELECT 4TH DIGIT 1680 WAIT AND READ DIGIT CALL RDIG 1390 ISOLATE AND 017 (1×+3)+A STORE 1700 LD - 民田子 1710 RAPUP 1720 * 1730 * LOAD 2.000 OVERRANGE VALUE INTO DATA BUFFER 1740 * 1750 OVER LI A+2 LOAD MSD VALUE LIF (IX+0),A 1760 1770 XOR A (IX+1), A LOAD LSD VALUES LD 1780 1790 LI (IX+2),A 1800 LD (1X+3),A 1810 JR RAPUP 1870 * 1880 * 1890 * READ DIGIT ROUTINE 1900 * ILI P IN READ DATA BYTE 1910 RDIG CFL CONVERT TO HIGH TRUE LOGIC 1920 1930 LI I+A SAVE COPY 1940 AND В TEST FOR GIVEN DIGIT READY ZFRDIG JUMP IF NOT 1900 JR 19:0 RESTORE A REGISTER LU A,U 1970 RETURN TO CALLER RET 1930 DELAY C+377 LD 1990 10 EL 1 DEC С Ζ 2000 RET 2010 JR DEL1

Figure 8.19 continued

Potential Applications

I feel that data acquisition is a natural application for ZAP. The interface outlined above can be used in a solar heating system to monitor and record pertinent data. Using the facilities of the ZAP monitor and the DVM interface routine, an 8-channel data logger is practical. In general, all that would be required is a supervisory program that calls the DVM 8 times to obtain the 8 sensor inputs. It then sets the limits of the memory table to a serial output subroutine and stores the readings on a cassette. This could be done continuously or at regular intervals. The ultimate system would include a real-time clock so that these readings, as well as the times at which they were taken, could be recorded.

Real-Time Clock

If ZAP is going to be used for critical data acquisition or control functions, consideration should be given to real-time synchronization with process events. A simple definition of a real-time system is one that responds to the need for action in a period of time proportional to the urgency of the need. It boils down to the fact that the computer must be capable of performing a specific action at a specific time. For this to happen, the computer must be able to "tell time."

We can accomplish this by using either software or hardware applications. The simplest technique is to use a clock circuit (figure 8.20) to provide a time tick to the central processor's nonmaskable interrupt line. It can be every 60th, 10th, or 1 second, as suggested in the schematic. When the computer acknowledges the interrupt, it first saves all the registers from the program it was executing, and then services the real-time interrupt. Frequently, the first action is to increment an internal counter that keeps track of elapsed time. Usually it's a value equivalent to the total number of clock ticks, whether in seconds or milliseconds. Once this regular interval has been established, it is easy for the computer to perform real-time functions.

Clock resolutions down to milliseconds sound great and make interval timing extremely accurate. However, I doubt most ZAP builders would want to use such an interface in light of the complex software involved. I much prefer an interface that is easier to implement and more likely to be used.

Essentially, the kind of real-time system most appealing to ZAP owners has a resolution of perhaps 1 minute rather than 1 ms. Also, it's best if it can be read directly in hours and minutes rather than as a total clock count. A direct benefit is reduced overhead. The computer does not have to acknowledge the clock update or scan status flags as often. At first glance, it may not seem like much of a saving, but some routines can use up to 10 percent of the processor time handling a millisecond clock interrupt.

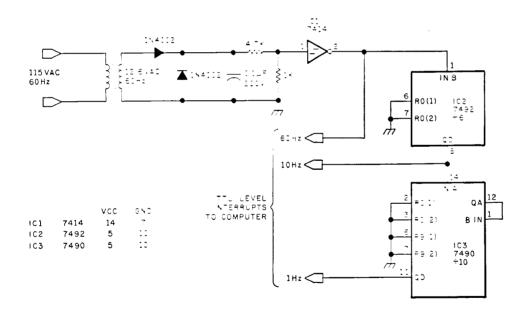


Figure 8.20 A simple time-base generator for an interrupt-driven real-time clock.

An Old Clock Chip to the Rescue

The easiest way to provide an hourly and minute-by-minute input is to interface the computer to an MOS/LSI clock chip similar to that found on most digital clocks or watches. There are two approaches to the design of a clock interface: one method is to let the clock circuit operate independently from the computer, attached in such a way that the computer can monitor the output lines and extract a time value on the fly. The software necessary for this approach would be very much like the DVM interface described previously. The other method, which I prefer because it involves less software, is to give the computer complete control over the information flow of the clock in a synchronous manner.

Figure 8.21 shows such a clock interface. This circuit, manually preset to keep it simple, is computer directed. The basic 4-chip circuit consists of an MM5312 4-digit BCD/ 7-segment output digital clock chip, an MM5369 time-base generator, and two MOSto-TTL buffers to send data to the processor.

Time is set on the chip by grounding the slow and fast set lines, pins 14 and 15. To know what is being set you must read the interface at the same time, and display the time on the 4-digit hexadecimal address display, already part of the expanded ZAP. Time is read from the interface as 4 binary-coded decimal numbers. The 8 input lines to the computer are attached to an 8-bit parallel input port, and are divided between 4 digit-enable lines, and 4 BCD digit-value lines. Data appear as a digit enable and an associated BCD number. The tens of minutes data is read on B0 thru B3 when B5 is high (B4, B6, and B7 are low). Similarly, B0 thru B3 will hold the tens of hours quantity when B7 is high. The interface logic will stay on a particular digit until it is instructed to proceed to the next digit. Sequencing is under program control and uses one output bit of a convenient parallel port.

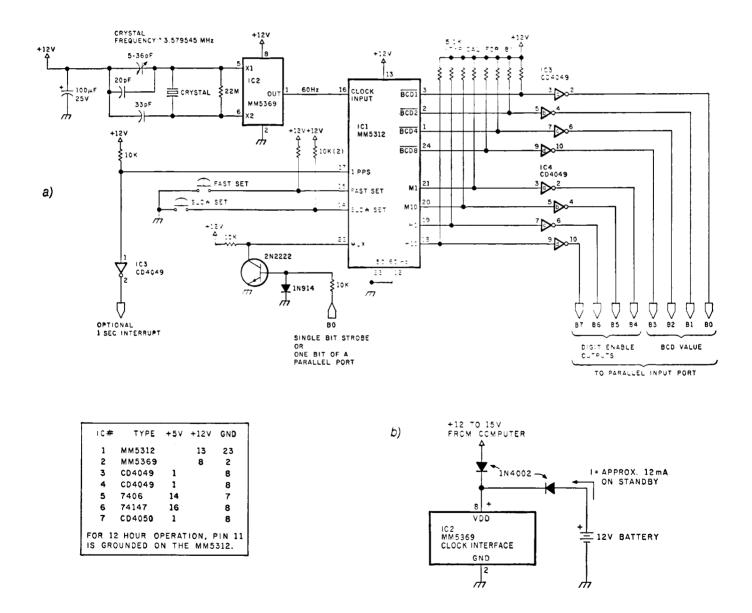
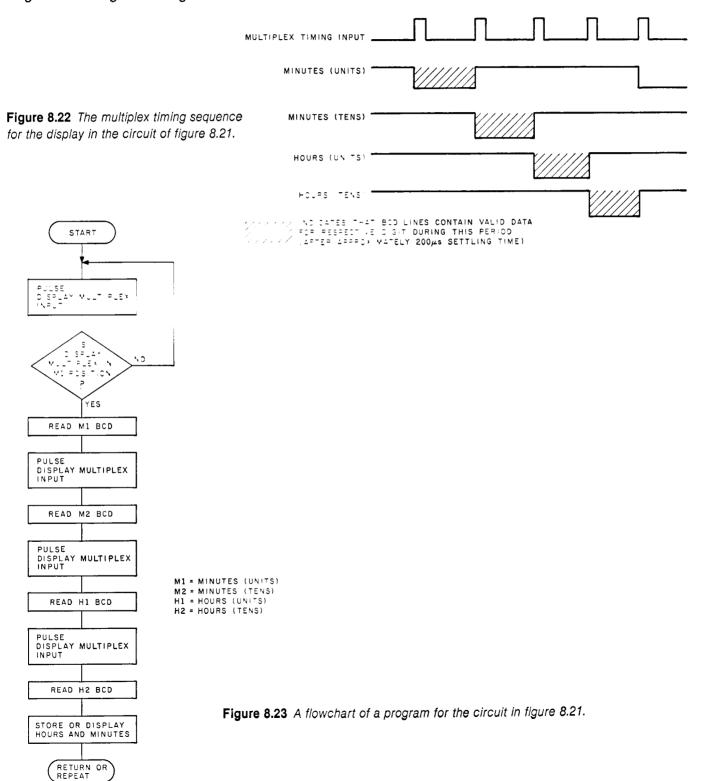


Figure 8.21 A schematic diagram of a real-time clock interface. a) Using a MOS digital clock chip.

b) With battery backup.

Figure 8.22 shows how the multiplexer line is controlled in this application. One bit of an output port is used to pulse multiplexer input pin 22. (All that is required is a 1 ms pulse. As an alternative, a one-shot could be triggered from a decoded strobe line of an unwired port.) At any time, 1 of the 4 digit-enable lines will be low and a digit's value will be on the BCD output lines. Just determine which digit it is and store the value. Next we pulse the multiplexer input to enable the next digit and save it as well. Conceivably, it takes only 4 iterations of this procedure to obtain a complete 4-digit reading. If you prefer a more orderly approach, you can follow the program flow outlined in figure 8.23. The only difference is that it waits until the chip cycles to the beginning before storing the readings.



CHAPTER 9 BUILD A CRT TERMINAL

LOW COST VERSATILE CRT TERMINAL

This chapter describes the design of a low-cost features-oriented cathode-ray tube (CRT) terminal. Two MOS/LSI devices from Standard Microsystems Corporation reduce the number of parts required for a CRT terminal yet enhance its capabilities.

The two devices, the CRT 5027 video timer and controller and the CRT 8002 video display attributes controller, provide virtually all of the circuitry for the display portion of the CRT terminal. (See Appendices C8 and C9 for specifications.)

The terminal is designed to stand alone and communicate via an RS-232C interface with any computer system. If, in the expanded ZAP, the 6-character hexadecimal display proves inadequate, then the experimenter has only to construct this unit and attach it to the serial port already assembled.

Device Description

The CRT 5027 contains the logic required to generate all of the timing signals (vertical and horizontal synchronization, page refresh memory address, etc.) required by a CRT terminal. The entire display format including interlace/non-interlace, characters per row, rows per frame, scans per row, horizontal synchronization pulse width, and timing are user programmable for all standard and most nonstandard formats.

Although the CRT 5027 is basically structured for use with its own microprocessor, this design describes a "dumb terminal" using a low-cost PROM and standard TTL logic to replace the microprocessor control. While increasing the number of the parts, this design results in a low-cost, high quality alphanumeric/graphics terminal.

The CRT 8002 provides a 7 \times 11 dot matrix, 128 character generator ROM, and a high-speed video shift register cursor. It includes logic to generate such functions as underline, blinking, reverse video, blanking, and strike-through. Additional wide and thin graphics modes allow the creation of line drawings, forms and unique graphic symbols.

Terminal Description

As with most electronic designs, a CRT terminal involves a large number of performance and cost trade-offs. A screen format of 16 rows of 64 characters per row was selected to minimize memory requirements (1 K bytes) and keep the video frequency within the limits of lower cost video monitors. An 80-character line would have not only increased the video frequency beyond the bandwidth of many low-cost monitors, but also would have increased the memory requirements. Similarly, more rows per page would have increased the memory requirement unless the characters per line were reduced.

In many microprocessor applications, the page memory is shared with the processor via a data bus. In this application, the page memory is used strictly by the CRT with data input synchronously, character-by-character, into the cursor position.

Full graphics or attributes may be selected on a character-by-character basis using

control words on the input data bus. A block diagram of the terminal is shown in figure 9.1.

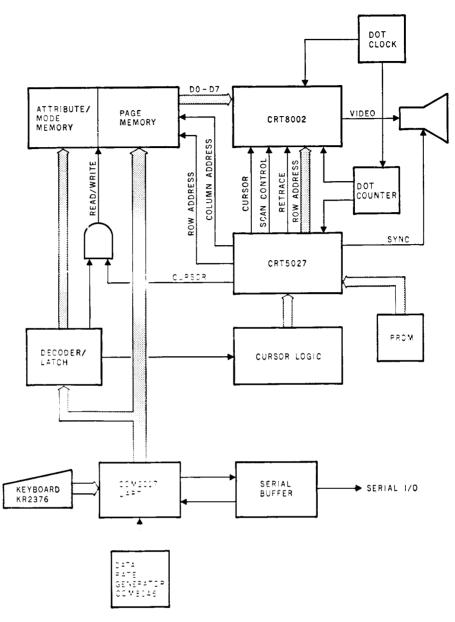


Figure 9.1 A block diagram of a concost cathode-ray tube terminal.

Character Format

The CRT 8002 requires a minimum 8×12 character block to form its basic 7×11 character and to provide line and character spacing. However, in order to allow framing a character fully for a reverse video presentation, the horizontal character block must be increased to 9 or 10 dots. For the same reason, allocating 13 lines per character allows top and bottom framing as well.

With the standard TV sweep rates of 60 Hz (vertical) and 15,750 Hz (horizontal), there are 15,750 \div 60 = 262.5 lines per frame. As non-interlaced operation requires an even number of lines, a horizontal frequency of 15,720 Hz is used. The 16 rows \times 13 scan lines per row result in 208 lines of displayed data. The remaining 54 lines will be automatically blanked by the CRT 5027 and will provide upper and lower margins.

To allow for left and right margins as well as for retrace time, a total 80 character times are allocated per line. A good rule of thumb is that the total number of character

times is 25% greater than the actual number of displayed characters.

The video clock frequency is calculated as follows: 10 (dots per character) \times 80 (character times per line) \times 15,720 Hz (horizontal sweep frequency) = 12.576 MHz. See the worksheet in table 9.1.

1. H CHARACTER MATRIX (No. of Dots):	
2. V CHARACTER MATRIX (No. of Horiz. Scan Lines):	
3. H CHARACTER BLOCK (Step 1 + Desired Horiz. Spacing = No. in Dots):	
4. V CHARACTER BLOCK (Step 2 + Desired Vertical Spacing = No. in Horiz. Scan Lines):	
5. VERTICAL FRAME (REFRESH) RATE (Freq. in Hz):	60
6. DESIRED NO. OF DATA ROWS:	16
7. TOTAL NO. OF ACTIVE "VIDEO DISPLAY" SCAN LINES (Step 4 x Step 6 = No. in,Horiz. Scan Lines):	208_
8. VERT. SYNC DELAY (No. in Horiz. Scan Lines):	26
9. VERT. SYNC (No. in Horiz. Scan Lines; T = <u>_/90.8</u> µs*):	_3
10. VERT. SCAN DELAY (No. in Horiz. Scan Lines; T == <u>/.59</u> ms*):	25
11. TOTAL VERTICAL FRAME (Add steps 7 thru 10 = No. in Horiz. Scan Lines):	262
12. HORIZONTAL SCAN LINE RATE (Step 5 x Step 11 = Freq. in KHz):	15 720
13. DESIRED NO. OF CHARACTERS PER HORIZ. ROW:	64
14. HORIZ. SYNC DELAY (No. in Character Time Units: T = <u>477</u> us**):	6
15. HORIZ. SYNC (No. in Character Time units. T = 557 us to -557	
16. HORIZ, SCAN DELAM (No. In Character Time Units IT = <u>233</u> us**);	3
17. TOTAL CHARACTER TIME UNITS IN TI HORIZI SCANLINE (Add Steps 13 thru 16)	80
18 CHARACTER RATE: Step 12 x Step 17 = Freq. in MHz):	1.2576
19 CLOCK DCT PATE Step 3 + Step 18 = Frequin MHz):	12.576
° Nemical Interval NHorizontal Interval	

Table 9.1 A CRT 5027 worksheet for a 64 characters per row, 16 row, non-meriaced screen format.

Programming the VTAC

The CRT 5027 VTAC (Video Timer and Controller) is user programmable for all timing and format requirements. The programming data is stored in 9 on-chip registers. Although a microprocessor can easily provide the programming data, a low-cost PROM is used in this application. The 9 registers are programmed as follows (see table 9.2):

Register 0: This register contains the number of character times for one horizontal period, and is normally 1.25 times the number of characters per line, in this case $64 \times 1.25 = 80$. As the internal counters are initialized at zero, the actual number in the register is 80 - 1 = 79.

Register 1: This has 3 fields:

- 1) bit 7 one for interlace, zero for non-interlace. In this example, noninterlaced operation is selected.
- 2) bits 3 thru 6 program the number of character times for the width of the horizontal synchronization pulse. This parameter is monitor dependent and is typically

5 μ s. Because there are 80 character times for a 63.6 μ s horizontal scan time (1 ÷ 15,720), each character time is 0.801 μ s; 7 character times will be used to generate a 5.56 μ s pulse.

3) bits 0 thru 2 set the horizontal "front porch." This essentially positions the data horizontally. The monitor's specification will determine initial programming although some experimentation may be required to center the display exactly. Six character times were selected for the front porch.

	0	0	1	1	1	1	1	0
--	---	---	---	---	---	---	---	---

REG. #	ADDRESS A3 A0	FUNCTION	BIT ASSIGNMENT	HEX.	DEC.
0	0000	HORIZ. LINE COUNT 80	0 1 0 0 1 1 1 1	4F	79
1	0001	INTERLACE	0 0 1 1 1 1 1 0	<u>3E</u>	_62_
2	0010	SCANS DATA FOW <u>13</u> Characters fow <u>67</u>	X · · O C O 1 1	63	99
3	0011	SKEW CHARACTERS DATA ROWS6		<u>8</u> =	143
4	0100	SCANS/FRAME <u>262</u> X = <u>3</u>	0 0 0 0 0 0 1 1	03	3
5	0101	VERTICAL DATA START = 3 + VERTICAL SCAN DELAY: SCAN DELAY <u>25</u> CATA START <u>28</u>	0 0 0 1 1 1 0 0	IC	_28
6	0110	LAST I SPLAYED DATA ROW (= DATA POAS)	X X 0 0 1 1 1 1	OF	15

Register 1

Table 9.2 A CRT 5027 register-programming worksheet for a 16 \times 64 screen format.

Register 2: This has two fields:

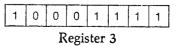
- bits 3 thru 6 (bit 7 is not used) set the number of scans per character. In this case, we have defined the character as 10 × 13, so the binary equivalent of 13 1 = 12 is used (all CRT 5027 counters start at zero, not one, so programming of counters is always one less than the number).
- 2) bits 0 thru 2 contain a 3-bit code for the number of characters per line. From the data sheet the code for 64 is 011.

0	1	1	0	0	0	1	1
		n			•		

Register 2

Register 3: This has two fields:

- 1) bits 6 and 7 delay the blanking cursor and synchronization timing to allow for character generator and programmable memory propagation delays. Generally, one character time will allow for these delays.
- 2) bits 0 thru 5 define the number of data rows, once again starting with binary zero for one line. 16 1 = 15 will be programmed.



Register 4: Register 4 sets the number of raster lines per frame. For the noninterlaced mode this is derived by the formula $(N - 256) \div 2 = 3$.

0 0 0 0 0 0 1 1

Register 4

Register 5: This contains the number of raster lines between the start of the vertical synchronization pulse and the start of data (vertical synchronization + back porch). This time must be long enough to allow for the full retrace time of the monitor and to allow vertical positioning of the display. We will use 28 here. The front porch will be calculated by the CRT 5027 as $262 - (13 \times 16) - 28 = 26$.

0	0	0	1	1	1	0	0	
Register 5								

Register 6: Register 6, the scrolling register, is programmed with the number of the last data row to be displayed. Since we want to initialize the CRT 5027, this will be programmed the same as Register 3 (bits 6 and 7 are not used).

	0 0 0 0 1 1 1 1								
Register 6									

Register 7 and Register 8: These registers contain the cursor character number and row number respectively. Since the cursor is to be initially positioned at the top left corner, both registers will be initialized with all zeros. Subsequent cursor position changes will be entered as described under "circuit operation."

C	÷	0	0	C	0	С	3
		Re	- egis	ter	7		
			-	ter			

Circuit Description

Referring to figure 9.2 IC 1A. IC 1B, IC 4 provide the video dot clock (12.58 MHz) and the character clock DCC, which is the dot clock \div 10 (each character is 10 dots wide. The video dot clock determines the actual video data rate. The character clock determines the speed each character is addressed. IC 6A buffers the dot clock input of the CRT 8002. A pull-up resistor is used on the output to guarantee the logic one requirement of the VDC input.

The LOAD command loads the register information required for programming the CRT 5027 from the PROM IC 7 to the CRT 5027. The "self-load" capability of the CRT 5027 is used to automatically scan the PROM addresses. LOAD is automatically generated on power-on by IC 1D.

Because of the bus structure of the CRT 5027, cursor position information is loaded on the same bus as the register data. Three-state data selectors IC 14 and IC 15 select cursor X position data from counter IC 8 and IC 7 or cursor Y position data from IC 1D. IC 12 and IC 13 select the address mode for the CRT 5027. Three modes are used: "nonprocessor self-load" for register loading, load cursor X position, and load cursor Y position.

IC 16 thru IC 21 decode attribute mode and cursor controls from the ASCII data bus. If graphics or special attributes are not desired, IC 16, 17, and 21 are not required. Similarly, if cursor controls are directly available, decoding them is not necessary.

IC 19 and IC 20 are 256×4 PROMs. Their exact programming can be suited to the user needs. The programming used in this terminal is shown in table 9.3. When a key designated as an attribute or mode key is depressed, the appropriate control word is latched in IC 21; all subsequent data entries will have that word loaded in the upper 4 bits of programmable memory. This allows the attribute or mode to be changed on a character-by-character basis. IC 18, a 2 to 4 decoder, is enabled when a cursor control backspace, carriage return/line feed, or 1 is decoded and provides the appropriate cursor movement.

TTL or low power TTL can be used throughout. Shottky TTL is recommended for IC 6 due to the fast rise time requirements of the clock input.

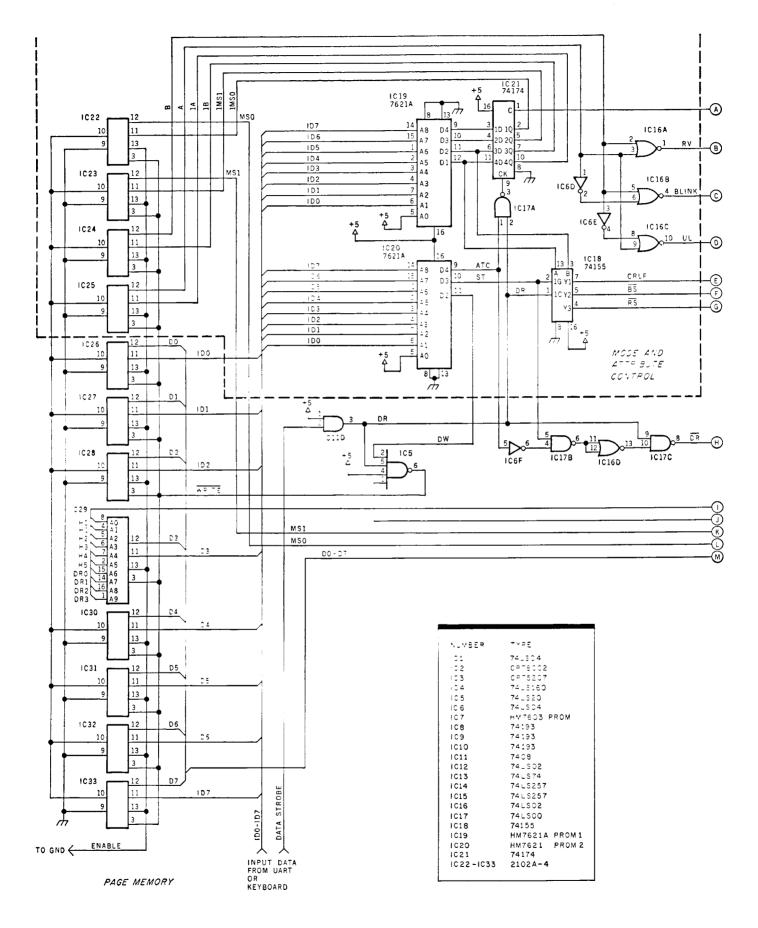


Figure 9.2 A schematic diagram of a low-cost versatile CRT terminal using the CRT 5027 and CRT 8002 chips (continued on next page).

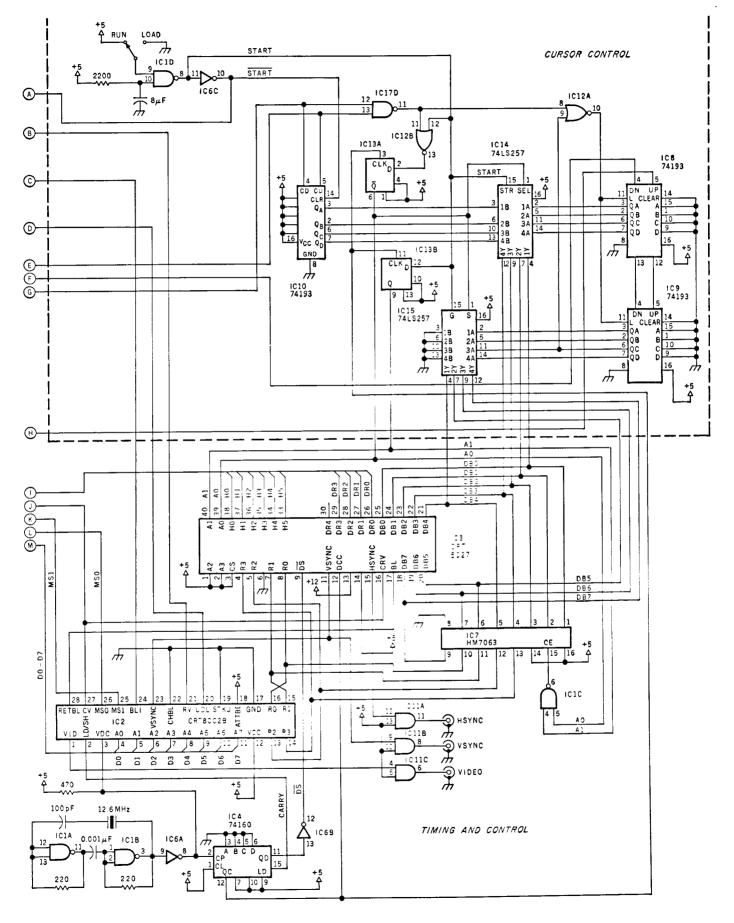


Figure 9.2 continued

Operation

After power-on, Control Q should be depressed to latch the system in the "normal" mode. Depressing the space key and the erase key simultaneously will then blank the screen. All further character entries will be displayed normally. If other attributes or graphics are desired, the appropriate control code is entered. This character will not be displayed or cause cursor movement, but will latch the new command. Modes may be changed for every character desired. Cursor movement may be decoded from the ASCII input by the control key as indicated in table 9.3.

PROM Programming

Keyboard Entry	Function	Address	PROM 1 Output	PROM 2 Output
		76543210	$D_1D_2D_3D_4$	$D_1D_2D_3D_4$
Return	Carriage Return	00011011	0011	1000
LF	Line Feed	00010101	1011	1000
Control H	Cursor Left	00010001	0111	1000
RS	Cursor Up	00111101	1111	1000
US	Cursor Right	00111111	1111	1010
Control Q	Normal Attribute	00100011	1111	1011
Control W	Blink	00101111	1011	1011
Control E	Underline	00001011	0111	1011
Control R	Reverse Video	00100101	0011	1011
Control T	External Mode	00101001	1101	1011
Control Y	Wide Graphics	00110011	1100	1011
Control U	Thin Graphics	00101011	1110	1011
Balance of PROM			0011	1110

 Table 9.3 PRCM programming for the circuit of figure 9.2.

The Rest of the System

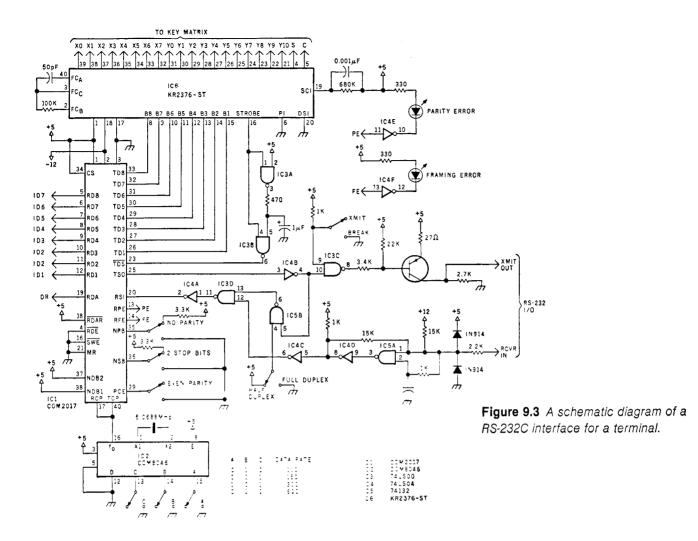
Figure 9.3 illustrates the balance of the circuitry required to implement a full RS-232C compatible serial I. O terminal. Utilization of MOS LSI reduces the package count to a bare minimum.

A KR2376 keyboard encoder. IC 1, encodes and de-bounces the keyboard switches and provides an ASCII data word to the COM 2017 UART (see Appendices C6 and C7). The UART, in turn, provides the serial receive transmit interface. The data rate is programmable by means of the switch controlled input code to a COM 8046 data rate generator see Appendix C10).

TERMINAL VARIATIONS

The terminal described can easily be modified for a wide variety of other screen formats. The following changes are required for an 80-characters per row, 24-row format:

- 1. Horizontal sweep rate to allow for the increased number of displayed lines (312), the horizontal sweep rate is increased to 20,220 Hz.
- 2. The video oscillator frequency is calculated as 9 (dots per character) \times 100 (character times per row) \times 20,220 = 18.198 MHz. Notice that 9 dots per character was selected instead of 10, as 10 would have resulted in a clock frequency of 20.2 MHz, which is beyond the CRT 8002A's top frequency. IC 4, therefore, must be set for divide by 9 rather than 10.
- 3. An additional 1 K bytes of page memory is required. Figure 9.4 shows the revised address connections.
- 4. Register programming for the CRT 5027 follows the worksheet shown in tables 9.4 and 9.5.



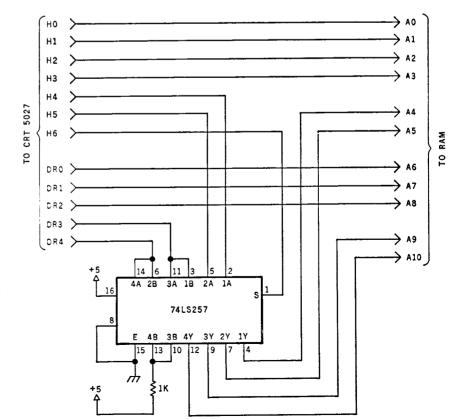


Figure 9.4 A memory-mapping system for a 24×80 screen format.

1. H CHARACTER MATRIX (No. of Dots):	7
2. V CHARACTER MATRIX (No. of Horiz. Scan Lines):	
3. H CHARACTER BLOCK (Step 1 + Desired Horiz. Spacing = No. in Dots):	9
4. V CHARACTER BLOCK (Step 2 + Desired Vertical Spacing = No. in Horiz. Scan Lines):	
5. VERTICAL FRAME (REFRESH) RATE (Freq. in Hz):	60
6. DESIRED NO. OF DATA ROWS:	24
7. TOTAL NO. OF ACTIVE "VIDEO DISPLAY" SCAN LINES (Step 4 x Step 6 = No. in Horiz. Scan Lines):	312
8. VERT. SYNC DELAY (No. in Horiz. Scan Lines):	3
9. VERT. SYNC (No. in Horiz. Scan Lines; $T = $	3
10. VERT. SCAN DELAY (No. in Horiz. Scan Lines: $T = \underline{8902} \mu s^*$):	18
11. TOTAL VERTICAL FRAME (Add steps 7 thru 10 = Noun Horiz. Scan Lines):	336
12 HOP ZONTAL SCANLINE RATE (Step 5 x Step 11 = Freq. in KHz):	20220
13. DESIRED NO. OF CHARACTERS PER HORIZI ROW:	80
14. HORIZ, SYNC DELAY (No. in Character Time Units: T = <u>1.48</u> µs**):	3
15. HORIZ. SYNC (No. in Character Time Units; $T = -\frac{4.94}{\mu}s^{**}$):	10
16. HORIZ. SCAN DELAY (No. in Character Time Units; $T = 346 \mu s^{-1}$):	
17. TOTAL CHARACTER TIME UNITS IN (1) HORIZ. SCAN LINE (Add Steps 13 thru 16):	100
S CHARACTER RATE (Step 12 x Step 17 = Freq. in MHz):	2.022
19 CLCCK (DOT) RATE (Step 3x Step 18 = Freq. in MHz):	18.198

*veriga trena **⇔oroona tienka

Table 9.4 A CRT 5027 worksneet for an 80 characters per row, 24 row, noninterlaced screen format.

9EG #	ADDRESS A3 A0	fullo <u>fici,</u>	B T 4SS GWENT	μ <u>Ξ</u> Υ,	DEC.
Ç	0000	HOR ZILINE COUNT <u>/00</u>	C · · : : : · ·	63	99
	0001	INTERLACE <u>0</u> Historia di <u>0</u> Historia di <u>0</u> Historia di <u>0</u>	0.0.2.2	_53_	83
2	010	SCANS DATA FOR /3 Characters for <u>80</u>	X 1 1 0 0 · C 1	65	101
3	CC11	SKEW CHARACTERS 2		97	
4	C100	SCANS/FRAME_ <u>336</u> X = <u>40</u>	0 0 1 0 1 0 0 0	_28	40
5	0101	VERTICAL DATA START = 3 + VERTICAL SCAN DELAY: SCAN DELAY <u>8</u> DATA START 21			_21
6	0110	LAST DISPLAYED DATA ROW (= DATA ROWS)	X X 0 1 0 1 1 1		23

. Table 9.5 A CRT 5027 register-programming worksheet for a 24 \times 80 screen format.

Appendix A

Construction Techniques

CONSTRUCTION TIPS

As a result of building a project every month for my "Ciarcia's Circuit Cellar" column in *BYTE* magazine and of constructing every circuit in this book, I feel I can speak as an authority on the subject of prototype construction. A prototype is a nice term that describes the one-of-a-kind kluge that you build from a schematic. This is opposed to the kit or semi-assembled project that includes a printed circuit board which only reguires plugging in components.

Prototyping a circuit is not easy. There are many dos and don'ts, but successful prototyping is primarily a function of experience. And experience comes only by building something.

The text is purposely laid out with this philosophy in mind. I suggest that you start with the power supply. Not only is the rest of the computer useless without it, but it has built-in protective circuitry that is very forgiving if you make mistakes. Also, by constructing the power supply first, there is less likelihood of destroying the rest of the computer as you are testing the power supply.

In general, the cardinal rule of prototyping is: be neat. The ZAP computer has high frequencies. Wiring should be the shortest distance between two connections. The longer the wire, the more of an antenna it becomes. In extreme cases, the computer can actually cease to function because of induced electrical noise. With the relatively slower digital signals carried by the wiring attached to external input and output ports, the situation is less critical. Short pulses and high-speed data, such as the signals on the central processor control and address lines, are more critical. In these cases, it is always a good idea to use additional protective circuitry such as buffers.

To a certain degree, the ZAP computer can be laid out as you see fit. Figure A.1 suggests one approach: it can be wirewrapped or hand soldered. Almost any board large enough to accommodate all the chips should suffice. A good choice is a standard S-100 prototyping card available at most computer stores. There is no particular bus other than the standard Z80 signals designated for ZAP because it is primarily intended as a single-board system. The 100-pin connector provides a convenient I/O and power connector. Care should be taken if you decide to split the computer schematic and assemble the computer on more than one board. The separation should be between logical subsystems; for maximum success, all signals should be buffered in and out of the board, e.g., all the memory could be put on a separate card. As outlined in the text, the address and data lines necessary to this function are already properly buffered.

The question of wirewrapping versus soldering is the builder's prerogative. Personally, I prefer point-to-point hardwiring because it's easier to modify when troubleshooting. Wirewrapping might be easier where the ZAP circuit has already been tested and refined.

Long power-supply daisy chains should be avoided. Rather than running a single +5 V and ground wire, it is better to use a double-sided prototyping board so that the top and bottom sides of the board can be set to ground and +5 V respectively. With this approach, each chip can be plugged in (using IC sockets) and the power leads soldered directly to the copper planes. Wirewrapping or not, it is a good idea to solder the power leads to reduce the potential of intermittent connections. Using the ground

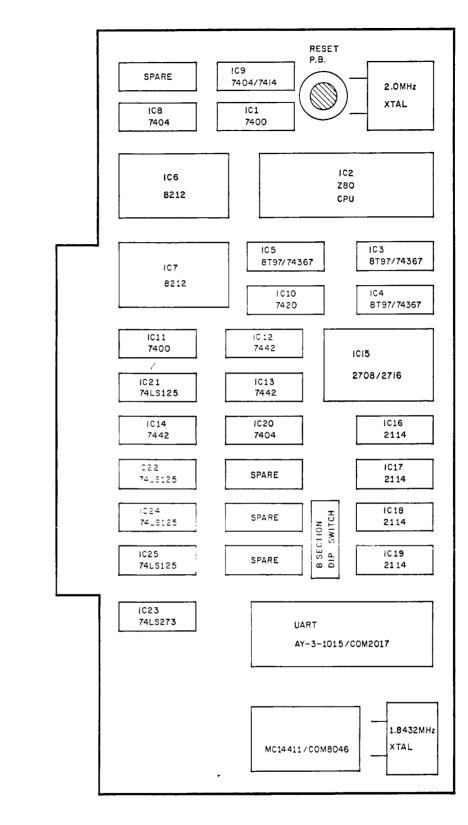


Figure A.1 A typical layout of the basic ZAP computer.

plane for wiring is one of the best ways to reduce noise in computers. If you don't have a ground plane, then solder heavy wire around the perimeter of the circuit board and run short jumpers to it.

Decoupling capacitors are another must for computer prototyping. Digital-integrated circuits, while being virtually burn-out proof in most applications, are unfortunately susceptible to noise carried along the power lines. Often, it will cause them to

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go into oscillation. By placing a 0.01μ F to 0.1μ F capacitor between +5V and ground about every third IC, the problem is eliminated. Another good idea is to place an electrolytic capacitor at the entrance of any DC power connection to the board. Generally, capacitors are tantalum and three pieces would be required for ZAP's three supplies.

Finally, if you like the concept of ZAP but would rather spend more time applying the finished product than testing your construction techniques, you can look into purchasing various kits and assemblies, including EPROMs programmed for the ZAP monitor. For the latest price list, write or call: The MicroMint Inc, 917 Midway, Woodmere NY, 11598. Telephone: (516) 374-6793.

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Appendix B ASCII Codes

		Parity Space		Control Keybd.	
Octal	Hex	or	Character	Equiv.	Alternate Code Names
$\begin{array}{c} 000\\ 001\\ 002\\ 003\\ 004\\ 005\\ 006\\ 007\\ 010\\ 011\\ 012\\ 013\\ 014\\ 015\\ 016\\ 017\\ 020\\ 021\\ 022\\ 023\\ 024\\ 025\\ 026\\ 027\\ 030\\ 031\\ 032\\ 033\\ 034\\ 035\\ 036\\ 037\\ 040\\ 041\\ 042\\ 043\\ 044\\ 045\\ 046\\ 047\\ 047\\ 047\\ 047\\ 047\\ 047\\ 047\\ 047$	00 02 03 04 05 06 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A BC DEF 01 12 34 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 23 45 56 78 9A 12 12 23 45 56 78 9A 12 23 45 56 78 9A 12 12 23 45 56 78 9A 12 12 12 12 12 12 12 12 12 12	Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Eve	NUH STXXTQKL BBHLVFCSSLCC234KNBN BCSSSSSSS VDCC234KNBN SECESSSSSS VSP!"#\$%&''	@ABCDWFGI-JKLYZOPQR%FJYYN[/]^	NULL, CTRL SHIFT P, TAPE LEADER START OF HEADER, SOM START OF TEXT, EOA END OF TEXT, EOM END OF TRANSMISSION. END ENQUIRY. WRU. WHO ARE YOU ACKNOWLEDGE, RU, ARE YOU BELL BACKSPACE, FE0 FOR:ZONTAL TAB, TAB LINE FEED, NEW LINE, NL VERTICAL TAB, VTAB FORM FEED, FORM, PAGE CARRIAGE RETURN, EOL SHIFT OUT, RED SHIFT SHIFT IN, BLACK SHIFT DATA LINK ESCAPE, DC0 XON, READER ON TAPE, PUNCH ON XOFF, READER OFF TAPE, PUNCH OFF NEGATIVE ACKNOWLEDGE, ERR SYNCHRONOUS IDLE, SYNC END OF TEXT BUFFER, LEM CANCEL, CANCL END OF MEDIUM SUBSTITUTE ESCAPE, PREFIX FILE SEPARATOR GROUP SEPARATOR RECORD SEPARATOR NIT SEPARATOR SPACE, BLANK
050 051 052	28 29 2A	Even Odd Odd	() *		
053 054 055 056 057	2B 2C 2D 2E 2F	Even Odd Even Even Odd	+ ;_ ;		COMMA MINUS
	$\begin{array}{c} 001\\ 002\\ 003\\ 004\\ 005\\ 006\\ 007\\ 010\\ 011\\ 012\\ 013\\ 014\\ 015\\ 016\\ 017\\ 020\\ 021\\ 022\\ 023\\ 024\\ 025\\ 026\\ 027\\ 030\\ 031\\ 032\\ 033\\ 034\\ 035\\ 036\\ 037\\ 040\\ 041\\ 042\\ 043\\ 044\\ 045\\ 046\\ 047\\ 050\\ 051\\ 052\\ 055\\ 056\\ 056\\ 056\\ 056\\ 056\\ 056\\ 056$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Octal Hex or 000 00 Even 001 01 Odd 002 02 Odd 003 03 Even 004 04 Odd 005 05 Even 006 06 Even 007 07 Odd 011 09 Even 012 0A Even 013 0B Odd 014 0C Even 015 0D Odd 016 0E Odd 017 0F Even 020 10 Odd 021 11 Even 022 12 Even 023 13 Odd 024 14 Even 025 15 Odd 030 18 Even 031 19 Odd 032 1A Odd <	Octal Hex or Character 000 00 Even NUL 001 01 Odd SOH 002 02 Odd STX 003 03 Even ETX 004 04 Odd EOT 005 05 Even ENQ 006 06 Even ACK 007 07 Odd BEL 010 08 Odd BS 011 09 Even HT 012 0A Even LF 013 0B Odd VT 014 0C Even SI 020 10 Odd DLE 021 11 Even DC1 022 12 Even DC2 023 13 Odd DC3 024 14 Even ESC 030 18 Even ESC	SpaceKeybd. CharacterKeybd. Equiv.00000EvenNUL@00101OddSOHA00202OddSTXB00303EvenETXC00404OddEOTD00505EvenENQE00606EvenACKF00707OddBELG01008OddBSH01109EvenHTI0120AEvenLFJ0130BOddVTK0140CEvenFFL0150DOddCRM0160EOddDLEP02111EvenDC1Q02212EvenDC2R02313OddDC4T02515OddNAKU02616OddSVNV02717EvenETBW03018EvenCANX0331BEvenESC[0341COddSP \wedge 0351DEvenRS \wedge 0371FOddUS $-$ 04323OddY $-$ 04424Even\$ $ $ 04525Odd $%$ $-$ 04525O

Dec	Octal	Hex	Parity Space or	Character	Control Keybd. Equiv.	Alternate Code Names
048 049 050 051 052 053 054 055 056 057 058	060 061 062 063 064 065 066 067 070 071 072	30 31 32 33 34 35 36 37 38 39 3A	Even Odd Even Odd Even Even Odd Odd Even Even	0 1 2 3 4 5 6 7 8 9 :		NUMBER ZERO NUMBER ONE
059 060 061	072 073 074 075	3B 3C 3D	Odd Even Odd	;, < =		LESS THAN
062 063 064	076 077 100	3E 3F 40	Odd Even Odd	> ? @.		GREATER THAN SHIFT P
065 066 067 068 069 070 071	101 102 103 104 105 106 107	41 42 43 44 45 46 47	Even Even Odd Even Odd Odd Even	A B C D E F G		
072 073 074 075 076 077 078	110 111 12 13 114 115 116	48 49 4A 4B 4C 4D 4D 4E	Even Odd Odd Even Odd Even Even	H J K L N		LETTER I
079 080 081 082 083 084 085 036 036 087 088 089	117 120 121 122 123 124 125 126 127 130 131	4 F 50 51 52 53 54 55 56 57 58 59	Odd Even Odd Even Odd Even Odd Odd Even	ОРQR ST U> VXY		LETTER O
090 091 092 095 095 097 099 099 099 100 102 103 105 107 108 109 110	132 133 134 135 136 137 140 141 142 143 144 145 146 147 150 151 152 153 154 155 156 157	5ABCDEF01234566789ABCDEF	Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even Odd Even	Z [] a b c d e f g h i j k l m n o		SHIFT K SHIFT L SHIFT M ↑, SHIFT N ←, SHIFT O, UNDERSCORE ACCENT GRAVE
112 113	160 161	70 71	Odd Even	р q		

Dec	Octal	Hex	Parity Space or	Character	Control Keybd. Equiv.	Alternate Code Names
114	162	72	Even	r		
115	163	73	Odd	S		
116	164	74	Even	t		
117	165	75	Odd	u		
118	166	76	Odd	v		
119	167	77	Even	w		
120	170	78	Even	x		
121	171	79	Odd	у		
122	172	7A	Odd	Z		
123	173	7B	Even	{		
124	174	7C	Odd			VERTICAL SLASH
125	175	7D	Even	}		ALTMODE
126	176	7E	Even	~		(ALTMODE)
127	177	7F	Odd	DEL		DELETE, RÜBOUT

Appendix C1

intel

2708 8K (1K × 8) UV ERASABLE PROM

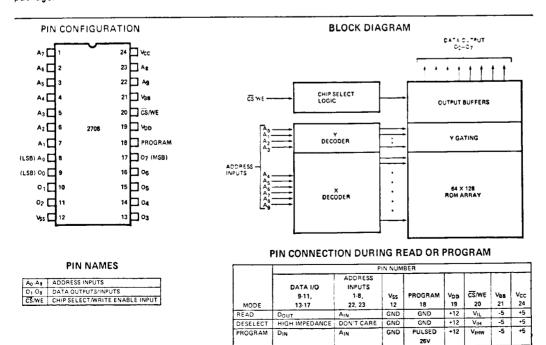
	Max. Power	Max. Access
2708	800 m W	450 ns
2708L	425 m W	450 ns
2708-1	800 m W	350 ns
2708-6	800 m W	550ns

- Low Power Dissipation 425 mW Max. (2708L)
- Data Inputs and Outputs TTL Compatible during both Read and Program Modes
- Fast Access Time 350 ns Max. (2708-1)
- Static No Clocks Required
- Three-State Outputs OR-Tie Capability

The Intel® 2708 is an 8*92-bit ultraviolet light erasable and electrically reprogrammable EPROM, ideally suited where fast turnaround and pattern experimentation are important requirements. All data inputs and outputs are TTL compatible during both the read and program modes. The outputs are three-state, allowing direct interface with common system bus structures.

The 2708L at 425mW is available for systems requiring lower power dissipation than from the 2708. A power dissipation savings of over 50% without any sacrifice in speed is obtained with the 2708L. The 2708L has high input no seimmunity and is specified at 10% power supply to erance. A high-speed 2708-1 is also available at 350ms for microprocessors requiring fast access times.

The 2708 family is fabricated with the N-channel silicon gate FAMOS technology and is available in a 24-bin dual in-line package.



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PROGRAMMING

The programming specifications are described in the Data Catalog PROM/ROM Programming Instructions Section. •• • m.

Absolute Maximum Ratings*
Temperature Under Bias
Storage Temperature
VDD With Respect to VBB +20V to -0.3V
V_{CC} and V_{SS} With Respect to V_{BB}
All Input or Output Voltages With Respect
to VBB During Read
CS/WE Input With Respect to VBB
During Programming +20V to -0.3V
Program Input With Respect to VBB +35V to -0.3V
Power Dissipation 1.5W

MMENT

esses above those listed under "Absolute Maximum ings" may cause permanent damage to the device. is a stress rating only and functional operation he device at these or any other conditions above se indicated in the operational sections of this ification is not implied. Exposure to absolute kimum rating conditions for extended periods may ct device reliability.

D.C. AND A.C. OPERATING CONDITIONS DURING READ

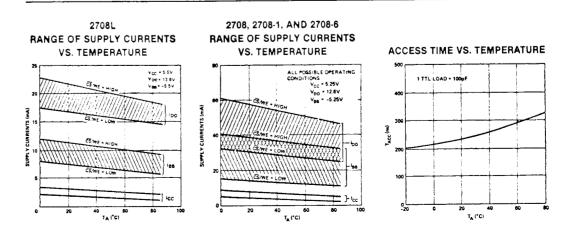
	2708	2708-1	2708-6	2708L
Temperature Range	0°C-70°C	0°C-70°C	0°C-70°C	0°C-70°C
V _{CC} Power Supply	5V ± 5%	5V ± 5%	5V ± 5%	5V ± 10%
V _{DD} Power Supply	12V ± 5%	12V ± 5%	12V ± 5%	12V ± 10%
V _{BB} Power Supply	5V ± 5%	-5V ±5%	$-5V \pm 5\%$	-5V ± 10%

READ OPERATION D.C. AND OPERATING CHARACTERISTICS

	_	2708, 2708-1, 2708-6 Limits			2708L Limits			11-14-	Test Conditions
Symbol	Parameter	Min.	Typ. ^[2]	Typ. ^[2] Max.		Min. Typ. ^[2] N		Units	lest continons
ILI	Address and Chip Select Input Sink Current		1	10		1	10	μA	V _{IN} = 5.25V or V _{IN} = V _{IL}
LO	Output Learage Climent	-	1	10		1	10	μA	V _{OUT} = 5.5V, CS/WE = 5V
1 _{DD} [3]	VDD Supp , Climent		50	65		21	28	mA	Worst Case Supply Currents
+cc[3]	Voc Supply Current		6	10		2	4	mA	All Inputs High;
1 _{BB} [3]	VBB Supply Current		30	45		10	14	mA	CSWE = 5V; T _A = 0 °C
VIL	Input Low Voltage	. V _{SS}		0.65	Vss		0.65	٧	
• •	Input High Voltage	3 0		V _{CC} +1	2.2		V _{CC} +1	٧	
				0.45			0.4	v	IOL = 1.6mA (2708, 2708-1 2708-6
·••.	Output Low Voltage			0.45			0.4	•	I _{OL} = 2mA (2708L)
12-1	Output High Voltage	2.7			3.7			v	I _{OH} = -100µA
•:-:	Output High Voltage	2.4			2.4			V	I _{OH} = -1mA
	De une Dissignition			800			325	mW	T _A = 70 °C
20	Power Dissipation	·		<u>.</u>	<u> </u>		425	mW	T _A =0*C

NCTES: • Healmust be applied prior to V_{CC} and V_{DD}. Vealmust also be the last power supply switched off. 2. The tail veal are for T_A = 25°C and nominal subclete taiges 3. The total values are for T_A = 25°C and nominal subclete taiges 3. The total power dissipation is not calculated by summing the various currents (I_{DD}, I_{CC}, and I_{BB}) multiplied by their respective vol-tages since current paths exist between the various power subclete and V_{SS}. The I_{DD}, I_{CC}, and I_{BB} currents should be used to deter-mine total version supply capacity only.

4 BB for the 2708L is specified in the programmed state and is 18mA maximum in the unprogrammed state.



2708 FAMILY

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A.C. CHARACTERISTICS

Symbol	Decementer	2708, 2708L Limits		2708-1 Limits		2708-6 Limits		11-14-
	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Units
t _{ACC}	Address to Output Delay		450		350		550	ns
t _{co}	Chip Select to Output Delay		120		120		160	ns
t _{DF}	Chip Deselect to Output Float	0	120	0	120	0	160	ns
t _{он}	Address to Output Hold	0		0		0		ns

CAPACITANCE [1] $T_A = 25^{\circ}C$, f = 1 MHz

Symbol	Parameter	Typ.	Max.	Unit.	Conditions
C _{IN}	Input Capacitance	4	6	рF	V _{IN} = 0V
Ссут	Output Capacitance	8	12	рF	V ₂₀ - = 0V

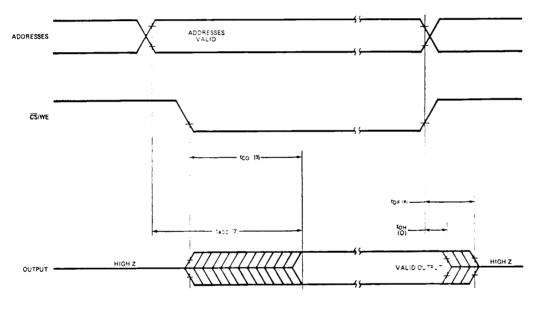
Timing Measurement Reference Levels: 0.8V and $2.8 \bar{V}$ for inputs; 0.8V and 2.4V for outputs. Input Pulse Levels: 0.65V to 3.0V

Output Load: 1 TTL gate and CL = 100 pF Input Rise and Fall Times: ≤20 ns

A.C. TEST CONDITIONS:

NOTE: 1. This parameter is periodically sampled and is not 100% tested.

A.C. WAVEFORMS ^[2]



NOTES

2 ALL TIMES SHOWN IN PARENTHESES ARE MINIMUM AND APE NSEC LN_ESS OTHERWISE SPECIFIED. 3 CS MAY BE DELAYED UP TO LACCHOO AFTER ADDRESSES ARE VAUD W THOUT IMPACT ON LACC. 4 IDER'S SPECIFIED FROM CS OR ADDRESS CHANGE, WHICHEVER OCCURS FIRST

ERASURE CHARACTERISTICS

The erasure characteristics of the 2708 family are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000-4000Å range. Data show that constant exposure to room level fluorescent lighting could erase the typical device in approximately 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the 2708 is to be exposed to these types of lighting conditions for extended periods of time, opaque labels are available from Intel which should be placed over the 2708 window to prevent unintentional erasure.

The recommended erasure procedure (see Data Catalog PROM/ROM Programming Instructions Section) for the 2708 family is exposure to shortwave ultraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity X exposure time) for erasure should be a minimum of 15 W-sec/cm². The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with a 12000 μ W/cm² power rating. The device should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure.

Appendix C2

intel[°] 2716 16K (2K × 8) UV ERASABLE PROM

- Fast Access Time
 - 350 ns Max. 2716-1
 - 390 ns Max. 2716-2
 - 450 ns Max. 2716
 - 490 ns Max. 2716.5
 - 650 ns Max. 2716.6
- Single + 5V Power Supply
- Low Power Dissipation
 525 mW Max. Active Power
 132 mW Max. Standby Power

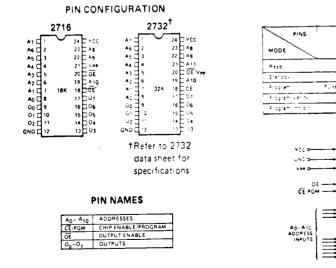
- Pin Compatible to Intel® 2732 EPROM
- Simple Programming Requirements
 - Single Location Programming
 - Programs with One 50 ms Pulse
- Inputs and Outputs TTL Compatible during Read and Program

Completely Static

The Intel[®] 2716 is a 16,384-bit ultraviolet erasable and electrically programmable read-only memory (EPROM). The 2716 operates from a single 5-volt power supply, has a static standby mode, and features fast single address location programming. It makes designing with EPROMs faster, easier and more economical.

The 2716, with its single 5-volt supply and with an access time up to 350 ns, is ideal for use with the newer high deformance +5V microprocessors such as Intel's 8085 and 8086. A selected 2716-5 and 2716-6 is available for slower speed abolic at ons. The 2716 is also the first EPROM with a static standby mode which reduces the power dissipation without increasing access time. The maximum active power dissipation is 525 mW while the maximum standby power dissipation is on , 132 mW, a 75% savings.

The 2716 has the simplest and fastest method yet devised for programming EPROMs – single oulse TTL evel programming. No need for high voltage pulsing because all programming controls are handled by TTL signals. Program an, ocation at any time-either individually, sequentially or at random, with the 2716's single address location programming. Total programming time for all 16,384 bits is only 100 seconds.



MODE SELECTION

PINS	<u>€</u> € ≥3₩ 18	0E 201	∀рр (21)	VCC (24)	OUTPUTS (9-11, 13-17)
Pess	· .	¥ (L	+5	+5	Pour
Starico.		Donin Care	+5	+5	High Z
·:::	P. set . 10	VIH	+25	+5	DIN
Program ver tv	• • •	VIL	+25	+5	POUT
Program into t		VIH	+25	+5	High Z

BLOCK DIAGRAM

PROGRAMMING

The programming specifications are described in the Data Catalog PROM/ROM Programming Instructions Section.

Absolute Maximum Ratings*

Temperature Under Bias10°C to +80°C
Storage Temperature
All Input or Output Voltages with
Respect to Ground
VPP Supply Voltage with Respect
to Ground During Program +26.5V to -0.3V

*COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC and AC Operating Conditions During Read

	2716	2716-1	2716-2	2716-5	2716-6
Temperature Range	0°C – 70°C	0°C – 70°C	$0^{\circ}C - 70^{\circ}C$	0°C - 70°C	0°C - 70°C
V _{CC} Power Supply[1,2]	5V ±5%	5∨ ±10%	5V ±5%	5V ±5%	5∨ ±5%
Vpp Power Supply [2]	V _{cc}	Vcc	Vcc	V _{CC}	Vcc

READ OPERATION D.C. and Operating Characteristics

0			Limits		Unit	Conditions
Symbol	Parameter	Min.	Typ. ^[3]	Max.		Conditions
1 _{LI}	Input Load Current			10	μA	V _{IN} = 5.25V
1LO	Output Leakage Current			10	μA	V _{OUT} = 5.25V
·==1 ^[2]	V _{PP} Current			5	mA	V _{PP} = 5.25V
lcc ^{.(2)}	V _{CC} Current (Standby)		10	25	mA	$\overline{CE} = V_{IH}, \overline{OE} = V_{IL}$
1002 ¹²¹	V _{CC} Current (Active)		57	100	mA	OE = CE = VIL
V _	Input Low Voltage	-0.1	l	0.8	V	
V -	Input High Voltage	2.0	-	V _{CC} +1	V	
·••-	Output Low Voltage			0.45	V	I _{OL} = 2.1 mA
¥c-	Output High Voltage	2.4			V	I _{OH} = -400 μA

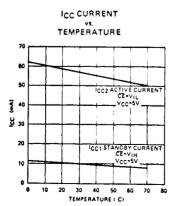
NOTES: 1. Yee must be applied simultaneously or before Vpp and removed simultaneously or after Vpp.

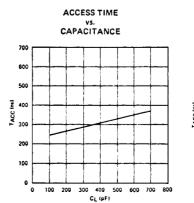
2 Upp may be connected directly to VCC except during programming. The supply current would then be the sum of ICC and Ipp1.

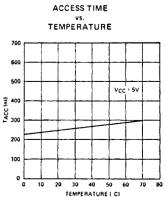
3. Typical values are for $T_A = 25^{\circ}C$ and nominal supply voltages.

4. This parameter is only sampled and is not 100% tested.

Typical Characteristics







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A.C. Characteristics

		Limits (ns)										
		2716		2716-1		2716-2		2716-5		2716-6		Test
Symbol	Parameter	Min.	Max.	Min.	Max.	Min,	Max,	Min.	Max.	Min.	Max.	Conditions
tACC	Address to Output Delay		450		350		390		450		450	CE ≈ OE = VIL
tCE	CE to Output Delay		450		350		390	1	490		650	ÕĒ ≂ V _{IŁ}
tOE	Output Enable to Output Delay		120		120		120		160		200	CE = VIL
^t DF	Output Enable High to Output Float	0	100	0	100	0	100	0	100	0	100	ČE = VIL
^t он	Output Hold from Addresses, CE or OE Whichever Occurred First	0		0		0		0	_	0	-	CE = OE = VIL

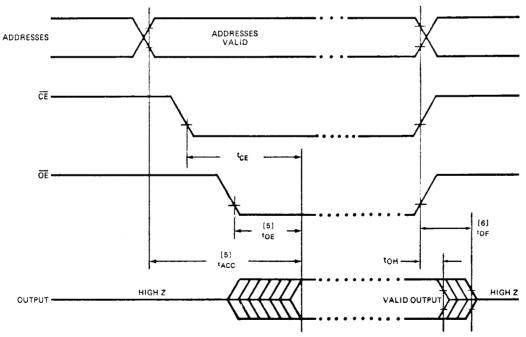
Capacitance ^[4] $T_A = 25^{\circ}C$, f = 1 MHz

Symbol	Parameter	Тур.	Max.	Unit	Conditions
C _{IN}	Input Capacitance	4	6	рF	V _{IN} = 0V
C _{OUT}	Output Capacitance	8	12	рF	Vour = 0V

A.C. Test Conditions:

Output Load: 1 TTL gate and C_{\perp} = 100 pF Input Rise and Fall Times: ≤20 ns Input Pulse Levels: 0.8V to 2.2V Timing Measurement Reference Level: Inputs 1V and 2V Outputs 0.8V and 2V

A.C. Waveforms [1]



NOTE:

- V_{CC} must be applied simultaneously or before Vpp and removed simultaneously or after Vpp.
 Vpp may be connected directly to V_{CC} except during programming. The supply current would then be the sum of I_{CC} and Ipp1.
- 3. Typical values are for $T_A = 25^\circ$ C and nominal supply voltages. 4. This parameter is only sampled and is not 100% tested.
- 5. OE may be delayed up to $t_{ACC} t_{OE}$ after the failing edge of CE without impact on t_{ACC} . 6. t_{DF} is specified from OE or CE, whichever occurs first.

ERASURE CHARACTERISTICS

The erasure characteristics of the 2716 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000-4000Å range. Data show that constant exposure to room level fluorescent lighting could erase the typical 2716 in approximately 3 years, while it would take approximately 1 week to cause erasure when exposed to direct sunlight. If the 2716 is to be exposed to these types of lighting conditions for extended periods of the coace labes are available from Intel which should be blaced over the 2716 window to prevent unintentional erasure.

The recommended erasure procedure (see Data Catalog PROM/ROM Programming Instruction Section) for the 2716 is exposure to shortwave ultraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity X exposure time) for erasure should be a minimum of 15 W-sec/cm². The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with a 12000 μ W/cm² power rating. The 2716 should be placed within 1 inch of the lamp tubes during erasure. Some amos have a filter on their tubes which should be removed the for erasure.

DEVICE OPERATION

The five modes of operation of the 2716 are listed in Table I. It should be noted that a inputs for the five modes are at TTL levels. The power subplies redured are a +5V V_{CC} and a V_{PP}. The V_{PP} power subplies redured at 25V during the three programming modes, and must be at 5V in the other two modes.

TABLE I. MODE SELECT ON

PINS MUDE	CE/PGM (18)	0E (20)	· 22	* 00 24	095 9'' '3'7
···:	VIL	V L	••	••	÷:.•
Stance.	VIH	Don - Care	÷	•÷	- ;- 2
Prave T	Puised VIL to VIH	V ₁₋₁	·::	••	î.
Program Lawred	VIL	VIL	•35	-5	2014
tiggam inter	VIL	V _{1H}	-::	- 5	- ;- Z

READ MODE

The 2716 has two control functions, both of which must be logical, satisfied in order to obtain data at the outputs. Chip Enable (\overline{CE}) is the power control and should be used for device selection. Output Enable (\overline{OE}) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address address time (t_{ACC}) is equal to the output the output (t_{CE}). Data is available at the outputs 120 hs (t_{CE}) after the falling edge of \overline{OE} , assuming that \overline{CE} has been low and addresses have been stable for at least $t_{ACC} - t_{OE}$.

STANDBY MODE

The 2716 has a standby mode which reduces the active power dissipation by 75%, from 525 mW to 132 mW. The 2716 is placed in the standby mode by applying a TTL high signal to the \overline{CE} input. When in standby mode, the outputs are in a high impedence state, independent of the \overline{OE} input.

OUTPUT OR-TIEING

Because 2716's are usually used in larger memory arrays, Intel has provided a 2 line control function that accomodates this use of multiple memory connections. The two line control function allows for:

- a) the lowest possible memory power dissipation, and
- b) complete assurance that output bus contention will not occur.

To most efficiently use these two control lines, it is recommended that \overrightarrow{CE} (pin 18) be decoded and used as the primary device selecting function, while \overrightarrow{OE} (pin 20) be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low power standby mode and that the output bins are only active when data is desired from a particular memory device.

PROGRAMMING

Initially, and after each erasure, all bits of the 2716 are in the "11" state. Data is introduced by selectively programming "0's" into the desired bit locations. Although only "0's" will be programmed, both "1's" and "0's" can be presented in the data word. The only way to change a "0" to a "1" is by ultraviolet light erasure.

The 2716 is in the programming mode when the VPP bower supply is at 25V and \overline{OE} is at $V_{1H}.$ The data to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

When the address and data are stable, a 50 msec, active high, TTL program pulse is applied to the $\overline{\text{CE}}/\text{PGM}$ input. A program pulse must be applied at each address location to be programmed. You can program any location at any time — either individually, sequentially, or at random. The program pulse has a maximum width of 55 msec. The 2716 must not be programmed with a DC signal applied to the $\overline{\text{CE}}/\text{PGM}$ input.

Programming of multiple 2716s in parallel with the same data can be easily accomplished due to the simplicity of the programming requirements. Like inputs of the paralleled 2716s may be connected together when they are programmed with the same data. A high level TTL pulse applied to the \overline{CE}/PGM input programs the paralleled 2716s

PROGRAM INHIBIT

Programming of multiple 2716s in parallel with different data is also easily accomplished. Except for \overline{CE}/PGM , all like inputs (including \overline{OE}) of the parallel 2716s may be common. A TTL level program pulse applied to a 2716's \overline{CE}/PGM input with Vpp at 25V will program that 2716. A low level \overline{CE}/PGM input inhibits the other 2716 from being programmed.

PROGRAM VERIFY

A verify should be performed on the programmed bits to determine that they were correctly programmed. The verify may be performed wth V_{PP} at 25V. Except during programming and program verify, V_{PP} must be at 5V.

2716

Appendix C3 intہ

2102A, 2102AL/8102A-4* 1K x 1 BIT STATIC RAM

P/N	Standby Pwr. (mW)	Operating Pwr. (mW)	Access (ns)
2102AL-4	35	174	450
2102AL	35	174	350
2102AL-2	42	342	250
2102A-2		342	250
2102A		289	350
2102A-4		289	450

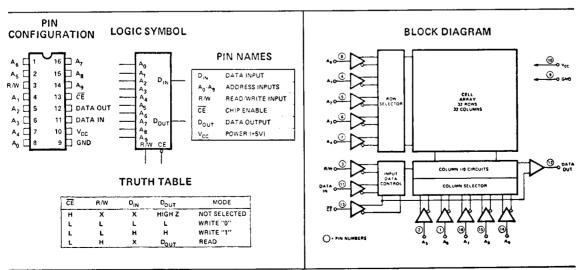
- Single +5 Volts Supply Voltage
- Directly TTL Compatible: All Inputs and Output
- Standby Power Mode (2102AL)
- Three-State Output: OR-Tie Capability
- Inputs Protected: All Inputs Have Protection Against Static Charge
- Low Cost Packaging: 16 Pin Dual-In-Line Configuration

The Intel® 2102A is a high speed 1024 word by one bit static random access memory element using N-channel MOS devices integrated on a monolithic array. It uses fully DC stable (static) circuitry and therefore requires no clocks or refreshing to operate. The data is read out noncestructively and has the same polarity as the input data.

The 2102A is designed for memory applications where high performance, low cost, large bit storage, and simple interfacing are important design objectives. A low standby power version (2102AL) is also available. It has all the same operating characteristics of the 2102A with the apped feature of 35mW maximum power dissipation in standby and 174mW in operations.

It is directly TTL compatible in all respects: inputs, output, and a single +5 volt supply. A separate chip enable (CE) lead allows easy selection of an individual package when outputs are OR-tied.

The Intel® 2102A is fabricated with N-channel silicon gate technology. This technology allows the design and production of high performance easy to use MOS circuits and provides a higher functional density on a monolithic chip than either conventional MOS technology or P-channel silicon gate technology.



*All 8102A-4 specifications are identical to the 2102A-4 specifications.

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Absolute Maximum Ratings*

Ambient Temperature Under Bi	
Storage Temperature	-65°C to +150°C
Voltage On Any Pin With Respect To Ground	-0.5V to +7V
Power Dissipation	1 Watt

*COMMENT:

Stresses above those listed under "Absolute Maximum Rating" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

D. C. and Operating Characteristics

 $T_A = 0^{\circ}C$ to $70^{\circ}C$, $V_{CC} = 5V \pm 5\%$ unless otherwise specified.

Symbol	Parameter	1	02A, 210 2AL, 210 Limits Typ. ^[1]	2AL-4	2102 Min.	A-2, 2102 Limits Typ. ^[1]	A L-2 Max.	Unit	Test Conditions
۱ _{LI}	Input Load Current		1	10		1	10	μA	V _{IN} = 0 to 5.25V
LOH	Output Leakage Current		1	5		1	5	μA	СĒ = 2.0V, Vout = Voh
LOL	Output Leakage Current		-1	-10		-1	-10	μA	CE = 2.0V, V _{OUT} = 0.4V
lcc	Power Supply Current	-	33	Note 2		45	65	mA	All Inputs = 5.25V, Data Out Open, T _A = 0°C
VIL	Input Low Voltage	-0.5		0.8	-0.5		0.8	V	
VIH	Input High Voltage	2.0		V _{CC}	2.0		v_{cc}	v	
VOL	Output Low Voltage			0.4			0.4	V	I _{OL} = 2.1mA
Vон	Output High Voltage	2.4			2.4			V	I _{OH} = -100µА

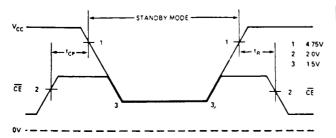
Notes 1. Typical values are for $T_A = 25^{\circ}$ C and nominal supply voltage.

2. The maximum ICC value is 55mA for the 2102A and 2102A-4, and 33mA for the 2102AL and 2102AL-4.

Standby Characteristics 2102AL, 2102AL-2, and 2102AL-4 (Available only in the Plastic Package) $T_A = 0^{\circ} C \cos 20^{\circ} C$

		210	D2AL, 2102A Limits	L·4		2102AL-2 Limits			
Symbol	Parameter	Min.	Түр.[1]	Max.	Min.	Typ.[1]	Max.	Unit	Test Conditions
VPD	Ngg in Standby	1.5			1.5			V	
	CE Blas in Standby	2.0			2.0			V	2.0V≤VpD≤V _{CC} Max.
		VPD		-	VPD			V	1.5V ≤V _{PD} < 2.0V
I _{PD1}	Standow Current	1	15	23		20	28	mA	All Inputs = V _{PD1} = 1.5V
PD2	Standby Current		20	30		25	38	mA	Ali Inputs = V _{PD2} = 2.0V
t _{CP}	Chip Deselect to Standow Time	0			0			ns	
t _R [3]	Standby Recovery Time	tRC			tRC			ns	

STANDBY WAVEFORMS



NOTES:

1. Typical values are for $T_A = 25^{\circ}$ C.

2. Consider the test conditions as shown: If the standby voltage (Vpp) is between 5.25V (V_{CC} Max.) and 2.0V, then CE must be held at 2.0V Min. (V₁H). If the standby voltage is less than 2.0V but greater than 1.5V (Vpp Min.), then CE and standby voltage must be at least the same value or, if they are different, CE must be the more positive of the two.

3. tR = tRC (READ CYCLE TIME).

A. C. Characteristics $T_A = 0^{\circ}C$ to 70°C, $V_{CC} = 5V \pm 5\%$ unless otherwise specified READ CYCLE

		2102A-2, 2102AL-2 Limits (ns)		2102A, 2102AL Limits (ns)		2102A-4, 2102AL-4 Limits (ns)	
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.
t _{RC}	Read Cycle	250		350		450	
t _A	Access Time		250		350		450
t _{CO}	Chip Enable to Output Time		130		180		230
toh1	Previous Read Data Valid with Respect to Address	40		40		40	
t _{OH2}	Previous Read Data Valid with Respect to Chip Enable	0		0		0	

WRITE CYCLE

twc	Write Cycle	250	350	450
t _{AW}	Address to Write Setup Time	20	20	20
twp	Write Pulse Width	180	250	300
twn	Write Recovery Time	0	0	0
t _{DW}	Data Setup Time	*80	250	300
t _{DH}	Data Hold Time	0	0	0
tcw	Chip Enable to Write Setup Time	180	250	300

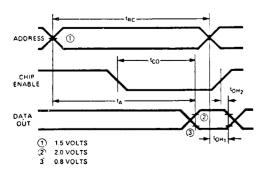
A.C. CONDITION	S OF TEST	r
Input Pulse Levels:		0 8 v 5 t to 2.0 Volt
Input Rise and Fall Tin	nes:	10nsec
Timing Measurement	Inputs:	1.5 Volts
Reference Levels	Output:	0 Biand 2.0 Volts
Output Load:	1 TTL	Gate and Cill = 100 pF

Capacitance^[2] $T_A = 25^{\circ}C$, f = 1 MHz

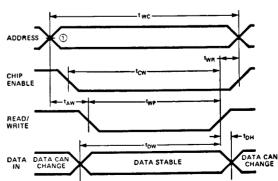
	TEOT	LIMITS (pF)			
SYMBOL	TEST	түр.	MAX.		
C _{IN}	INPUT CAPACITANCE (ALL INPUT PINS: VIL = 0V	3	5		
C _{OUT}	OUTPUT CAPACITANCE V _{OUT} = 0V	7	10		

Waveforms

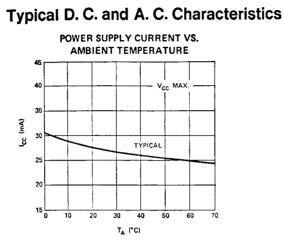
READ CYCLE



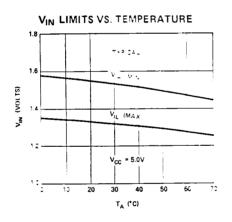
WRITE CYCLE



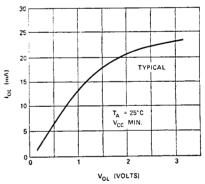
NOTES: 1. Typical values are for $T_A = 25^{\circ}$ C and nominal supply voltage. 2. This parameter is periodically sampled and is not 100% tested.



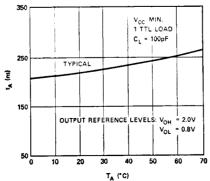
POWER SUPPLY CURRENT VS. SUPPLY VOLTAGE 35 T_A = 25°C 30 25 (MA) TYPICAL 20 <u>_</u>8 15 10 5 L 2 3 4 5 6 VCC (VOLTS)



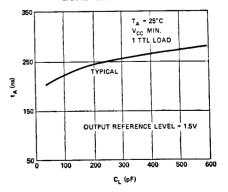
OUTPUT SINK CURRENT VS. OUTPUT VOLTAGE



ACCESS TIME VS.



ACCESS TIME VS. LOAD CAPACITANCE



Appendix C4

intel

2114A 1024 X 4 BIT STATIC RAM

	2114AL-1	2114AL-2	2114AL-3	2114AL-4	2114A-4	2114A-5
Max. Access Time (ns)	100	120	150	200	200	250
Max. Current (mA)	40	40	40	40	70	70

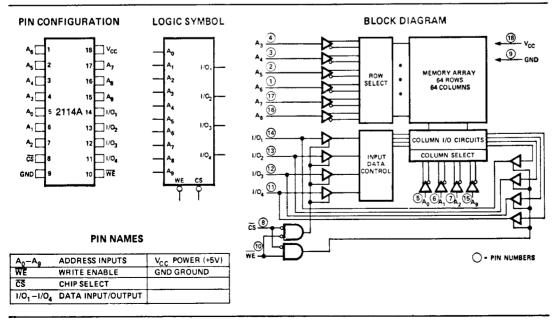
- HMOS Technology
- Low Power, High Speed
- Identical Cycle and Access Times
- Single +5V Supply ±10%
- High Density 18 Pin Package

- Completely Static Memory No Clock or Timing Strobe Required
- Directly TTL Compatible: All Injuts and Outputs
- Common Data Input and Output Using Three-State Outputs
- 2114 Upgrade

The Intel® 2114A is a 4096-bit static Random Access Memory organized as 1024 words by 4-bits using HMOS, a high performance MOS technology. It uses fully DC stable (static) circuitry throughout, in both the array and the decoding, therefore it requires no clocks or refreshing to operate. Data access is particularly simple since address setup times are not required. The data is read out nondestructively and has the same polarity as the input data. Common input/output pins are provided.

The 2114A is designed for memory applications where the high performance and high reliability of HMOS. How cost, large bit storage, and simple interfacing are important design objectives. The 2114A is placed in an 18-pin package for the highest possible density.

It is directly TTL compatible in all respects: inputs, outputs, and a single +5V supply. A separate Chip Select (\overline{CS}) lead allows easy selection of an individual package when outputs are or-tied.



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ABSOLUTE MAXIMUM RATINGS*

Temperature Under Bias	10°C to 80°C
Storage Temperature	
Voltage on any Pin	
With Respect to Ground	3.5V to +7V
Power Dissipation	1.0W
D.C. Output Current	

*COMMENT: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

D.C. AND OPERATING CHARACTERISTICS

 $T_A = 0^{\circ}C$ to 70°C, $V_{CC} = 5V \pm 10\%$, unless otherwise noted.

SYMBOL	PARAMETER		- 1/L-2/L Τγρ.[1]	1		2114A-4/- Typ. 1		UNIT	CONDITIONS
I _{LI}	Input Load Current (All Input Pins)			10			10	μA	V _{IN} = 0 to 5.5V
ILO	I/O Leakage Current			10			10	μA	$\overline{CS} = V_{H}$ $V_{I/O} = GND$ to VCC
lcc	Power Supply Current		25	40		50	70	mA	$V_{CC} = max$, $I_{I/O} = 0 mA$ $T_A = 0^{\circ}C$
VIL	Input Low Voltage	-3.0		0.8	-3.0		0.8	V	
VIH	Input High Voltage	2.0		6.0	2.0		6.0	V	
'or	Output Low Current	2.1	9.0		2.1	9.0		mA	V _{OL} = 0.4V
Існ	Output High Current	-1.0	-2.5	_	-1.0	-2.5		mA	V _{OH} = 2.4V
los ^[2]	Output Short Circuit Current			40			40	mA	

NOTE: 1. Typical values are for $T_A = 25^{\circ}$ C and $V_{CC} = 5.0V_{*}$

2. Duration not to exceed 30 seconds.

CAPACITANCE

T_A = 25°C, f = 1.0 MHz

SYMBOL	TEST	MAX	UNIT	CONDITIONS
CLO	Input Output Capacitance	5	pF	V _{I/O} = OV
CiN	Input Capacitance	5	pF	V _{IN} = OV

NOTE: This parameter is periodically sampled and not 100% tested.

A.C. CONDITIONS OF TEST

Input Pulse Levels	0.8 Volt to 2.0 Volt
Input Rise and Fall Times	
Input and Output Timing Levels	
Output Load	

2114A FAMILY

A.C. CHARACTERISTICS $T_A = 0^{\circ}C$ to 70°C, $V_{CC} = 5V \pm 10\%$, unless otherwise noted.

READ CYCLE [1]

		2114	AL-1	2114AI	-2	2114AI	3	2114A	-4/L-4	2114A-	5	
SYMBOL	PARAMETER	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	UNIT
t _{PC}	Read Cycle Time	100		120		150		200		250		ns
tA	Access Time		100		120	1	150		200		250	ns
t _{co}	Chip Selection to Output Valid		70		70		70		70		85	ns
t _{cx}	Chip Selection to Output Active	10		10		10		10		10		ns
torp	Output 3-state from Deselection		30		35		40		50		60	ns
t _{oha}	Output Hold from Address Change	15		15		15		15		15		ns

WRITE CYCLE [2]

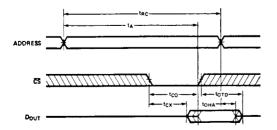
		2114A	L-1	2114AI	L-2	2114Al	-3	2114A-	4/L-4	2114A-	-5	
SYMBOL	PARAMETER	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	UNIT
twc	Write Cycle Time	100		120		150		200		250		^ \$
tw	Write Time	75		75		90		120		135		۳S
twe	Write Release Time	0		0		0		0		0		rs.
torw	Output 3-state from Write		30		35	1	40		50		60	ns
tow	Data to Write Time Overlap	70		70		. 90		120		135		лs
t _{DH}	Data Hold from Write Time	0		0		0		0		0		ns

NOTES:

NOTES: 1. A Read occurs during the overlap of a low CS and a high WE. 2. A Write occurs during the overlap of a low CS and a low WE, twis measured from the latter of CS or WE going low to the earlier of CS or WE going high.

WAVEFORMS

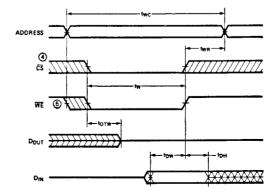
READ CYCLE³



NOTES:

WE is high for a Read Cycle.
 If the CS low transition occurs simultaneously with the WE low transition, the output buffers remain in a high impedance state.
 WE must be high during all address transitions.

WRITE CYCLE



Appendix C5

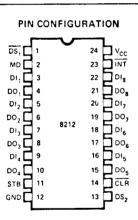
intel

8212 8-BIT INPUT/OUTPUT PORT

- Fully Parallel 8-Bit Data Register and Buffer 3.65V Output High Voltage for
- Service Request Flip-Flop for Interrupt Generation
- Low Input Load Current .25mA Max.
- Three State Outputs
- Outputs Sink 15mA

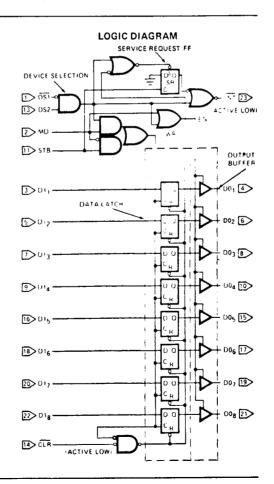
- 3.65V Output High Voltage for Direct Interface to 8008, 8080A, or 8085A CPU
- Asynchronous Register Clear
- Replaces Buffers, Latches and Multiplexers in Microcomputer Systems
- Reduces System Package Count

The 8212 input/output port consists of an 8-bit latch with 3-state output buffers along with control and device selection logic. Also included is a service request fing-flop for the generation and control of interrupts to the microprocessor. The device is multimode in nature. It can be used to implement latches, gated buffers or multiplexers. Thus, all of the principal peripheral and input/output functions of a microcomputer system can be implemented with this device.



PIN NAMES

DH Die	DATA IN
DO: DO	DATAOUT
DS1 DS2	DEVICE SELECT
MD	MODE
STB	STROBE
INT	INTERRUPT (ACTIVE LOW)
CLR	CLEAR (ACTIVE LOW)



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FUNCTIONAL DESCRIPTION

Data Latch

The 8 flip-flops that make up the data latch are of a "D" type design. The output (Q) of the flip-flop will follow the data input (D) while the clock input (C) is high. Latching will occur when the clock (C) returns low.

The latched data is cleared by an asynchronous reset input (CLR). (Note: Clock (C) Overrides Reset (CLR).)

Output Buffer

The outputs of the data latch (Q) are connected to 3-state, non-inverting output buffers. These buffers have a common control line (EN); this control line either enables the buffer to transmit the data from the outputs of the data latch (Q) or disables the buffer, forcing the output into a high impedance state. (3-state)

The high-impedance state allows the designer to connect the 8212 directly onto the microprocessor bi-directional data bus.

Control Logic

The 8212 has control inputs DS1, DS2, MD and STB. These inputs are used to control device selection, data latching, output buffer state and service request flip-flop.

DS1, DS2 (Device Select)

These 2 inputs are used for device selection. When $\overline{DS1}$ is low and DS2 is n gn DS1 DS2 the bey de is selected in the selected state the output outfer is enabled and the service request flip-flob SR is asynchronously set.

MD (Mode)

This input is used to control the state of the output puffer and to determine the source of the clock input. C I to the data latch

When MD is high (output mode) the output puffers are enabled and the source of clock C to the data latch is from the device selection logic CST + DS2.

When MD is low (input mode) the cutput buffer state is determined by the device selection (cg.c. DS1 - DS2) and the source of clock (C) to the data latch is the STB Strope input.

STB (Strobe)

This input is used as the clock (C) to the data latch for the input mode $\forall D = 0$ and to synchronously reset the service request f p-f op (SR).

Note that the SR flip-flop is negative edge triggered.

Applications of the 8212 - For

- Microcomputer Systems
- Basic Schematic Symbol П

T

- Gated Buffer 111 **Bi-Directional Bus Driver**
- IV Interrupting Input Port

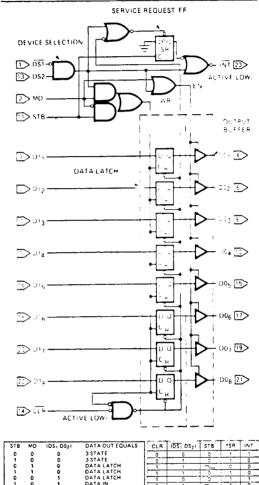
1. Basic Schematic Symbols

Two examples of ways to draw the 8212 on system schematics - (1) the top being the detailed view showing pin numbers, and (2) the bottom being the symbolic view

Service Request Flip-Flop

The (SR) flip-flop is used to generate and control interrupts in microcomputer systems. It is asynchronously set by the CLR input (active low). When the (SR) flipflop is set it is in the non-interrupting state.

The output of the (SR) flip-flop (Q) is connected to an inverting input of a "NOR" gate. The other input to the "NOR" gate is non-inverting and is connected to the device selection_logic (DS1 \cdot DS2). The output of the "NOR" gate (INT) is active low (interrupting state) for connection to active low input priority generating circuits.



	0	٥	٥	3 STATÉ	0	0	0	1	1
j	,	0	0	3 STATE	0	1	2	1	0
	0	1	0	DATA LATCH	1	1		0	0
	1	1	0	DATA LATCH		1	0	1	0
ł	0	0	1	DATA LATCH	1	0	2	1	1
ł	1	0	1	DATA IN	1	1			0
1	0	<u>1</u>	1	DATA IN	i i i i i i i i i i i i i i i i i i i			<u> </u>	لمنسبه
1	1	1	1	DATA IN		INTERNAL	SR FLIP	FLOP	
	CLR	SETS	TS DATA LA SR FLIP FLI FFECT ON I						

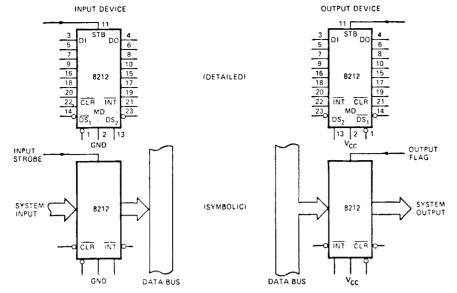
8212

v Interrupt Instruction Port

- VI **Output Port**
- VII 8080A Status Latch
- VIII 8085A Address Latch

showing the system input or output as a system bus (bus containing 8 parallel lines). The output to the data bus is symbolic in referencing 8 parallel lines.

BASIC SCHEMATIC SYMBOLS



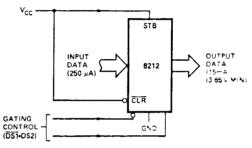
II. Gated Buffer (3-State)

The simplest use of the 8212 is that of a gated buffer. By tying the mode signal low and the strobe input high, the data latch is acting as a straight through gate. The output buffers are then enabled from the device selection logic DS1 and DS2.

When the device selection logic is false, the outputs are 3-state.

When the device selection logic is true the input data from the system is directly transferred to the output. The input data load is 250 micro amps. The output data can sink 15 milli amps. The minimum high output is 3.65 volts.

GATED BUFFER

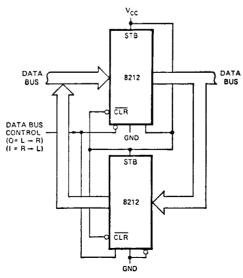


8212

III. Bi-Directional Bus Driver

A pair of 8212's wired (back-to-back) can be used as a symmetrical drive, bi-directional bus driver. The devices are controlled by the data bus input control which is connected to DS1 on the first 8212 and to DS2 on the second. One device is active, and acting as a straight through buffer the other is in 3-state mode. This is a very useful circuit in small system design.

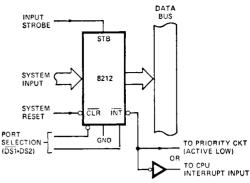
BI-DIRECTIONAL BUS DRIVER



IV. Interrupting Input Port

This use of an 8212 is that of a system input port that accepts a strobe from the system input source, which in turn clears the service request flip-flop and interrupts the processor. The processor then goes through a service routine, identifies the port, and causes the device selection logic to go true — enabling the system input data onto the data bus.

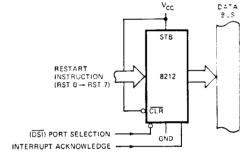
INTERRUPTING INPUT PORT



V. Interrupt Instruction Port

The 8212 can be used to gate the interrupt instruction, normally RESTART instructions, onto the data bus. The device is enabled from the interrupt acknowledge signal from the microcrocessor and from a port selection signal. This signal is normally tied to ground. (DS1 could be used to multiplex alvariety of interrupt instruction ports onto a common bus.

INTERRUPT INSTRUCTION PORT

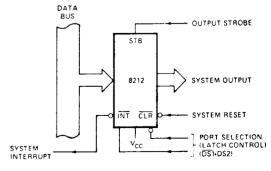


8212

VI. Output Port (With Hand-Shaking)

The 6212 can be used to transmit data from the data bus to a system output. The output strobe could be a handshaking's gha such as reception of data" from the device that the system is outputting to. It in turn, can interrupt the system signifying the reception of data. The selection of the port comes from the device selection logic.(DS1+DS2)

OUTPUT PORT (WITH HAND-SHAKING)

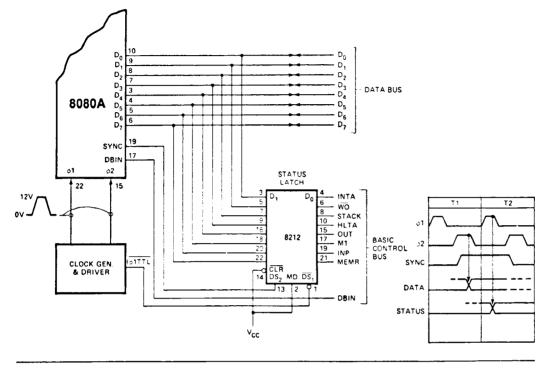


VII. 8080A Status Latch

Here the 8212 is used as the status latch for an 8080A microcomputer system. The input to the 8212 latch is directly from the 8080A data bus. Timing shows that when the SYNC signal is true, which is connected to the DS2 input and the phase 1 signal is true, which is a TTL level coming from the clock generator; then, the status data will be latched into the 8212.

Note: The mode signal is tied high so that the output on the latch is active and enabled all the time.

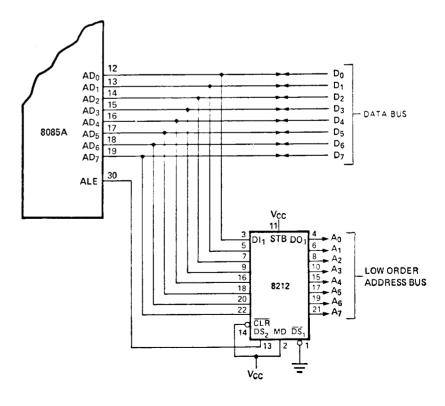
It is shown that the two areas of concern are the bidirectional data bus of the microprocessor and the control bus.



8212

VIII. 8085A Low-Order Address Latch

The 8085A microprocessor uses a multiplexed address/ data bus that contains the low order 8-bits of address information during the first part of a machine cycle. The same bus contains data at a later time in the cycle. An address latch enable (ALE) signal is provided by the 8085A to be used by the 8212 to latch the address othat it may be available through the whole machine address to at it in this configuration, the MODE input is team grickeeping the 8212's output buffers turned on at all times.



ABSOLUTE MAXIMUM RATINGS*

 Temperature Under Bias Plastic
 0°C to +70°C

 Storage Temperature
 -65°C to +160°C

 All Output or Supply Voltages
 -0.5 to +7 Volts

 All Input Voltages
 -1.0 to 5.5 Volts

 Output Currents
 100mA

'COMMENT

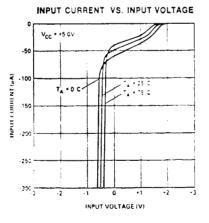
Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

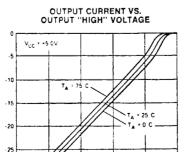
D.C. CHARACTERISTICS $T_A = 0^{\circ}C$ to +75°C, $V_{CC} = +5V \pm 5\%$

	- ·		Limits		Unit	Test Conditions	
Symbol	Parameter	Min.	lin. Typ. N				
lF	Input Load Current, ACK, DS ₂ , CR, DI ₁ -DI ₈ Inputs			25	mA	VF = .45V	
lF	Input Load Current MD Input			75	mA	VF = .45V	
lF	Input Load Current DS1 Input			-1.0	mA	VF = .45V	
IR.	Input Leakage Current, ACK, DS, CR, DI ₁ -DI ₈ Inputs			10	μA	VR ≤V00	
IR	Input Leakage Current MO Input			30	μA	VR ≤VCC	
IR I	Input Leakage Current DS+ Input			40	μA	VR SVCC	
Vc	Input Forward Voltage Clamp			-1	V	1c = -5mA	
ViL	Input "Low" Voltage			.85	V		
ViH	Input "High" Voltage	20			V		
VOL	Output "Low" Voltage			.45	V	IOL = 15mA	
Vон	Output "High" Voltage	3 65	4.0		V	юн = -1mA	
Isc	Short Circuit Output Current	-15		-75	mA	$V_0 = 0V$, $V_{00} = 5V$	
101	Cutput Leakage Current High			20	μA	Vo = .45V-5.25V	
lcc	Power Supply Current	;	90	130	mA	1	

8212

TYPICAL CHARACTERISTICS





3.0

OUTPUT "HIGH" VOLTAGE (V)

20

10

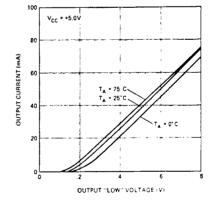
40

5.0

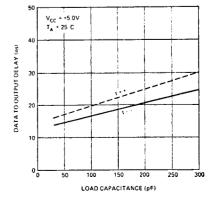
OUTPUT CURRENT (mA)

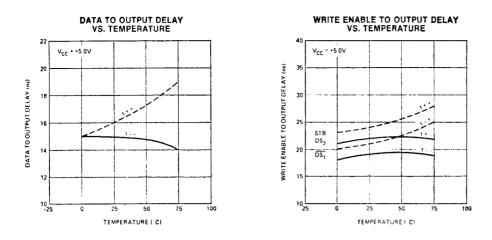
-30 35

OUTPUT CURRENT VS. OUTPUT "LOW" VOLTAGE



DATA TO OUTPUT DELAY VS. LOAD CAPACITANCE





821	2
-----	---

A.C. CHARACTERISTICS $T_A = 0^{\circ} C$ to $+70^{\circ} C$. $V_{CC} = +5V \pm 5\%$

A	Deveryone		Limits	Unit	Test Conditions	
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
tpw	Pulse Width	30			ns	
tPD	Data to Output Delay			30	ns	Note 1
twe	Write Enable to Output Delay			40	ns	Note 1
tSET	Data Set Up Time	15			ns	
tн	Data Hold Time	20			ns	
tR	Reset to Output Delay			40	ns	Note 1
ts	Set to Output Delay			30	ns	Note 1
te	Output Enable Disable Time			45	ns	Note 1
tc	Clear to Output Delay			55	ns	Note 1

CAPACITANCE* F = 1MHz. VBAS = 2 5V. VCC = +5V, TA = 25°C

Symbol	Test	Limits	
		Тур. Мах.	
CIN	DS1 MD Input Capacitance	90F 120F	
CIN	DS ₂ , CK, ACK, DI1-DI8 Input Capacitance	5pF 9pF	
Cout	DO1-DO8 Output Capacitance	8pF 12pF	

*This parameter is sampled and not 100% tested.

SWITCHING CHARACTERISTICS

Conditions of Test

Input Pulse Amplitude = 2.5V Input Rise and Fall Times 5ns Between 1V and 2V Measurements made at 1.5V with 15mA and 30pF Test Load

Note 1:

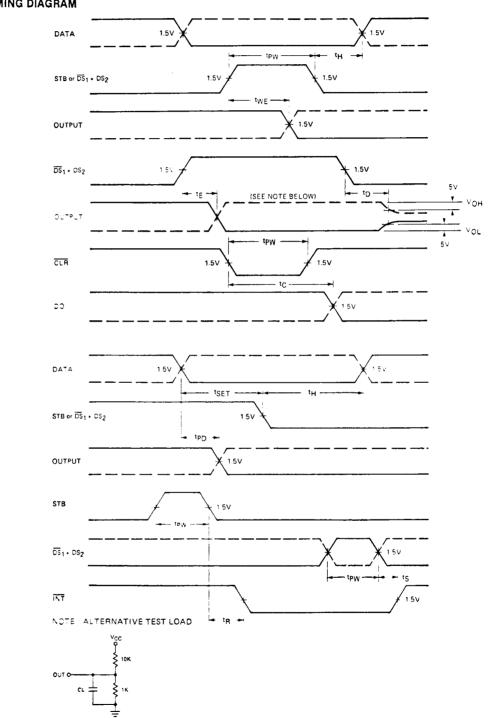
Test	CL.	R ₁	R ₂
tPD, tWE, tR, tS, tC	30pF	300Ω	600Ω
te, ENABLE1	30pF	10KΩ	1KΩ
te, ENABLE I	30pF	300N	600Ω
te, DISABLE	5pF	300N	600Ω
tE, DISABLEI	5pF	10KΩ	1ΚΩ

*Includes probe and jig capacitance.



 $\begin{array}{c}
TO \\
D.U.T. \\
C_{L^{*}} \xrightarrow{-} \\
\overline{-} \\
\overline{-}$

*INCLUDING JIG & PROBE CAPACITANCE



8212

TIMING DIAGRAM

Appendix C6

STANDARD MICROSYSTEMS CORPORATION

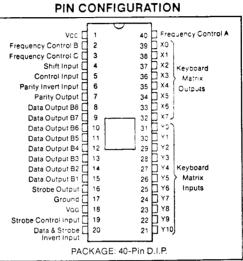
KR2376-XX

35 Marcus Blvd Hauppauge N Y 11787 (516) 273-3100 TWX-510-227-8898 We keep ahead of our competition so you can keep ahead of yours.

Keyboard Encoder Read Only Memory

FEATURES

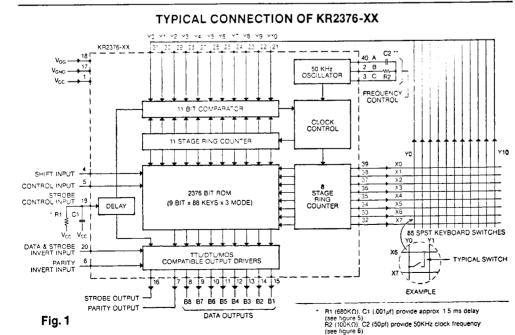
- Outputs directly compatible with TTL/DTL or MOS logic arrays.
- External control provided for output polarity selection.
- External control provided for selection of odd or even parity.
- Two key roll-over operation.
- □ N-key lockout.
- Programmable coding with a single mask change.
- Self-contained oscillator circuit.
- Externally controlled delay network provided to eliminate the effect of contact bounce.
- C One integrated circuit required for complete keyboard assembly.
- Static charge protection on all input and cutput terminals.
- Entire circuit protected by a layer of glass passivation.



GENERAL DESCRIPTION

The SMC KR2376-XX is a 2376-bit Read Only Memory with all the logic necessary to encode single pole single throw keyboard closures into a usable 9-bit code. Data and strobe outputs are directly compatible with TTL/DTL or MOS logic arrays without the use of

any special interface components. The KR2376-XX is fabricated with low th resho P-channel technology and contains 2942 P-channel enhancement mode transistors on a single mono and chip, available in a 40 pin dual-in-line package



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MAXIMUM GUARANTEED RATINGS†

Operating Temperature Range	0°C to +70°C
Storage Temperature Range	65° C to +150° C
Storage Temperature Hange	-20V to $+0.3V$
GND and V _{GG} , with respect to Vcc	$20V \text{ to } \pm 0.3V$
Logic Input Voltages, with respect to Vcc	-20° 10 $\pm 0.3^{\circ}$

† Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied.

ELECTRICAL CHARACTERISTICS

(TA = 0° C to +70° C, Vcc = +5V \pm 0.5V, Vcc = -12V \pm 1.0V, unless otherwise noted)

Characteristics	Min	Тур	Max	Unit	Conditions
CLOCK	20	50	100	KHz	see fig.1 footnote (**) for typical R-C values
DATA INPUT Logic "0" Level Logic "1" Level Input Capacitance	Vcc-1.5		-0.8 10	V V pf	
INPUT CURRENT *Control, Shift & Y0 thru Y10	10	100	140	μA	$V_{1N} = +5.0V$
*Control, Shift & Y0 thru Y10 Data Invert, Parity Invert	5	30 .01	50 1	μΑ μΑ	$V_{IN} = Ground$ $V_{IN} = -5.0V$ to $+5.0V$
DATA OUTPUT & X OUTPUT Logic "0" Level Logic "1" Level	Vcc-1.0		-04		lou = 1.6mA (see fig. 7) Io- = 100 μΑ
POWER CONSUMPTION	100 1.0	140	200	m	Nom Power Supp. Voltages (see fig. 8)
S.: TCH CHARACTERISTICS	see timi	ng diagra	am-fig. 2		
Contact Closure Resistance cetween X1 and Y1			300	Chm	
Contact Open Resistance between X1 and Y1	1 x 10 ⁷			04~	

*inputs with Internal Resistor to Vgg

DESCRIPTION OF OPERATION

The KR2376-XX contains (see Fig. 1), a 2376-bit ROM, 8-stage and 11-stage ring counters, an 11-bit comparator, an oscillator circuit, an externally controllable delay network for eliminating the effect of contact bounce, and TTL/DTL/MOS compatible output drivers.

The ROM portion of the chip is a 264 by 9-bit memory arranged into three 88-word by 9-bit groups. The appropriate levels on the Shift and Control inputs selects one of the three 88-word groups; the 88-individual word locations are addressed by the two ring counters. Thus, the ROM address is formed by combining the Shift and Control Inputs with the two ring counters.

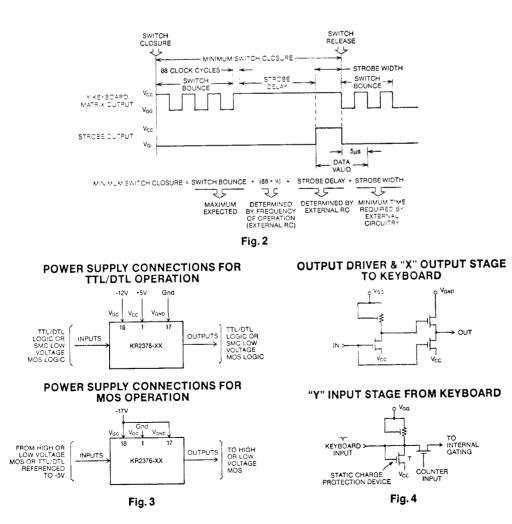
The external outputs of the 8-stage ring counter and the external inputs to the 11-bit comparator are wired to the keyboard to form an X-Y matrix with the 88-keyboard switches as the crosspoints. In the standby condition, when no key is depressed, the two ring counters are clocked and sequentially address the ROM; the absence of a Strobe Output indicates that the Data Outputs are 'not valid' at this time. When a key is depressed, a single path is completed between one output of the 8-stage ring counter (X0 thru X7) and one input of the 11-bit comparator (Y0-Y10). After a number of clock cycles, a condition will occur where a level on the selected path to the comparator matches a level on the corresponding comparator input from the 11-stage ring counter. When this occurs, the comparator generates a signal to the clock control and to the Strobe Output (via the delay network). The clock control stops the clocks to the ring counters and the Data Outputs (B1-B9) stabilize with the selected 9-bit code, indicated by a 'valid' signal on the Strobe Output. The Data Outputs remain stable until the key is released.

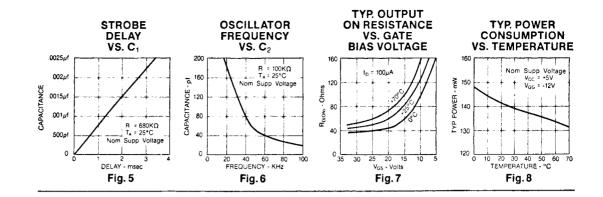
As an added feature two inputs are provided for external polarity control of the Data Outputs. Parity Invert (pin 6) provides polarity control of the Parity Output (pin 7) while the Data and Strobe Invert Input (pin 20) provides for polarity control of Data Outputs B1 thru B8 (pins 8 thru 15) and the Strobe Output (pin 16).

SPECIAL PATTERNS

Since the selected coding of each key is defined curing the manufacture of the chip, the coding can be changed to fit any particular application of the keyboard. Up to 264 codes of up to 8 bits (plus one parity bit) can be programmed into the KR2376-XX ROM covering most popular codes such as ASC11, EBCD1C, Selectric, etc., as well as many specialized codes. The ASC11 code is available as a standard pattern. For special patterns, use Fig. 9.

TIMING DIAGRAM





CODE ASSIGNMENT CHART KR2376-ST 8 Bit ASCII, odd parity

NBC	1 1 1 1	y	×. 1 8	R	×.,		× .		X.4		Х <u>.</u> 1		z. a		й., 1 ^{в.} и
Ya B	1		i	222	:		=	1 H.L. 1 H.L. 1 H.L.		i i		1 			NE SAMAN SAMA SA NE NE N
	1	558 8		-	Ì	n n n	5 8 8	10, 2 1, 8 2, 10, 1,		1 / 12 14 14		1 . N 1 2 . N 1 9 1	X # X # # #		NUM X A V B BU C V SUP
				1 Fr		T 65 T 55 T 63	X	a Å		. 					
	1 🗰 📖	Ē	=	8 N 30				.018				E N E H 59		T.	
	# #						-		11 11	10 10 10 10					
* <u>*</u> ****		11 ETHIC 12 ETHIC			=					n n Rici		H ACH		N 1944	
*, *,									8 8	H H H H H H H H H H H H H H H H H H H		8 81 8 10 13 12 15			N MLA
		約.										DC,			
			111			B 3P		10 10							
				IN				រី ភ្ល រដ		1 301 				N IT	
				5118 5118		os.		E.		s.e	i	IL EDIC IL EDIC	. 	VT VT	

Fig.9 N S C B1 82 83 84 85 86 81 85 - PARITY BIT 1 2 3 4 5 6 7 8 ÷

(Code representative of key depress on at location X0-Y9 and proper mode selection)

NORMAL

DATA (B1-B8) INVERT TRUTH TABLE

DATA & STROBE INVERT INPUT (Pin 20)	CODE. ASSIGNVENT CHART	DATA OUTPUTS B1-88)
1	1	0
0	1	1
1	0	1
0	С	0

STROBE INVERT TRUTH TABLE

DATA & STROBE INVERTINPUT (Pin 20)	steche	STROBE C TRUT
1	1	0
0	0	Û
1	0	1
0	1	1

PARITY INVERT **TRUTH TABLE**

PARITY	CODE	PARITY
INVERT INPUT	ASSIGNMENT	
(Pin 6)	CHART	(Pin 7)
1	1	0
0	1	1
1	0	1
0	0	0

MODE SELECTION

Ŝ Ĉ = N S Ĉ = S

SC=C S C = INVALID (SPURIOUS DATA)



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-We keep ahead of our competition so you can keep ahead of yours.

Circuit diagrams utilizing SMC products are included as a means of illustrating typical semiconductor applica-tions, consequently complete information sufficient for construction purposes is not necessarily given. The information has been carefully checked and is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies. Furthermore, such information does not convey to the purchaser of the semiconductor devices described any license under the patent rights of SMC or others. SMC reserves the right to make changes at any time in order to improve design and supply the best product possible.

N = Normal Mode S = Shift Mode C = Control Mode = : Output Logic "1" (see data B1-B8) Logic "1" = :50V Logic "0" = Ground

Appendix C7

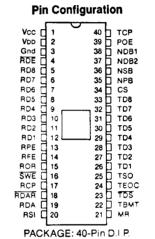


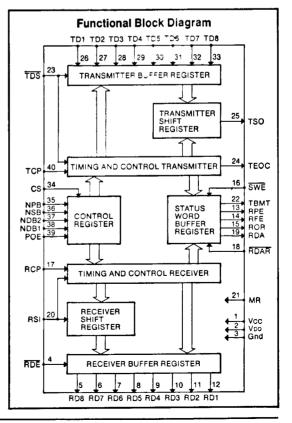
COM2502 COM2017 COM2502/H COM2017/H

Universal Asynchronous Receiver/Transmitter

FEATURES

- □ Direct TTL Compatibility no interfacing circuits required
- □ Full or Half Duplex Operation can receive and transmit simultaneously at different baud rates
- □ Fully Double Buffered eliminates need for precise external timing
- □ Start Bit Verification decreases error rate
- □ Fully Programmable data word length, parity mode, number of stop bits; one, one and one-half, or two
- ☐ High Speed Operation 40K baud, 200ns strobes
- □ Master Reset Resets all status outputs
- Tri-State Outputs -- bus structure oriented
- Low Power-minimum power requirements
- □ Input Protected eliminates handling problems
- Ceramic or Plastic Dip Package easy board insertion





GENERAL DESCRIPTION

The Universal Asynchronous Receiver/Transmitter is an MOS/LSI monolothic circuit that performs all the receiving and transmitting functions associated with asynchronous data communications. This circuit is fabricated using SMC's P-channel low voltage oxidenitride technology. The duplex mode, baud rate, data word length, parity mode, and number of stop bits are independently programmable through the use of external controls. There may be 5, 6, 7 or 8 data bits, odd/even or no parity, and 1, or 2 stop bits or 1.5 stop bits when utilizing a 5-bit code from the COM 2017 or COM 2017/H. The UART can operate in either the full or half duplex mode. These programmable features provide the user with the ability to interface with all asynchronous peripherals.

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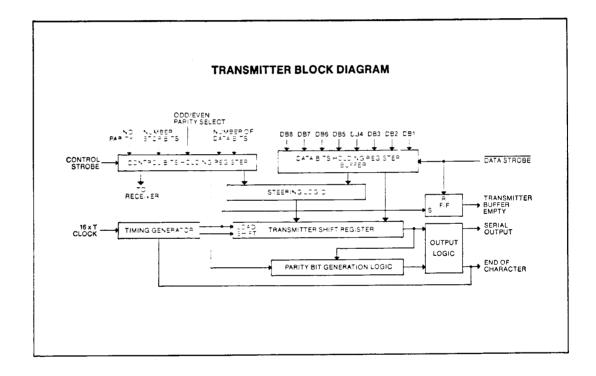
At start-up the power is turned on, a clock whose frequency is 16 times the desired baud rate is applied and master reset is pulsed. Under these conditions TBMT, TEOC, and TSO are all at a high level (the line is marking).

When TBMT and TEOC are high, the control bits may be set. After this has been done the data bits may be set. Normally, the control bits are strobed into the transmitter prior to the data bits. However, as long as minimum pulse width specifications are not violated, TDS and CS may occur simultaneously. Once the date strobe (TDS) has been pulsed the TBMT signal goes low, indicating that the data bits buffer register is full and unavailable to receive new data.

If the transmitter shift register is transmitting previously loaded data the TBMT signal remains low. If the transmitter shift register is empty, or when it is through transmitting the previous character, the data in the buffer register is loaded immediately into the transmitter shift register and data transmission commences. TSO goes low (the start bit), TEOC goes low, the TBMT goes high indicating that the data in the data bits buffer register has been loaded into the transmitter shift register and that the data bits buffer register is available to be loaded with new data.

If new data is loaded into the data bits buffer register at this time, TBMT goes low and remains in this state until the present transmission is completed. One full character time is available for loading the next character with no loss in speed of transmission. This is an advantage of double buffering.

Data transmission proceeds in an orderly manner: start bit, data bits, parity bit (if selected), and the stop bit(s). When the last stop bit has been on the line for one bit time TEOC goes high. If TBMT is low, transmission begins immediately. If TBMT is high the transmitter is completely at rest and, if desired, new control bits may be loaded prior to the next data transmission.



DESCRIPTION OF OPERATION - RECEIVER

At start-up the power is turned on, a clock whose frequency is 16 times the desired baud rate is applied and master reset is pulsed. The data available (RDA) signal is now low. There is one set of control bits for both the receiver and transmitter.

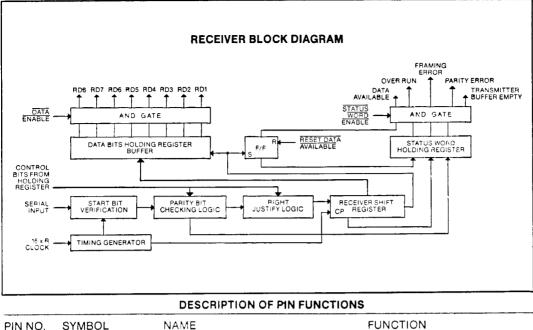
Data reception begins when the serial input line transitions from mark (high) to space (low). If the RSI line remains spacing for a 1/2 bittime, agenuine start bit is verified. Should the line return to a marking condition prior to a 1/2 bit time, the start bit verification process begins again. A mark to space transition must occur in order to initiate start bit verification. Once a start bit has been verified, data reception proceeds in an orderly manner: start bit verified and received, data bits received, parity bit received (if selected) and the stop bit(s) received.

If the transmitted parity bit does not agree with the received parity bit, the parity error flip-flop of the status word buffer register is set high, indicating a parity error. However, if the no parity mode is se-

lected, the parity error flip-flop is unconditionally held low, inhibiting a parity error indication. If a stop bit is not received, due to an improperly framed character, the framing error flip-flop is set high, indicating a framing error.

Once a full character has been received internal logic looks at the data available (RDA) signal. If, at this instant, the RDA signal is high the receiver assumes that the previously received character has not been read out and the over-run flip-flop is set high. The only way the receiver is aware that data has been read out is by having the data available reset low.

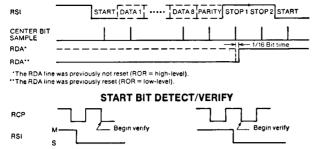
At this time the RDA output goes high indicating that all outputs are available to be examined. The receiver shift register is now available to begin receiving the next character. Due to the double buffered receiver, a full character time is available to remove the received character.



PIN NO.	SYMBOL	NAME	FUNCTION
1	Vcc	Power Supply	-5 volt Supply
2	VDD	Power Supply	-12 voit Supply
3	GND	Ground	Ground
4	RDE	Received Data Enable	A low-level input enables the outputs (RD8-RD1) of the receiver buffer register.
5-12	RD8-RD1	Receiver Data Outputs	These are the 8 tri-state data outputs enabled by RDE. Unused data output lines, as selected by NDB1 and NDB2, have a low-level output, and received characters are right justified, i.e. the LSB always appears on the RD1 output.
13	RPE	Receiver Parity Error	This tri-state output (enabled by SWE is at a high-level if the received character parity bit does not agree with the selected parity.
14	RFE	Receiver Framing Error	This tri-state output (enabled by SWE less at a high-level if the received character has no valid stop bit.
15	ROR	Receiver Over Run	This tri-state output (enabled by \overline{SWE}) is at a high-level if the previously received character is not read (RDA output not reset) before the present character is transferred into the receiver buffer register.
16	SWE	Status Word Enable	A low-level input enables the outputs (RPE, RFE, ROR, RDA, and TBMT) of the status word buffer register.
17	RCP	Receiver Clock	This input is a clock whose frequency is 16 times (16X) the desired receiver baud rate.
18	RDAR	Receiver Data Available Reset	A low-level input resets the RDA output to a low-level.
19	RDA	Receiver Data Available	This tri-state output (enabled by SWE) is at a high-level when an entire character has been received and transferred into the receiver buffer register.
20	RSI	Receiver Serial Input	This input accepts the serial bit input stream. A high-level (mark) to low-level (space) transition is required to initiate data reception.
21	MR	Master Reset	This input should be pulsed to a high-level after power turn-on. This sets TSO, TEOC, and TBMT to a high-level and resets RDA, RPE, RFE and ROR to a low-level.

ТВМТ	Transmitter Buffer Empty	This tri-state output (enabled by SWE) is at a high-level when the transmitter buffer register may be loaded with new data.
TDS	Transmitter Data Strobe	A low-level input strobe enters the data bits into the transmitter buffer register.
TEOC	Transmitter End of Character	This output appears as a high-level each time a full character is transmitted. It remains at this level until the start of transmission of the next character or for one-half of a TCP period in the case of continuous transmission.
TSO	Transmitter Serial Output	This output serially provides the entire transmitted character. TSO remains at a high-level when no data is being transmitted.
TD1-TD8	Transmitter Data Inputs	There are 8 data input lines (strobed by TDS) available. Unused data input lines, as selected by NDB1 and NDB2, may be in either logic state. The LSB should always be placed on TD1.
CS	Control Strobe	A high-level input enters the control bits (NDB1, NDB2, NSB, POE and NPB) into the control bits holding register. This line may be strobed or hard wired to a high-level.
NPB	No Parity Bit	A high-level input eliminates the parity bit from being transmitted; the stop bit(s) immediately follow the last data bit. In addition, the receiver requires the stop bits, to follow immediately after the last data bit. Also, the RPE output is forced to a low-level. See pin 39, POE.
NSB	Number of Stop Bits	This input selects the number of stop bits. A low-level input selects 1 stop bit; a high-level input selects 2 stop bits. Selection of 2 stop bits when programming a 5 data bit wor generates 1.5 stop bits from the COM 2017 or COM 2017. H.
NDB2, NDB1	Number of Data Bits/Character	These 2 inputs are internally decoded to select either 5.6.7, or 8 data bits/character as per the following truth table: NDB2 NDB1 data bits/character L L 5 L H 6 H L 7 H H 8
POE	Odd/Even Parity Select	The logic level on this input, in conjunction with the NPB input, determines the parity mode for both the receiver and transmitter, as per the following truth table: NPB POE MODE L L odd parity L H even parity H X no parity X = don't care
ТСР	Transmitter Clock	This input is a clock whose frequency is 16 times (16X) the desired transmitter baud rate.
	TRANSMITTER TIM	ING — 8 BIT, PARITY, 2 STOP BITS
:	TDS	
	· · · · · · · · · · · · · · · · · · ·	
	, , ,	
	L	SMITTER START-UP
,		
1	TRANS	
	TEOC TSO TD1-TD8 CS NPB NSB NDB2, NDB1 POE TCP	Data StrobeTEOCTransmitter End of CharacterTSOTransmitter Serial OutputTD1-TD8Transmitter Data InputsCSControl StrobeNPBNo Parity BitNSBNumber of Stop BitsNDB2, NDB1Number of Data Bits/CharacterPOEOdd/Even Parity SelectTCPTransmitter Clock





If the RSI line remains spacing for a 1/2 bit time, a genuine start bit is verified. Should the line return to a marking condition prior to a 1/2 bit time, the start bit verification process begins again.

MAXIMUM GUARANTEED RATINGS*

Operating Temperature Range	0°C to +70°C
Storage Temperature Range	
Lead Temperature (soldering, 10 sec.)	
Positive Voltage on any Pin, Vcc	
Negative Voltage on any Pin, Vcc	

*Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied.

ELECTRICAL CHARACTERISTICS	$(T_A = 0^\circ C \text{ to } 70^\circ C, V_{CC} = +5V \pm 5\%$	$V_{DD} = -12V \pm 5\%$, unless otherwise noted)
----------------------------	-----------------------------------------------------------------	---------------------------------------------------

Parameter	Min.	Тур.	Max.	Unit	Conditions
D.C. CHARACTERISTICS		,		-	· · · · · · · · · · · · · · · · · · ·
INPUT VOLTAGE LEVELS					
Low-level, Vi∟	Vop		0.8	V.	
High-level, Vін	Vcc-1.5		Vcc	V	
OUTPUT VOLTAGE LEVELS			• •		
Low-level, VoL	2.4	0.2 4.0	0.4	v	$lo_L = 1.6mA$
High-level, Von	2.4	4.0		v	Іон = 100μА
			1.0	^	ana nata A
			1.6	mA	see note 4
OUTPUT CURRENT			4		
Leakage, ILo Short circuit, Ios**			-1 10	μA mA	$\overline{SWE} = \overline{RDE} = V_{IH}, 0 \le V_{OUT} \le -5V$ $V_{OUT} = 0V$
			10	IIIA	V001 - UV
		5	10	pf	$V_{IN} = V_{CC}$, f = 1MHz
		5	10	μı	$v_{\rm IN} = v_{\rm CC}, t = t_{\rm IVI HZ}$
		10	20	pf	$\overline{SWE} = \overline{RDE} = V_{H}, f = 1MHz$
All outputs, Cout POWER SUPPLY CURRENT		10	20	pi	SWE = RDE = VIR, I = 10112
			28	-	All outputs = Von, All inputs = Vcc
			28	mA mA	
			20	1073	
A.C. CHARACTERISTICS					$T_A = +25^{\circ}C$
CLOCK FREQUENCY					12 123 0
(COM2502, COM2017)	DC		400	KHz	RCP. TCP
(COM2502H, COM2017H)	ĐČ		640		RCP, TCP
PULSE WIDTH					
Clock	1			μs	RCP, TCP
Master reset	500			'ns	MR
Control strobe	200			ns	<u>CS</u>
Transmitter data strobe	200			ns	TDS
Receiver data available reset	200			ns	RDAR
INPUT SET-UP TIME					
Data bits	≥0			ns	TD1-TD8
Control bits	≥0			ns	NPB, NSB, NDB2, NDB1, POE
	>0				
Data bits Control bits	≥0 ≥0			ns ns	TD1-TD8 NPB, NSB, NDB2, NDB1, POE
	2.0			113	Load = $20 \text{ pf} + 1 \text{ TTL input}$
STROBE TO OUTPUT DELAY			350		$\frac{1000}{\text{RDE}} = 2001 \pm 111 \text{Linput}$
Receive data enable Status word enable			350 350	ns ns	SWE: TPD1, TPD0 SWE: TPD1, TPD0
OUTPUT DISABLE DELAY			350	ns	RDE. SWE
OUTPUT DISABLE DELAT			300	115	NUL, SYVE

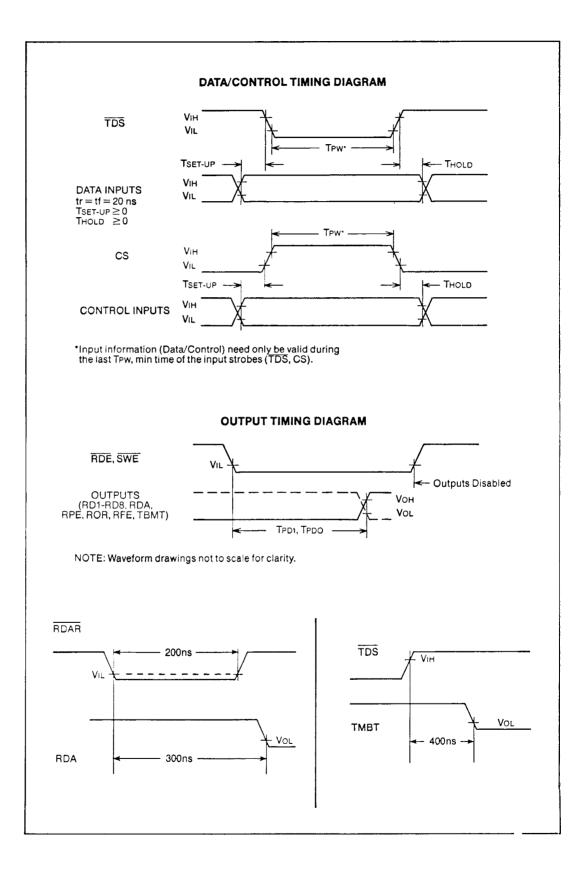
**Not more than one output should be shorted at a time.

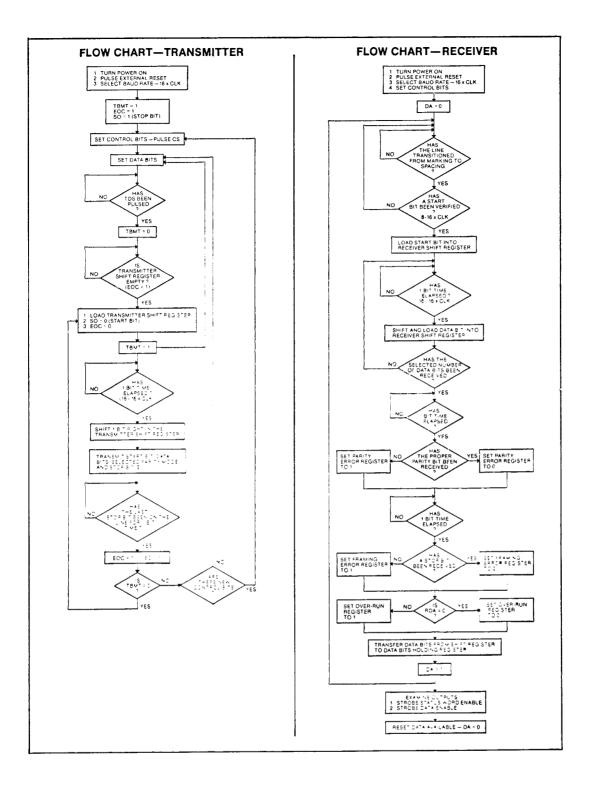
NOTES: 1. If the transmitter is inactive (TEOC and TBMT are at a high-level) the start bit will appear on the TSO line within one clock period (TCP) after the trailing edge of TDS.

2. The start bit (mark to space transition) will always be detected within one clock period of RCP, guaranteeing a maximum start bit slippage of 1/16th of a bit time.

The tri-state output has 3 states: 1) low impedance to Vcc 2) low impedance to GND 3) high impedance OFF ≈ 10M ohms. The "OFF" state is controlled by the SWE and RDE inputs.

4. Under steady state conditions no current flows for TTL or MOS interfacing. (COM 2502 or COM 2502/H)







STANDARD MICROSYSTEMS CORPORATION We keep alead of our competition so you can keep alead of yours

Appendix C8



We keep ahead of our competition so you can keep ahead of yours.

CRT 5027 **CRT 5037** CRT 5057 LPC FAMILY

CRT Video Timer and Controller **VTAC**[®]

FEATURES

 Fully Programmable Display Format Characters per data row (1-200) Data rows per frame (1-64) Raster scans per data row (1-16) Programmable Monitor Sync Format Raster Scans/Frame (256-1023) "Front Porch Sync Width "Back Porch Interlace Non-Interlace Vertical Blanking □ Lock Line Input CRT 5057) Direct Outputs to CRT Monitor Horizonta Sund Vertica Sund Composite Synd (CRT 5027, CRT 5037) Blanking Cursor coincidence E Programmed - a: Processor data bus External PRCM Mask Cotion FOM Standard or Non-Standard CRT Monitor Compatible Refresh Rate 60-z. 50Hz,... Scrolling Sing e _ re Multi-Line Cursor Position Registers Character Format: 5x7, 7x9,... Programmable vertical Data Positioning E Balanced Beam Current Interlace (CRT 5037) Graphics Compatible

PIN CONFIGURATION

A2 d	1		40	Ълі
A2 U A3 0	2		39	
csd	3		38	Енø
R3 D	4		37	Бні
R2 d	5		36	ын2 Ын2
GND D	6		35	р на
81 0	7		34	D H4
RØD	8		33	D H5
DS D	9 (ц на 1 на
1				h H7/DR5
LLI/CSYN D	10		31	F
VSYND	11		30	DR4
	12		29	DR3
	13			DR2
Vcc [14			DR1
HSYN C	15			DRØ
CRV D	16			DDBø
BLD	17			DB1
DB7 C	18			D DB2
DB6 🛙	19			ровз
DB5 D	20		21	DB4
PAC	KAC	6E: 40-F	Pin D	D.I.P.

Split-Screen Applications

Horizontal

Vertical

- Interlace or Non-Interlace operation
- TTL Compatibility
- BUS Oriented
- □ High Speed Operation
- COPLAMOS® N-Channel Silicon
- Gate Technology
- □ Compatible with CRT 8002 VDAC™
- Compatible with CRT 7004

GENERAL DESCRIPTION

The CRT Video Timer and Controller Chip (VTAC)® is a user programmable 40-pin COPLAMOS® nchannel MOS/LSI device containing the log of functions required to generate all the timing signals for the presentation and formatting of interlaced and non-interlaced , depidata on a standard or non-standard CRT monitor.

With the exception of the dot counter, which may be clocked at a video frequency above 25 MHz and therefore not recommended for MOS implementation, all frame formatting, such as horizontal, vertical, and composite sync, characters per data row, data rows per frame, and raster scans per data row and per frame are totally user programmable. The data row counter has been designed to fac ...tate scrolling.

Programming is effected by loading seven 8 bit control registers directly off an 8 bit bid irectional data bus. Four register address lines and a chip select line provide complete microprocessor compatibility for program controlled set up. The device can be "self loaded" via an external PROM tied on the data bus as described in the OPERATION section. Formatting can also be programmed by a single mask option.

In addition to the seven control registers two additional registers are provided to store the cursor character and data row addresses for generation of the cursor video signal. The contents of these two registers can also be read out onto the bus for update by the program.

Three versions of the VTAC® are available. The CRT 5027 provides non-interlaced operation with an even or odd number of scan lines per data row, or interlaced operation with an even number of scan lines per data row. The CRT 5037 may be programmed for an odd or even number of scan lines per data row in both interlaced and non-interlaced modes. Programming the CRT 5037 for an odd number of scan lines per data row eliminates character distortion caused by the uneven beam current normally associated with odd field/even field interlacing of alphanumeric displays.

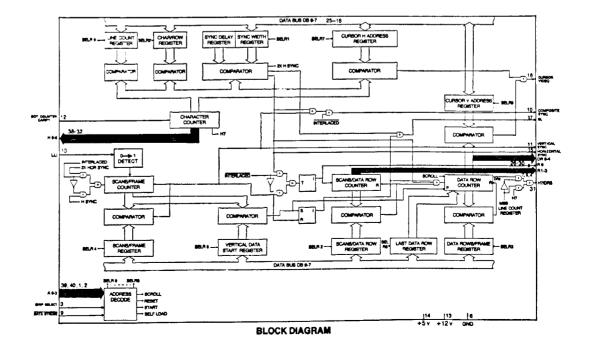
The CRT 5057 provides the ability to lock a CRT's vertical refresh rate, as controlled by the VTAC's® vertical sync pulse, to the 50 Hz or 60 Hz line frequency thereby eliminating the so called "swim" phenomenon. This is particularly well suited for European system requirements. The line frequency waveform, processed to conform to the VTAC's® specified logic levels, is applied to the line lock input. The VTAC® will inhibit generation of vertical sync until a zero to one transition on this input is detected. The vertical sync pulse is then initiated within one scan line after this transition rises above the logic threshold of the VTAC.®

To provide the pin required for the line lock input, the composite sync output is not provided in the CRT 5057.

***FOR FUTURE RELEASE**

Description of Pin Functions

Pin No.	Symbol	Name	Input/ Output	Function
_				
25-18	DBØ-7	Data Bus	I/O	Data bus. Input bus for control words from microprocessor or PROM. Bidirectional bus for cursor address.
3	CS	Chip Select	ł	Signals chip that it is being addressed
39,40,1,2	AØ-3	Regist er Address	ł	Register address bits for selecting one of seven control registers or either of the cursor address registers
9	DS	Data Strobe	I	Strobes DBØ-7 into the appropriate register or outputs the cursor character address or cursor line address onto the data bus
12	DCC	DOT Counter Carry	ł	Carry from off chip dot counter establishing basic character clock rate. Character clock.
38-32	HØ-6	Character Counter Outputs	0	Character counter outputs.
7, 5, 4	R1-3	Scan Counter Outputs	0	Three most significant bits of the Scan Counter; row select inputs to character generator.
31	H7/DR5	H7/DR5	0	Pin definition is user programmable. Output is MSB of Character Counter if horizontal line count (REG.Ø) is ≥128; otherwise output is MSB of Data Row Counter.
8	RØ	Scan Counter LSB	0	Least significant bit of the scan counter. In the inter- laced mode with an even number of scans per data row, RØ will toggle at the field rate; for an odd number of scans per data row in the interlaced mode. RØ will toggle at the data row rate.
26-30	DRØ-4	Data Ro w Counter Outputs	0	Data Row counter outputs.
17	BL	Bank	0	Defines non active portion of horizontal and vertical scans.
15	HSYN	Hor zontal Sync	0	Initiates horizontal retrace.
11	VSYN	Vertical Sync	0	Initiates vertical retrace.
10	CSYN/ LLI	Composite Sync Output Line Look Input	/ 0/I	Composite sync is provided on the CRT 5027 and CRT 5037. This output is active in non-interlaced mode only. Provides a true RS-170 composite sync wave form. For the CRT 5057, this pin is the Line Lock Input. The line frequency waveform, processed to conform to the VTAC's® specified logic levels, is applied to this pin.
16	CRV	Cursor Video	0	Defines cursor location in data field.
14	Vcc	Power Supply	PS	+5 volt Power Supply
13	Voo	Power Supply	PS	+12 volt Power Supply



Operation

The design philosophy employed was to allow the device to interface effectively with either a microprocessor based or hardwire logic system. The device is programmed by the user in one of two ways; via the processor data bus as part of the system initialization routine, or during power up via a PROM tied on the data bus and addressed directly by the Row Select outputs of the chip. (See figure 4). Seven 8 bit words are required to fully program the chip. Bit assignments for these words are shown in Table 1. The information contained in these seven words consists of the following:

Horizontal Formatting: Characters/Data Row	A 3 bit code providing 8 mask programmable character lengths from 20 to 132. The standard device will be masked for the following character lengths: 20, 32, 40, 64, 72, 80, 96, and 132.
Horizontal Sync Delay	3 bits assigned providing up to 8 character times for generation of "front porch".
Horizontal Sync Width	4 bits assigned providing up to 15 character times for generation of horizontal sync width.
Horizontal Line Count	8 bits assigned providing up to 256 character times for total horizontal formatting.
Skew Bits	A 2 bit code providing from a 0 to 2 character skew (delay) between the horizontal address counter and the blank and sync (horizontal vertical composite) signals to allow for retiming of video data prior to generation of composite video signal. The Cursor Video signal is also skewed as a function of this code.
Vertical Formatting:	
Interlaced/Non-interlaced	This bit provides for data presentation with odd/even field formatting for inter- laced systems. It modifies the vertical timing counters as described below. A logic 1 establishes the interlace mode.
Scans/Frame	 8 bits assigned, defined according to the following equations: Let X = value of 8 assigned bits. 1) in interlaced mode—scans/frame = 2X + 513. Therefore for 525 scans, program X = 6 (0000110). Vertical sync will occur precisely every 262.5 scans, thereby producing two interlaced fields. Range = 513 to 1023 scans/frame, odd counts only. 2) in non-interlaced mode—scans/frame = 2X + 256. Therefore for 262 scans, program X = 3 (0000011). Range = 256 to 766 scans/frame, even counts only. In either mode, vertical sync width is fixed at three horizontal scans (= 3H).
Vertical Data Start	8 bits defining the number of raster scans from the leading edge of vertical sync until the start of display data. At this raster scan the data row counter is set to the data row address at the top of the page.
Data Rows Frame	6 c ts assigned providing up to 64 data rows per frame.
Last Data Row	6 cits to allow up or down scrolling via a preload defining the count of the last cisc ayed data row.
Scans/Data Row	4 pits assigned providing up to 16 scan lines per data row.

Additional Features

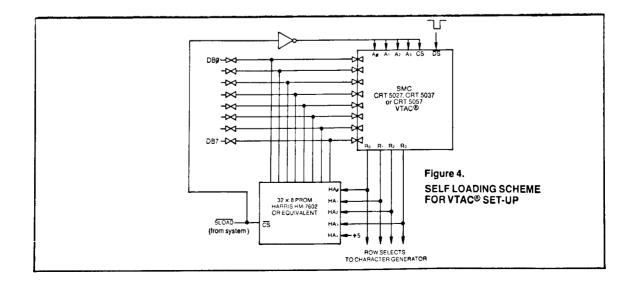
Device Initialization:

Under microprocessor control—The device can be reset under system or program control by presenting a 1010 address on A3-0. The device will remain reset at the top of the even field page until a start command is executed by presenting a 1110 address on A3-0.

Via "Self Loading"—In a non-processor environment, the self loading sequence is effected by presenting and holding the 1111 address on A3-Ø, and is initiated by the receipt of the strobe pulse (DS). The 1111 address should be maintained long enough to insure that all seven registers have been loaded (in most applications under one millisecond). The timing sequence will begin one line scan after the 1111 address is removed. In processor based systems, self loading is initiated by presenting the Ø111 address to the device. Self loading is terminated by presenting the start command to the device which also initiates the timing chain.

Scrolling—In addition to the Register 6 storage of the last displayed data row a "scroll" command (address 1Ø11) presented to the device will increment the first displayed data row count to facilitate up scrolling in certain applications.

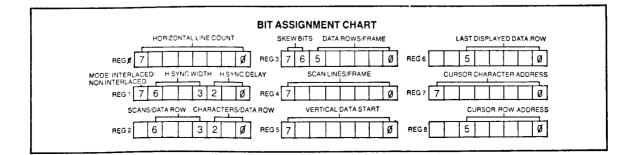
	Control Registers Programming Chart
Horizontal Line Count: Characters/Data Row:	Total Characters/Line = N + 1, N = 0 to 255 (DB0 = LSB) DB2 DB1 DB0
	0 0 = 20 Active Characters/Data Row
	0 0 1 = 32
	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
	1 0 0 = 72
	1 0 1 = 80
	1 1 0 = 96
Levisoptal Supa Dalaw	1 1 1 = 132 = N, from 1 to 7 character times (DB0 = LSB) (N = 0 Disallowed)
Horizontal Sync Delay: Horizontal Sync Width:	= N, from 1 to 15 character times (DB3 = LSB) (N = 0 Disallowed) = N, from 1 to 15 character times (DB3 = LSB) (N = 0 Disallowed)
Holizontal Sync Width.	Sync/Blank Delay Cursor Delay
Skew Bits	DB7 DB8 (Character Times)
	0 0 0 0
	1 0 1 0 0 1 2 1
Scans/Frame	8 bits assigned, defined according to the following equations: Let X = value of 8 assigned bits. (DB0 = LSB)
	1) in interlaced mode—scans/frame = $2X + 513$. Therefore for 525 scans, program X = 6 (00000110). Vertical sync will occur precisely every 262.5 scans, thereby producing two interlaced fields.
	Range = 513 to 1023 scans/frame, odd counts only.
	2) in non-interlaced mode—scans/frame = $2X + 256$. Therefore for 262 scans, program X = 3 (00000011).
	Range = 256 to 766 scans/frame, even counts only.
	In either mode, vertical sync width is fixed at three horizontal scans ($=$ 3H).
Vertical Data Start:	N = number of raster lines delay after leading edge of vertical sync of vertical start position. (DB0 = LSB)
Data Rows/Frame:	Number of data rows = $N + 1$, $N = 0$ to 63 (DBO = LSB)
Last Data Row:	N = Address of last dsplayed data row, N = 0 to 63, ie; for 24 data rows, program N = 23. (DB0 = LSB)
Mode:	Register, 1, DB7 = 1 establishes Interlace.
Scans/Data Row:	Interlace Mode
	CRT 5027: Scans per Data Row = N + 1 where N = programmed number of cata rows. N = 0 to 15. Scans per data row must be even counts only.
	CRT 5037. CRT 5057: Scans per data Row = $N + 2$. $N = 0$ to 14, odd or ever
	counts. Non-Interlace Mode
	CRT 5027. CRT 5037. CRT 5057: Scans per Data Row = N + 1, odd or even count. N = 0 to 15.

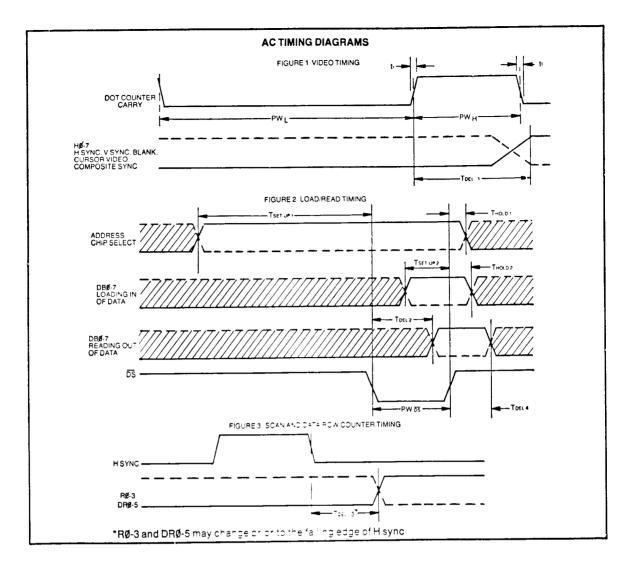


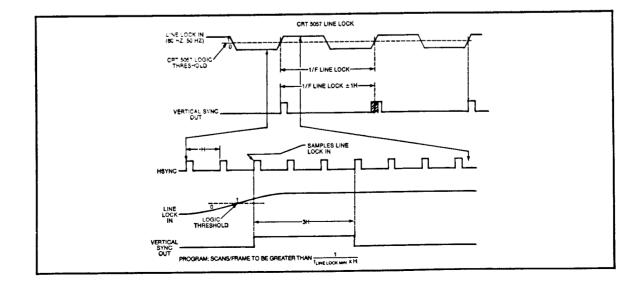
Register Selects/Command Codes

	negister Scients/Command Codes								
A3	A2	A1	AØ	Select/Command	Description				
0 0 0 0 0 0 0	0 0 1 1 1	0 1 1 0 1 1	0 1 0 1 0 1 0	Load Control Register Ø Load Control Register 1 Load Control Register 2 Load Control Register 3 Load Control Register 4 Load Control Register 5 Load Control Register 6 Processor Initiated Self Load	See Table 1 Command from processor instructing VTAC® to enter Self Load Mode (via ex-				
1	0	0	0	Read Cursor Line Address	ternal PROM)				
1 1	Ö O	0 1	1 0	Read Cursor Character Address Reset	Resets timing chain to top left of page. Reset is latched on chip by DS and counters are				
1	0	1	1	Up Scroll	held until released by start command. Increments address of first displayed data row on page. ie; prior to receipt of scroll command—top line = 0, bottom line = 23. After receipt of Scroll Command—top line = 1, bottom line = 0.				
1	1	0	0	Load Cursor Character Address*					
1	1	0 1	1 0	Load Cursor Line Address* Start Timing Chain	Receipt of this command after a Reset or Processor Self Load command will release the timing chain approximately one scan line later. In applications requiring synchronous operation of more than one CRT 5027 the dot counter carry should be held low during the DS for this command.				
1	1	1	1	Non-Processor Self Load	Device will begin self load via PROM when DS goes low. The 1111 command should be maintained on A3-Ø long enough to guarantee self load. (Scan counter should cycle through at least once). Self load is automatically termi- nated and timing chain initiated when the all "1's" condition is removed, indepen- dent of DS. For synchronous operation of more than one VTAC ⁵ , the Dot Counter Carry should be held low when the com- mand is removed.				
*NOT	*NOTE: During Self-Load, the Cursor Character Address Register (REG 7) and the Cursor Row Address Register (REG 6) are enabled during states Ø111 and 1000 of the R3-RØ Scan Counter outputs respectively. Therefore, Cursor data in the PROM should be stored at these addresses.								

TABLE 1







MAXIMUM GUARANTEED RATINGS*
Operating Temperature Range
Storage Temperature Range55°C to + 150°C
Lead Temperature (soldering, 10 sec)+325°C
Positive Voltage on any Pin, with respect to ground+18.0V
Negative Voltage on any Pin, with respect to ground0.3V
*Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied.
NOTE: When powering this device from laboratory or system power supplies, it is important that the Absolute Maximum Ratings not be exceeded or device failure can result. Some power supplies

the Absolute Maximum Ratings not be exceeded or device failure can result. Some power supplies exhibit voltage spikes or "glitches" on their outputs when the AC power is switched on and off. In addition, voltage transients on the AC power line may appear on the DC output. For example, the bench power supply programmed to deliver + 12 volts may have large voltage transients when the AC power is switched on and off. If this possibility exists it is suggested that a clamp circuit be used.

ELECTRICAL CHARACTERISTICS (TA= 0°C to 70°C, Vcc= +5V±5%, Voo= +12V±5%, unless otherwise noted)

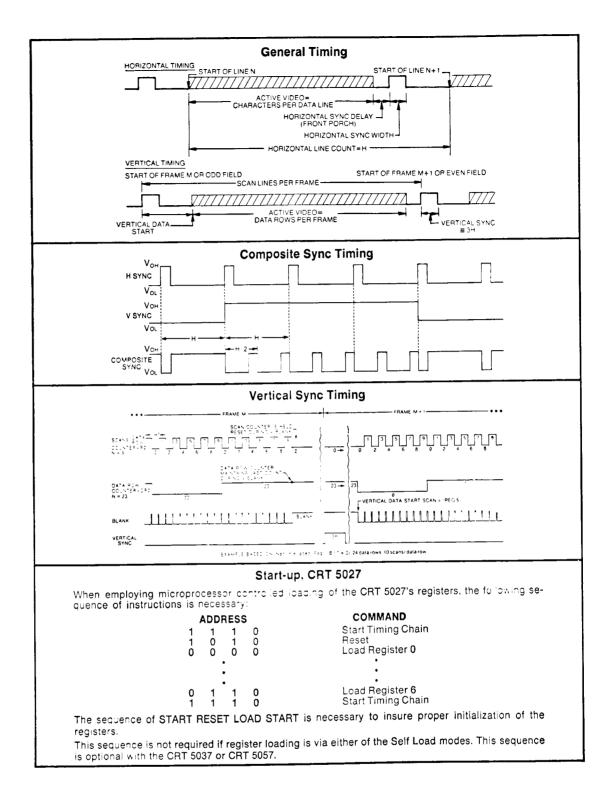
Parameter	Min.	Тур.	Max.	Unit	Comments
D.C. CHARACTERISTICS					
INPUT VOLTAGE LEVELS					
Low Level, Vic			0.8	V	
High Level, Vін	Vcc-1.5		Vcc	V	
OUTPUT VOLTAGE LEVELS					
Low Level—VoL for RØ-3			0.4	V	loι = 3.2ma
Low Level—VoL all others			0.4	V	lot = 1.6ma
High Level—Voн for RØ-3, DBØ-7	2.4				Iон = 80µа
High Level—Voн all others	2.4				іон=40µа
INPUT CURRENT					
Low Level, IIL (Address, CS only)	~ ~		250	μA	$V_{IN} = 0.4V$
Leakage, IL (All Inputs except Addres	ss, CS)		10	μA	O≤Vin≤Vcc
INPUT CAPACITANCE		10	15	- 5	
Data Bus, Cin		10 25	15 40	pF	
DS, Clock, Cin All other, Cin		25 10	40 15	pF	
DATA BUS LEAKAGE in INPUT MODE		10	15	pF	
			10	μA	0.4V ≤ V ⊾ ≤ 5.25V
IDB POWER SUPPLY CURRENT			10	μη	$0.4V = V_{\rm N} = 0.25V$
Icc		80	100	mA	
loo		40	70	mA	
A.C. CHARACTERISTICS		-0		ma	Tx = 25°C
DOT COUNTER CARRY					TK = 23 Q
frequency	0.2		4.0	MHz	Figure 1
PWH	35		4.0	ns	Figure 1
PWL	215			ns	Figure 1
tr, tr		10	50	ns	Fiqure 1
DATA STROBE					
PWDS	150ns		10µs		Figure 2
ADDRESS, CHIP SELECT					5
Set-up time	125			ns	Figure 2
Hold time	50			ns	Figure 2
DATA BUS—LOADING					•
Set-up time	125			ns.	Figure 2
Hold time	75			ns	Figure 2
DATA BUS-READING					
TDEL2	_		125	ns	Figure 2, CL=50pF
TDEL4	5		60	ns	Figure 2, CL=50pF
OUTPUTS: HØ-7, HS, VS, BL, CRV,			105		
CS-TDEL			125	ns	Figure 1, CL=20pF
OUTPUTS: RØ-3, DRØ-5	*		500	-	Figure 3, CL=20pF
TDEL3	Ŧ		500	ns	Figure 5, OL=20pF

*RØ-3 and DRØ-5 may change prior to the falling edge of H sync

Restrictions

1. Only one pin is available for strobing data into the device via the data bus. The cursor X and Y coordinates are therefore loaded into the chip by presenting one set of addresses and outputed by presenting a different set of addresses. Therefore the standard WRITE and READ control signals from most microprocessors must be "NORed" externally to present a single strobe (DS) signal to the device.

2. In interlaced mode the total number of character slots assigned to the horizontal scan must be even to insure that vertical sync occurs precisely between horizontal sync pulses.





36 Marcus Bivd Haucounge N ***** (566:273 3100 TWX 50 22* 5908 We leep ahead of our competition so you can leep ahead of yours. Circuit diagrams utilizing SMC products are included as a means of illustrating typical semiconductor applications, consequently complete information sufficient for construction purposes is not necessarily given. The information has been carefully checked and is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies. Furthermore, such information does not convey to the purchaser of the semiconductor devices described any license under the patent rights of SMC or others. SMC reserves the right to make changes at any time in order to improve design and supply the best product possible.

Appendix C9



CRT 8002

 μ PC FAMILY

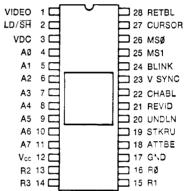
We keep ahead of our competition so you can keep ahead of yours.

CRT Video Display Attributes Controller Video Generator **VDAC**TM

FEATURES

- On chip character generator (mask programmable) 128 Characters (alphanumeric and graphic) 7 x 11 Dot matrix block On chip video shift register Maximum shift register frequency 20MHz 15MHz 10MHz 400hs CRT 8002A CRT 8002B CRT 8002C Access time On chip horizontal and vertical retrace video blanking
- No descender circuitry required
- □ Four modes of operation (intermixable) Internal character generator (ROM) Wide graphics Thin graphics
- External inputs (fonts 'dot graphics)
- C On chip attribute logic-character, field
 - **Reverse video** Character blank Character blink Underline
- Strike-thru □ Four on chip cursor modes Underline Blinking underline Reverse video Blinking reverse video
- Programmable character blink rate
- D Programmable cursor blink rate
- The SMC CRT 8002 Video Display Attributes Controller (VDAC) is an N-channel COPLAMOS® MOS LSI device which utilizes CLASP® technology. It contains a 7X11X128 character generator ROM, a wide graphics mode, a thin graphics mode, an external input mode, observed address (data lister field and is observed). character address/data latch, field and or character attribute logic, attribute latch, four cursor modes, two programmable blink rates, and a high speed video shift register. The CRT 8002 VDAC[™] is a companion chip to SMC's CRT 5027 VTAC. Together these two chips comprise the circuitry required for the display portion of a CRT video terminal.
- The CRT 8002 video output may be connected directly to a CRT monitor video input. The CRT 5027 blanking output can be connected directly to the CRT 8002 retrace blank input to provide both horizontal and vertical retrace blanking of the video output.
- Four cursor modes are available on the CRT 8002. They are: underline, blinking underline, reverse video block, and blinking reverse video block. Any one of these can be mask programmed as the cursor function. There is a separate cursor blink rate which can be mask programmed to provide a 15Hz to 1Hz blink rate.

PIN CONFIGURATION



□ Subscriptable

- Expandable character set
- External fonts Alphanumeric and graphic
 - RAM, ROM, and PROM
- □ On chip address buffer
- On chip attribute buffer
- □ + 5 volt operation
- TTL compatible
- □ MOS N-channel silicon-gate COPLAMOS[®] process
- CLASP® technology-ROM and options
- □ Compatible with CRT 5027 VTAC³

General Description

The CRT 8002 attributes include: reverse video, char-acter blank, blink, underline, and strike-thru. The character blink rate is mask programmable from 7.5Hz to 0.5Hz and has a duty cycle of 75/25. The underline and strike-thru are similar but independently controlled functions and can be mask programmed to any number of raster lines at any position in the character block. These attributes are available in all modes.

In the wide graphic mode the CRT 8002 produces a graphic entity the size of the character block. The graphic entity contains 8 parts, each of which is assoclated with one bit of a graphic byte. thereby providing for 256 unique graphic symbols. Thus, the CRT 8002 can produce either an alphanumeric symbol or a graphic entity depending on the mode selected. The mode can be changed on a per character basis.

The thin graphic mode enables the user to create single line drawings and forms.

The external mode enables the user to extend the onchip ROM character set and/or the on-chip graphics capabilities by inserting external symbols. These external symbols can come from either RAM, ROM or PROM.

MAXIMUM GUARANTEED RATINGS*

MON GOARANTEED RATINGS	
Operating Temperature Range	2
Storage Temperature Range)
Lead Temperature (soldering, 10 sec.)+325°C	
Positive Voltage on any Pin, with respect to ground	
Negative Voltage on any Pin, with respect to ground	/
* Stresses above those listed may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied.	
the second state of the state of the state of the second se	

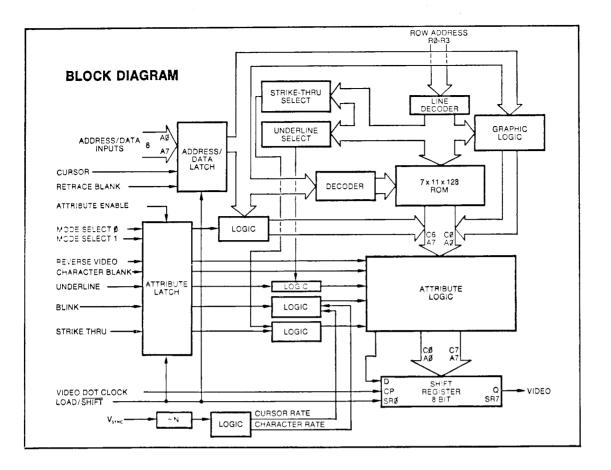
NOTE: When powering this device from laboratory or system power supplies, it is important that the Absolute Maximum Ratings not be exceeded or device failure can result. Some power supplies exhibit voltage spikes or "glitches" on their outputs when the AC power is switched on and off. In addition, voltage transients on the AC power line may appear on the DC output. If this possibility exists it is suggested that a clamp circuit be used.

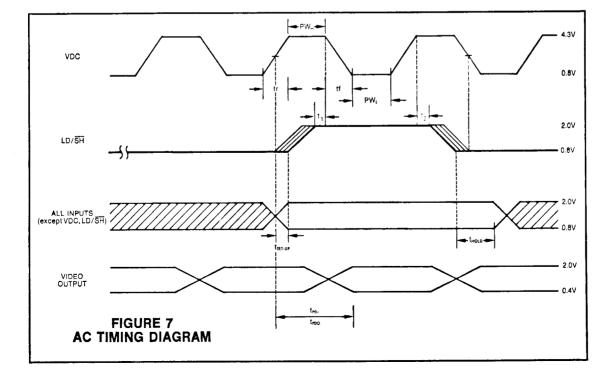
ELECTRICAL CHARACTERISTICS (TA=0°C to 70°C, Vcc=+5V±5%, unless otherwise noted)

Parameter	Min.	Тур.	Max.	Unit	Comments
D.C. CHARACTERISTICS					
INPUT VOLTAGE LEVELS Low-level, V _{IL} High-level, V _{IH}	2.0		0.8	v	excluding VDC excluding VDC
INPUT VOLTAGE LEVELS-CLOCK Low-level, V _{it} High-level, V _{iH}	4.3		0.8	v v	See Figure 6
OUTPUT VOLTAGE LEVELS Low-level, V _{OL} High-level, V _{OH}	2.4		0.4	v v	l _{ou} =0.4 mA. 74LSXX load l _{on} =−20 _µ A
INPUT CURRENT Leakage, I _L (Except CLOCK) Leakage, I _L (CLOCK Only)			10 50	μΑ μΑ	0≤V₁N≤Vcc 0≤V₁N≤Vcc
INPUT CAPACITANCE Data LD SH CLOCK		10 20 25		PF PF PF	@ 1 MHz @ 1 MHz @ 1 MHz
		100		mA	
A.C. CHARACTERISTICS See Figure 6, 7					



0/410.01	DADAMETER	CRT 8002A		CRT 8002B		CRT 8002C		UNITS
SYMBOL	PARAMETER	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
VDC	Video Dot Clock Frequency	1.0	20	1.0	15	1.0	10	MHz
PW _H	VDC—High Time	15.0		23		40		ns
PWL	VDC—Low Time	15.0		23		40		ns
t _{cy}	LD/SH cycle time	400		533		800		ns
t _{r.} t _f	Rise, fall time		10		10		10	ns
t _{set-up}	Input set-up time	≥0		≥0		≥0		ns
t _{HOLD}	Input hold time	15		15		15		ns
t _{PDI} , t _{PDO}	Output propagation delay	15	50	15	65	15	100	ns
t,	LD/SH set-up time	10		15		20		ns
t ₂	LD/SH hold time	15		15		15		ns





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APPENDIX C 281

DESCRIPTION OF PIN FUNCTIONS

			-00111	
PIN NO.	SYMBOL	NAME	INPUT/ OUTPUT	FUNCTION
	· · - · _ ·			
1	VIDEO	Video Output	O	The video output contains the dot stream for the selected row of the alph numeric, wide graphic, thin graphic, or external character after processing t the attribute logic, and the retrace blank and cursor inputs.
				In the alphanumeric mode, the characters are ROM programmed into the
				77 dots, (7X11) allocated for each of the 128 characters. See figure 5. The to row (RØ) and rows R12 to R15 are normally all zeros as is column C7. Thus, th
				character is defined in the box bounded by R1 to R11 and CØ to C6. When a ro
				of the ROM, via the attribute logic, is parallel loaded into the 8-bit shift-registe
				the first bit serially shifted out is C7 (A zero; or a one in REVID). It is followe
				by C6, C5, through CØ. The timing of the Load/ <u>Shift</u> pulse will determine the number of addition.
				(, zero to N) backfill zeros (or ones if in REVID) shifted out. See figure
				When the next Load/Shift pulse appears the next character's row of the ROM
				via the attribute logic, is parallel loaded into the shift register and the cycl repeats.
2	LD/SH	Load/Shift		The 8 bit shift-register parallel-in load or serial-out shift modes are established
-				by the Load/Shift input. When low, this input enables the shift register for
				serial shifting with each Video Dot Clock pulse. When high, the shift registe parallel (broadside) data inputs are enabled and synchronous icading occur
				on the next Video Dot Clock pulse. During parallel loading, ser al data flo
				is inhibited. The Address/Data inputs (AØ-A7) are latched on the negative
3	VDC	Video Dot Clock	<u> </u>	transition of the Load/Shift input. See timing diagram, figure 7.
4-11	AØ-A7	Address/Data	<u> </u>	In the Alphanumeric Mode the 7 bits on inputs (AØ-A6) are internally decode
				to address one of the 128 available characters (A7=X). In the External Mod
				AC-A7 is used to insert an 8 bit word from a user defined external ROM, PRO
				or BAM into the on-chip Attribute logic. In the wide Graphic Modes AØ-A7 used to define one of 256 graphic entities. In the thin Graphic Mode AØ-A2
		!	L	used to define the 3 line segments.
12	Vcc	Power Supply	PS	- 5 vo : cower supply
13,14,15,16 17	R2.R3 R1 R2 GND	Bow Address Ground	GND	These 4 binary inputs define the row address in the current character bloc Ground
18	ATTEE	Attribute Enable		A cost ve level on this input enables data from the Reverse Video, Charact
		Att Bate Enable	•	Black, Underline, Strike-Thru, Blink, Mode Select Ø, and Mode Select 1 input
				to be strobed into the on-chip attribute latch at the negative transition of the Load Shift pulse. The latch loading is disabled when this input is low
				The atched attributes will remain fixed until this input becomes high agai
				To fact tate attribute latching on a character by character basis, the ALLB
19	STKRU	Strike-Thru	1	in gn Seelt ming diagram, figure 7. When this input is high and RETBL=0, the paralle' inputs to the shift regist
	011410		'	are forced high (SRØ-SR7), providing a solid line segment throughout the
			Ì	i character block. The operation of strike-thru is modified by Reverse Vide
				see table "). In addition, an on-chip ROM programmable decoder is available to decode the line count on which strike-thru is to be blaced as well as
				program the strike-thruito be 1 to N raster lines high. Actually, the strike-th
			1	cessider, mask programmable) logic allows the strike-thruits be any numb or arrangement of horizontal lines in the character block. The standard strik
				thru we be a double line on rows R5 and R6.
20	UNDLN	Underline	1	When this input is high and RETBL=0, the parallel inputs to the shift regist
			!	are forced high (SRØ-SR7), providing a solid line segment throughout the character block. The operation of underline is modified by Reverse Vide
1				see tap e 1). In addition, an on-chip ROM programmable decoder is availab
				to becode the line count on which underline is to be placed as well as program the underline to be 1 to N raster lines high. Actually, the under
1]	decoder (mask programmable) logic allows the underline to be any numb
				or arrangement of horizontal lines in the character block. The standard under
				ne will be a single line on R11.
21	REVID	Reverse Video		When this input is low and RETBL=0, data into the Attribute Logic is presented rectly to the shift register parallel inputs. When reverse video is high data
				into the Attribute Logic is inverted and then presented to the shift registe
				carallel inputs. This operation reverses the data and field video. See table
22	CHABL	Character Blank		When this input is high, the parallel inputs to the shift register are all set low providing a blank character line segment. Character blank will override blin
			Į	The operation of Character Blank is modified by the Reverse Video inpu
		 		See table 1.
23	V SYNC	V SYNC		This input is used as the clock input for the two on-chip mask programmab blink rate dividers. The cursor blink rate (50/50 duty cycle) will be twice the
				character blink rate (75/25 duty cycle). The divisors can be programmed fro
				\div 4 to \div 30 for the cursor (\div 8 to \div 60 for the character).
24	BLINK	Blink	I	When this input is high and RETBL = 0 and CHABL = 0, the character will blir
1			1	at the programmed character blink rate. Blinking is accomplished by blankir the character block with the internal Character Blink clock. The standar
				character blink rate is 1.875 Hz.
25	MS1	Mode Select 1	<u> </u>	These 2 inputs define the four modes of operation of the CRT 8002 as follow
25 26	MS1 MSØ	Mode Select 1 Mode Select Ø		These 2 inputs define the four modes of operation of the CRT 8002 as follow Alphanumeric Mode - In this mode addresses AØ-A6 (A7=X) are in
				These 2 inputs define the four modes of operation of the CRT 8002 as follow <u>Alphanumeric Mode</u> In this mode addresses AØ-A6 (A7=X) are in ternally decoded to address 1 of the 128 available ROM characters. Th addressed character along with the decoded row will define a 7 bit outp
	MSØ	Mode Select Ø MSØ MODE 1 Alphanume		These 2 inputs define the four modes of operation of the CRT 8002 as follow <u>Alphanumeric Mode</u> – In this mode addresses AØ-A6 (A7=X) are in ternaily decoded to address 1 of the 128 available ROM characters. The addressed character along with the decoded row will define a 7 bit outp from the ROM to be loaded into the shift register via the attribute logic.
	MSØ MS1 1 1	Mode Select Ø MSØ MODE 1 Alphanume 0 Thin Graph	ric	These 2 inputs define the four modes of operation of the CRT 8002 as follow <u>Alphanumeric Mode</u> – In this mode addresses AØ-A6 (A7=X) are in ternally decoded to address 1 of the 128 available ROM characters. Th addressed character along with the decoded row will define a 7 bit outp from the ROM to be loaded into the shift register via the attribute logic. <u>Thin Graphics Mode</u> – In this mode AØ-A2 (A3-A7=X) will be loaded
	MSØ MS1 1	Mode Select Ø MSØ MODE 1 Alphanume	ric ics ide	These 2 inputs define the four modes of operation of the CRT 8002 as follow <u>Alphanumeric Mode</u> – In this mode addresses AØ-A6 (A7=X) are in ternaily decoded to address 1 of the 128 available ROM characters. The addressed character along with the decoded row will define a 7 bit outp from the ROM to be loaded into the shift register via the attribute logic.

DESCRIPTION OF PIN FUNCTIONS

PIN NO.	SYMBOL	NAME	INPUT/ OUTPUT	FUNCTION
25 26 (cont.)				External Mode – In this mode the inputs AØ-A7 go directly from the character latch into the shift register via the attribute logic. Thus the user may define external character fonts or graphic entities in an external PROM. ROM or RAM. See figure 3. Wide Graphics Mode – In this mode the inputs AØ-A7 will define a graphic entity as described in figure 1. Each line of the graphic entity is determined by the wide graphic logic in conjunction with the row inputs RØ to R3. In this mode each segment of the entity is defined by one of the bits of the 8 bit word. Therefore, the 8 bits can define any 1 of the 256 possible graphic entities. These entities are but up against each other to form a contiguous pattern or can be interspaced with alphanumeric characters. Each of the entities occupies the space of 1 character block and thus requires 1 byte of memory. These 4 modes can be intermixed on a per character basis.
27	CURSOR	Cursor	I	 When this input is enabled 1 of the 4 pre-programmed cursor modes will be activated. The cursor mode is on-chip mask programmable. The standard cursor will be a blinking (at 3.75 Hz) reverse video block. The 4 cursor modes are: Underline—In this mode an underline (1 to N raster lines) at the programmed underline position occurs. Blinking Underline—In this mode the underline blinks at the cursor rate. Reverse Video Block—In this mode the Character Block is set to reverse video. Blinking Reverse Video Block—In this mode the Character Block is set to reverse video. Blinking Reverse Video Block—In this mode the Character Block is set to reverse video. Blinking Reverse Video Block—In this mode the Character Block will alternate between normal video and reverse video. The cursor functions are listed in table 1.
28	RETBL	Retrace Blank	1	When this input is latched high, the shift register parallel inputs are uncon- ditionally cleared to all zeros and loaded into the shift register on the next Load/Shift pulse. This blanks the video, independent of all attributes, during horizontal and vertical retrace time.

TABLE 1									
CURSOR	RETBL	REVID	CHABL	UNDLN*	FUNCTION				
X 0 0	1 0 0	X 0 0	X 0 0	X 0 1	"0" S.R. All D (S.R.) All "1" (S.R.)* D (S.R.) All others				
0 0 0	0 0 0	0 1 1	1 0 0	X 0 1	"0" (S.R.) All D (S.R.) All "0" (S.R.)* D (S.R.) All others				
0	0	1	1	<u>x</u>	"1" (S.R.) A I				
Underline*	0	0	0	X	"1" (S.R.)" D (S.R.) All others				
Underline*	0	0	1	x	"1" (S.R.)* "0" (S.R.) All others				
Underline*	0	1	0	Х	"0" (S.R.)* D (S.R.) All others				
Underline*	0	1	1	×	"0" (S.R.)* "1" (S.R.) All others				
Blinking** Underline*	0	0	0	X	"1" (S.R.)* Blinking D (S.R.) All others				
Blinking** Underline*	0	0	1	x	"1" (S.R.) * Blinking "0" (S.R.) All others				
Blinking** Underline*	0	1	0	x	" <u>0</u> " (S.R.)* Blinking D (S.R.) All others				
Blinking** Underline*	0	1	1	x	"0" (S.R.)* Blinking "1" (S.R.) All others				
REVID Block REVID Block	0	0	0 0	0	D (S.R.) All "0" (S.R.)* D (S.R.) All others				
REVID Block REVID Block	0	0	1	X 1	"1" (S.R.) All "0" (S.R.)*				
REVID Block REVID Block	0	1	0	0 1	D (S.R.) All others D (S.R.) All "1" (S.R.)* D (S.R.) All others				
REVID Block	0	1	1	X	"0" (S.R.) All				
Blink** REVID Block Blink** REVID Block Blink** REVID Block Blink** REVID Block Blink** REVID Block Blink** REVID Block	0 0 0 0 0 0 0	0 0 1 1 1	0 0 1 0 0 1	01X01X	Alternate Normal Video/REVID At Cursor Blink Rate				

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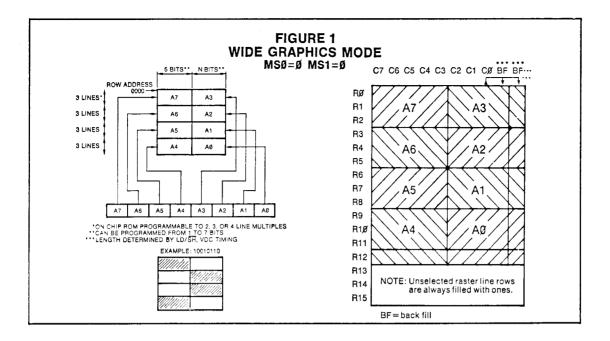
*At Selected Row Decode **At Cursor Blink Rate Note: If Character is Bunking at Character Rate, Cursor will change it to Cursor Blink Rate.

FIGURE 5 ROM CHARACTER BLOCK FORMAT

										-	ROWS	R3	R2	R1	RØ
(ALL ZEROS)-	- 0	0	0	0	0	0	0	0	-	_	RØ	0	0	0	0
, ,	ſo	0	0	0	0	0	0	0		—	R1	0	0	0	1
	0	10	0	0	0	0	0	0	_		R2	0	0	1	0
	0	0	0	0	0	0	0	0	_		R3	0	0	1	1
	0	0	0	0	0	0	0	0	i	-	R4	0	1	0	0
	0	l o	0	0	0	0	0	0	_		R5	0	1	0	1
77 BITS	$\langle \circ \rangle$	0	0	0	0	0	0	0	-		R6	0	1	1	0
(7 x 11 ROM)	0	0	0	0	0	0	0	0	-	_	R7	0	1	1	1
	0	0	0	0	0	0	0	0		_	R8	1	0	0	0
	0	0	0	0	0	0	0	0	_	_	R9	1	0	0	1
	0	0	0	0	0	0	0	0	—	—	R1Ø	1	0	1	0
	lo	0	0	0	0	0	0	0		—	R11	1	0	1	1
	Γo	0	0	0	0	0	0	0	·	-	R12	1	1	0	0
	0	0	0	0	0	0	0	0		—	R13	1	1	0	1
(ALL ZEROS)	ή ο	0	0	0	0	0	0	0	-	-	R14	1	1	1	0
	lo	0	0	0	0	0	0	0	_	_	R15	1	1	1	1
	*C7	C6	C5	C4	C3	C2	C1	CØ	Ī	Ţ	EXTENDE FOR INTE	D ZERO	S (BA	CK FI	_L) C-
*COLUMN 7 IS A COLUMN 7 IS S	LL Z H.FT	EROS ED O	G (RE UT F	VID = IRST	= 0)					V	ING (NUN BY LD/SI	ABER CO	ONTRO	DLLED	~

\leq									e***0	2111	1000	1001	1010	1011	1100	1101	1110	
	$\overline{\ }$	A.	0000	0001	0010	0011	0100	010.					C6. C0	C6. C0	C6. C0	C6 C0	C6 C0	C5 C5
A :		\geq	C6C0	C6C0	C6C0	C6 C0	05 00	05 00	04 00 0440000	25 C2		C6 C0				0000000		
	200																	
	oo.	a									22222222							
	010	9. 										uouou			CEDECQU			
	0"1	R1		9951888	*													
	190	A,						00000000	000000000000000000000000000000000000000									3888886
	101	R1 R11				0000000							00000000		8666566			
	110	A1 A11						0.000000										
	111	R1								00000000								

CONSULT FACTORY FOR CUSTOM FONT AND OPTION PROGRAMMING FORMS.



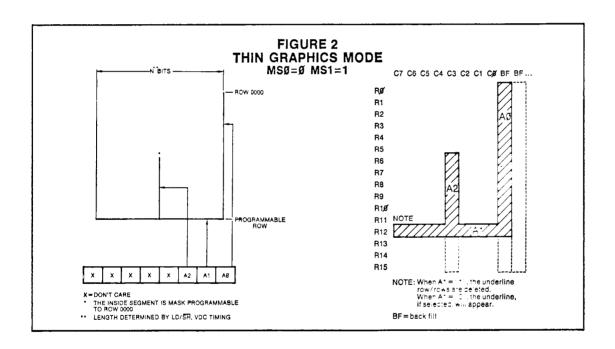
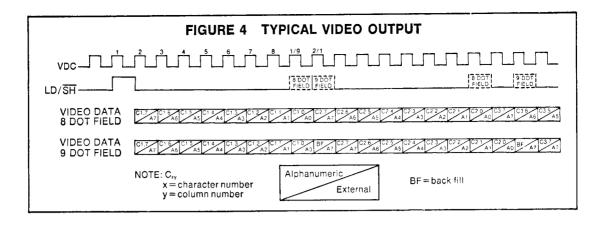
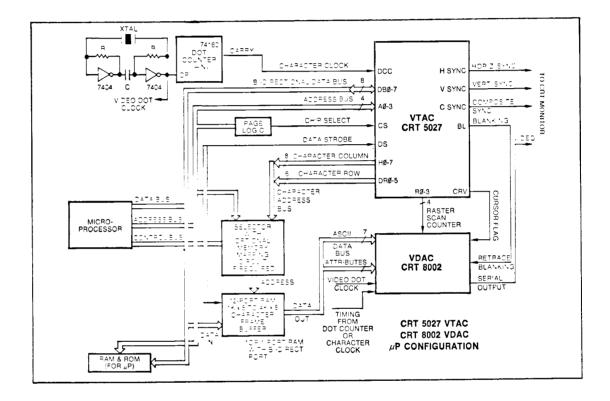
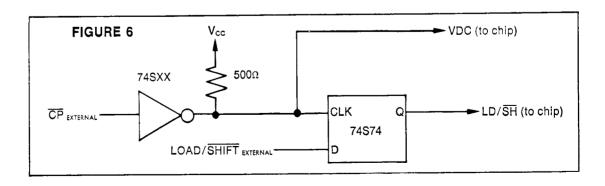


	FIGURE 3 EXTERNAL MODE MSØ=1 MS1=Ø													
	C7	C6	C5	C4	СЗ	C2	C1	CØ	BF	BF	•••			
RØ – R15	A7	A6	A5	A4	A3 [°]	A2	A1	AØ	A7	A7				
									BF	=ba	ck fil			









Circuit diagrams utilizing SMC products are included as a means of illustrating typical semiconductor applications: consequently complete information sufficient for construction purposes is not necessarily given. The information has been carefully checked and is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies. Furthermore, such information does not convey to the purchaser of the semiconductor devices described any license under the patent rights of SMC or others. SMC reserves the right to make changes at any time in order to improve design and supply the best product possible.

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Appendix C10

STANDARD MICROSYSTEMS CORPORATION 35 Marcus Bivd Hauppauge NY 117877 15161 273 -31001 TWX - 570 - 227 - 6839

COM 8046 COM 8046T

We keep ahead of our competition so you can keep ahead of yours.

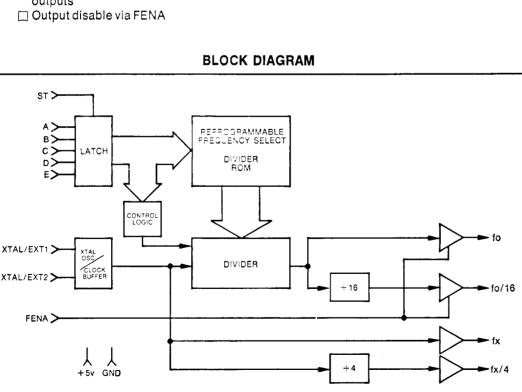
Baud Rate Generator Programmable Divider

FEATURES

- On chip crystal oscillator or external frequency input
- □ Single + 5v power supply
- Choice of 32 output frequencies
- □ 32 asynchronous/synchronous baud rates
- Direct UART/USRT/ASTRO/USYNRT
- compatibility
- technology allows generation of other frequencies
- TTL, MOS compatible
- 🗋 1X Clock via fo/ 16 output
- Crystal frequency output via fx and fx/4 outputs

XTAL/EXT1 16 fo XTAL/EXT2 2[15 A +5v 3[14 B fx 4 [13 C GND 51 12 D fo/16 6[11 ST FENA 7 10 fx/4E 81 9 NC

PIN CONFIGURATION



General Description

The Standard Microsystems COM 8046 is an enhanced version of the COM 5046 Baud Rate Generator. It is fabricated using SMC's patented COPLAMOS[®] and CLASP[®] technologies and employs depletion mode loads, allowing operation from a single +5v supply.

The standard COM 8046 is specifically dedicated to generating the full spectrum of 16 asynchronous/ synchronous data communication frequencies for 1X, 16X and 32X UART/USRT/ASTRO/USYNRT devices.

The COM 8046 features an internal crystal oscillator which may be used to provide the master reference frequency. Alternatively, an external reference may be supplied by applying complementary TTL level signals to pins 1 and 2. Parts suitable for use only with an external TTL reference are marked COM 8046T. TTL outputs used to drive the COM 8046 or COM 8046T should not be used to drive other TTL inputs, as noise immunity may be compromised due to excessive loading.

The reference frequency (fx) is used to provide two high frequency outputs: one at fx and the other at fx/4. The fx/4 output will drive one standard 7400 load, while the fx output will drive two 74LS loads.

The output of the oscillator/buffer is applied to the divider for generation of the output frequency f_0 . The divider is capable of dividing by any integer from 6

to 2¹⁹ + 1, inclusive. If the divisor is even, the output will be square; otherwise the output will be high longer than it is low by one fx clock period. The output of the divider is also divided internally by 16 and made available at the $f_{\rm O}/16$ output pin. The $f_{\rm O}/16$ cutput will drive one and the $f_{\rm O}$ output will drive two standard 7400 TTL loads. Both the $f_{\rm O}$ and $f_{\rm O}/16$ outputs can be disabled by supplying a low logic level to the FENA input pin. Note that the FENA input has an internal pull-up which will cause the pin to rise to approximately $V_{\rm Cc}$ if left unconnected.

The divisor ROM contains 32 divisors, each 19 bits wide, and is fabricated using SMC's unique $CLASP^{\mathfrak{E}}$ technology. This process permits reduction of turnaround-time for ROM patterns.

The five divisor select bits are held in an externally strobed data latch. The strobe input is level sensitive: while the strobe is high, data is passed directly through to the ROM. Initiation of a new frequency is effected within 3.5 μ s of a change in any of the five divisor select bits; strobe activity is not reaured. This feature may be disabled through a CLASPE programming option causing new frequency in tation to be delayed until the end of the current for a forycle. All five data inputs have pull-ups identical to that of the FENA input, while the strobe input has no pull-up.

Description of Pin Functions

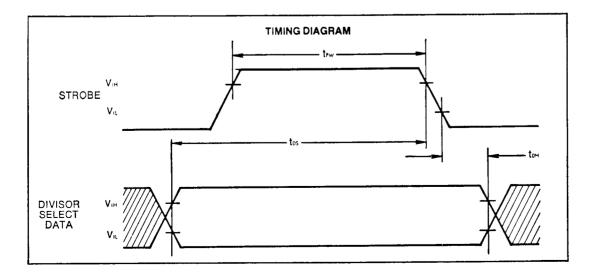
Pin No.	Symbol	Name	Function
1	XTAL/EXT1	Crystal or External Input 1	This input is either one pin of the crystal package or one polarity of the external input.
2	XTAL/EXT2	Crystal or External Input 2	This input is either the other pin of the crystal package or the other polarity of the external input.
3	V _{cc}	Power Supply	+5 volt supply
4	fx	fx	Crystal/clock frequency reference output
5	GND	Ground	Ground
6 7	f _o /16	f _o /16	1X clock output
7	FENA	Enable	A low level at this input causes the $f_{\rm O}$ and $f_{\rm O}/16$ outputs to be held high. An open or a high level at the FENA input enables the $f_{\rm O}$ and $f_{\rm O}/16$ outputs.
8	E	E	Most significant divisor select data bit. An open at this input is equivalent to a logic high.
9	NC	NC	No connection
10	f _x /4	f _x /4	1/4 crystal/clock frequency reference output.
11	ŜT	Strobe	Divisor select data strobe. Data is sampled when this input is high preserved when this input is low.
12-15	D,C,B,A	D,C,B,A	Divisor select data bits. A = LSB. An open circuit at these inputs is equivalent to a logic high.
16	fo	fo	16X clock output

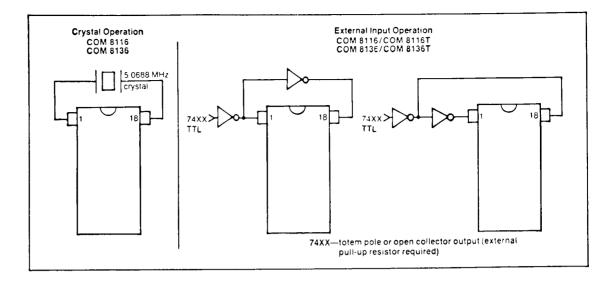
ELECTRICAL CHARACTERISTICS COM8046, COM8046T, COM8116, COM8116T, COM8126, COM8126T, COM8136, COM8136T, COM8146, COM8146T

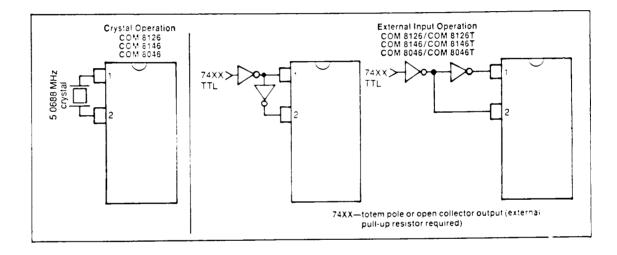
Operating Storage Te Lead Temp Positive Vo Negative V	tanteed ratings* .0°C to + 70°C remperature Range -55°C to + 150°C erature (soldering, 10 sec.) +325°C itage on any Pin, with respect to ground +8.0V oftage on any Pin, with respect to ground -0.3V
functional	above those listed may cause permanent damage to the device. This is a stress rating only and operation of the device at these or at any other condition above those indicated in the operational f this specification is not implied.
the Absol exhibit vo In additio	hen powering this device from laboratory or system power supplies, it is important that ute Maximum Ratings not be exceeded or device failure can result. Some power supplies Itage spikes or "glitches" on their outputs when the AC power is switched on and off. n, voltage transients on the AC power line may appear on the DC output. If this possibility is suggested that a clamp circuit be used.

ELECTRICAL CHARACTERISTICS (T_A=0°C to 70°C, Vcc= +5V \pm 5%, unless otherwise noted)

Parameter	Min.	Тур.	Max.	Unit	Comments
D.C. CHARACTERISTICS					
INPUT VOLTAGE LEVELS					
Low-level, Va			0.8	V	
High-level, Vin	2.0			v	excluding XTAL inputs
OUTPUT VOLTAGE LEVELS			0.4	l v	$I_{\odot} = 1.6 \text{mA}$, for $f_x/4$, $f_O/16$
Low-level, Va			0.4	Ň	$I_{0} = 3.2 \text{ mA}, \text{ for } I_{0}, I_{T}$
			0.4	v	$I_{0} = 0.8 \text{ mA}$, for f_x
	0.5		0.1	v	$I_{0+} = -100\mu A$; for fx, $I_{0+} = -50\mu A$
High-level, Vor	3.5			l v	$10^{4} - 100^{4}$, 101 k, $10^{4} - 00^{4}$
INPUT CURRENT Low-level. In			-0.1	mA	V _{IN} =GND, excluding XTAL inputs
All inputs, C N		5	10	pF	V _m =GND, excluding XTAL inputs
EXT INPUT LOAD		8	10		Series 7400 equivalent loads
POWER SUPPLY CURRENT					
lcc			50	mA	
A.C. CHARACTERISTICS					$T_{*} = +25^{\circ}C$
CLOCK FREQUENCY, fin	0.01		7.0	MHz	XTAL/EXT, 50% Duty Cycle = 5%
	0.04				COM 8046, COM 8126. CC 1 8146
	0.01		5.1	MHz	XTAL/EXT, 50% Duty Cycle = 5% COM 8116, COM 8136
STROBE PULSE WIDTH, tru	150		DC	ns	
INPUT SET-UP TIME	000			ns	
	200			ns	
	50		1	ns	
STROBE TO NEW FREQUENCY DELAY		1	3.5	μS	0 fx = 5.0 MHz







For ROM re-programming SMC has a computer program available whereby the customer need only supply the input frequency and the desired output frequencies The ROM programming is automatically generated

Crystal Specifications

User must specify termination (bin, wire, other) Prefer: HC-18/U or HC-25/U Frequency — 5.0688 MHz, AT cut Temperature range 0 C to 70 C Series resistance 50 Ω Series Resonant Overall tolerance ± 01% or as required

Crystal manufacturers (Part a List) Northern Engineering Laboratories 357 Beloit Street Burlington, Wisconsin 53105

(414) 763-3591 Bulova Frequency Control Products

61-20 Woodside Avenue Woodside, New York 11377 (212) 335-6000

CTS Knights Inc. 101 East Church Street Sandwich, Illinois 60548 (815) 786-8411 Crystek Crystals Corporation

1000 Crystal Drive Fort Myers. Florida 33901 (813) 936-2109

COM 8046 COM 8046T

Table 2 REFERENCE FREQUENCY = 5.068800MHz

Divisor Select EDCBA	Des red Baud Pate	Clock Factor	Desired Frequency (KHz)	Divisor	Actual Baud Rate	Actu al Frequen cy (KHz)	Deviation
00000 00011 00101 00101 00101 00110 00111 01000 01011 01001 01011 01101 01111 10000 10011 10010 10011 10100 10011 10100 10011 11000 11011 11100 11011 11100 11101 11110	50 00 75 00 10 00 10 00 2000 2000 2000 2000 2000 2000 2000 1000 1000 1000 1000 1000 1000 1000 1000 1000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 200000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 20000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 200000 2000000 2000000 2000000 200000000	32X 32X 32X 32X 32X 32X 32X 32X 32X 32X	$\begin{array}{c} 1\ 60000\\ 2.40000\\ 3.52000\\ 4.30400\\ 4.80000\\ 9.60000\\ 9.60000\\ 19.20000\\ 38.40000\\ 57.60000\\ 115.20000\\ 115.20000\\ 115.20000\\ 230.40000\\ 230.40000\\ 230.40000\\ 230.40000\\ 2.152000\\ 2.15200\\ 2.15200\\ 2.15200\\ 9.60000\\ 32.0000\\ 38.40000\\ 32.0000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 38.40000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 307.20000\\ 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307.200\\ 307.200\\ 307.200$	3168 2112 140 1177 1056 792 264 132 88 64 33 264 44 33 226 44 33 226 44 33 2255 21056 528 265 21056 528 266 41 528 266 41 33 6 336 4224 1056 528 266 41 33 6 336 4224 1056 528 266 41 27 52 88 6 336 4224 1056 2355 21 267 267 267 267 267 267 267 267 267 267	50.00 75.00 110.00 134.58 150.00 200.00 200.00 1200.00 2400.00 3600.00 4800.00 75.00 110.00 134.52 150.00 300.00 600.00 1200.00 2400.00 1200.00 75.00 110.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 1200.00 18800.00 1200.00 18800.00 1200.00 18800.00 1200.00 18800.00 18800.00 19800.00	$\begin{array}{c} 1.600000\\ 2.400000\\ 3.520000\\ 4.306542\\ 4.800000\\ 6.400000\\ 9.600000\\ 19.200000\\ 38.400000\\ 57.600000\\ 57.600000\\ 76.800000\\ 115.200000\\ 115.200000\\ 13.600000\\ 15.20000\\ 1.50000\\ 1.50000\\ 9.600000\\ 1.500000\\ 22.00000\\ 22.00000\\ 22.00000\\ 22.00000\\ 33.400000\\ 57.600000\\ 15.200000\\ 153.600000\\ 316.800000\\ 316.800000\\ \end{array}$	0 CCCCF 0 CCCCF 0 CCCCF C CCCF C C

Appendix D ZAP Operating System

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FILF Ready Assm	30	00	7:	323					
7324 7324 7324 7324 7324 7324						* *THE FI *AS OPI		ING EQUATES NG SYSTEM CI	
7324 7324 7324 7324 7324					0160 0170 0180 0190	TWO Three Four	EQU EQU EQU EQU EQU	0 1 2 3 4	
7324 7324 7324 7324 7324 7324					0210 0220 0230 0240	FIVE EIGHT ADDIS1 ADDIS2 DATDIS	EQU EQU	5 8D 5 6 7	*MSDS ADDRESS ITSPLAY PORT *LSDS ADDRESS ITSPLAY PORT *DATA DIESLAY FORT
7324 7324 7324 7324 7324		2			0260 0270 0280 0290	EXECC NEXTC UARTIO UARTST KEYPT			EXEC KEY NEXT KEY #UART IZC FOR t #UART STAILS P ort #KEYBUARD INP ut Port
7324 7324 0000 0000					0300 0310 0320 0330 0340	* * *	ST	0	ነው ድህረው የህም አረውኩ በስታ በነው በአስዋ በነው
000 0 0000						XAND EI X			NO SYSTEM STACK POINTER 3 Recogniition Module
	3N 23	C4 40 ୯୭	00		0390 0400 0410		LD JP DS	SP,SPSTRT WARM01 2	*INITALIZE STACK POINTER
0010 0	03 (†:	47	00			WARM RST2E	JP DS JP	WARM1 5 RST2V	*RST 1 OR WARM START *RST 2 TRANSFER
0013 0018 (0018					0470	RST3E	DS JP DS	5 RST3V 5	*RST 3 TRANSFER
0029 C 0023 0028 C					0490 0500	RST4E RST5E	JP DS JP	RST4V 5 RST5V	*RST 4 TRANSFER *RST 5 TRANSFER
002B 0030 0 0033					0530	RST6E	DS JP DS	5 RST6V 5	*RST 6 TRANSFER
0038 0 0038 0040 E				07	0550	RST7E WARM01	JP DS LD	RSTZV 5 (SPLSAV),SF	*RST 7 TRANSFER

0044 C3 89 00 0047 0047	0552 0560 * 0570 *	JP	WARM2	*GO TO COMMAND RECOGNITION
0047 0047 0047 0047	0600 *ENTER 0610 *FS DI	S THE	COMMAND RECU	SERS REGISTERS AND DONITION MODE WITH TA AND ADDRESS DISPLAYS
0047 0047 32 E3 07 0044 E1 0048 22 DD 07	0620 * 0630 WARM1 0640 0650	LD POP LD		*SAVE USERS A *GET USERS PC FROM STACK *SAVE USERS PC IN SAVE AREA
004E F5 004F E1 0050 22 E7 07	0660 0670 0680	PUSH POP LD	HL (ESAV),HL	*GET USERS FLAGS *SAVE USERS FLAGS
0053 DD 22 D7 07 0057 FD 22 D9 07	0690 0700		(TYLSAU), IY	*SAVE USERS IX *SAVE USERS IY *SAVE USERS SP
005B ED 73 DB 07 005F ED 57	0710 0720 0730	LD LD LD	AFI (ISAV)#A	*SAVE USERS I
0061 32 DF 07 0064 ED 5F 0066 32 E0 07	0740 0750		A,R (RSAV),A	*SAVE USERS R
0069 21 E4 07 006C 70	0760 0770 0780	LD LD INC	HL,BSAV (HL),B HL	*SAVE USERS B
006D 23 006E 71	0790 0800	LD INC	(HL),C	*SAVE USERS C
006F 23 0070 72 0071 23	0810 0820	LD INC	(HL),D HL	*SAVE USERS D
0072 73 0073 08	0830 0840	LD EX	(HL),E AF,AF	*SAVE USERS E *SAVE ALTERNATE REGISTERS
0074 F5 0075 32 EB 07	0850 0860 0870	PUSH LD LD		*SAVE ALT A *Save alt H&L
0078 22 E9 07 007B E1 007C 22 EF 07	0880	FOP	HL (AESAV),HL	*SAVE ALT FLAGS
007F 21 EC 07 0082 70	0900 0910		HL,ABSAV (HL),B	*SAVE ALT B
0083 23 0084 71	0920 0930	INC LD	HL (HL),C	*SAVE ALT C
0085 23 0086 72	0940 0950	INC LD	HL. (HL), u	*SAVE ALT D
0087 23 0088 73	09 60 097 0	INC LD	HL),E	*SAVE ALT E
0089 0089	0980 * 0990 * 1000 *80%	ANT D	ECOGNITION M	nni II. IE
0089 0089	1010 *			*CLEAR DISPLAY
0089 CD F1 00 008C 3E FF 008E D3 05	1020 WARM2 1030 1040 1050	LD LD OUT OUT		*DISPLAY FFFF FF
0090 D3 06 0092 D3 07 0094 CD 03 01 0097 06 40	1030 1030 1070 1080	OUT		*GET INPUT CHARACTER
0099 B8 009A CA F1 01 009D 04	1090 1100 1110	CP JP INC	B Z,MEMORY B	*JUMP IF MEMORY REQUEST
009E B8 009E CA 4B 02 009E CA 4B 02	1120 1130 1140	CP JP INC		*JUMP IF REGISTER REQUEST
00A3 B8 00A4 CA 10 03 00A7 C3 89 00	1150 1160 1170	90 JP JP	B Z,GOREQ WARM2	
00A7 C3 89 00 00AA 00AA 00AA	1120 * 1190 * 1190 MEM 1200 *	EQU		*MEMORY KEY
00AA 00AA 00AA	1210 * 1220 *RES	TART F RETUR	RESTORES THE RNS CONTROL T	USERS REGISTERS TO THE ADDRESS

-

00A 00A	ιA				1250	*REGIS		IN THE PC SAV	VE LOCATIC	т иі и	'HE
	ім іА ЗА іД 47	EC	07		1260 1270 1280	RESTRT	L.D L.D	A,(ABSAV) B,A	*RESTORE	E ALT R	GISTERS
006	E 3A	ED	07		1290		LD	A,(ACSAV)			
00E 00E	1 4F 2 3A	EE	07		$\begin{array}{c}1300\\1310\end{array}$		L D L D	CIA AI(ADSAV)			
	5 57 6 3A	ta ta	07		$1320 \\ 1330$		L.D L.D	D,A A,(AESAV)			
OOE	9 SF A 3A				1340		L. II	E,A A,(AFSAV)			
008	0 6F	rν	07		$1350 \\ 1360$		LD LD	LуA			
	E E5 F F1				$\frac{1370}{1380}$		PUSH POP	HL AF			
	0 3A 3 2A				$1390 \\ 1400$		L. D L. D	A,(AASAV) HL,(ALSAV)			
000	6 D9			A ***	1410		EXX		- 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1	****	
000	7 FD B DD	26	07		$\frac{1420}{1430}$		L.D L.D	IY,(IYLSAV) IX,(IXLSAV)			
	F 21 2 7E	DF	07		$1440 \\ 1450$		1.0 1.0	HL,ISAV A,(HL)			
O O E	3 ED	47			1460		$L_{\rm c}$	ТзА			
001	5 23 6 7E				$1470 \\ 1480$		INC LD	HL A,(HL)			
	2 ED 9 21		07		$1490 \\ 1500$		L D L D	R¥A HL¥ASAV			
	C 7E D 23				$\begin{array}{c} 1510\\ 1520 \end{array}$		LD INC	Ay(HL) HL	*RESTORE	A	
OOL	E 46				1530		01	B*(HL)	*RESTORE	B	
	F 23 0 4E				$1540 \\ 1550$		INC LD	HL C,(HL)	*RESTORE	С	
0 O E	$\begin{array}{ccc} 1 & 23 \\ 2 & 56 \end{array}$				1560 1570		INC LD	HL D,(HL)	*RESTORE	ΣI	
	3 23 4 5E				$1580 \\ 1590$		INC LD	HL E,(HL)	*RESTORE	E	
OOE	5 ED 9 2A			07	$\begin{array}{c} 1600 \\ 1610 \end{array}$		L.D L.D	SP;(SPLSAV) HL;(PCLSAV)	*RESTORE	$ST \land T >$	
00E	C E5				1620		PUSH	H.			0 11010
	D 2A 0 C9	E: 1	07		$\frac{1630}{1640}$		LD RET	HL,(LSAV)	*RESTORE *RETURN 7		ł
00F 00F					$1650 \\ 1660$						
0 O F	1				1620	ж		······································	n kanalan an san san san san sa	sers warrenar	41 - A N / 25
00F 00F	1.				1690	*SETS :	THE KE	RS THE DATA A EYBOARD BUFFE			
00F 00F			~	150	1700 1710	*KEYB07	ARD FL	_AGS			
00F	1 3E 3 32		0.7 [°]			CLDIS	L.D L.D	A,ZERO (KFLAGS),A	*CLEAR F	1 465	
OOF	6 32	F2	07	4	1740		LD	(KDATA1),A	*CLEAR E		
	9 32 C D3		07		$1750 \\ 1760$		LD OUT	(KDATA2),A DATDIS	*CLEAR I	ATA FI	ELD DISPLAY
	E D3 0 D3				1770 1780		OUT OUT	ADDIS1 ADDIS2	*CLEAR A	NDDRESS	FIELD DISPLAY
010	2 C9	00			1790	Nr.	RET	112.20 2.10 42			
010 010	3				$\begin{array}{c} 1800 \\ 1810 \end{array}$	ж					
010 010								3 FOR INPUT F FING DATA AT			
010 010								ROBE BIT (7) HE STROBE BIT			
010 010	3					*CHARA(IS RETURNED 1			
010		ሰሳ			1880		IN	KEYPT	*INPUT I	ነልፐል	IN A, (N)
010	5 CB	7F	A.1		1900	τγlou I du∂Υ	BIT	7,A			TA IP CL. NN
	7 CA A 32				$\frac{1910}{1911}$		JP LD	Z,KEYIN (TEMP),A	*SAVE CHA		

.

010D 010F 0111 0114 0117 0119 011A	CB C2 3A CB	7F 0D F4 BF			1912 1913 1914 1915 1920 1930 1940		BIT JP LD	KEYPT 7,A NZ,KEYIN1 A,(TEMP) 7,A	*JUMP IF STROBE PRESENT *CLEAR STROBE
011A 011A 011A					1970	*KFLGO: *	SETS	5 THE NEXT(O)	AD NO DATA(2) KEYBOARD FLAGS
011A 011A 011D	СВ	C6	07		1980 1990 2000 2010		LD SET SET	HL;KFLAGS O;(HL) 2;(HL)	*SET NEXT FLAG
011F 0121 0122 0123	Ε1				2020 2030 2040	*	POP RET	HL	*CLEAR RETURN
0123 0123 0123					2050 2060 2070	* *KFLGO *	SETS	THE NEXT(0)	KEYBOARD FLAG
0123 0123 0126 0128 0129	CB E1	С4	07	4. Sf	2100 2110 2120	KFLG0	SET	HL,KFLAGS O,(HL) HL	*SET NEXT FLAG *CLEAR RETURN
012A 012A 012A 012A					2130 2140 2150 2160	* *KFLG12	2 SET	S THE EXEC(1)	AND NO DATA(2) KEYBOARD FLAG
012A 012A 012D 012F 0131 0132-	CB CB E1	СE	07		2170	* KFLG12	LD SET SET POP RET	HL,KFLAGS 1,(HL) 2,(HL) HL	*CLEAR RETURN
0133 0133 0133 0133					2260	* *KFLG1 *	SETS	THE EXEC (1)	KEYBOARD FLAG
0133 0133 0136 0138 0139- 013A 013A	CB E1		07		2270 2280 2290 2300 2310 2320 2330	KFLG1 *	LD SET POP RET	HL•KFLAGS 19(HL) HL	*SET EXEC FLAG *CLEAR RETURN
013A 013A 013A 013A 013A					2360	*ONECA *FROM *THE U	ТНЕ К	UTS ONE CHARA Eyboard, Vali N Kdata2	CTER FOLLOWED BY A NEXT OR EXEC Dates it, and returns it to
013A 013A 013D 0140 0142	CD D3 CD	03 07 5D	01		2410 2420 2430	ONECAR	CALL OUT CALL	KEYIN DATDIS CARCK1	*CLEAR DISPLAY,BUFFER,&FLAGS *GET CHARACTER *DISPLAY CHARACTER *CHECK CHARACTER
0145 0147 014A 014C	C2 D6 F2	51 10 <u>3</u> A	01	1	2440 2450 2460 2470		BIT JP SUB JP ADD	6,A NZ,ONECA1 16D P,ONECAR 16D	*JUMP IF SHIFT *CHARACTER=0-F *JUMP IF NOT 0-F
014F 0151 0154 0157	32 CD CD	F3 03 6A	07 01 01		$2500 \\ 2510$	ONECA1	LD CALL CALL	(KDATA2),A KEYIN CARCK2	*SAVE CHARACTER *GET NEXT CHARACTER *GO DO AGAIN NOT EXEC OR NEXT
015A 015D 015D 015D 015D	C3	51	01			* *			XT OR EXEC ON AN INITIAL E ROUTINE RETURNS TO CALLER VIA

0150 0150 0150 0150 0150	2570 *KFLG02, 2580 *VIA KFL 2590 * 2600 *		E ROUTINE RETURNS TO THE CALLER
015D 06 20 015F B8	2610 CARCK1 L	D B,NEXTC	*CHECK FOR NEXT
0160 CA 1A 01 0163 06 10 0163 88	2630 J 2640 L	JP Z,KFLGO: D B,EXECC D B	
0166 CA 2A 01 0169 C9 016A	2660 J	JP Z,KFLG1: RET	2 *IF EXEC JUMP *ELSE RETURN
016A 016A 016A 016A 016A 016A	2700 *CARCK2 2710 *FLAG VI 2720 *IF NOT 2730 *THE ORI 2740 *	(A KELGO OR I NEXT OR EXE	VEXT OR EXEC, SETS THE PROPER (FLG1 AND RETURNS TO THE USER) THE ROUTINE RETURNS TO THE REQUEST
016A 016A 06 20 016C B8	2750 * 2760 Carck2 L 2770 C	D BANEXTC	*CHECK FOR NEXT
0160 CA 23 01 0170 06 10	2780	JP Z•KFLGO .D B•EXECC	
0172 B8 0173 CA 33 01 0176 C9	2810 J	P B JP Z,KFLG1 KET	
0177 0177	2830 * 2840 *		
0177 0177			ARACTERS FROM THE KEYBOARD OR EXEC AND RETURNS THEM TO THE
0177 0177	2870 ¥USER IN 2880 ¥	/ KDATA2	
0177 0177 CD A0 01	2890 * 2900 tuocar c	CALL CLDAT	*CLEAR BUFFER, FLASS, AND DISPLAY
017A CD 03 01 017D CD 5D 01		ALL KEYIN ALL CARCKI	*GET CHARACTER *Check for Next or exec
0180 D6 10 0182 F2 77 01	2940 TWOCA1 S 2950 J	3UB 160 JP P,TWOCAI	*CHARACTER=0-F R *JUMP IF NOT 0-F
0185 C6 10 0187 21 F3 07	2960 A	NDD 16D .D HE,KDAT(
018A 46	2980 L	D By(HL) SLC B	*02T CLU DATA
018B CB 00 018D CB 00 018F CB 00	3000 R	ale b ale b	
0191 CB 00 0193 80	3020 F	ADD AVB	*A=0L7:&NEW
0194 D3 07	3031 0	DATDIS	*DISPLAY INPUT
0196 77 0197 CD 03 01		D (HL))A Dall Keyin	*SAVE NEW DATA *Get next character
019A CD 6A 01 019D C3 80 01		DALL CARCK2 JP TWOCA1	*CHECK FOR TERMINATION *JUMP IF NO TERMINATION
01A0 01A0	3080 * 3090 *		
01A0 01A0 01A0	3100 *CLDAT C 3110 * 3120 *	LEARS THE I	NFUT BUFFER,FLAGS, AND DATA DIS
01A0 3E 00	3130 CLDAT L	LD A,ZERO LD (KFLAGS),A *CLEAR FLAGS
01A2 32 F1 07 01A5 32 F3 07 01A8 32 F2 07	3150 L	D (KDATA2 D (KDATA2 D (KDATA1	>,A *CLEAR BUFFER
01AB C9 01AC 3E 00		RET _D A,ZERO	*CLEAR ADDRESS DISPLAY
01AE D3 05 01B0 D3 06	3182 C 3183 C	OUT ADDIS1	
01B2 C9 01B3	3184 F 3190 *	RET	
01B3 01B3	3200 * 3210 *FORCAR	INPUTS FOUR	CHARACTERS FROM THE KEYBOARD
0183			OR EXEC AND RETURNS THEM

01B3		E USER IN KDATA1	AND KDATA2
01B3 01B3	3240 * 3250 *		
01B3 CD A0 01	3260 FORCAR	CALL KEYIN	*CLEAR FLAGS AND BUFFER
01B6 CD 03 01	3270		*GET INFUT CHARACTER
01B9 CD 5D 01	3280	CALL CARCK1	*CHECK FOR NEXT OR EXEC
01BC D6 10	3290 FORCA1	SUB 16D	*CHARACTER=0-F
01BE F2 B3 01	3300	JP PyFORCAR	*JUMP IF NOT O-F
01C1 C6 10	3310	ADD 16D	
01C3 32 F4 07	3320	LD (TEMP),A	¥SAVE CHARACTER
01C6 3A F2 07	3330	LD A,(KDATA1)	¥A≕MSD
01C9 21 F3 07	3340	LD HL,KDATA2	*ADJUST DATA FOR NEW CHARACTER
01CC ED 67	3350	RRD	
01CE 07	3360	RLCA	
01CF 07	3370	RLCA	
01D0 07	3380	RLCA	
01D1 07	3390	RLCA	
01D2 E6 F0	3400	AND 240D	*MASK OFF OLD IDGIT
01D4 21 F4 07	3410	LD HL,TEMP	
0107 86	3420	ADD A,(HL)	*ADD IN NEW DIGIT) *SAVE NEW LSDS
01D8 2A F3 07 01DB 22 F2 07	3430 3440	LD (KDATA1),HI	_ *SAVE NEW MSDS
01DE 32 F3 07	3450	LD (KDATA2),A	*SAVE NEW LSDS
01E1 D3 06	3460	OUT ADDIS2	*Display LSDS
01E3 3A F2 07	3470	LD A,(KDATA1)	
01E6 D3 05	3480	OUT ADDIS1	
01E8 CD 03 01	3490	CALL KEYIN	*GET NEXT CHARACTER
01EB CD 6A 01	3500	CALL CARCK2	*CHECK FOR NEXT OR EXEC
01EE C3 BC 01 01F1	3510 3520 *	JP FORCAL	*JUMP IF NOT NEXT OR EXEC
01F1 01F1	3530 ¥ 3540 ¥		
01F1 01F1	3550 * 3560 *Memory	Y INFERS AN ABDE	ISS FROM THE KEYBOARD FOLLOWED
01F1		TA AS DEFICIED BY	THE SEQUENCE
01F1		(Abdress)next,(D	ATA)NEXT(DATA)EXEC
01F1 01F1	3600 ¥ MEM	TA IS TO BE DISFI (ADDRESS)NEXT,NE	XT.,,,NEXT,EXEC
01F1 01F1	3610 *EXEC (3620 *	WILL RETURN CONT	ROL TO THE COMMAND RECOGNITION
01F1 01F1 3E 00	3630 * 3640 memory	LD A,ZERO	*CLEAR MEMORY BASE ADDRESS
01F3 32 F6 07	265 0	LD (MBASEL),A	
01F6 32 F7 07	2650	LD (MBASEL2),A	
01F2 CD FC ()	17 4 A 1	CALL CLADD	*GET BASE ADDRESS
01FC CD B3 ()	17 4 A 1	CALL FORCAR	
01FF 3A FL 07	2000 2000 2000	LD A, (KFLAGS) BIT 1,A	(i) Go has 1 Art 1 Go has 1 Do not 1 Go had a de la constante
0202 CB 4F 0204 C2 89 CG	5710 5710 51:0	JP NZ;WARM2	*JUMP IF EXEC FLAG SET *Save memory address
0207 3A F2 07 020A 32 F7 07	3720	LD A,(KBATA1) LD (MBASE2),A	
020D 3A F3 07	3230	LD A,(KDATA2)	
0210 32 F6 07	3240	LD (MBASE1),A	
0213 2A F6 07	3750	LD Ay(HL)) *GET MEM BASE ADDRESS
0216 7E	3760 MEM1		*GET MEMORY DATA
0217 D3 07	3770	OUT DATDIS	*DISPLAY MEMORY DATA
0219 CD 77 01	3780	Call Twocar	*Get New Data
021C 3A F1 07	3790	LD A,(KFLAGS)	
021F CB 57	3800	Bit 2,A	
0221 C2 43 02	3810	JP NZ,MEM2	
0224 2A F6 07	3820	LD HL,(MBASE1	
0227 3A F 3 07	38 30	LD A,(KDATA2)	*GET NEW DATA
022A 77	3840	LD (HL),A	*REPLACE OLD DATA
022B 3A F1 07	3850	LD A,(KFLAGS)	
022E CB 4F	3860	BIT 1,A	
0230 C2 89 00 0233 2A F6 07		101 807 1140540	VINE TE EVEC ELAS CET
$\nabla x_0 \oplus \overline{\omega} \oplus \overline{\omega} \oplus \overline{\omega} \oplus \overline{\omega} = 1$ \oplus ∇Z	3870	JP NZ;WARM2	*JUMP IF EXEC FLAG SET
	3880 MEM12	LD HL;(MBASE1) *INC BASE MEM ADD

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023A 7D 023B D3 06 023D 7C 023E D3 05 0240 C3 16 02 0243 CB 4F 0245 G2 89 00 0248 C3 33 02 0248 0248 0248 0248	3901 3902 3903 3904 3910 3920 MEM2 3930 3940 3950 * 3950 * 3950 * 3960 * 3970 *	LD OUT LD OUT JF BIT JP JP	A,L ADDIS2 A,H ADDIS1 MEM1 1,A NZ,WARM2 MEM12	*JUMP IF EXEC FLAG SET
024B 024B 024B 024B 024B 024B 024B 024B	3990 *REGIS 4000 *DATA 4010 * REG 4020 *REGIS 4030 *AL,AH 4040 *IF DN 4050 * REG 4060 *EXEC 4070 *	AS DE (INIT TER S (AA,A) (AA,A) (INIT (INIT WILL 1	FINED BY TH REG)NEXT,() EQUENCE IS : B,AC,AD,AE,A TA IS TO BE REG)NEXT,NE REG)NEXT,NE	DATA)NEXT(DATA)EXEC IX,IY,SF,PC,I,R,H,L,A,B,C,D,E,F, AF DISPLAYED EXTEXEC ROL TO THE COMMAND RECOGNITION
024B CD 3A 01 024E 3A F1 07	4090 REGIST 4100	CALL LD	ONECAR Ay(KFLAGS)	*GET INITIAL CHARACTER
0251 CB 57	4110	BIT	2 y A	ለ በአለም ከም አንድ ምራምራ ምር ልድ ሮንምም
0253 C2 89 00 0256 3A F3 07	4120 4130	JP LD	NZ;WARM2 A;(KDATA 2)	*JUMP IF NO DATA FLAG SET *GET BASE REGISTER
0259 32 F5 07	4140 REGIO	LD	(TEMP2),A	WOULDRY FOR OUTET
025C CB 77 025E C2 CC 02	4141 4142	BIT JP	6≠A NZ≠REGISA	*CHECK FOR SHIFT *JUMP IF SHIFT KEY SET
0261 FE 06	4143	CP	6	
0263 F2 6C 02 0266 3D	4144 4145	JP DEC	P,REGI1	*JUMP IF EIGHT BIT REGISTER
0267 30	4146	DEC	A A	
0268 87	4147	ADD	A	*I=(I-2)*2
0269 C3 6E 02 026C 3C	4148 4149 REGI1	JP INC	REGI2	
026D 3C	4150	INC	A A	
026E 32 F8 07	4151 REGI2	L D		*SAVE INDEX
0271 3A F5 07 0274 FE 10	4152 4153	LD CP	A,(TEMP2) 10H	
0276 FA 83 02	4154	JP	M,REGI2A	
0279 CB 77	4155	BIT	6,A	
027B C2 83 02 027E 3E 48	4157 4158	UP LD	NZ,REGI 2 A A,48H	*JUMP IF BIT 6 SET
0280 32 F5 07	4159	LO	(TEMP2);A	
0283 D3 07	4160 REGI2A		DATDIS	*DISFLAY REGISTER SELECT
0285 3A F8 07 0288 FE 08	4210 4220	LD CP	A,(REGINX) EIGHT	
028A FA D6 02	4230	JP	MyXYSP	*JUMP IF 16 BIT REG
028D 21 D7 07	4240	1	HL,IXLSAV	*GET BASE ADD
0290 4F 0291 06 00	4250 4260	L.10 L.10	CyA ByZERO	
0293 09	4270	ADD	HL,BC	
0294 22 F6 07	4280	LD	(MBASE1),HL	. *SAVE REG SAVE ADD
0297 7E	4290	LD	Ay (HL)	*GET REGISTER DATA
0298 D3 06	4300	OUT	ADDIS2	*DISPLAY DATA
029A 78 029B D3 05	4310 4320	LD OUT	A,B ADDIS1	
029D CD 77 01	4330		TWOCAR	*GET NEW DATA
02A0 3A F1 07	4340	LD prr	A, (KFLAGS)	
02A3 CB 57 02A5 C2 B7 02	4350 4360	BIT JP	2#A NZ#REGI3	*JUMP IF NO DATA
02A8 2A F6 07	4390	L.D	HL, (MBASE1))
02AB 3A F2 07 02AE 77	4400 4410	L.D L.D	A,(KDATA1) (HL),A	*GET NEW DATA *REPLACE OLD DATA
02AF 3A F1 07	4411	Lΰ	A, (KFLAGS)	-prochant facts for fan Andrew Andrew Andre 1995 - F
02B2 CB 4F	4412	BIT	1,A	

02B4 C2 S9 00 02B7 3A F5 07 02BA 3C 07 02BB 32 F5 07 02BE 3A F8 07 02BE 3A F8 07 02C1 3C 02 02C2 FE 1A 02C4 FA 6E 02 02C7 3E 02 02C7 3E 02 02C9 C3 59 02 02C2 FA 4B 02 02C2 C3 59 02 02C2 C3 59 02 02C2 FA 4B 02 02D1 C6 12 02 02D3 C3 6E 02 02D4 21 D7 07 02D9 4F 02 02 02DA 06 00 02 02DC 09 59 02	4413 4420 REGI3 4421 4422 4423 4430 4440 4450 4440 4450 4460 REGI4 4470 4500 4510 4510 4520 XYSP 4530 4540 4550	JP LD LD LD LD LD LD LD LD LD LD LD LD LD	NZ,WARM2 A,(TEMP2) A (TEMP2),A A.(REGINX) A 1AH M,REGI2 A,TWO REGI0 48H M,REGI2 A,TWO REGI0 48H M,REGIST 12H REGI2 HL,IXLSAV C,A B,ZERO HL,BC	<pre>*JUMP IF EXEC FLAG SET *INCREMENT INDEX *JUMP IF INDEX .LT. 1A *SET INITIAL INDEX *JUMP IF INVALID REGISTER *HL=REG SAVE ADDRESS</pre>
02DD 22 F6 07 02E0 7E 06 02E1 D3 06 02E3 23 06 02E4 7E 02 02E5 D3 05 02E7 3A F8 07 02E4 3C 07 02E5 D3 05 02E6 CD B3 01 02E6 CD B3 01 02E7 3A F1 07 02E6 CD B3 01 02F1 3A F1 07 02F6 C2 08 03 02F7 2A F6 07 02F6 C2 08 03 02F7 2A F6 07 02F7 2A F6 07 02F7 2A F6 07 0300 3A F2 07 0303 23 07 0305 0304 77 0300 07 <t< td=""><td>4560 4570 4580 4590 4600 4610 4620 4630 4630 4640 4650 4650 4650 4660 4670 4680 4710 4720 4720 4730 4740 4750 4760 4761 4762 REGI5 4763 4770</td><td>LD BIT JF LD LD LD LD LD LD LD BIT JF</td><td>(MBASE1),HL A,(HL) ADDIS2 HL A,(HL) ADDIS1 A,(REGINX),A (REGINX),A FORCAR A,(KFLAGS) 2,A NZ,REGI5 HL,(MBASE1) A,(KDATA2) (HL),A A,(KDATA1) HL (HL),A A,(KFLAGS) 1,A NZ,WARM2 REGI3</td><td>*DISPLAY REGISTER DATA *GET NEW DATA *JUMP IF NO DATA</td></t<>	4560 4570 4580 4590 4600 4610 4620 4630 4630 4640 4650 4650 4650 4660 4670 4680 4710 4720 4720 4730 4740 4750 4760 4761 4762 REGI5 4763 4770	LD BIT JF LD LD LD LD LD LD LD BIT JF	(MBASE1),HL A,(HL) ADDIS2 HL A,(HL) ADDIS1 A,(REGINX),A (REGINX),A FORCAR A,(KFLAGS) 2,A NZ,REGI5 HL,(MBASE1) A,(KDATA2) (HL),A A,(KDATA1) HL (HL),A A,(KFLAGS) 1,A NZ,WARM2 REGI3	*DISPLAY REGISTER DATA *GET NEW DATA *JUMP IF NO DATA
030D C3 B7 02 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 0310 B3 01 0310 CD AC 01 0310 CD B3 01 0310 CD B3 01 0313 CD B3 01 0314 CD B3 07 0315 C2 89 00 0318 C2 89 00 0318 C2 89 07 0321 32 DD 07 0324 3A F2 07 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 0320 </td <td>4230 *REGIS 4240 *MODUL 4250 * 4250 * 4250 GOREQ 4271 4280 4290 4290 4290 4290 4290 4290 4290 429</td> <td>TER S E CALL CALL LD BIT JP LD LD LD LD LD LD LD LD LD LD LD LD LD</td> <td>THE USERS RE SAVE AREA AND - CLADD - FORCAR A,(KFLAGS) 2,A NZ,WARM2 A,(KDATA2) (PCLSAV),A A,(KDATA1) (PCHSAV),A RESTRT A UART LOOP (ES A LOOP WIT HED TO THE IN OR IS DETECTI</td> <td>*IF NO DATA EXIT *SAVE NEW ADDRESS CHECK ROUTINE FH THE OUTPUT</td>	4230 *REGIS 4240 *MODUL 4250 * 4250 * 4250 GOREQ 4271 4280 4290 4290 4290 4290 4290 4290 4290 429	TER S E CALL CALL LD BIT JP LD LD LD LD LD LD LD LD LD LD LD LD LD	THE USERS RE SAVE AREA AND - CLADD - FORCAR A,(KFLAGS) 2,A NZ,WARM2 A,(KDATA2) (PCLSAV),A A,(KDATA1) (PCHSAV),A RESTRT A UART LOOP (ES A LOOP WIT HED TO THE IN OR IS DETECTI	*IF NO DATA EXIT *SAVE NEW ADDRESS CHECK ROUTINE FH THE OUTPUT

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032D 032D 032D	5050 *THE OU	HARACTER IS I JTPUT CHARACT ADDRESS DIS	DISPLAYED ON THE DATA DISPLAY TE IS DISPLAYED ON THE MSD GPLAY
032D 032D 06 00 032F DB 03	5080 UATST 5090	LD B,ZERO IN UARTST BIT 0,A	* *get status
0331 CB 47 0333 CA 53 03 0336 78 0337 D3 05 0339 D3 02	5100 5110 5120 UATSTO 5130 5140	JP Z,UAER	A *JUMP IF XMIT BUFFER NOT EMPTY *GET OUTPUT CHARACTER
033B DB 03 033D CB 4F 033F CA 3B 03	5160 5170	IN UARTST BIT 1,A JP Z,UATS	T1 *JUMP IF NO DATA AVAILABLE
0342 E6 1C 0344 C2 53 03 0347 DB 02 0349 D3 07	5180 5190 5240 5250	AND 1CH JF NZ,UAE IN UARTIO OUT DATDIS	R1 *JUMP IF PARITY ERROR *GET INPUT CHARACTER
0348 88 0340 02 5A 03 034F 04	5260 5270 5280 5290	CP B JP NZ,UAE INC B JP UATSTO	R2 #JUMP IF INPUT.NE.OUTPUT
0350 C3 36 03 0353 D3 06 0355 DB 02 0357 D3 07	5300 UAER1 5310 5320	OUT ADDIS2 IN UARTIO OUT DATDIS	*GET INPUT DATA
0359 76 035A 3E OF 035C ED 79 035E 7 6	5330 5340 UAER2 5350 5360	HALT LD A,OFH OUT (ADDIS HALT	2),A
035F 035F 035F 035F 035F 035F 035F	5410 *INPUT	S DATA INTO IS TERMINAT TECDED OR TH	THE SPECIFIED BUFFER ED WHEN A CARRIAGE RETURN E NUMBER OF SPECIFIED CHARACTERS FROM THE TRANSMITDING DEVICE
035F 035F 035F 2A F9 07 0362 3A FD 07	5430 *HAVE 5440 * 5450 TTYINF 5460		YIBF) *GET BUFFER ADDRESC
0365 47 0366 DB 03 0368 CB 4F	5470 5480 TTYIN1 5490	LD B,A	*GET UART STATUS
036A CA 66 03 036D E6 1C 036F C2 9B 03	5500 5510 5520	JP Z,TTYI AND 1CH JP NZ,TTY	ERR #JUMP IF PARITY ERROR
0372 DB 02 0374 77 0375 BF	5570 5580 5590	IN UARTIC LD (HL),A CP A,ODH	*SAFE CHARACTER IN USERS BUF
0376 CA 91 03 0379 3E 01 0378 22 FB 07 037E 32 FE 07 0381 78	5600 5&10 5620 TTYIN 5630 5631	LD (TTYOU LD A,B	*SET OUTPUT CHARACTER COUNT BF),HL *SET OUTPUT BUFFE ADDRESS C),A
0382 32 F4 07 0385 CD 9E 03 0388 3A F4 07 0388 47	5632 5640 5641 5642 5650	LD (TEMP) CALL TTYOUT LD A;(TE) LD B;A DEC B	r *GO OUTPUT CHARACTER
038C 05 038D C8 038E C3 66 03	5660 5670	RET Z JP TTYIN:	*RETURN IF ALL CHARACTERS IN #GET LINE FEED ADDRESS
0391 21 9C 03 0394 3E 02 0396 06 01 0398 C3 7B 03	5680 TTYIN 5690 5700 5710	LD AFTWO LD BFONE JP TTYIN	3
0398 C9 039C 0D 0A	5720 TTYER 5730 LF		*RETURN WITH ERROR CODE IN A
039E 039E	5740 * 5750 *TTY	OUTPUT DRIVE	र

039E 039E 039E 039E 039E 039E	5760 *TTYOUT OUTPUTS DATA FROM THE SPECIFIED 5770 *USERS BUFFER TO THE UART. THE NUMBER OF 5780 *USER SPECIFIED CHARACTES ARE OUTPUT 5790 *AND CONTROL RETURNED TO THE USER 5800 *
039E 2A FB 07 03A1 3A FE 07	5810 TTYOUT LD HL, (TTYOBF) *GET BUFFER ADDRESS 5820 LD A, (TTYOC) *GET NUMBER OF CHARACTERS
0364 47	5830 LD B+A
03A5 OE 00 03A7 11 00 00	5840 TTYOU1 LD C,ZERO 5850 LD DE,ZERO
03AA DB 03	5860 TTYD1 IN UARTST *GET STATUS
03AC CB 47 03AE CA BC 03	5870 BIT 0,A 5880 JP Z,TTYOU2 *JUMP IF BUFFER NOT EMPTY
03B1 7E	5890 LD A, (HL) *GET CHARACTER
03B2 D 3 02 03B4 05	5900 OUT UARTIO *OUTPUT CHARACTER 5910 DEC B
03B5 3E 00	5920 LD AZERO 5930 RET Z *RETURN IF BUFFER EMPTY
03B7 C8 03B8 23	5930 RET Z *RETURN IF BUFFER EMPTY 5931 INC HL
0389 C3 A5 03	5940 JP TTYOU1 5950 TTYOU2 INC DE *TRY AGAIN DELAY
03BC 1 3 03BD 7B	5960 LD A/E
03BE FE 00 03C0 C2 BC 03	5970 CP ZERO 5980 JP NZ+TTYOU2
03C3 7A	5990 LD A,D
03C4 FE 00 03C6 C2 BC 03	6000 CP ZERO 6010 JP NZ,TTYOU2
0309 00	6020 INC C
03CA FE 05 03CC C2 AA 03	6030 CP FIVE 6040 JP NZ,TTYD1 *JUMP IF .LT.5 TRYS
03CF 3E 01	6050 LD A,ONE #ELSE RETURN WITH A=1
03D1 C9 03D2	6060 RET 6070 *
0704	6080 ST 7C4H
07C4 07C4	6090 * 6100 *Page 2 constans,jump areas,and register
07C4 07C4	6110 *SAVE AREAS 6120 *
0704	6130 SPSTRT DB O *STACK AREA
00 07C5	6140 *
07C5	6150 * USER RESTART AREA
07C5 07C5	6160 ¥ 6170 RST2V DS 3 = #USER BRANCH AREA FOR RST 2
0708	6180 RST3V DS 3 *USER BRANCH AREA FOR RST 3
07CB 07CE	6190 RST4V DS 3 *USER BRANCH AREA FOR RST 4 6200 RST5V DS 3 *USER BRANCH AREA FOR RST 5
0701	6210 RST6V DS 3 *USER BRANCH AREA FOR RST 6
0704 070 7	6220 RST7V DS 3 *USER BRANCH AREA FOR RST 7 6230 *
07D7 07D7	6240 *REGISTER SAVE AREA 6250 *
0707	6260 IXLSAV DB O
00 07108	6270 IXHSAV DB O
00	
07D9 00	6280 IYLSAV DB O
0706	6290 IYHSAV DB O
00 070B	6300 SPLSAV DB 0
00	
0700	6310 SPHSAV DB O
0700	6320 PCLSAV DB 0
07DE	6330 PCHSAV DB 0
00 07DF	6340 ISAV DB O

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00					
07E0	6350 F	RSAV	DB	0	
00 07E1	6360 L	SAU	DB	0	
00					
07E2 00	6370 H	ISAV	DB	0	
07E3 00	6380 f	ASAV	DB	0	
07E4	6390 E	3SAV	DB	0	
00 07E5	6400 C	CSAV	DB	0	
00					
07E6 00	6410 I		DВ	0	
07E7 00	6420 E	ESAV	DB	0	
07E8	6 430 F	FSAV	DB	0	
00 07E 9	6440 P	ALSAV	DB	0	
00 07EA	6450 A	14690	DB	0	
00					
07EB 00	6460 A	IASAV	DB	0	
07EC 00	6470 A	18SAV	DB	0	
07ED	6480 A	1CSAV	DB	0	
00 07EE	6490 A	DSAV	DB	0	
00 07EF	6500 A	COALL	DB	0	
00					
07F0 00	6510 A	NFSAV	DB	0	
07F1	6520 *				
07F1 07F1	- 6530 ¥ - 6540 ¥		TURAU	E AREA	
07F1		FLAGS	DB	0	*KEYBOARD FLAGS
00 07F2	6560 K	(DATA1	DB	0	*KEYBOARD INPUT BUFFER
00 07F3	6570 K	(DATA2	ne	0	
00					
07F4 00	6580 T	E.M.	DВ	0	
07F5 00	6581 T	EMP2	DB	0	
07F6	6590 M	BASE1	DB	0	*BASE MEMORY ADDRESS
00 07F7	M 0066	BASE2	DB	0	
00 07F8	6610 R	EGINX	DB	0	*REGISTER INDEX
00 07F9	6620 T	TYIBF	DS	2	*TTY INPUT BUFFER ADDRESS
07FB 07FD	6630 T	TYOBF	DS	2	*TTYOUTFUT BUFFER ADDRESS
00	6640 T			0	*TTY INPUT CHARACTER COUNT
07FE 00	6650 T	TYOC	DB	0	*TTY OUTPUT CHARACTER COUNT
07FF 07FF	6660 * 6670 E				
VITE	00/V L	1410			

FILE 3000 7323 READY •

Appendix E - Z80 CPU Technical Specifications

Due to wide availability on the Internet, the Z80 CPU Technical Specifications were not scanned and included with the rest of this document.

Z80 CPU data sheets, technical documentation, and user manuals can be found on Gaby Chaudry's Z80 site at http://www.z80.info/ , or via a web search.

GLOSSARY

Accumulator A temporary register where results of calculations may be stored by the central processor. One or more accumulators may be part of the arithmetic-logical unit.

Acoustical coupler A device that permits a terminal to be connected to the computer via a telephone line. It connects to the telephone handset.

Address An identifying number or label for locations in the memory.

Algorithm A step-by-step solution to a problem in a finite number of steps. A specific procedure for accomplishing a desired result.

ASCII American Standard Code for Information Interchange. Widely used 7-bit standard code. Also known as USASCII; IBM uses EBCDIC, which has 8 bits.

Assembler A program that converts symbolic instructions into machine macroinstructions.

Backplane A board equipped with plugs interconnected by buses into which the modules that make up a computer may be inserted. Also known as a motherboard.

BASIC Beginner's All-purpose Symbolic Instruction Code. Algebraic language developed at Dartmouth College. The language is easy to learn and use.

Binary A numbering system based on multiples of two using the digits 0 and 1.

Bit Abbreviation of binary digit. A single element in a binary number—either a 0 or a 1. Bits are represented in a microcomputer by the status of electronic switches that can be either on or off. Four bits equal a nibble; eight bits equal a byte.

Byte A group of adjacent bits, usually eight bits, which is operated upon as a unit by the central processor.

CMOS Complementary Metal-Oxide Semiconductor. Technology that combines the component density of p-channel MOS (PMOS) and the speed of n-channel MOS (NMOS). Power consumption is very low.

Clock A device that generates regular pulses that synchronize events throughout a microcomputer.

Central processor The central processor controls the operation of a microcomputer. The central processor can fetch and store data and instructions from memory.

CRT Cathode-Ray Tube. An electronic vacuum tube that can be used for graphic display. Also refers to a terminal incorporating a CRT.

Compiler A program that translates high-level programming language into machine language. May produce numerous macro-instructions for each high-level instruction, unlike an assembler which translates item for item. When using a compiler, one cannot change a program without recompilation.

Development system A microcomputer system having all the related equipment necessary for hardware and software development.

Digital Pertaining to discrete integral numbers in a given base which may express all

the variables occurring in a problem. Represented electronically by 2 (binary) to 16 (hexadecimal) states at the present time. Contrasts with analog, which refers to a continuous range of voltage or current quantities.

Double density Method of doubling bit density on magnetic storage mediums.

Dynamic memory Storage of data on dynamic chips in which storage of a small charge indicates a bit. Because the charge leaks over time, dynamic memory must be periodically refreshed.

EBCDIC IBM's 8-bit code, similar to ASCII.

Editor A program that rearranges text. Permits the addition or deletion of symbols and changes of format.

EIA-RS-232C Interface standard for data transmitted sequentially that is not synchronous with the central processor.

EPROM Erasable-Progammable Read-Only Memory. A PROM that can be erased and reprogrammed. Some EPROMs have a quartz window over the chip; data can be erased by exposure to intense ultraviolet light; other EPROMs may be erased electrically.

File A set of related records treated as a unit.

Flag A bit attached to a word for identification or for the purpose of signaling some condition. Typical microprocessors include carry, zero, sign, overflow and half-carry status flags.

Floating-point package A set of software routines that allows some microcomputers to perform floating-point arithmetic without the addition of extra hardware.

FSK Frequency Shift Keying. Technique of transforming bits into two different frequencies representing 0 and 1 for transmission over telephone or radio lines. The interface device is called a modem.

Ground Electrical reference point of a circuit.

Hard-copy Printed output on paper.

Hardware The physical components, peripherals, or other equipment that make up a computer system. Contrast with software.

Hexadecimal A numbering system based on multiples of 16 using the character 0 thru 9 and A thru F. For example, 0B hexadecimal equals 0000 1011 binary. One byte may be encoded in exactly 2 hexadecimal symbols.

High-level language A programming language that is relatively independent of assembler or machine language. The grammar often resembles English and requires a compiler or interpreter to convert to executable code. Examples: BASIC, FORTRAN, COBOL, ALGOL, PL/M, APL.

Instruction A step in a program that defines an operation together with the address(es) of any data needed for the operation.

Interface A common boundary between two systems or devices. The hardware or software necessary to interconnect two parts of a system.

Interrupt A break in the execution of a program usually caused by a signal from an

external device.

Kansas City standard Refers to a standard for cassette tape recordings of EIA-RS-232C data. Eight cycles of 2400 Hz equals 1, and 4 cycles of 1200 Hz equals 0.

Least significant bit The binary digit occupying the right-most position in a number or word, ie: 2° or 1.

LIFO Last-In, First-Out. Method of accessing the most recent entry, then the next most recent, and so on.

Light pen Photosensitive device that can be used to change the display on a CRT by generating a pulse at the point of contact.

Machine language Sets of binary integers that may be directly executed as instructions by the microcomputers without prior interpretation.

Mass storage Floppy disks, cassettes or tapes used to store large amounts of data. Less accessible, but larger than main storage.

Memory Storage device for binary information.

Microcomputer A small computer system capable of performing a basic repertoire of instructions. Includes a central processor, often contained on a single chip, memory, I/O devices, and power supply.

Microprocessor A central processor on a chip. A complete processor on a single chip, manufactured using microminiature manufacturing techniques, known as LSI (large scale integration).

Modem MOdulator—DEModulator. Device that transforms binary data into frequencies suitable for transmission over telephone lines and back again.

Monitor A program that controls the operation of basic routines to optimize computer time.

Most significant bit The binary digit occupying the left-most position in a number or word, usually 2^7 or 128.

Octal A numbering system based on multiples of eight using digits 0 thru 7. Now largely superseded by the hexadecimal system.

Operating system Software that operates the hardware resources of a microcomputer. The operating system may do scheduling, debugging, I/O control, accounting, compilation, storage assignment, and data management.

Parity An extra bit that indicates whether a computer word has an odd or even number of 1s. Used to detect errors.

Peripheral Any piece of equipment, usually an I/O device, attached to the central processor.

Programmable memory Storage in which access to new information is independent of the address previously examined.

Read-only memory (ROM) Storage that cannot be altered. The information is written at the time of manufacture.

Register A memory device directly accessible by the central processor used for the

temporary storage of a computer word during arithmetic, logical, or input/output operations.

S-100 A 100-pin bus used in the popular 8080/Z80 system.

Software Programs that translate high-level languages into machine language, such as compilers, operating systems, assemblers, generators, library routines, and editors.

Stack A technique of presenting programs sequentially. A stack is a LIFO structure controlled by PUSH and POP instructions.

Tiny BASIC The BASIC programming language reduced to a simple form that permits integer arithmetic and some string operations. Tiny BASIC usually occupies 4 K or less bytes of memory.

Three-state Capable of existing in three logical states—0 (low), 1 (high), or undefined (high-impedance), ie: floating.

UART Universal Asynchronous Receiver Transmitter. A transmitter that converts serial to parallel and *vice versa*.

Word A set of bits that occupies one storage location and is treated as a unit. May have any number of bits, but usually 4, 8, or 16.

Word processor A text editor that allows the user to modify text: formats, books, letters, and reports.

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About the Author

Steve is a computer consultant, electrical engineer, author of BYTE magazine's most popular column, "Ciarcia's Circuit Cellar," and a "national technological treasure."